

SCHOOL OF ELECTRONICS ENGINEERING

B. Tech Electronics and Communication Engineering with Specialization in Sensor and Wearable Technology

Curriculum (2018-2019 admitted students)

VISION STATEMENT OF VELLORE INSTITUTE OF TECHNOLOGY

Transforming life through excellence in education and research.

MISSION STATEMENT OF VELLORE INSTITUTE OF TECHNOLOGY

World class Education: Excellence in education, grounded in ethics and critical thinking, for improvement of life.

Cutting edge Research: An innovation ecosystem to extend knowledge and solve critical problems.

Impactful People: Happy, accountable, caring and effective workforce and students.

Rewarding Co-creations: Active collaboration with national & international industries & universities for productivity and economic development.

Service to Society: Service to the region and world through knowledge and compassion.

VISION STATEMENT OF THE SCHOOL OF ELECTRONICS ENGINEERING

To be a leader by imparting in-depth knowledge in Electronics Engineering, nurturing engineers, technologists and researchers of highest competence, who would engage in sustainable development to cater the global needs of industry and society.

MISSION STATEMENT OF THE SCHOOL OF ELECTRONICS ENGINEERING

- Create and maintain an environment to excel in teaching, learning and applied research in the fields of electronics, communication engineering and allied disciplines which pioneer for sustainable growth.
- Equip our students with necessary knowledge and skills which enable them to be lifelong learners to solve practical problems and to improve the quality of human life.

B. Tech Electronics and Communication Engineering with Specialization in Sensor and Wearable Technology

PROGRAMME EDUCATIONAL OBJECTIVES (PEOs)

1. Graduates will be engineering practitioners and leaders, who would help solve industry's technological problems

2. Graduates will be engineering professionals, innovators or entrepreneurs engaged in technology development, technology deployment, or engineering system implementation in industry

3. Graduates will function in their profession with social awareness and responsibility

4. Graduates will interact with their peers in other disciplines in industry and society and contribute to the economic growth of the country

5. Graduates will be successful in pursuing higher studies in engineering or management

6. Graduates will pursue career paths in teaching or research

B. Tech Electronics and Communication Engineering with Specialization in Sensor and Wearable Technology

PROGRAMME OUTCOMES (POs)

PO_01: Having an ability to apply mathematics and science in engineering applications.

PO_02: Having a clear understanding of the subject related concepts and of contemporary issues and apply them to identify, formulate and analyse complex engineering problems.

PO_03: Having an ability to design a component or a product applying all the relevant standards and with realistic constraints, including public health, safety, culture, society and environment

PO_04: Having an ability to design and conduct experiments, as well as to analyse and interpret data, and synthesis of information

PO_05: Having an ability to use techniques, skills, resources and modern engineering and IT tools necessary for engineering practice

PO_06: Having problem solving ability- to assess social issues (societal, health, safety, legal and cultural) and engineering problems

PO_07: Having adaptive thinking and adaptability in relation to environmental context and sustainable development

PO_08: Having a clear understanding of professional and ethical responsibility

PO_09: Having cross cultural competency exhibited by working as a member or in teams

PO_10: Having a good working knowledge of communicating in English – communication with engineering community and society

PO_11: Having a good cognitive load management skills related to project management and finance

PO_12: Having interest and recognise the need for independent and lifelong learning

B. Tech Electronics and Communication Engineering with Specialization in Sensor and Wearable Technology

PROGRAMME SPECIFIC OUTCOMES (PSOs)

On the completion of B.Tech Electronics and Communication Engineering with Specialization with Specialization in Sensor and Wearable Technology,

Students will be able to

PSO1. Design and develop different classes of sensors, wearable devices and systems.

PSO2. Apply engineering tools to solve complex Electronics Engineering and interdisciplinary problems pertaining to wearable systems.

PSO3: Use skills and techniques to solve contemporary problems in the field of sensors and wearable technology.

B. Tech Electronics and Communication Engineering with Specialization in Sensor and Wearable Technology

CREDIT STRUCTURE

Category-wise Credit distribution

Category	Credits
University Core (UC)	70
University Elective(UE)	12
Program Core(PC)	69
Program Elective (PE)	29
Total Number of Credits	180

University Core – 70 Credits

Course Code	Course Title	L	Т	Р	J	С
CHY1002	Environmental Sciences	3	0	0	0	3
CSE1001	Problem Solving and Programming	0	0	6	0	3
CSE1002	Problem Solving and Object Oriented Programming	0	0	6	0	3
ECE3999	Technical Answers for Real World Problems (TARP)	1	0	0	8	3
ECE4098	Comprehensive Examination	0	0	0	0	2
ECE4099	Co-Op / Capstone Project	0	0	0	0	20
ENG1011	English for Engineers	0	0	4	0	2
HUM1021	Ethics and Values	2	0	0	0	2
MAT1011	Calculus for Engineers	3	0	2	0	4
MAT2001	Statistics for Engineers	2	2	2	0	4
MGT1022	Lean Start-up Management	1	0	0	4	2
PHY1001	Engineering Physics	3	0	2	0	4
PHY1999	Introduction to Innovative Projects	1	0	0	4	2
CBY4097	Chemistry / Biology	3	0	2	0	4
EXC4097	Co-Extra Curricular Basket	0	0	0	0	2
FLC4097	Foreign Language Course Basket	0	0	0	0	2
STS4097	Soft Skills	0	0	0	0	6
ECE3099	Industrial Internship	0	0	0	0	2

Program core -68 credits

S.No	Course Code	Course Title	L	Т	Р	J	С
1	CSE2003	Data Structures and Algorithms	2	0	2	4	4
2	ECE1017	Electromagnetic Field Theory and Transmission Lines	3	0	0	0	3
3	ECE1018	Signal Analysis and Processing	2	0	2	4	4
4	ECE1033	Basics of Sensors and Wearable Technology	2	0	2	0	3
5	ECE2010	Control Systems	3	0	0	4	4
6	ECE2024	Principles of Communication Engineering	2	0	0	0	2
7	ECE2026	Digital Circuit Design	2	0	2	4	4
8	ECE2028	Analog Circuits	2	0	2	4	4
9	ECE2032	Wearable Devices and Its Applications	2	0	2	4	4
10	ECE2033	Introduction to Data Analytics	2	0	2	0	3
11	ECE3029	Graphical System Design for Communication Engineers	0	0	4	0	2
12	ECE3030	Principles of Computer Communication	3	0	2	0	4
13	ECE3031	Microcontroller and Embedded Systems	2	0	2	4	4
14	ECE3032	Sensor Technology	2	0	2	0	3
15	ECE3037	Wireless sensor networks and IoT	2	0	0	4	3
16	ECE3042	Data Acquisition Techniques	3	0	0	4	4
17	ECE3044	Wearable Technology and IoT	2	0	0	4	3
18	EEE1001	Basic Electrical and Electronics Engineering	2	0	2	0	3
19	MAT2002	Applications of Differential and Difference Equations	3	0	2	0	4
20	MAT3004	Applied Linear Algebra	3	2	0	0	4

Program Electives – 30 Credits

S.No	Course Code	Course Title	L	Т	Р	J	С
1	CSE3019	Data Mining	2	0	2	4	4
2	CSE4033	Cloud Computing and Information Security	2	0	2	0	3
3	CSE4034	IoT Edge Nodes and its Applications	2	0	2	0	3
4	CSE4035	Mobile App Development for IoT	2	0	0	4	3
5	ECE2025	Probability and Statistical Theory of Communication	1	0	2	0	2
6	ECE2027	EMC and EMI	2	0	2	0	3
7	ECE2034	Flexible Electronics And Sensors	3	0	0	0	3
8	ECE3002	VLSI System Design	3	0	2	0	4
9	ECE3010	Antenna and Wave Propagation	3	0	0	0	3
10	ECE3011	Microwave Engineering	3	0	2	4	5
11	ECE3035	RFID and Flexible Sensors	3	0	0	0	3
12	ECE3036	Sensors for Structural Health Monitoring	2	0	0	4	3
13	ECE3038	MEMS and Nano Sensors	3	0	0	0	3
14	ECE3040	Wireless Technologies for IoT	3	0	0	0	3
15	ECE4002	Advanced Microcontrollers	3	0	0	4	4
16	ECE4005	Optical Communication and Networks	2	0	2	4	4
17	ECE4007	Information Theory and Coding	3	0	0	4	4
18	ECE4009	Wireless and Mobile Communication	3	0	2	4	5
19	ECE4025	Embedded Programming	2	0	2	0	3
20	ECE4026	M2M Communication	2	0	0	4	3
21	ECE4027	Embedded Sensing Technologies	2	0	0	4	3
22	ECE4030	Building Management System	1	0	0	0	1
23	ECE4031	Artificial Intelligence with Python	3	0	2	0	4
24	ECE4032	Neural Networks and Deep Learning	3	0	0	4	4
25	ITE1002	Web Technologies	2	0	2	0	3
26	MAT3005	Applied Numerical Methods	3	2	0	0	4
27	SWE4004	Geographical Information System	3	0	0	0	3

UNIVERSITY CORE

Course code	Course Title	L T P J C
CHY1701	Engineering Chemistry	3 0 2 0 4
Pre-requisite		Syllabus version
		1.1

Course Objectives:

- 1. To impart technological aspects of applied chemistry
- 2. To lay foundation for practical application of chemistry in engineering aspects

Expected Course Outcomes (CO): Students will be able to

- 1. **Recall** and **analyze** the issues related to impurities in water and their removal methods and **apply** recent methodologies in water treatment for domestic and industrial usage
- 2. **Evaluate** the causes of metallic corrosion and **apply** the methods for corrosion protection of metals
- 3. **Evaluate** the electrochemical energy storage systems such as lithium batteries, fuel cells and solar cells, and **design** for usage in electrical and electronic applications
- 4. **Assess** the quality of different fossil fuels and create an awareness to **develop** the alternative fuels
- 5. **Analyze** the properties of different polymers and distinguish the polymers which can be degraded and **demonstrate** their usefulness
- 6. **Apply** the theoretical aspects: (a) in **assessing** the water quality; (b) **understanding** the construction and working of electrochemical cells; (c) **analyzing** metals, alloys and soil using instrumental methods; (d) **evaluating** the viscosity and water absorbing properties of polymeric materials

Module:1 Water Technology

Characteristics of hard water - hardness, DO, TDS in water and their determination – numerical problems in hardness determination by EDTA; Modern techniques of water analysis for industrial use - Disadvantages of hard water in industries.

Module:2 Water Treatment

Water softening methods: - Lime-soda, Zeolite and ion exchange processes and their applications. Specifications of water for domestic use (ICMR and WHO); Unit processes involved in water treatment for municipal supply - Sedimentation with coagulant- Sand Filtration - chlorination; Domestic water purification – Candle filtration- activated carbon filtration; Disinfection methods-Ultrafiltration, UV treatment, Ozonolysis, Reverse Osmosis; Electro dialysis.

Module:3 Corrosion

Dry and wet corrosion - detrimental effects to buildings, machines, devices & decorative art forms, emphasizing Differential aeration, Pitting, Galvanic and Stress corrosion cracking; Factors that enhance corrosion and choice of parameters to mitigate corrosion.

Module:4Corrosion Control4 hours

Corrosion protection - cathodic protection – sacrificial anodic and impressed current protection methods; Advanced protective coatings: electroplating and electroless plating, PVD and CVD.

Alloying for corrosion protection – Basic concepts of Eutectic composition and Eutectic mixtures - Selected examples – Ferrous and non-ferrous alloys.

5 hours

8 hours

6 hours

solar cells, dye sensitized solar cells - working principles, characteristics and applications. Module:7 **Polymers** 6 hours Difference between thermoplastics and thermosetting plastics; Engineering application of plastics -ABS, PVC, PTFE and Bakelite; Compounding of plastics: moulding of plastics for Car parts, bottle caps (Injection moulding), Pipes, Hoses (Extrusion moulding), Mobile Phone Cases, Battery Trays, (Compression moulding), Fibre reinforced polymers, Composites (Transfer moulding), PET bottles (blow moulding); Conducting polymers- Polyacetylene- Mechanism of conduction – applications (polymers in sensors, self-cleaning windows) Module:8 **Contemporary issues:** 2 hours Lecture by Industry Experts Total Lecture hours: 45 hours Text Book(s) 1. Sashi Chawla, A Text book of Engineering Chemistry, Dhanpat Rai Publishing Co., Pvt. 1. Ltd., Educational and Technical Publishers, New Delhi, 3rd Edition, 2015. 2. O.G. Palanna, McGraw Hill Education (India) Private Limited, 9th Reprint, 2015. 3. B. Sivasankar, Engineering Chemistry 1st Edition, Mc Graw Hill Education (India), 2008 4. "Photovoltaic solar energy : From fundamentals to Applications", Angà "le Reinders, Pierre Verlinden, Wilfried van Sark, Alexandre Freundlich, Wiley publishers, 2017. **Reference Books** 1. O.V. Roussak and H.D. Gesser, Applied Chemistry-A Text Book for Engineers and *Technologists*, Springer Science Business Media, New York, 2nd Edition, 2013. 2. S. S. Dara, A Text book of Engineering Chemistry, S. Chand & Co Ltd., New Delhi, 20th Edition, 2013. Mode of Evaluation: Internal Assessment (CAT, Quizzes, Digital Assignments) & FAT List of Experiments Experiment title Hours Water Purification: Estimation of water hardness by EDTA method and its 1 h 30 min 1. removal by ion-exchange resin

applications. Fuel cells – Polymer membrane fuel cells, Solid-oxide fuel cells- working principles, advantages, applications.

Solar cells – Types – Importance of silicon single crystal, polycrystalline and amorphous silicon

Module:6	Fuels and Combustion	8 hours
<u><u><u></u></u> <u></u> <u></u></u>		

Calorific value - Definition of LCV, HCV. Measurement of calorific value using bomb calorimeter and Boy's calorimeter including numerical problems.

Controlled combustion of fuels - Air fuel ratio – minimum quantity of air by volume and by weight-Numerical problems-three way catalytic converter- selective catalytic reduction of NO_X; Knocking in IC engines-Octane and Cetane number - Antiknocking agents.

Brief introduction to conventional primary and secondary batteries; High energy electrochemical

Module:5 | Electrochemical Energy Systems

6 hours

	Water Quality Monitoring:	3 h				
2.	Assessment of total dissolved oxygen in different water samples	by				
	Winkler's method					
3.	Estimation of sulphate/chloride in drinking water by conductivity n	nethod				
4/5	Material Analysis: Quantitative colorimetric determination of div	valent 3h				
	metal ions of Ni/Fe/Cu using conventional and smart phone digital	-imaging				
	methods					
6.	Analysis of Iron in carbon steel by potentiometry	1 h 30 min				
7.	7. Construction and working of an Zn-Cu electrochemical cell					
8.	Determination of viscosity-average molecular weight of different	1 h 30 min				
	natural/synthetic polymers					
9.	Arduino microcontroller based sensor for m	onitoring 1 h 30 min				
	pH/temperature/conductivity in samples.					
	Total Laborate	bry Hours 17 hours				
	de of Evaluation: Viva-voce and Lab performance & FAT					
Reco	ommended by Board of Studies 31-05-2019					
App	proved by Academic Council 54 th Date 13-	06-2019				

		Course			
CHY1002		Environment	al Sciences		0 3
Pre-requisite				Syllabus v	
					V:1.
Course Obje					
		derstand and appreciate the	unity of life in	n all its forms, the	
		e on the environment.			
		rious causes for environme			
		duals contribution in the en	1		
4. To unde	erstand the in	pact of pollution at the glo	bal level and a	llso in the local environm	ent.
		····· · · · · · · · · · · · · · · · ·	_		
<u> </u>		me: Students will be able		• • 1• • 1• • 1•	
		nize the environmental issu	les in a proble	m oriented interdisciplina	ary
perspe		stand the law environmen	tal iccuracy the	agianga habind those prol	alama
	tential soluti	rstand the key environmen	lai issues, the	science bennia mose prot	JICHIS
-		nstrate the significance of	biodiversity	and its preservation	
		ify various environmental h	•		
		n various methods for the c		f resources	
	0	ulate action plans for sustai			nce.
	ity, and social				,
	•	foundational knowledge en	abling them to	make sound life decision	ns as
		er in an environmental prof			
Module:1	Environme	ent and Ecosystem		7 ho	ours
Module:1		•			
Key environ	mental probl	ems, their basic causes		ble solutions. IPAT eq	uation
Key environ Ecosystem, ea	mental problem arth – life sup	ems, their basic causes oport system and ecosystem	n components	ble solutions. IPAT eq ; Food chain, food web, I	uatior Energ
Key environ Ecosystem, ea flow in ecosy	mental probl arth – life suj ystem; Ecolo	ems, their basic causes oport system and ecosystem gical succession- stages in	n components nvolved, Prim	ble solutions. IPAT eq ; Food chain, food web, I ary and secondary succ	uation Energ ession
Key environ Ecosystem, ea flow in ecosy Hydrarch, me	mental probl arth – life suj ystem; Ecolo sarch, xerarch	ems, their basic causes oport system and ecosystem	n components nvolved, Prim	ble solutions. IPAT eq ; Food chain, food web, I ary and secondary succ	uatior Energ ession
Key environ Ecosystem, ea flow in ecosy Hydrarch, me	mental probl arth – life suj ystem; Ecolo sarch, xerarch	ems, their basic causes oport system and ecosystem gical succession- stages in	n components nvolved, Prim	ble solutions. IPAT eq ; Food chain, food web, I ary and secondary succ	uation Energy ession
Key environ Ecosystem, ea flow in ecosy Hydrarch, me on these cycle	mental probl arth – life suj ystem; Ecolo sarch, xerarci	ems, their basic causes oport system and ecosystem gical succession- stages in h; Nutrient, water, carbon, h	n components nvolved, Prim	ble solutions. IPAT eq ; Food chain, food web, I ary and secondary succ	uation Energ ession ties
Key environ Ecosystem, ea flow in ecosy Hydrarch, me on these cycle	mental probl arth – life suj ystem; Ecolo sarch, xerarch ss.	ems, their basic causes oport system and ecosystem gical succession- stages in h; Nutrient, water, carbon, h	n components nvolved, Prim	ble solutions. IPAT eq ; Food chain, food web, l ary and secondary succ es; Effect of human activi	uation Energy ession ties
Key environ Ecosystem, ea flow in ecosy Hydrarch, me on these cycle Module:2	mental probl arth – life suj ystem; Ecolo sarch, xerarch ss. Biodiversit ypes, mega-b	ems, their basic causes oport system and ecosystem gical succession- stages in h; Nutrient, water, carbon, n y iodiversity; Species interaction	i components nvolved, Prim nitrogen, cycle ion - Extinct,	ble solutions. IPAT eq ; Food chain, food web, I ary and secondary succ es; Effect of human activi 6 hor endemic, endangered and	uation Energ ession ties urs I rare
Key environ Ecosystem, ea flow in ecosy Hydrarch, me on these cycle Module:2 Importance, ty species; Hot-s	mental probl arth – life suj ystem; Ecolo sarch, xerarch ss. Biodiversit ypes, mega-b spots; GM cro	ems, their basic causes oport system and ecosyster gical succession- stages in h; Nutrient, water, carbon, n y iodiversity; Species interactops- Advantages and disadv	i components nvolved, Prim nitrogen, cycle ion - Extinct, antages; Terre	ble solutions. IPAT eq ; Food chain, food web, I aary and secondary succ es; Effect of human activi 6 ho endemic, endangered and estrial biodiversity and Ac	uation Energ ession ties urs I rare quatic
Key environ Ecosystem, ea flow in ecosy Hydrarch, me on these cycle Module:2 Importance, ty species; Hot-species; Hot-sp	mental probl arth – life suj ystem; Ecolo sarch, xerarch ss. Biodiversit ypes, mega-b spots; GM cro	ems, their basic causes oport system and ecosystem gical succession- stages in h; Nutrient, water, carbon, n y iodiversity; Species interaction	i components nvolved, Prim nitrogen, cycle ion - Extinct, antages; Terre	ble solutions. IPAT eq ; Food chain, food web, I aary and secondary succ es; Effect of human activi 6 ho endemic, endangered and estrial biodiversity and Ac	uation Energ ession ties urs I rare quatic
Key environ Ecosystem, ea flow in ecosy Hydrarch, me on these cycle Module:2 Importance, ty species; Hot-s	mental probl arth – life suj ystem; Ecolo sarch, xerarch ss. Biodiversit ypes, mega-b spots; GM cro	ems, their basic causes oport system and ecosyster gical succession- stages in h; Nutrient, water, carbon, n y iodiversity; Species interactops- Advantages and disadv	i components nvolved, Prim nitrogen, cycle ion - Extinct, antages; Terre	ble solutions. IPAT eq ; Food chain, food web, I aary and secondary succ es; Effect of human activi 6 ho endemic, endangered and estrial biodiversity and Ac	uation Energ ession ties urs I rare quatic
Key environ Ecosystem, ea flow in ecosy Hydrarch, me on these cycle Module:2 Importance, ty species; Hot-s biodiversity – methods.	mental probl arth – life sup ystem; Ecolo sarch, xerarch ss. Biodiversit ypes, mega-b pots; GM cro Significance	ems, their basic causes oport system and ecosyster gical succession- stages in n; Nutrient, water, carbon, n y iodiversity; Species interactops- Advantages and disady , Threats due to natural and	ion - Extinct, antages; Terre	ble solutions. IPAT eq ; Food chain, food web, I aary and secondary succes; Effect of human activi 6 ho endemic, endangered and estrial biodiversity and Ad c activities and Conserva	uation Energ ession ties urs l rare quatic tion
Key environ Ecosystem, ea flow in ecosy Hydrarch, me on these cycle Module:2 Importance, ty species; Hot-species; Hot-sp	mental probl arth – life suj ystem; Ecolo sarch, xerarch ss. Biodiversit ypes, mega-b pots; GM cro Significance Sustaining	ems, their basic causes oport system and ecosyster gical succession- stages in h; Nutrient, water, carbon, h y iodiversity; Species interactops- Advantages and disady , Threats due to natural and Natural Resources	ion - Extinct, antages; Terre	ble solutions. IPAT eq ; Food chain, food web, I aary and secondary succes; Effect of human activi 6 ho endemic, endangered and estrial biodiversity and Ad c activities and Conserva	uation Energ ession ties urs I rare quatic
Key environ Ecosystem, ea flow in ecosy Hydrarch, me on these cycle Module:2 Importance, ty species; Hot-species; Hot-sp	mental probl arth – life suj ystem; Ecolo sarch, xerarch ss. Biodiversit ypes, mega-b pots; GM cro Significance Sustaining	ems, their basic causes oport system and ecosyster gical succession- stages in n; Nutrient, water, carbon, n y iodiversity; Species interactops- Advantages and disady , Threats due to natural and	ion - Extinct, antages; Terre	ble solutions. IPAT eq ; Food chain, food web, I aary and secondary succes; Effect of human activi 6 ho endemic, endangered and estrial biodiversity and Ad c activities and Conserva	uation Energ ession ties urs l rare quatic tion
Key environ Ecosystem, ea flow in ecosy Hydrarch, me on these cycle Module:2 Importance, ty species; Hot-s biodiversity – methods.	mental probl arth – life sug ystem; Ecolo sarch, xerarch s. Biodiversit ypes, mega-b pots; GM cro Significance Sustaining Environme	ems, their basic causes oport system and ecosyster gical succession- stages in n; Nutrient, water, carbon, n y iodiversity; Species interactops- Advantages and disady , Threats due to natural and Natural Resources ental Quality	ion - Extinct, antages; Terre anthropogeni	ble solutions. IPAT eq ; Food chain, food web, I aary and secondary succ es; Effect of human activi 6 hou endemic, endangered and estrial biodiversity and Ac c activities and Conserva 7 h	uation Energ ession ties urs l rare quatic tion ours
Key environ Ecosystem, ea flow in ecosy Hydrarch, me on these cycle Module:2 Importance, ty species; Hot-s biodiversity – methods. Module:3 Environmenta	mental probl arth – life suj ystem; Ecolo sarch, xerarch ss. Biodiversit ypes, mega-b ypes, mega-b ypots; GM cro Significance Significance Sustaining Environme	ems, their basic causes oport system and ecosyster gical succession- stages in h; Nutrient, water, carbon, h y iodiversity; Species interacto ops- Advantages and disady , Threats due to natural and Natural Resources ental Quality causes and solutions. Bio	ion - Extinct, antages; Terre anthropogeni and logical hazard	ble solutions. IPAT eq ; Food chain, food web, I aary and secondary succ es; Effect of human activi 6 hou endemic, endangered and estrial biodiversity and Ac c activities and Conserva 7 h ds – AIDS, Malaria, Ch	uation Energy ession ties urs I rare quatic tion ours
Key environ Ecosystem, ea flow in ecosy Hydrarch, me on these cycle Module:2 Importance, ty species; Hot-species; Hot-sp	mental probl arth – life suj ystem; Ecolo sarch, xerarch ss. Biodiversit ypes, mega-b pots; GM cro Significance Sustaining Environme al hazards – , PCB, Phtha	ems, their basic causes oport system and ecosyster gical succession- stages in n; Nutrient, water, carbon, n y iodiversity; Species interactops- Advantages and disady , Threats due to natural and Natural Resources ental Quality	ion - Extinct, antages; Terre anthropogeni and logical hazard zards- Risk an	ble solutions. IPAT eq ; Food chain, food web, 1 aary and secondary succ es; Effect of human activi 6 hou endemic, endangered and estrial biodiversity and Ad c activities and Conserva 7 h ds – AIDS, Malaria, Ch nd evaluation of hazards.	uation Energy ession ties urs l rare quatic tion ours eemica Wate
Key environ Ecosystem, ea Flow in ecosy Hydrarch, me on these cycle Module:2 Species; Hot-so biodiversity – methods. Module:3 Environmenta hazards- BPA Footprint; virt	mental probl arth – life sup ystem; Ecolo sarch, xerarch ss. Biodiversit ypes, mega-b pots; GM cro Significance Sustaining Environme I hazards – , PCB, Phtha ual water, blu	ems, their basic causes oport system and ecosyster gical succession- stages in h; Nutrient, water, carbon, h y iodiversity; Species interactor ops- Advantages and disady , Threats due to natural and Natural Resources ental Quality causes and solutions. Bio lates, Mercury, Nuclear ha	ion - Extinct, antages; Terre anthropogeni and logical hazard zards- Risk an management	ble solutions. IPAT eq ; Food chain, food web, 1 aary and secondary succ es; Effect of human activi 6 hou endemic, endangered and estrial biodiversity and Ad c activities and Conserva 7 h ds – AIDS, Malaria, Ch nd evaluation of hazards.	uation Energ ession ties urs l rare quatic tion ours eemica Wate
Key environ Ecosystem, ea flow in ecosy Hydrarch, me on these cycle Module:2 Importance, ty species; Hot-species; Hot-sp	mental probl arth – life sup ystem; Ecolo sarch, xerarch ss. Biodiversit ypes, mega-b pots; GM cro Significance Sustaining Environme I hazards – , PCB, Phtha ual water, blu	ems, their basic causes oport system and ecosyster gical succession- stages in h; Nutrient, water, carbon, n y iodiversity; Species interactor ops- Advantages and disadw , Threats due to natural and Natural Resources ental Quality causes and solutions. Bio dates, Mercury, Nuclear have revolution. Water quality	ion - Extinct, antages; Terre anthropogeni and logical hazard zards- Risk an management	ble solutions. IPAT eq ; Food chain, food web, 1 aary and secondary succ es; Effect of human activi 6 hor endemic, endangered and estrial biodiversity and Ad c activities and Conserva 7 h ds – AIDS, Malaria, Ch and evaluation of hazards. and its conservation. Soli	uation Energy ession ties urs l rare quatic tion ours eemica Wate d and
Key environ Ecosystem, ea flow in ecosy Hydrarch, me on these cycle Module:2 Importance, ty species; Hot-species; Hot-sp	mental probl arth – life sup ystem; Ecolo sarch, xerarch ss. Biodiversit ypes, mega-b pots; GM cro Significance Sustaining Environme I hazards – , PCB, Phtha ual water, blu	ems, their basic causes oport system and ecosyster gical succession- stages in h; Nutrient, water, carbon, h y iodiversity; Species interactor ops- Advantages and disady , Threats due to natural and Natural Resources ental Quality causes and solutions. Bio dates, Mercury, Nuclear have revolution. Water quality id waste management meth	ion - Extinct, antages; Terre anthropogeni and logical hazard zards- Risk an management	ble solutions. IPAT eq ; Food chain, food web, 1 aary and secondary succ es; Effect of human activi 6 hou endemic, endangered and estrial biodiversity and Ad c activities and Conserva 7 h ds – AIDS, Malaria, Ch nd evaluation of hazards.	uation Energy ession ties urs l rare quatic tion ours eemica Wate d and

Renewable - Non renewable energy resources- Advantages and disadvantages - oil, Natural gas, Coal, Nuclear energy. Energy efficiency and renewable energy. Solar energy, Hydroelectric power, Ocean thermal energy, Wind and geothermal energy. Energy from biomass, solar- Hydrogen revolution.

Module:5	Environmental Impact Assessment	6 hours
	to environmental impact analysis. EIA guidelines, I	
	ntal Protection Act – Air, water, forest and wild life	
	es. Public awareness. Environmental priorities in In	
Module:6	Human Population Change and Environment	6 hours
Urban envir	nmental problems; Consumerism and waste produc	ts: Promotion of economic
	t – Impact of population age structure – Women and	
1	nt. Sustaining human societies: Economics, environ	
I I I I	6	, , , , , , , , , , , , , , , , , , ,
Module:7	Global Climatic Change and Mitigation	5 hours
	uption, Green house effect, Ozone layer depletion an	
	its, Carbon sequestration methods and Montreal Pro	tocol. Role of Information
technology i	n environment-Case Studies.	
Module:8	Contemporary issues	2 hours
	Industry Experts	-
		2 hours 45 hours
Lecture by	Industry Experts	-
Lecture by Text Books	Total Lecture hours:	45 hours
Lecture by Text Books 1. G. Tyle	r Miller and Scott E. Spoolman (2016), Environmen	45 hours
Lecture by Text Books 1. G. Tyle learning	Total Lecture hours: Total Lecture hours: r Miller and Scott E. Spoolman (2016), Environmen g.	45 hours tal Science, 15 th Edition, Cengage
Lecture by Text Books 1. G. Tyle learning 2. George	r Miller and Scott E. Spoolman (2016), Environmen g. Tyler Miller, Jr. and Scott Spoolman (2012), Living	45 hours tal Science, 15 th Edition, Cengage in the Environment –
Lecture by Text Books 1. G. Tyle learning 2. George Principl	Total Lecture hours: Total Lecture hours: r Miller and Scott E. Spoolman (2016), Environmen g. Tyler Miller, Jr. and Scott Spoolman (2012), Living es, Connections and Solutions, 17 th Edition, Brooks	45 hours tal Science, 15 th Edition, Cengage in the Environment –
Lecture by Text Books 1. G. Tyle learning 2. George Principl Reference F	Total Lecture hours: Total Lecture hours: r Miller and Scott E. Spoolman (2016), Environmen g. Tyler Miller, Jr. and Scott Spoolman (2012), Living es, Connections and Solutions, 17 th Edition, Brooks Books	45 hours tal Science, 15 th Edition, Cengage in the Environment – /Cole, USA.
Lecture by Text Books 1. G. Tyle learning 2. George Principl Reference F 1. David	Total Lecture hours: Total Lecture hours: r Miller and Scott E. Spoolman (2016), Environmen g. Tyler Miller, Jr. and Scott Spoolman (2012), Living es, Connections and Solutions, 17 th Edition, Brooks Books M.Hassenzahl, Mary Catherine Hager, Lin	45 hours tal Science, 15 th Edition, Cengage in the Environment – /Cole, USA. da R.Berg (2011), Visualizing
Lecture by Text Books 1. G. Tyle learning 2. George Principl Reference H 1. David Enviror	Total Lecture hours: Total Lecture hours: r Miller and Scott E. Spoolman (2016), Environmen g. Tyler Miller, Jr. and Scott Spoolman (2012), Living es, Connections and Solutions, 17 th Edition, Brooks Books M.Hassenzahl, Mary Catherine Hager, Lin mental Science, 4thEdition, John Wiley & Sons, US	45 hours tal Science, 15 th Edition, Cengage in the Environment – /Cole, USA. da R.Berg (2011), Visualizing SA.
Lecture by Text Books 1. G. Tyle learning 2. George Principl Reference E 1. David Enviror Mode of eva	Total Lecture hours: Total Lecture hours: r Miller and Scott E. Spoolman (2016), Environmen g. Tyler Miller, Jr. and Scott Spoolman (2012), Living es, Connections and Solutions, 17 th Edition, Brooks Books M.Hassenzahl, Mary Catherine Hager, Lin mental Science, 4thEdition, John Wiley & Sons, US luation: Internal Assessment (CAT, Quizzes, Digital	45 hours tal Science, 15 th Edition, Cengage in the Environment – /Cole, USA. da R.Berg (2011), Visualizing SA.
Lecture by Text Books 1. G. Tyle learning 2. George Principl Reference E 1. David Enviror Mode of eva Recommend	Total Lecture hours: Total Lecture hours: r Miller and Scott E. Spoolman (2016), Environmen g. Tyler Miller, Jr. and Scott Spoolman (2012), Living es, Connections and Solutions, 17 th Edition, Brooks Books M.Hassenzahl, Mary Catherine Hager, Lin mental Science, 4thEdition, John Wiley & Sons, US luation: Internal Assessment (CAT, Quizzes, Digital	45 hours tal Science, 15 th Edition, Cengage in the Environment – /Cole, USA. da R.Berg (2011), Visualizing SA. I Assignments) & FAT

Course code	Course Ti				P J	С
CSE1001	PROBLEM SOLVING AND	PROGRAMMING	-	-	6 0	3
Pre-requisite	NIL		Syll	labu	s vers	
<u> </u>						1.0
Course Objectiv						
	elop broad understanding of compu	iters, programming langua	ages a	and th	neir	
genera		1 . 1 . 6 . 11 . 1 .				
	ice the essential skills for a logical t					
	n expertise in essential skills in pro-	ogramming for problem s	olving	g usn	ng	
compute Expected Course						
-	tand the working principle of a con	muter and identify the nu	rnosa	ofa	comp	
	nming language.	iputer and identify the pu	pose	01 a	comp	ute
1 0	various problem solving approache	s and ability to identify a	n ann	ronri	ate	
	ch to solve the problem	s and ability to identify a	n app	Topn	ale	
11	ntiate the programming Language c	constructs appropriately to	solve	anv	probl	em
	various engineering problems using			J	I ···	
	modulate the given problem using		ogram	ming	ŗ	
	ntly handle data using flat files to p					n
	of Challenging Experiments (Indi					
1. Steps in P	oblem Solving Drawing flowchart u	using yEd tool/Raptor Too	ol		3 Hou	urs
2. Introducti	n to Python, Demo on IDE, Keywo	rds, Identifiers, I/O Staten	nents.		4 Hou	urs
	gram to display Hello world in Pyth	non.				
	and Expressions in Python				4 Hoi	
	c Approach 1: Sequential				2 Hou	
	c Approach 2: Selection (if, elif, if				2 Ho	
-	c Approach 3: Iteration (while and	tor)			4 Hou	
-	l its Operations				2 Hou	
9. Regular E					2 Hou 2 Hou	
10. List and it 11. Dictionari	-				2 Hot 2 Hot	
	its operations				2 Hot 2 Hot	
13. Set and its	-				2 Hot	
14. Functions					2 Hot	
	chniques (Bubble/Selection/Insertio	n)			4 Hot	
	Techniques : Sequential Search and				3 Hou	
17. Files and		j			4 Hot	urs
	-					
Total Lectu	e hours:				45 ho	ur
Text Book(s)						
	., 2016. Introduction to computation and data. PHI Publisher.	nd programming using pytho	on: wit	h app	licatio	ons
Reference Books						
1. Charles Severance.	rance.2016.Python for everybody	: exploring data in P	ython	3,	Char	les
2. Charles Dier	pach.2013.Introduction to compute	er science using python:	: a c	ompı	utatio	nal
problem-solv	ng focus. Wiley Publishers.					
Mode of Evaluati						
Recommended by						
Approved by Aca	lemic Council No. 38	Date 23-10-20	15			

	e		Cours			1	⊿ Ⅰ	P J	C
CSE1002		PROBLE	M SOLVING A PROGRA	ND OBJEC'. AMMING	F ORIENTEI		0	6 0	3
Pre-requisite	e	Nil				Sylla	abus	s ver	sio
									1.
Course Object									
			ect oriented conce					_	
			al time applicatio						res
-	e the ski	lls of a logical	thinking and to se	olve the prob	lems using any	y proces	ssing		
elements	0								
Expected Con									
		-	ural programmin	g and to repro	esent the real v	vorld er	titie	es as	
programming			. 1. 1.	1 11	1	1.	1		
	•	oriented concep	ots and translate re	eal-world app	olications into	graphic	al		
representation		C 1	1 1	1 11		<i>.</i> •			
		U	and objects of the		11			~ <i>t</i> -	
			nultiple interfaces	; with same f	unctionality ba	ised fea	ure	s to	
		uting problems	constructs for una	ntininated at	too/innuto or o	touse	ao**	aria	
					ates/inputs and	to use	gen	eric	
			odate different d		hlom				
		un against file ared Program	inputs towards so	iving the pro	blem			12 ho	
				tamaanta am	functions	maint			Ju
			ll and looping sta	tements - arra	tys - functions	- point	ers -		
dynamic mem	nory and	ocation - struct	ule						
Module:2	Introd	luction to obje	ct oriented appr	oach				10 ho	111
		v	roach: Why obje		rogramming?	- Char			
			d objects - encap						
			Demerits of obje						rai
			rgument function						
01 0 01 1111						, , , , , , , , , , , , , , , , , , , ,	-		
independent re			rning reference p		nce.				
independent r			rning reference p		nce.				
	referenc	e function retu			nce.			14 ho	DU
Module:3	referenc Classe	es and object	ts	ass by referen		ructure			
Module:3 Classes and c	referenc Classe objects:	e function retu es and object Definition o		ass by referen	ass versus st		cor	struc	cto
Module:3 Classes and c	referenc Classe objects:	e function retu es and object Definition o	t s f classes access	ass by referen	ass versus st		cor	struc	cto
Module:3 Classes and c destructor cop friend class	Classo objects: py cons	es and object cs and object Definition o structor and its	ts f classes access importance array	ass by referen	ass versus st		cor	struc	cto
Module:3 Classes and c destructor cop friend class	Classo objects: py cons	es and object s and object Definition o structor and its	t s f classes access	ass by referen	ass versus st		cor and t	struc	cto ior
Module:3 Classes and c destructor cop friend class Module:4	Classe objects: py cons Polym	es and object s and object Definition of structor and its norphism and	ts f classes access importance array	ass by referent	ass versus st lynamic objec	ts - frie	cor and t	istruc funct 26 ho	ior
Module:3 Classes and c destructor cop friend class Module:4 Polymorphisn	Classo objects: py cons Polym m and	es and object s and object Definition of structor and its norphism and Inheritance: H	ts f classes access importance array d Inheritance	ass by referent	ass versus st lynamic objec le polymorphi	ts - frie	cor end t	Struc Funct	ior Du
Module:3 Classes and o destructor cop friend class Module:4 Polymorphism loading opera	Classo objects: py cons Polym m and ator ove	es function returns es and object Definition of structor and its norphism and Inheritance: Ferloading, Inhe	ts f classes access importance array d Inheritance Polymorphism -	ass by referent specifier cl y of objects of compile time of inheritance	ass versus st lynamic objec e polymorphi - constructor	ts - frie	cor end 1 nctic	Eunct	oto ior ou ve
Module:3 Classes and o destructor cop friend class Module:4 Polymorphism loading opera	Classo objects: py cons Polym m and ator ove	es function returns es and object Definition of structor and its norphism and Inheritance: Ferloading, Inhe	ts f classes access importance array d Inheritance Polymorphism - ritance - types o	ass by referent specifier cl y of objects of compile time of inheritance	ass versus st lynamic objec e polymorphi - constructor	ts - frie	cor end 1	Eunct	oto ior ou ve
Module:3 Classes and c destructor cop friend class Module:4 Polymorphisn loading opera inheritance co overriding	Classo objects: py cons Polym m and ator ove onstrain	es function returns es and object Definition of structor and its norphism and Inheritance: Herloading. Inheritance ts of multiple i	ts f classes access importance array d Inheritance Polymorphism - ritance - types o nheritance - virtu	ass by referent	ass versus st lynamic objec e polymorphi - constructor	ts - frie	cor nd t nctic lestr	estruc funct 26 ho on o uctor func	oui ve s i tio
Module:3 Classes and or destructor cop friend class Module:4 Polymorphism loading opera inheritance co overriding Module:5	Classe objects: py cons Polym m and ator ove onstrain Excep	es function returns es and object Definition of structor and its norphism and Inheritance: Herloading. Inhe ts of multiple i	ts f classes access importance array d Inheritance Polymorphism - ritance - types o nheritance - virtu	ass by referent specifier cl y of objects of compile time of inheritance al base class tes	ass versus st lynamic objec e polymorphi - constructor - run time poly	ts - frie sm fur s and d ymorph	cor nd t	26 ho on o uctor func	cto ior ou ve s i tio
Module:3 Classes and or destructor cop friend class Module:4 Polymorphism loading opera inheritance co overriding Module:5 Exception ha	Classo objects: py cons Polym m and ator ove onstrain Excep andling	es function returns es and object Definition of structor and its norphism and Inheritance: F erloading. Inhe its of multiple i otion handling and Templates	ts f classes access importance array d Inheritance Polymorphism - ritance - types o nheritance - virtu g and Templa Exception handl	ass by referent specifier cl y of objects of compile time of inheritance al base class tes ing(user-defi	ass versus st lynamic objec e polymorphi - constructor - run time poly ned exception	ts - frie sm fur s and d ymorph) - Func	cor nd t nctic lestr ism-	26 ho on o uctor func 18 ho	oui ove rs i tio
Module:3 Classes and or destructor cop friend class Module:4 Polymorphism loading opera inheritance co overriding Module:5 Exception ha	Classo objects: py cons Polym m and ator ove onstrain Excep andling	es function returns es and object Definition of structor and its norphism and Inheritance: F erloading. Inhe its of multiple i otion handling and Templates	ts f classes access importance array d Inheritance Polymorphism - ritance - types o nheritance - virtu	ass by referent specifier cl y of objects of compile time of inheritance al base class tes ing(user-defi	ass versus st lynamic objec e polymorphi - constructor - run time poly ned exception	ts - frie sm fur s and d ymorph) - Func	cor nd t nctic lestr ism-	26 ho on o uctor func 18 ho	oun tior

	lule:6 IO Streams and Files	10 hours
	streams and Files IOstreams, Manipulators - overloading Inserters() and Extract	tors(),
	uential and Random files writing and reading objects into/from files	
	t Book(s)	
1.	Stanley B Lippman, Josee Lajoie, Barbara E, Moo, C++ primer, Fifth editi Wesley, 2012.	on, Addison-
2	Ali Bahrami, Object oriented Systems development, Tata McGraw - Hill Educ	cation, 1999.
3	Brian W. Kernighan, Dennis M. Ritchie, The C programming Language, 2nd Prentice Hall Inc., 1988.	edition,
Refe	erence Books	
1.	Bjarne stroustrup, The C++ programming Language, Addison Wesley, 4th edi	tion, 2013
2.	Harvey M. Deitel and Paul J. Deitel, C++ How to Program, 7th edition, Prenti	
3.	Maureen Sprankle and Jim Hubbard, Problem solving and Programming conce edition, Pearson Eduction, 2014.	
Mod	le of Evaluation: CAT / Assignment / Quiz / FAT / Project / Seminar	
	of Challenging Experiments (Indicative)	
1.	Postman Problem	10 hours
	A postman needs to walk down every street in his area in order to deliver the	10 110 010
	mail. Assume that the distances between the streets along the roads are	
	given. The postman starts at the post office and returns back to the post	
	office after delivering all the mails. Implement an algorithm to help the post	
	man to walk minimum distance for the purpose.	
2.	Budget Allocation for Marketing Campaign	15 hours
	A mobile manufacturing company has got several marketing options such as	
	Radio advertisement campaign, TV non peak hours campaign, City top	
	paper network, Viral marketing campaign, Web advertising. From their	
	previous experience, they have got a statistics about paybacks for each	
	marketing option. Given the marketing budget (rupees in crores) for the	
	current year and details of paybacks for each option, implement an algorithm	
	to determine the amount that shall spent on each marketing option so that the	
	company attains the maximum profit.	
3.	Missionaries and Cannibals	10 hours
	Three missionaries and three cannibals are on one side of a river, along with	
	a boat that can hold one or two people. Implement an algorithm to find a	
	way to get everyone to the other side of the river, without ever leaving a	
	group of missionaries in one place outnumbered by the cannibals in that	
	place.	
4.	Register Allocation Problem	15 hours
	A register is a component of a computer processor that can hold any type of	
	data and can be accessed faster. As registers are faster to access, it is	
	desirable to use them to the maximum so that the code execution is faster.	
	For each code submitted to the processor, a register interference graph (RIG)	
	is constructed. In a RIG, a node represents a temporary variable and an edge	
	is added between two nodes (variables) t1 and t2 if they are live	
	simultaneously at some point in the program. During register allocation, two	
	temporaries can be allocated to the same register if there is no edge	
	connecting them. Given a RIG representing the dependencies between	
	variables in a code, implement an algorithm to determine the number of	
	registers required to store the variables and speed up the code execution	

5.	Selective Job Scheduling Problem	n			15 hours			
	A server is a machine that waits fo	r requests from o	other machin	nes and				
	responds to them. The purpose of a							
	resources among clients. All the cl							
	execution and the server may get n							
	situation, the server schedule the jo							
	and logic. Each job contains two v	•		• •				
	for execution. Assume that there as							
	on time and memory. The servers a							
	memory Schedule Server respectiv			1				
	the time Schedule Server and mem	•						
	Server arranges jobs based on time							
	whereas memory Schedule Server	arranges jobs ba	sed on mem	ory required				
	for execution in ascending order							
6.	Fragment Assembly in DNA Seq	15 hours						
	DNA, or deoxyribonucleic acid, is							
	almost all other organisms. The int							
	made up of four chemical bases: ad							
	thymine (T). In DNA sequencing,							
	small fragments (reads) which assemble to form a single genomic sequence (superstring). Each read is a small string. In such a fragment assembly, given							
	a set of reads, the objective is to de							
	contains all the reads. For example 011, 100, 101, 110, 111 the shortes							
	of reads, implement an algorithm t							
	contains all the given reads.							
7.	House Wiring	10 hours						
7.	An electrician is wiring a house where where the second se	room has	10 110013					
	many power points in different locations. Given a set of power points and the distances between them, implement an algorithm to find the minimum							
	cable required.		Total Lal	oratory Hours	90 hours			
Mod	e of assessment: Project/Activity		I otur Dut		20110010			
		29-10-2015						
Reco	Recommended by Board of Studies29-10-2015Approved by Academic CouncilNo. 39Date17-12-2015							

ECE3099	In	dustrial Inter	nship			L	Τ	P	J	C
			-			0	0	0	0	2
Pre-requisite	Completion of mi	nimum of Two	o semeste	ers		•				
Course Object	ives:									
The course is de	esigned so as to exp	ose the studen	ts to indu	ustry e	nvironi	ment	t and	l to	take	
up on-site assig	nment as trainees or	r interns.								
Expected Cour	rse Outcome:									
_	is internship the stu	dent should be	able to:							
1 11				.1. 1						
	exposure to industring industries to effectively	rial practices a	na to wo	ork in to	eams					
	and the impact of er	nainaaring col	utions in	a alah		nom	i			
		ignicering son	illons m	a giou						
environ	mental and societal			υ	ui, eeoi	nom	ic,			
	mental and societal	context		-				mino	Ţ	
4. Develop	the ability to engage	context ge in research		-				ming	5	
 Develop Compre 	the ability to engage hend contemporary	context ge in research a issues	and to in	-				ming	5	
 Develop Compre 	the ability to engage	context ge in research a issues	and to in	-				ning	5	
 Develop Compre 	the ability to engage hend contemporary	context ge in research a issues	and to in	-				ming	2	
 Develop Compre Engage 	the ability to engage hend contemporary	context ge in research a issues	and to in	-						
 Develop Compre 	the ability to engage hend contemporary	context ge in research a issues	and to in	-					Wee	k
 Develop Compre Engage 	the ability to engage hend contemporary	context ge in research a issues	and to in	-		long				k
 Develop Compre Engage Contents	o the ability to engag hend contemporary in establishing his/h	context ge in research a issues her digital foot	and to in	-		long				k
 Develop Compre Engage Contents	the ability to engage hend contemporary	context ge in research a issues her digital foot	and to in	-		long				k
 4. Develop 5. Compre 6. Engage Contents Four weeks of vertex of vert	o the ability to engag hend contemporary in establishing his/h	context ge in research a issues ner digital foot	and to in	-		long				k
 4. Develop 5. Compre 6. Engage Contents Four weeks of vertex of vert	o the ability to engag hend contemporary in establishing his/h	context ge in research a issues ner digital foot	and to in	-		long				k
 4. Develop 5. Compre 6. Engage Contents Four weeks of v Supervised by a	b the ability to engage hend contemporary in establishing his/h work at industry site an expert at the indu	context ge in research a issues ner digital foot	and to in	volve	in life-]	long 4				k
 4. Develop 5. Compre 6. Engage Contents Four weeks of v Supervised by a	o the ability to engag hend contemporary in establishing his/h	context ge in research a issues ner digital foot	and to in	volve	in life-]	long 4				k
 4. Develop 5. Compre 6. Engage Contents Four weeks of v Supervised by a Mode of Evaluation	work at industry site an expert at the indu	context ge in research a issues ner digital foot	and to in	volve	in life-]	long 4				
 4. Develop 5. Compre 6. Engage Contents Four weeks of v Supervised by a	work at industry site an expert at the indu	context ge in research a issues her digital foot	and to in	volve	in life-]	long 4				

Course code	Technical Answ	vers for Real Wo	rld Proble	ems (TARP)	L T P J C
ECE3999					1 0 0 8 3
Pre-requisite	PHY1999 and 115	Credits Earned			Syllabus version
					1.0
Course Objectives					
1. To help student needs	ts to identify the need	l for developing n	ewer tech	nologies for	industrial / societal
2. To train studen	ts to propose and imp	plement relevant t	echnology	for the deve	elopment of the
prototypes / pro					
	idents learn to the us	e the methodolog	ies availab	ole to assess	the developed
prototypes / pro	oducts				
Exported Course	Outcomo				
Expected Course	e course, the student	will be able to			
	life problems related				
5	priate technology(ies	•	lentified p	roblems usir	g engineering
	arrive at innovative s		ionunioa p		
Module:1					15 hours
 Field visits 6 – 10 stude Minimum of Appropriate Solution sh design/relev Consolidate Participatio will be used Project outo political and Contributio 	on of real life problem can be arranged by the ents can form a team of eight hours on self- e scientific methodol ould be in the form of vant scientific metho- ed report to be submi- n, involvement and co d as the modalities for come to be evaluated d demographic feasither n of each group men- component to have to	he faculty concern (within the same -managed team ac ogies to be utilize of fabrication/codi dology(ies) tted for assessmen contribution in gro or the continuous a in terms of techn pility nber to be assesse	/ different ctivity d to solve ng/modeli nt oup discuss assessment ical, econc d	the identifie ng/product d sions during t of the theor omical, socia	lesign/process the contact hours y component l, environmental,
20:30:50 – project Recommended by		ed, presentation an 05/03/2016	nd project i	reviews	
Approved by Acad		40th AC	Date	18/03/2010	0

Course Code	Course Title	L T P J C
ECE4099	Capstone Project	0 0 0 20
Pre-requisite	As per the academic regulations	Syllabus version
		1.0

Course Objectives:

To provide sufficient hands-on learning experience related to the design, development and analysis of suitable product / process so as to enhance the technical skill sets in the chosen field.

Expected Course Outcome:

At the end of the course the student will be able to

- 1. Formulate specific problem statements for ill-defined real life problems with reasonable assumptions and constraints.
- 2. Perform literature search and / or patent search in the area of interest.
- 3. Conduct experiments / Design and Analysis / solution iterations and document the results.
- 4. Perform error analysis / benchmarking / costing
- 5. Synthesise the results and arrive at scientific conclusions / products / solution
- 6. Document the results in the form of technical report / presentation

Contents

- 1. Capstone Project may be a theoretical analysis, modeling & simulation, experimentation & analysis, prototype design, fabrication of new equipment, correlation and analysis of data, software development, applied research and any other related activities.
- 2. Project can be for one or two semesters based on the completion of required number of credits as per the academic regulations.
- 3. Can be individual work or a group project, with a maximum of 3 students.
- 4. In case of group projects, the individual project report of each student should specify the individual's contribution to the group project.
- 5. Carried out inside or outside the university, in any relevant industry or research institution.
- 6. Publications in the peer reviewed journals / International Conferences will be an added advantage

Mode of Evaluation: Periodic reviews, Presentation, Final oral viva, Poster submission

Recommended by Board of Studies	10.06.2015		
Approved by Academic Council	37 th AC	Date	16.06.2015

Course code		Course title		L	Τ	P	J	C
ENG1011		English for Enginee	rs	0	0	4	0	2
Pre-requisite	Cleared EPT /	/ Effective English			S	•	is versi	ion
Course Obie-4						V.	. 2.2	
Course Object		for academic purposes	and real-life situatio	ins				
		ommunication with focu			elopm	ent.		
3. To aid student	s apply language and c	communication skills in						
Expected Cour			<u> </u>					
		n academic and real-li ot print and learn to fa		idantl	X 7			
1 0	00	porting skills to aid th		lucitti	у.			
4. Comprehend	language and comm	unication skills in aca	demic and social c	ontex	xts.			
5. Acquire voca	bulary and learn stra	ategies for error-free c	ommunication.					
Module:1	Listening						4 ho	ours
(Casual and Academic	2						
Module:2	Speaking						4 ho	ours
	Socializing Skills - Intr	roducing Oneself- His	/ Her Goals & SW(DT				
Module:3	Reading						2 ho	ours
<u> </u>	Skimming and Scanni	ing						
Module:4	Writing						2 ho	ours
I	Error-free sentences,	, Paragraphs						
Module:5	Listening						4 ho	ours
	News (Authenti	ic Material): Analyzin Informati		iain S	pecifi	С		
Module:6	Speaking						4 ho	ours
(Group Discussion on	factual, controversial	and abstract issue	S				
Module:7	Reading:						2 ho	ours
[Extensive Reading							
Module:8	Writing						2 ho	ours
E	Email Etiquette with	focus on Content and	Audience					
Module:9	Listening						4 ho	ours
	Speeches : General a	nd Domain Specific In	formation					
Module:10	Speaking						4 ho	ours
[Developing Persuasiv	ve Skills - Turncoat and	Debate					
Module:11	Reading						2 ho	urs
I	ntensive Reading							
Module:12	Writing						2 ho	urs

	Data	a Transcoding	
Module:1	13	Cross Cultural Communication	4 hours
	Und	erstanding Inter and Cross-Cultural Communication	Nuances
Module:1	14	Speaking	4 hours
	Publi	c Speaking/Extempore /Monologues	
Module:1	15	Reading for research	2 hours
	Read	ing Scientific/Technical Articles	
Module:1	L6	Writing	2 hours
	Crea	ting a Digital/Online Profile – LinkedIn (Résumé/Vid	eo Profile)
Module:1	L7	Speaking:	4 hours
-	Moc	k Job/Placement Interviews	
Module:1	18	Writing	2 hours
	Repo	ort Writing	
Module:1	19	Speaking	4 hours
	Pres	entation using Digital Tools	
Module:2	20	Vocabulary	2 hours
	Cross	sword Puzzles/Word games	
		Total Lecture hours:	60 hours
Text Boo	k (s)		I
1.		Oxenden and Christina Latham-Koenig, New English	
	with	Test and Assessment CD-ROM: Six-level general Eng	lish course for adults Paperback
2	Feb 2	013, Oxford University Press, UK	
2	Clive	Oxenden and Christina Latham-Koenig,New Students	English File: Advanced
	Book	Paperback – Feb 2012, Oxford University Press, UK	
3	Micha	ael Vince,Language Practice for Advanced - 2014,4th Edition, Macmillan Education, Oxford	,
Reference	e Books		
1.	Steven Press,	Brown, Dorolyn Smith, Active Listening 3, 2011, 3 rd I	Edition, Cambridge University
	UK		
2.	Tony Ly	nch, Study Listening, 2013, 2 nd Edition, Cambridge L	Iniversity Press, UK
3.	Liz Ham UK	p-Lyons, Ben Heasley, Study Writing, 2010, 2 nd Editi	ion, Cambridge University Press,
	Kenneth Cambrid	n Anderson, Joan Maclean, Tony Lynch, Study Speak	king, 2013, 2 nd Edition,

4.	University Press, UK							
5.	Eric H. Glendinning, Beverly I University Press, UK	Holmstrom, Study	Reading, 20)12, 2 nd Edition C	ambridge			
6.	Michael Swan, Practical English Usage (Practical English Usage), Jun 2017, 4th edition, Oxford							
	University Press, UK							
7.	Michael McCarthy, Felicity O Edition), May 2015, Cambrid	-	•	se Advanced (Sou	uth Asian			
8.	Michael Swan, Catherine Wa	lter, Oxford English	n Grammar	Course Advance	d, Feb 2012,			
	4 th Edition, Oxford University	Press, UK						
9.	Heather Silyn-Roberts, Writing for Science and Engineering: Papers, Presentations and Reports, Jun 2016, 2nd Edition, Butterworth-Heinemann, UK							
Mode of I	Evaluation: Assignment and FAT	- Mini Project, Flip	ped Class R	loom, Lecture, Pl	PT's, Role play,			
Assignme	nts Class/Virtual Presentations,	Report and beyon	d the classr	oom activities				
	List	of Challenging Exp	eriments (I	ndicative)				
1.	Create a Digital or Online P	Profile or a Digital F	ootprint		6 hours			
2.	Prepare a video resume 8 hours							
3.	Analyse a documentary critically 4 hours							
4.	Turn Coat- Speaking for and against the topic / Activities through VIT6 hoursCommunity Radio							
5	Present a topic using 'Prez	,			6 hours			
6	Analyse a case on cross cultural communication critically 6 hours							
7	Create a list of words relating to your domain 4 hours							
8	Listen to a conversation of native speakers of English and answer the following questions 6 hours							
9	Read an article and critically analyse the text in about 150 words6 hours							
10	Read an autobiography and role play the character in class by taking an excerpt from the book 8 hours							
			Total P	ractical Hours	60 hours			
Mode of e	evaluation: Mini Project, Flipped	Class Room, Lectu	ire, PPT's, R	l Role play, Assignr	nents			
Class/Virt	ual Presentations, Report and b	eyond the classroo	om activities	S				
,								
-	ended by Board of Studies	22-07-2017						

HUMI021 ETHICS AND VALUES 2 0 0 2 Pre-requisite Nil Syllabus version I. To understand and appreciate the ethical issues faced by an individual in profession, society and polity 1.1 Course Objectives: 1.1 I. To understand and appreciate the ethical issues faced by an individual in profession, society and polity 2. To understand the negative health impacts of certain unhealthy behaviors 3. To appreciate the need and importance of physical, emotional health and social health Expected Course Outcome: Students will be able to: 1. Follow sound morals and ethical values scrupulously to prove as good citizens 2. Understand various social problems and learn to act ethically 3. Understand various social problems and learn to act ethically 3. Understand the concept of addiction and how it will affect the physical and mental health 4. Identify ethical concerns in research and intellectual contexts, including academic integrity, use and citation of sources, the objective presentation of data, and the treatment of human subjects 5. Identify the main typologies, characteristics, activities, actors and forms of cybercrime Module:1 Being Good and Responsible 5 hours Gandhian values such as truth and non-violence – Comparative analysis on leaders of past and present – Society's interests versus self-interests - Personal Social Responsibility: Helping the needy, charity and serving the society
Image: Constraint of the second se
Course Objectives: 1. To understand and appreciate the ethical issues faced by an individual in profession, society and polity 2. To understand the negative health impacts of certain unhealthy behaviors 3. To appreciate the need and importance of physical, emotional health and social health Expected Course Outcome: Students will be able to: 1. Follow sound morals and ethical values scrupulously to prove as good citizens 2. Understand various social problems and learn to act ethically 3. Understand the concept of addiction and how it will affect the physical and mental health 4. Identify ethical concerns in research and intellectual contexts, including academic integrity, use and citation of sources, the objective presentation of data, and the treatment of human subjects 5. Identify the main typologies, characteristics, activities, actors and forms of cybercrime Module:1 Being Good and Responsible 5 hours Gandhian values such as truth and non-violence – Comparative analysis on leaders of past and present – Society's interests versus self-interests - Personal Social Responsibility: Helping the needy, charity and serving the society Module:2 Social Issues 1 4 hours Harassment – Types - Prevention of harassment, Violence and Terrorism 4 hours Corruption: Ethical values, causes, impact, laws, prevention – Electoral malpractices; White collar crimes - Tax evasions – Unfair
1. To understand and appreciate the ethical issues faced by an individual in profession, society and polity 2. To understand the negative health impacts of certain unhealthy behaviors 3. To appreciate the need and importance of physical, emotional health and social health Expected Course Outcome: Students will be able to: 1. Follow sound morals and ethical values scrupulously to prove as good citizens 2. Understand various social problems and learn to act ethically 3. Understand the concept of addiction and how it will affect the physical and mental health 4. Identify ethical concerns in research and intellectual contexts, including academic integrity, use and citation of sources, the objective presentation of data, and the treatment of human subjects 5. Identify the main typologies, characteristics, activities, actors and forms of cybercrime Module:1 Being Good and Responsible Shours Gandhian values such as truth and non-violence – Comparative analysis on leaders of past and present – Society's interests versus self-interests - Personal Social Responsibility: Helping the needy, charity and serving the society Module:2 Social Issues 1 4 hours Harassment – Types - Prevention of harassment, Violence and Terrorism 4 hours Corruption: Ethical values, causes, impact, laws, prevention – Electoral malpractices; White collar crimes - Tax evasions – Unfair trade practices
 2. To understand the negative health impacts of certain unhealthy behaviors 3. To appreciate the need and importance of physical, emotional health and social health Expected Course Outcome: Students will be able to: Follow sound morals and ethical values scrupulously to prove as good citizens Understand the concept of addiction and how it will affect the physical and mental health Identify ethical concerns in research and intellectual contexts, including academic integrity, use and citation of sources, the objective presentation of data, and the treatment of human subjects Identify the main typologies, characteristics, activities, actors and forms of cybercrime Module:1 Being Good and Responsible Social sources of past and non-violence – Comparative analysis on leaders of past and present – Society's interests versus self-interests - Personal Social Responsibility: Helping the needy, charity and serving the society Module:2 Social Issues 1 /// A hours Harassment – Types - Prevention of harassment, Violence and Terrorism Module:3 Social Issues 2 /// A hours Corruption: Ethical values, causes, impact, laws, prevention – Electoral malpractices; White collar crimes - Tax evasions – Unfair trade practices Module:4 Addiction and Health /// S hours Pere pressure - Alcoholism: Ethical values, causes, impact, laws, prevention – III effects of smoking - Prevention of Suicides; Sexual Health: Prevention and impact of pre-marital pregnancy and Sexually Transmitted Diseases
3. To appreciate the need and importance of physical, emotional health and social health Expected Course Outcome: Students will be able to: 1. Follow sound morals and ethical values scrupulously to prove as good citizens 2. Understand various social problems and learn to act ethically 3. Understand the concept of addiction and how it will affect the physical and mental health 4. Identify ethical concerns in research and intellectual contexts, including academic integrity, use and citation of sources, the objective presentation of data, and the treatment of human subjects 5. Identify the main typologies, characteristics, activities, actors and forms of cybercrime Module:1 Being Good and Responsible Social Sources the objective presentation of data, and the treatment of human subjects 5. Identify the main typologies, characteristics, activities, actors and forms of cybercrime Module:1 Being Good and Responsible Social result and non-violence – Comparative analysis on leaders of past and present – Society's interests versus self-interests - Personal Social Responsibility: Helping the needy, charity and serving the society Module:2 Social Issues 1 4 hours Harassment – Types - Prevention of harassment, Violence and Terrorism 4 hours Corruption: Ethical values, causes, impact, laws, prevention – Electoral malpractices; White collar crimes - Tax evasions – Unfair trade practices <
Expected Course Outcome: Students will be able to: 1. Follow sound morals and ethical values scrupulously to prove as good citizens 2. Understand various social problems and learn to act ethically 3. Understand the concept of addiction and how it will affect the physical and mental health 4. Identify ethical concerns in research and intellectual contexts, including academic integrity, use and citation of sources, the objective presentation of data, and the treatment of human subjects 5. Identify the main typologies, characteristics, activities, actors and forms of cybercrime Module:1 Being Good and Responsible Society's interests versus self-interests - Personal Social Responsibility: Helping the needy, charity and serving the society Module:2 Social Issues 1 Harassment – Types - Prevention of harassment, Violence and Terrorism Module:3 Social Issues 2 4 hours Corruption: Ethical values, causes, impact, laws, prevention – Electoral malpractices; White collar crimes - Tax evasions – Unfair trade practices Module:4 Addiction and Health Shours Shours Peer pressure - Alcoholism: Ethical values, causes, impact, laws, prevention – Ill effects of smoking - Prevention of Suicides; Sexual Health: Prevention and impact of pre-marital pregnancy and Sexually Transmitted Diseases
Students will be able to: 1. Follow sound morals and ethical values scrupulously to prove as good citizens 2. Understand the concept of addiction and how it will affect the physical and mental health 4. Identify ethical concerns in research and intellectual contexts, including academic integrity, use and citation of sources, the objective presentation of data, and the treatment of human subjects 5. Identify the main typologies, characteristics, activities, actors and forms of cybercrime Module:1 Being Good and Responsible 5 hours Gandhian values such as truth and non-violence – Comparative analysis on leaders of past and present – Society's interests versus self-interests - Personal Social Responsibility: Helping the needy, charity and serving the society Module:2 Social Issues 1 4 hours Harassment – Types - Prevention of harassment, Violence and Terrorism 4 hours Corruption: Ethical values, causes, impact, laws, prevention – Electoral malpractices; White collar crimes - Tax evasions – Unfair trade practices Module:4 Addiction and Health 5 hours Peer pressure - Alcoholism: Ethical values, causes, impact, laws, prevention – Ill effects of smoking - Prevention of Suicides; Sexual Health: Prevention and impact of pre-marital pregnancy and Sexually Transmitted Diseases Module:5 Drug Abuse 3 hours
Students will be able to: 1. Follow sound morals and ethical values scrupulously to prove as good citizens 2. Understand various social problems and learn to act ethically 3. Understand the concept of addiction and how it will affect the physical and mental health 4. Identify ethical concerns in research and intellectual contexts, including academic integrity, use and citation of sources, the objective presentation of data, and the treatment of human subjects 5. Identify the main typologies, characteristics, activities, actors and forms of cybercrime Module:1 Being Good and Responsible 5 hours Gandhian values such as truth and non-violence – Comparative analysis on leaders of past and present – Society's interests versus self-interests - Personal Social Responsibility: Helping the needy, charity and serving the society Module:2 Social Issues 1 4 hours Harassment – Types - Prevention of harassment, Violence and Terrorism 4 hours Corruption: Ethical values, causes, impact, laws, prevention – Electoral malpractices; White collar crimes - Tax evasions – Unfair trade practices Module:4 Addiction and Health 5 hours Peer pressure - Alcoholism: Ethical values, causes, impact, laws, prevention – Ill effects of smoking - Prevention of Suicides; Sexual Health: Prevention and impact of pre-marital pregnancy and Sexually Transmitted Diseases Module:5 Drug Abuse 3 hours
 2. Understand various social problems and learn to act ethically 3. Understand the concept of addiction and how it will affect the physical and mental health 4. Identify ethical concerns in research and intellectual contexts, including academic integrity, use and citation of sources, the objective presentation of data, and the treatment of human subjects 5. Identify the main typologies, characteristics, activities, actors and forms of cybercrime Module:1 Being Good and Responsible 5 hours Gandhian values such as truth and non-violence – Comparative analysis on leaders of past and present – Society's interests versus self-interests - Personal Social Responsibility: Helping the needy, charity and serving the society Module:2 Social Issues 1 4 hours Harassment – Types - Prevention of harassment, Violence and Terrorism Module:3 Social Issues 2 4 hours Corruption: Ethical values, causes, impact, laws, prevention – Electoral malpractices; White collar crimes - Tax evasions – Unfair trade practices Module:4 Addiction and Health 5 hours Peer pressure - Alcoholism: Ethical values, causes, impact, laws, prevention – Ill effects of smoking - Prevention of Suicides; Sexual Health: Prevention and impact of pre-marital pregnancy and Sexually Transmitted Diseases Module:5 Drug Abuse 3 hours
 3. Understand the concept of addiction and how it will affect the physical and mental health 4. Identify ethical concerns in research and intellectual contexts, including academic integrity, use and citation of sources, the objective presentation of data, and the treatment of human subjects 5. Identify the main typologies, characteristics, activities, actors and forms of cybercrime Module:1 Being Good and Responsible 5 hours Gandhian values such as truth and non-violence – Comparative analysis on leaders of past and present – Society's interests versus self-interests - Personal Social Responsibility: Helping the needy, charity and serving the society Module:2 Social Issues 1 4 hours Harassment – Types - Prevention of harassment, Violence and Terrorism Module:3 Social Issues 2 4 hours Corruption: Ethical values, causes, impact, laws, prevention – Electoral malpractices; White collar crimes - Tax evasions – Unfair trade practices Module:4 Addiction and Health 5 hours Peer pressure - Alcoholism: Ethical values, causes, impact, laws, prevention – Ill effects of smoking - Prevention of Suicides; Sexual Health: Prevention and impact of pre-marital pregnancy and Sexually Transmitted Diseases Module:5 Drug Abuse 3 hours
4. Identify ethical concerns in research and intellectual contexts, including academic integrity, use and citation of sources, the objective presentation of data, and the treatment of human subjects 5. Identify the main typologies, characteristics, activities, actors and forms of cybercrime Module:1 Being Good and Responsible 5. Gandhian values such as truth and non-violence – Comparative analysis on leaders of past and present – Society's interests versus self-interests - Personal Social Responsibility: Helping the needy, charity and serving the society Module:2 Social Issues 1 4 hours: 4 hours: Module:3 Social Issues 2 4 hours: 4 hours: Corruption: Ethical values, causes, impact, laws, prevention – Electoral malpractices; White collar crimes - Tax evasions – Unfair trade practices Module:4 Addiction and Health 5 hours: Peer pressure - Alcoholism: Ethical values, causes, impact, laws, prevention – Ill effects of smoking - Prevention of Suicides; Sexual Health: Prevention and impact of pre-marital pregnancy and Sexually Transmitted Diseases Module:5 Drug Abuse 3 hours
citation of sources, the objective presentation of data, and the treatment of human subjects 5. Identify the main typologies, characteristics, activities, actors and forms of cybercrime Module:1 Being Good and Responsible 5 hours Gandhian values such as truth and non-violence – Comparative analysis on leaders of past and present – Society's interests versus self-interests - Personal Social Responsibility: Helping the needy, charity and serving the society Module:2 Social Issues 1 4 hours Harassment – Types - Prevention of harassment, Violence and Terrorism 4 hours Corruption: Ethical values, causes, impact, laws, prevention – Electoral malpractices; White collar crimes - Tax evasions – Unfair trade practices Module:4 Addiction and Health 5 hours Peer pressure - Alcoholism: Ethical values, causes, impact, laws, prevention – Ill effects of smoking - Prevention of Suicides; Sexual Health: Prevention and impact of pre-marital pregnancy and Sexually Transmitted Diseases Module:5 Drug Abuse 3 hours
5. Identify the main typologies, characteristics, activities, actors and forms of cybercrime 5. Identify the main typologies, characteristics, activities, actors and forms of cybercrime Module:1 Being Good and Responsible 5 hours Gandhian values such as truth and non-violence – Comparative analysis on leaders of past and present – Society's interests versus self-interests - Personal Social Responsibility: Helping the needy, charity and serving the society Module:2 Social Issues 1 4 hours Harassment – Types - Prevention of harassment, Violence and Terrorism 4 hours Corruption: Ethical values, causes, impact, laws, prevention – Electoral malpractices; 4 hours Module:4 Addiction and Health 5 hours Peer pressure - Alcoholism: Ethical values, causes, impact, laws, prevention – Ill effects of smoking – Prevention of Suicides; Sexual Health: Prevention and impact of pre-marital pregnancy and Sexually Transmitted Diseases Module:5 Drug Abuse 3 hours
Gandhian values such as truth and non-violence – Comparative analysis on leaders of past and present – Society's interests versus self-interests - Personal Social Responsibility: Helping the needy, charity and serving the society Module:2 Social Issues 1 4 hours Harassment – Types - Prevention of harassment, Violence and Terrorism 4 hours Module:3 Social Issues 2 4 hours Corruption: Ethical values, causes, impact, laws, prevention – Electoral malpractices; White collar crimes - Tax evasions – Unfair trade practices Module:4 Addiction and Health 5 hours Peer pressure - Alcoholism: Ethical values, causes, impact, laws, prevention – Ill effects of smoking - Prevention of Suicides; Sexual Health: Prevention and impact of pre-marital pregnancy and Sexually Transmitted Diseases Module:5 Drug Abuse 3 hours
Gandhian values such as truth and non-violence – Comparative analysis on leaders of past and present – Society's interests versus self-interests - Personal Social Responsibility: Helping the needy, charity and serving the society Module:2 Social Issues 1 4 hours Harassment – Types - Prevention of harassment, Violence and Terrorism 4 hours Module:3 Social Issues 2 4 hours Corruption: Ethical values, causes, impact, laws, prevention – Electoral malpractices; White collar crimes - Tax evasions – Unfair trade practices Module:4 Addiction and Health 5 hours Peer pressure - Alcoholism: Ethical values, causes, impact, laws, prevention – Ill effects of smoking - Prevention of Suicides; Sexual Health: Prevention and impact of pre-marital pregnancy and Sexually Transmitted Diseases Module:5 Drug Abuse 3 hours
Gandhian values such as truth and non-violence – Comparative analysis on leaders of past and present – Society's interests versus self-interests - Personal Social Responsibility: Helping the needy, charity and serving the society Module:2 Social Issues 1 4 hours Harassment – Types - Prevention of harassment, Violence and Terrorism 4 hours Module:3 Social Issues 2 4 hours Corruption: Ethical values, causes, impact, laws, prevention – Electoral malpractices; White collar crimes - Tax evasions – Unfair trade practices Module:4 Addiction and Health 5 hours Peer pressure - Alcoholism: Ethical values, causes, impact, laws, prevention – Ill effects of smoking - Prevention of Suicides; Sexual Health: Prevention and impact of pre-marital pregnancy and Sexually Transmitted Diseases Module:5 Drug Abuse 3 hours
Gandhian values such as truth and non-violence – Comparative analysis on leaders of past and present – Society's interests versus self-interests - Personal Social Responsibility: Helping the needy, charity and serving the society Module:2 Social Issues 1 4 hours Harassment – Types - Prevention of harassment, Violence and Terrorism 4 hours Module:3 Social Issues 2 4 hours Corruption: Ethical values, causes, impact, laws, prevention – Electoral malpractices; White collar crimes - Tax evasions – Unfair trade practices Module:4 Addiction and Health 5 hours Peer pressure - Alcoholism: Ethical values, causes, impact, laws, prevention – Ill effects of smoking - Prevention of Suicides; Sexual Health: Prevention and impact of pre-marital pregnancy and Sexually Transmitted Diseases Module:5 Drug Abuse 3 hours
Society's interests versus self-interests - Personal Social Responsibility: Helping the needy, charity and serving the society Module:2 Social Issues 1 4 hours Harassment – Types - Prevention of harassment, Violence and Terrorism 4 hours Module:3 Social Issues 2 4 hours Corruption: Ethical values, causes, impact, laws, prevention – Electoral malpractices; 4 hours Module:4 Addiction and Health 5 hours Peer pressure - Alcoholism: Ethical values, causes, impact, laws, prevention – Ill effects of smoking - Prevention of Suicides; 5 knours Sexual Health: Prevention and impact of pre-marital pregnancy and Sexually Transmitted Diseases 3 hours
serving the society Image: Social Issues 1 Image: A hours Module:2 Social Issues 1 4 hours Harassment – Types - Prevention of harassment, Violence and Terrorism 4 hours Module:3 Social Issues 2 4 hours Corruption: Ethical values, causes, impact, laws, prevention – Electoral malpractices; 4 hours White collar crimes - Tax evasions – Unfair trade practices 5 hours Peer pressure - Alcoholism: Ethical values, causes, impact, laws, prevention – Ill effects of smoking - Prevention of Suicides; 5 knours Sexual Health: Prevention and impact of pre-marital pregnancy and Sexually Transmitted Diseases 3 hours
Module:2 Social Issues 1 4 hours Harassment – Types - Prevention of harassment, Violence and Terrorism 4 hours Module:3 Social Issues 2 4 hours Corruption: Ethical values, causes, impact, laws, prevention – Electoral malpractices; 4 hours White collar crimes - Tax evasions – Unfair trade practices 5 hours Module:4 Addiction and Health 5 hours Peer pressure - Alcoholism: Ethical values, causes, impact, laws, prevention – Ill effects of smoking – Prevention of Suicides; 5 sexual Health: Prevention and impact of pre-marital pregnancy and Sexually Transmitted Diseases Module:5 Drug Abuse 3 hours
Harassment – Types - Prevention of harassment, Violence and Terrorism Module:3 Social Issues 2 4 hours Corruption: Ethical values, causes, impact, laws, prevention – Electoral malpractices; 4 hours White collar crimes - Tax evasions – Unfair trade practices 5 hours Module:4 Addiction and Health 5 hours Peer pressure - Alcoholism: Ethical values, causes, impact, laws, prevention – Ill effects of smoking - Prevention of Suicides; 9 sexual Health: Prevention and impact of pre-marital pregnancy and Sexually Transmitted Diseases Module:5 Drug Abuse 3 hours
Harassment – Types - Prevention of harassment, Violence and Terrorism Module:3 Social Issues 2 4 hours Corruption: Ethical values, causes, impact, laws, prevention – Electoral malpractices; 4 hours White collar crimes - Tax evasions – Unfair trade practices 5 hours Module:4 Addiction and Health 5 hours Peer pressure - Alcoholism: Ethical values, causes, impact, laws, prevention – Ill effects of smoking - Prevention of Suicides; 9 sexual Health: Prevention and impact of pre-marital pregnancy and Sexually Transmitted Diseases Module:5 Drug Abuse 3 hours
Module:3 Social Issues 2 4 hours Corruption: Ethical values, causes, impact, laws, prevention – Electoral malpractices; White collar crimes - Tax evasions – Unfair trade practices Module:4 Addiction and Health 5 hours Peer pressure - Alcoholism: Ethical values, causes, impact, laws, prevention – Ill effects of smoking – Prevention of Suicides; Sexual Health: Prevention and impact of pre-marital pregnancy and Sexually Transmitted Diseases Module:5 Drug Abuse 3 hourse
Corruption: Ethical values, causes, impact, laws, prevention – Electoral malpractices; White collar crimes - Tax evasions – Unfair trade practices Module:4 Addiction and Health 5 hours Peer pressure - Alcoholism: Ethical values, causes, impact, laws, prevention – Ill effects of smoking – Prevention of Suicides; Sexual Health: Prevention and impact of pre-marital pregnancy and Sexually Transmitted Diseases Module:5 Drug Abuse 3 hourse
White collar crimes - Tax evasions – Unfair trade practices Module:4 Addiction and Health 5 hours Peer pressure - Alcoholism: Ethical values, causes, impact, laws, prevention – Ill effects of smoking - Prevention of Suicides; Sexual Health: Prevention and impact of pre-marital pregnancy and Sexually Transmitted Diseases Module:5 Drug Abuse 3 hourse
Module:4 Addiction and Health 5 hours Peer pressure - Alcoholism: Ethical values, causes, impact, laws, prevention – Ill effects of smoking - Prevention of Suicides; Sexual Health: Prevention and impact of pre-marital pregnancy and Sexually Transmitted Diseases 3 hours
Peer pressure - Alcoholism: Ethical values, causes, impact, laws, prevention – Ill effects of smoking - Prevention of Suicides; Sexual Health: Prevention and impact of pre-marital pregnancy and Sexually Transmitted Diseases Module:5 Drug Abuse 3 hourse
Peer pressure - Alcoholism: Ethical values, causes, impact, laws, prevention – Ill effects of smoking - Prevention of Suicides; Sexual Health: Prevention and impact of pre-marital pregnancy and Sexually Transmitted Diseases Module:5 Drug Abuse 3 hourse
Prevention of Suicides; Sexual Health: Prevention and impact of pre-marital pregnancy and Sexually Transmitted Diseases Module:5 Drug Abuse 3 hourse
Sexual Health: Prevention and impact of pre-marital pregnancy and Sexually Transmitted Diseases Module:5 Drug Abuse 3 hourse
Module:5 Drug Abuse 3 hours
Module:6Personal and Professional Ethics4 hours
Dishonesty - Stealing - Malpractices in Examinations – Plagiarism
Module:7 Abuse of Technologies 3 hours
Hacking and other cyber crimes, Addiction to mobile phone usage, Video games and Social networking websites
websites
Module:8 Contemporary issues: 2 hours
Guest lectures by Experts
Guest lectures by Experts
Guest lectures by Experts Total Lecture hours: 30 hours

Ref	Reference Books									
1.										
2. 3. 4.	 Presupposition and Precepts,2016, Writers Choice, New Delhi, India. Vittal, N, "Ending Corruption? - How to Clean up India?", 2012, Penguin Publishers, UK. Pagliaro, L.A. and Pagliaro, A.M, "Handbook of Child and Adolescent Drug and Substance Abuse: Pharmacological, Developmental and Clinical Considerations", 2012Wiley Publishers, U.S.A. 									
	Mode of Evaluation: CAT, Assignment, Quiz, FAT and SeminarRecommended by Board of Studies26-07-2017									
	proved by Academic Council	No. 46	Date	24-08-2017						

3 5 4 55 4 6 4 4	Course Title	L		P	J	C
MAT-1011	Calculus for Engineers	3	-	2	0	4
Pre-requisite	MAT1001	S	yllabt		ers	ion
				1.0		
Course Objecti						
-	de the requisite and relevant background ne	-				
1	at engineering mathematics courses offered	0		tists.		
	duce important topics of applied mathemati	cs, namely Single	and			
	iable Calculus and Vector Calculus etc.	2				
1	rt the knowledge of Laplace transform, an i	mportant transform	n tech	niqu	e fo	r
	rs which requires knowledge of integration					
Expected Cour						
	s course the students should be able to					
	ingle variable differentiation and integratio		proble	ems 1	In	
-	ring and find the maxima and minima of fu			.1		1.
	and basic concepts of Laplace Transforms	-	ms wi	th po	erio	dic
	as, step functions, impulse functions and con-		Cord -	·		0
	e partial derivatives, limits, total differen				les	anc
-	ation problems involving several variables					• •
	e multiple integrals in Cartesian, Polar, Cyli and gradient, directional derivatives, diverg	1				es.
Gauss th	e e e	ence, cuit and Ore	CIIS , .	SIOK	5,	
	trate MATLAB code for challenging proble	me in engineering				
0. demons						
	•					
Module:1 An	nlication of Single Variable Calculus	9 ho	urs			
	plication of Single Variable Calculus Extrema on an Interval-Rolle's Theorem	9 ho n and the Mean		• Th	neor	em
Differentiation-	Extrema on an Interval-Rolle's Theorem	n and the Mean	Value			
Differentiation- Increasing and	Extrema on an Interval-Rolle's Theorer Decreasing functions and First derivative	n and the Mean test-Second deriva	Value tive to	est-N	Max	im
Differentiation- Increasing and and Minima-Co	Extrema on an Interval-Rolle's Theorem	n and the Mean test-Second deriva e - Area between c	Value tive to	est-N	Max	im
Differentiation- Increasing and and Minima-Co	Extrema on an Interval-Rolle's Theorer Decreasing functions and First derivative ncavity. Integration-Average function value	n and the Mean test-Second deriva e - Area between c	Value tive to	est-N	Max	im
Differentiation- Increasing and and Minima-Co of solids of revo	Extrema on an Interval-Rolle's Theorer Decreasing functions and First derivative ncavity. Integration-Average function value	n and the Mean test-Second deriva e - Area between c lation	Value tive to	est-N	Max	im
Differentiation- Increasing and and Minima-Co of solids of revo Module:2 La	Extrema on an Interval-Rolle's Theorer Decreasing functions and First derivative ncavity. Integration-Average function value Jution - Beta and Gamma functions-interre place transforms	n and the Mean test-Second deriva e - Area between c lation 7 he	Value ative to curves	est-N - Vo	Max olun	im nes
Differentiation- Increasing and and Minima-Co of solids of revo Module:2 La Definition of La	Extrema on an Interval-Rolle's Theorer Decreasing functions and First derivative ncavity. Integration-Average function value lution - Beta and Gamma functions-interre	n and the Mean test-Second deriva e - Area between c lation 7 h form of periodic f	Value ative te curves ours functio	est-N - Vo	Max olun Lapl	im nes
Differentiation- Increasing and and Minima-Co of solids of revo Module:2 La Definition of La	Extrema on an Interval-Rolle's Theorer Decreasing functions and First derivative ncavity. Integration-Average function value dution - Beta and Gamma functions-interre place transforms aplace transform-Properties-Laplace transf	n and the Mean test-Second deriva e - Area between c lation 7 h form of periodic f	Value ative te curves ours functio	est-N - Vo	Max olun Lapl	im nes
Differentiation- Increasing and L and Minima-Co of solids of revo Module:2 La Definition of La transform of uni	Extrema on an Interval-Rolle's Theorer Decreasing functions and First derivative ncavity. Integration-Average function value dution - Beta and Gamma functions-interre place transforms aplace transform-Properties-Laplace transf	n and the Mean test-Second deriva e - Area between c lation 7 h form of periodic f aplace transform-C	Value ative te curves ours functio	est-N - Vo	Max olun Lapl	im nes
Differentiation- Increasing and I and Minima-Co of solids of revo Module:2 La Definition of La transform of uni Module:3 Mu	Extrema on an Interval-Rolle's Theorer Decreasing functions and First derivative ncavity. Integration-Average function value dution - Beta and Gamma functions—interre place transforms aplace transform-Properties-Laplace transf t step function, Impulse function-Inverse L	n and the Mean test-Second deriva e - Area between c lation 7 he form of periodic f aplace transform-C 4 he	Value ative to curves ours Cunctic Convol	est-N - Vo ons-I lutio	Max olun Lapl	
Differentiation- Increasing and I and Minima-Co of solids of revo Module:2 La Definition of La transform of uni Module:3 Mu	Extrema on an Interval-Rolle's Theorer Decreasing functions and First derivative ncavity. Integration-Average function value dution - Beta and Gamma functions—interre place transforms aplace transform-Properties-Laplace transf t step function, Impulse function-Inverse L iltivariable Calculus o variables-limits and continuity-partial der	n and the Mean test-Second deriva e - Area between c lation 7 he form of periodic f aplace transform-C 4 he	Value ative to curves ours Cunctic Convol	est-N - Vo ons-I lutio	Max olun Lapl	im nes
Differentiation- Increasing and and Minima-Co of solids of revo Module:2 La Definition of La transform of uni Module:3 Mu Functions of two	Extrema on an Interval-Rolle's Theorer Decreasing functions and First derivative ncavity. Integration-Average function value dution - Beta and Gamma functions—interre place transforms aplace transform-Properties-Laplace transf t step function, Impulse function-Inverse L iltivariable Calculus o variables-limits and continuity-partial der	n and the Mean test-Second deriva e - Area between c lation 7 he form of periodic f aplace transform-C 4 he	Value ative to curves ours Cunctic Convol	est-N - Vo ons-I lutio	Max olun Lapl	im nes
Differentiation- Increasing and I and Minima-Co of solids of revo Module:2 La Definition of La transform of uni Module:3 Mu Functions of two and its propertie Module:4 Ap	Extrema on an Interval-Rolle's Theorer Decreasing functions and First derivative ncavity. Integration-Average function value dution - Beta and Gamma functions—interre place transforms aplace transform-Properties-Laplace transf t step function, Impulse function-Inverse L iltivariable Calculus to variables-limits and continuity-partial der s.	n and the Mean test-Second deriva e - Area between c lation 7 he form of periodic f aplace transform-C 4 he ivatives –total diff	Value ative to curves ours functic convol ferenti	est-N - Vo ons-I lutio al-Ja	Max olun Lapl n.	
Differentiation- Increasing and I and Minima-Co of solids of revo Module:2 La Definition of La transform of uni Module:3 Mu Functions of two and its propertie Module:4 Ap	Extrema on an Interval-Rolle's Theorer Decreasing functions and First derivative ncavity. Integration-Average function value dution - Beta and Gamma functions—interre place transforms aplace transform-Properties-Laplace transf t step function, Impulse function-Inverse L iltivariable Calculus to variables-limits and continuity-partial der s.	n and the Mean test-Second deriva e - Area between c lation 7 he form of periodic f aplace transform-C 4 he ivatives –total diff	Value ative to curves ours functic convol ferenti	est-N - Vo ons-I lutio al-Ja	Max olun Lapl n.	
Differentiation- Increasing and I and Minima-Co of solids of revo Module:2 La Definition of La transform of uni Module:3 Mu Functions of two and its propertie Module:4 Ap	Extrema on an Interval-Rolle's Theorer Decreasing functions and First derivative ncavity. Integration-Average function value lution - Beta and Gamma functions-interre place transforms aplace transform-Properties-Laplace transf t step function, Impulse function-Inverse L Iltivariable Calculus to variables-limits and continuity-partial der s. plication of Multivariable Calculus ion for two variables-maxima and minima	n and the Mean test-Second deriva e - Area between c lation 7 he form of periodic f aplace transform-C 4 he ivatives –total diff	Value ative to curves ours functic convol ferenti	est-N - Vo ons-I lutio al-Ja	Max olun Lapl n.	
Differentiation-Increasing and Iand Minima-Coof solids of revoModule:2LaDefinition of Latransform of uniModule:3MuFunctions of twoand its propertieModule:4ApTaylor's expansion	Extrema on an Interval-Rolle's Theorer Decreasing functions and First derivative ncavity. Integration-Average function value lution - Beta and Gamma functions-interre place transforms aplace transform-Properties-Laplace transf t step function, Impulse function-Inverse L Iltivariable Calculus to variables-limits and continuity-partial der s. plication of Multivariable Calculus ion for two variables-maxima and minima	n and the Mean test-Second deriva e - Area between c lation 7 he form of periodic f aplace transform-C 4 he ivatives –total diff	Value ative to curves ours functic convol ferenti	est-N - Vo ons-I lutio al-Ja	Max olun Lapl n.	
Differentiation- Increasing and I and Minima-Co of solids of revo Module:2 La Definition of La transform of uni Module:3 Mu Functions of two and its propertie Module:4 Ap Taylor's expans Lagrange's mult	Extrema on an Interval-Rolle's Theorer Decreasing functions and First derivative ncavity. Integration-Average function value lution - Beta and Gamma functions-interre place transforms aplace transform-Properties-Laplace transf t step function, Impulse function-Inverse L Iltivariable Calculus to variables-limits and continuity-partial der s. plication of Multivariable Calculus ion for two variables-maxima and minima	n and the Mean test-Second deriva e - Area between c lation 7 he form of periodic f aplace transform-C 4 he ivatives –total diff 5 he –constrained max	Value ative to curves ours functic convol ferenti	est-N - Vo ons-I lutio al-Ja	Max olun Lapl n.	
Differentiation-Increasing and Iand Minima-Coof solids of revoModule:2LaDefinition of Latransform of uniModule:3MuFunctions of twoand its propertieModule:4ApTaylor's expansLagrange's multiModule:5Mu	Extrema on an Interval-Rolle's Theorer Decreasing functions and First derivative ncavity. Integration-Average function value dution - Beta and Gamma functions—interre place transforms aplace transform-Properties-Laplace transf t step function, Impulse function-Inverse L iltivariable Calculus o variables-limits and continuity-partial der s. plication of Multivariable Calculus ion for two variables—maxima and minima tiplier method.	n and the Mean test-Second deriva e - Area between c lation 7 he form of periodic f aplace transform-C 4 he ivatives –total diff 5 he –constrained max	Value ative to curves ours functic Convol ours ferenti ima at ours	est-N - Vc ons-I lutio al-Ja nd n	Max olun Lapl n. acot	im nes lace
Differentiation-Increasing and Iand Minima-Coof solids of revoModule:2LaDefinition of Latransform of uniModule:3MuFunctions of twoand its propertieModule:4ApTaylor's expansLagrange's multiModule:5MuEvaluation of d	Extrema on an Interval-Rolle's Theorer Decreasing functions and First derivative ncavity. Integration-Average function value dution - Beta and Gamma functions—interre place transforms aplace transform-Properties-Laplace transf t step function, Impulse function-Inverse L Iltivariable Calculus o variables-limits and continuity-partial der s. plication of Multivariable Calculus ion for two variables—maxima and minima tiplier method.	n and the Mean test-Second deriva e - Area between c lation 7 he form of periodic f aplace transform-C 4 he ivativestotal diff constrained max 8 he ationchange of v	Value ative to curves ours functic Convol ferenti ours ima at ours variabl	est-N - Vc pns-I lutio al-Ja nd n	Max olun Lapl n. acot	ima nes lace Dian ma
Differentiation- Increasing and I and Minima-Coo of solids of revo Module:2 La Definition of La transform of uni Module:3 Mu Functions of two and its propertie Module:4 Ap Taylor's expans Lagrange's multi Module:5 Mu	Extrema on an Interval-Rolle's Theorer Decreasing functions and First derivative ncavity. Integration-Average function value dution - Beta and Gamma functions—interre place transforms aplace transform-Properties-Laplace transf t step function, Impulse function-Inverse L iltivariable Calculus to variables-limits and continuity-partial der s. plication of Multivariable Calculus ion for two variables—maxima and minima tiplier method. iltiple integrals ouble integrals—change of order of integr	n and the Mean test-Second deriva e - Area between c lation 7 he form of periodic f aplace transform-C 4 he ivatives -total diff -constrained max 8 he ation-change of v	Value ative to curves Durs Convol Durs ferenti Durs ima at purs variably	est-N - Vc pons-I lutio al-Ja al-Ja nd n es b	Max olun Lapl n. acob	im nes laco Dian ma vee
Differentiation- Increasing and I and Minima-Coo of solids of revo Module:2 La Definition of La transform of uni Module:3 Mu Functions of two and its propertie Module:4 Ap Taylor's expans Lagrange's multi Module:5 Mu	Extrema on an Interval-Rolle's Theorer Decreasing functions and First derivative ncavity. Integration-Average function value dution - Beta and Gamma functions—interre place transforms aplace transform-Properties-Laplace transf t step function, Impulse function-Inverse L iltivariable Calculus to variables-limits and continuity-partial der s. plication of Multivariable Calculus ion for two variables—maxima and minima tiplier method. iltiple integrals ouble integrals—change of order of integr olar co-ordinates - Evaluation of triple int ylindrical and spherical co-ordinates- eva	n and the Mean test-Second deriva e - Area between c lation 7 he form of periodic f aplace transform-C 4 he ivatives -total diff -constrained max 8 he ation-change of v	Value ative to curves Durs Convol Durs ferenti Durs ima at purs variably	est-N - Vc pons-I lutio al-Ja al-Ja nd n es b	Max olun Lapl n. acob	im nes laco Dian ma vee
Differentiation- Increasing and I and Minima-Coo of solids of revo Module:2 La Definition of La transform of uni Module:3 Mu Functions of two and its propertie Module:4 Ap Taylor's expans Lagrange's multi Module:5 Mu Evaluation of d Cartesian and p Cartesian and c	Extrema on an Interval-Rolle's Theorer Decreasing functions and First derivative ncavity. Integration-Average function value dution - Beta and Gamma functions—interre place transforms aplace transform-Properties-Laplace transf t step function, Impulse function-Inverse L iltivariable Calculus to variables-limits and continuity-partial der s. plication of Multivariable Calculus ion for two variables—maxima and minima tiplier method. iltiple integrals ouble integrals—change of order of integr olar co-ordinates - Evaluation of triple int ylindrical and spherical co-ordinates- eva	n and the Mean test-Second deriva e - Area between c lation 7 he form of periodic f aplace transform-C 4 he ivatives -total diff -constrained max 8 he ation-change of v	Value ative to curves Durs Convol Durs ferenti Durs ima at purs variably	est-N - Vc pons-I lutio al-Ja al-Ja nd n es b	Max olun Lapl n. acob	im nes laco Dian ma vee

		vector valued functions – gra alar and vector potentials–Sta	, , ,		e				
Mod	lule:7	Vector Integration			5 hours				
		e and volume integrals - S erification and evaluation of			nd Gauss divergence				
	lule:8	Contemporary Issues:			2 hours				
Inc	dustry E	Expert Lecture							
		Tota	al Lecture hours:		45 hours				
Text	t Book(s)							
[1] T	Thomas	'Calculus, George B.Thoma	s, D.Weir and J. Ha	ass, 13 th editio	n, Pearson, 2014.				
		ed Engineering Mathematics							
	erence l								
2 3 4	 High Calc Engi Mac 	her Engineering Mathematics her Engineering Mathematics ulus: Early Transcendentals, neering Mathematics, K.A. millan (2013)	s, John Bird, 6 th Ed James Stewart, 8 th	ition, Elsevier edition, Ceng	Limited, 2017. age Learning, 2017.				
Mod		valuation	Continue Arrest	The I	Х				
List		Digital Assignments, Quiz, llenging Experiments (Indi		ments, Final A	Assessment Test				
1.		uction to MATLAB through		ral Syntax	2 hours				
2					2 hours				
2	2Plotting and visualizing curves and surfaces in MATLAB –2 hoursSymbolic computations using MATLAB2 hours								
3.Evaluating Extremum of a single variable function2 hours									
4.	Under		2 hours						
5.	Evalua	2 hours							
6.	Evalua	2 hours							
7.	Apply	ing Lagrange multiplier opti	2 hours						
8.	Evalua	2 hours							
9. Evaluating triple integrals					2 hours				
10.		ating gradient, curl and diver	gence		2 hours				
11.	Evalua	ating line integrals in vectors			2 hours				
12.	Apply	ing Green's theorem to real v	1		2 hours				
			Total Labo	oratory Hours	24 hours				
Mod	le of As	sessment:							
			ssment, Final Asse	essment Test					
		led by Board of Studies	12-06-2015		1 < 0 < 0015				
App	roved b	y Academic Council	No. 37	Date	16-06-2015				

Course Code	Course title	L T P J		J	С			
MAT2001	Statistics for Engine	eers 3 0 2		0	4			
Prerequisites	MAT1011 – Calculus for Engine	ers	Syllabus Version			sion	1.0	
Course Objectives :								
*	idents with a framework that will he	lp them choose t	he ap	propr	iate d	escrit	otive	
-	rious data analysis situations.	I · · · · · · ·	1	r r		1		
	2. To analyse distributions and relationship of real-time data.							
	mation and testing methods to mak		mode	elling	techr	niques	s for	
decision maki	-			U		1		
Expected Course Ou	itcome:							
At the end of the cour	rse the student should be able to:							
1. Compute and	interpret descriptive statistics using 1	numerical and gra	aphica	al tech	nniqu	es.		
2. Understand th	e basic concepts of random variable	es and find an aj	pprop	riate	distri	butior	1 for	
• •	specific to an experiment.							
3. Apply statistic	cal methods like correlation, regressi	on analysis in an	alysi	ng, int	terpre	ting		
experimental of								
	riate decisions using statistical infe	erence that is the	e cen	tral to	o exp	erime	ental	
research.								
	methodology and tools in reliability	engineering prob	olems	•				
6. demonstrate R	programming for statistical data							
		Γ						
Module: 1	Introduction to Statistics		6 ho					
	tics and data analysis-Measures of c	central tendency	-Mea	sures	of v	ariabi	lity-	
	Kurtosis (Concepts only)].	Γ						
Module: 2	Random variables		8 ho					
	variables-Probability mass Function							
	on and joint density functions- Mar							
	cal expectation, and its properties C	ovariance, mom	ient g	enera	ting f	unctio	on –	
characteristic function			4 1.					
Module: 3	Correlation and regression		4 ho		•	N 1/	• 1	
C C	ression – Rank Correlation- Par	tial and Multip	le co	orrelat	10n-	Mult	iple	
regression.			71					
Module: 4	Probability Distributions		7 ho			4:-1		
distribution – Weibul	h distributions – Normal distribution	– Gamma distrib	ution	– EXĮ	onen	ual		
Module: 5	-		4 ho					
	Hypothesis Testing I	uitical nacion na			- 4 a a 4			
	s – Introduction-Types of errors, c						ار میں ما	
difference of means.	nple tests- Z test for Single Propor	tion, Difference	OI PI	oport	10n, 1	mean	and	
Module: 6	Hypothesis Testing II		9 ho					
	Hypothesis Testing II	tast goodnage			damar	dana	o of	
	Student's t-test, F-test- chi-square Experiments - Analysis of variance							
RBD- LSD.	Experiments - Analysis of variance		ay Cl	u351110	atiol	13 - C	ND-	
Module: 7	Reliability		5 ho	nire				
	ard function-Reliabilities of series a	nd narallel syste			m Ro	liahil	itv -	
	entive and repair maintenance- Avail		-1115-	Syster		114011	ity -	
	ntemporary Issues		2 ho	mrs				
Industry Expert Lectu		I	- 11(
	al Lecture hours		45 h	ours				

Text	book(s)				
1.	Probability and Statistics for engineer	rs and scient	sts, R.E	Walpole, R.H.M	yers, S.L.Mayer
	and K.Ye, 9 th Edition, Pearson Educa			-	
2.	Applied Statistics and Probability fo	r Engineers, l	Douglas	C. Montgomery,	George C.
	Runger, 6 th Edition, John Wiley & So	ons (2016).			
Refer	rence books				
1. I	Reliability Engineering, E.Balagurusam	y, Tata McG	aw Hill,	Tenth reprint 20	17.
	Probability and Statistics, J.L.Devore, 8				
	Probability and Statistics for Engineers	R.A.Johnson	, Miller	Freund's, 8th edit	tion, Prentice
	Hall India (2011).				
	Probability, Statistics and Reliability fo		nd Scien	tists, Bilal M. Ay	yub and Richard
	H. McCuen, 3 rd edition, CRC press (20	11).			
	e of Evaluation				
	al Assignments, Continuous Assessmer	t Tests, Quiz	Final A	ssessment Test.	
	of Experiments (Indicative)				
1	Introduction: Understanding Data t	<u> </u>		-	2 hours
2	Computing Summary Statistics /p		visualizi	ng data using	2 hours
	Tabulation and Graphical Represen				
3	Applying correlation and simple lin				2 hours
	computing and interpreting the coef				
4	Applying multiple linear regression			1 0	2 hours
	and interpreting the multiple coeffic				
5	Fitting the following probability dis		nomial c	listribution	2 hours
6	Normal distribution, Poisson distrib				2 hours
7	Testing of hypothesis for One san	iple mean an	d propo	tion from real-	2 hours
	time problems.				
8	Testing of hypothesis for Two sam time problems	ple means ar	d propo	rtion from real-	2 hours
9	Applying the t test for independent	-	-		2 hours
10	Applying Chi-square test for goodr real dataset				2 hours
11	Performing ANOVA for real datase	et for Comple	tely rand	lomized design,	2 hours
	Randomized Block design ,Latin so	uare Design			
			Total la	boratory hours	22 hours
	e of Evaluation				
Week	ly Assessment, Final Assessment Test				
Recor	mmended by Board of Studies	25-02-2017			
Appro	oved by Academic Council	7	Date:	05-10-2017	

Course code	Course title		Τ	P	J C	
MGT1022	Lean Start up Management	1	0	0	4 2	
Pre-requisite	Nil	Syl	labı	is ve	rsion	
					v.1.0	
Course Objectives	s: To develop the ability to					
1. Learn meth	ods of company formation and management.					
-	cal skills in and experience of stating of business using pre-	e-set	col	lecti	on of	
business ide						
3. Learn basic	s of entrepreneurial skills.					
Expected Course	Outcome: On the completion of this course the student will be	able	to:			
Impected Course						
	developing business models and growth drivers					
	siness model canvas to map out key components of enterprise					
•	arket size, cost structure, revenue streams, and value chain build-measure-learn principles					
	and quantifying business and financial risks					
8	······································					
Module:1					Iours	
-	sign Thinking (identify the vertical for business opportunity,	und	erst	and y	your	
customers, accurate	ely assess market opportunity)					
Module:2				3 1	Iours	
	Product (Value Proposition, Customer Segments, Build- measure	e-lear	m p			
					/	
Module:3					Iours	
	evelopment(Channels and Partners, Revenue Model and stream				irces,	
	ts, Customer Relationships and Customer Development Process	ses, I	Busi	ness		
model canvas –the	lean model- templates)					
Module:4				3 H	Iours	
	Access to Funding(visioning your venture, taking the product/	serv	ice			
Market plan includ	ling Digital & Viral Marketing, start-up finance - Costs/Prof					
flow, Angel/VC,/B	ank Loans and Key elements of raising money)					
Module:5				21	Iours	
	CSR, Standards, Taxes			51	10015	
Legui, Regulatory,						
Module:6				2 H	Iours	
Lectures by Entrep	reneurs					
	Total Lecture			15 I	hours	
Text Book(s)						
-	vner's Manual: The Step-By-Step Guide for Building a Great Com	ipany	y, St	eve		
,	Ranch; 1 st edition (March 1, 2012)					
2 The Four Step	² The Four Steps to the Epiphany, Steve Blank, K&S Ranch; 2 nd edition (July 17, 2013)					

3	The Lean Startup: How Today's Ent	1			eate Radically	
	Successful Businesses, Eric Ries, Crown Business; (13 September 2011)					
Reference Books						
1.	Holding a Cat by the Tail, Steve Blank, K&S Ranch Publishing LLC (August 14, 2014)					
2	Product Design and Development, Karal T Ulrich, SD Eppinger, McGraw Hill					
3	Zero to One: Notes on Startups, or I	How to Build the F	uture, Pete	er Thiel, Crown	Business(2014)	
4	Lean Analytics: Use Data to Build a	Better Startup Fast	ter (Lean S	eries), Alistair (Croll& Benjamin	
	Yoskovitz, O'Reilly Media; 1st Ed	ition (March 21, 2	013)			
5	Inspired: How To Create Products C	Customers Love, M	larty Caga	n, SVPG Press;	1st edition (June	
	18, 2008)					
6	Website References:					
	1. http://theleanstartup.com/					
	2. https://www.kickstarter.com/pro	ojects/881308232/	only-on-ki	ckstarter-the-le	aders-guide-by-	
	eric-ries					
	3. http://businessmodelgeneratio					
	4. https://www.leanstartupmachin					
	5. https://www.youtube.com/watc					
	6. http://thenextweb.com/entrepres	neur/2015/07/05/w	hats-wron	g-with-the-lean	-startup-	
	methodology/#gref					
	7. http://www.businessinsider.in/V			tup/articleshow	/53615661.cms	
	8. https://steveblank.com/tools-an	0 1				
	9. https://hbr.org/2013/05/why-the	-	-			
	10.chventures.blogspot.in/ platform	nsandnetworks.blo	gspot.in/p	/saas-model.htr	nl	
	de of Evaluation: Assignments;	Field Trips, Cas	e Studies	; e-learning; I	Learning through	
	earch, TED Talks					
Pro	oject					
1.	Project				60 hours	
				Total Project	60 hours	
Rec	commended by Board of Studies	08-06-2015				
Ap	proved by Academic Council	37	Date	16-06-2015		

Course code	Course title	L T P J C
PHY1701	Engineering Physics	3 0 2 0 4
Pre-requisite	None	Syllabus version
		V.2.1

Course Objectives:

To enable the students to understand the basics of the latest advancements in Physics viz., Quantum Mechanics, Nanotechnology, Lasers, Electro Magnetic Theory and Fiber Optics.

Expected Course Outcome: Students will be able to

1. Comprehend the dual nature of radiation and matter.

- 2. Compute Schrodinger's equations to solve finite and infinite potential problems.
- 3. Analyze quantum ideas at the nanoscale.
- 4. Apply quantum ideas for understanding the operation and working principle of optoelectronic devices.
- 5. Recall the Maxwell's equations in differential and integral form.
- 6. Design the various types of optical fibers for different Engineering applications.
- 7. Explain concept of Lorentz Transformation for Engineering applications.
- 8. Demonstrate the quantum mechanical ideas

Module:1	Introduction to Modern Physics	

Planck's concept (hypothesis), Compton Effect, Particle properties of wave: Matter Waves, Davisson Germer Experiment, Heisenberg Uncertainty Principle, Wave function, and Schrodinger equation (time dependent & independent).

Module:2	Applications of Quantum Physics	5 hours				
Particle in a 1-D box (Eigen Value and Eigen Function), 3-D Analysis (Qualitative), Tunneling						
Effect (Qualitative) (AB 205), Scanning Tunneling Microscope (STM).						
Module:3	Nanophysics	5 hours				
Introduction to Nano-materials, Moore's law, Properties of Nano-materials, Quantum confinement,						

Introduction to Nano-materials, Moore's law, Properties of Nano-materials, Quantum confinement, Quantum well, wire & dot, Carbon Nano-tubes (CNT), Applications of nanotechnology in industry.

Module:4	Laser Principles and Engineering Application	6 hours					
Laser Chara	acteristics, Spatial and Temporal Coherence, Einstein C	oefficient & its significance,					
Population	Population inversion, Two, three & four level systems, Pumping schemes, Threshold gain						
coefficient,	Components of laser, Nd-YAG, He-Ne, CO2 and Dye	e laser and their engineering					
applications							
Module:5	Electromagnetic Theory and its application	6 hours					
Physics of	Divergence, Gradient and Curl, Qualitative understanding	of surface and volume					
integral, M	axwell Equations (Qualitative), Wave Equation (Derivation	on), EM Waves, Phase					
velocity, C	roup velocity, Group index , Wave guide (Qualitative)						
Module:6	Propagation of EM waves in Optical fibers	10 hours					
	and Optoelectronic Devices						

6 hours

Light propagation through fibers, Acceptance angle, Numerical Aperture, Types of fibers - step index, graded index, single mode & multimode, Attenuation, Dispersion-intermodal and intramodal. Sources-LED & Laser Diode, Detectors-Photodetectors- PN & PIN - Applications of fiber optics in communication- Endoscopy.

_	uie:/	Special Theory of Relativity	5 hours		
		eference, Galilean relativity, Postulate of special theory of	f relativity, Simultaneity,		
lengt	th contr	action and time dilation.			
Mod	lule:8	Contemporary issues:	2 hours		
		Lecture by Industry Experts			
		Total Lecture hours:	45 hours		
Text	Book(s)			
1.	Arthu	r Beiser et al., Concepts of Modern Physics, 2013, Sixth Editi	ion, Tata McGraw Hill.		
2.		m Silfvast, Laser Fundamentals, 2008, Cambridge University			
3.		Griffith, Introduction to Electrodynamics, 2014, 4th Edition, I			
4.		r K. Mynbaev and Lowell L.Scheiner, Fiber Optic Comm			
		Pearson			
Refe	rence l	Books			
1.	Raym	ond A. Serway, Clement J. Mosses, Curt A. Moyer Modern	Physics, 2010, 3rd Indiar		
		n Cengage learning.			
2.		R. Taylor, Chris D. Zafiratos and Michael A. Dubson, Mod	lern Physics for Scientists		
		ngineers, 2011, PHI Learning Private Ltd.			
3.	Kenne	th Krane Modern Physics, 2010, Wiley Indian Edition.			
4.		nand Choudhary and Richa Verma, Laser Systems and	Applications, 2011, PHI		
5.	-	ing Private Ltd.			
	S. Na	gabhushana and B. Sathyanarayana, Lasers and Optical In	strumentation, 2010, I.K		
6.	International Publishing House Pvt. Ltd.,				
_	R. Shevgaonkar, Electromagnetic Waves, 2005, 1st Edition, Tata McGraw Hill				
7.			IcGraw Hill		
	R. She				
7. 8.	R. She Princi	evgaonkar, Electromagnetic Waves, 2005, 1st Edition, Tata M	n Edition, Oxford.		
	R. She Princi	evgaonkar, Electromagnetic Waves, 2005, 1st Edition, Tata M ples of Electromagnetics, Matthew N.O. Sadiku, 2010, Fourth	n Edition, Oxford.		
8.	R. She Princi Ajoy Press.	evgaonkar, Electromagnetic Waves, 2005, 1st Edition, Tata M ples of Electromagnetics, Matthew N.O. Sadiku, 2010, Fourth	n Edition, Oxford. 10, Cambridge University		
8.	R. She Princi Ajoy Press.	evgaonkar, Electromagnetic Waves, 2005, 1st Edition, Tata M ples of Electromagnetics, Matthew N.O. Sadiku, 2010, Fourth Ghatak and K. Thyagarajan, Introduction to Fiber Optics, 20	n Edition, Oxford. 10, Cambridge University		
8.	R. She Princi Ajoy Press. e of Ev	evgaonkar, Electromagnetic Waves, 2005, 1st Edition, Tata M ples of Electromagnetics, Matthew N.O. Sadiku, 2010, Fourth Ghatak and K. Thyagarajan, Introduction to Fiber Optics, 20 aluation: CAT / Assignment / Quiz / FAT / Project / Seminar	n Edition, Oxford. 10, Cambridge University		
8. Mod	R. She Princi Ajoy (Press. e of Ev	evgaonkar, Electromagnetic Waves, 2005, 1st Edition, Tata M ples of Electromagnetics, Matthew N.O. Sadiku, 2010, Fourth Ghatak and K. Thyagarajan, Introduction to Fiber Optics, 20 aluation: CAT / Assignment / Quiz / FAT / Project / Seminar List of Experiments	n Edition, Oxford. 10, Cambridge University		
8. Mod	R. She Princi Ajoy o Press. e of Ev Deter Elect	evgaonkar, Electromagnetic Waves, 2005, 1st Edition, Tata M ples of Electromagnetics, Matthew N.O. Sadiku, 2010, Fourth Ghatak and K. Thyagarajan, Introduction to Fiber Optics, 20 aluation: CAT / Assignment / Quiz / FAT / Project / Seminar List of Experiments rmination of Planck's constant using electroluminescence proc	n Edition, Oxford. 10, Cambridge University cess 2 hrs 2 hrs		
8. Mod <u>1.</u> 2.	R. She Princi Ajoy o Press. e of Ev Deter Elect Deter	evgaonkar, Electromagnetic Waves, 2005, 1st Edition, Tata M ples of Electromagnetics, Matthew N.O. Sadiku, 2010, Fourth Ghatak and K. Thyagarajan, Introduction to Fiber Optics, 20 aluation: CAT / Assignment / Quiz / FAT / Project / Seminar List of Experiments rmination of Planck's constant using electroluminescence pro- ron diffraction	n Edition, Oxford. 10, Cambridge University cess 2 hrs 2 hrs		
8. Mod <u>1.</u> 2.	R. She Princi Ajoy (Press. e of Ev Deter Deter diffe	evgaonkar, Electromagnetic Waves, 2005, 1st Edition, Tata M ples of Electromagnetics, Matthew N.O. Sadiku, 2010, Fourth Ghatak and K. Thyagarajan, Introduction to Fiber Optics, 20 aluation: CAT / Assignment / Quiz / FAT / Project / Seminar List of Experiments rmination of Planck's constant using electroluminescence pro- ron diffraction rmination of wavelength of laser source (He -Ne laser and dio	n Edition, Oxford. 10, Cambridge University cess 2 hrs 2 hrs		
8. Mod <u>1.</u> <u>2.</u> <u>3.</u>	R. She Princi Ajoy O Press. e of Ev Deter Deter differ Deter	evgaonkar, Electromagnetic Waves, 2005, 1st Edition, Tata M ples of Electromagnetics, Matthew N.O. Sadiku, 2010, Fourth Ghatak and K. Thyagarajan, Introduction to Fiber Optics, 20 aluation: CAT / Assignment / Quiz / FAT / Project / Seminar List of Experiments rmination of Planck's constant using electroluminescence pro- ron diffraction rmination of wavelength of laser source (He -Ne laser and dio rent wavelengths) using diffraction technique rmination of size of fine particle using laser diffraction	n Edition, Oxford. 10, Cambridge University cess 2 hrs 2 hrs de lasers of 2 hrs		
8. <u>Mod</u> <u>1.</u> <u>2.</u> <u>3.</u> <u>4.</u>	R. She Princi Ajoy (Press. e of Ev Deter differ Deter Deter	evgaonkar, Electromagnetic Waves, 2005, 1st Edition, Tata M ples of Electromagnetics, Matthew N.O. Sadiku, 2010, Fourth Ghatak and K. Thyagarajan, Introduction to Fiber Optics, 20 aluation: CAT / Assignment / Quiz / FAT / Project / Seminar List of Experiments rmination of Planck's constant using electroluminescence pro- ron diffraction rmination of wavelength of laser source (He -Ne laser and dio rent wavelengths) using diffraction technique rmination of size of fine particle using laser diffraction rmination of the track width (periodicity) in a written CD	n Edition, Oxford. 10, Cambridge University cess 2 hrs 2 hrs de lasers of 2 hrs 2 hrs 2 hrs		
8. <u>Mod</u> <u>1.</u> <u>2.</u> <u>3.</u> <u>4.</u> <u>5.</u>	R. She Princi Ajoy (Press. e of Ev Deter differ Deter Deter Deter Optic	evgaonkar, Electromagnetic Waves, 2005, 1st Edition, Tata M ples of Electromagnetics, Matthew N.O. Sadiku, 2010, Fourth Ghatak and K. Thyagarajan, Introduction to Fiber Optics, 20 aluation: CAT / Assignment / Quiz / FAT / Project / Seminar List of Experiments rmination of Planck's constant using electroluminescence pro- ron diffraction rmination of wavelength of laser source (He -Ne laser and dio rent wavelengths) using diffraction technique rmination of size of fine particle using laser diffraction rmination of the track width (periodicity) in a written CD cal Fiber communication (source + optical fiber + detector)	n Edition, Oxford. 10, Cambridge University cess 2 hrs 2 hrs de lasers of 2 hrs 2 hrs		
8. Mod 1. 2. 3. 4. 5. 6.	R. She Princi Ajoy (Press. e of Ev Deter Deter Deter Deter Deter Optic Anal	evgaonkar, Electromagnetic Waves, 2005, 1st Edition, Tata M ples of Electromagnetics, Matthew N.O. Sadiku, 2010, Fourth Ghatak and K. Thyagarajan, Introduction to Fiber Optics, 20 aluation: CAT / Assignment / Quiz / FAT / Project / Seminar List of Experiments rmination of Planck's constant using electroluminescence pro- ron diffraction rmination of wavelength of laser source (He -Ne laser and dio rent wavelengths) using diffraction technique rmination of size of fine particle using laser diffraction rmination of the track width (periodicity) in a written CD	n Edition, Oxford. 10, Cambridge University cess 2 hrs 2 hrs de lasers of 2 hrs 2 hrs		
8. Mod 1. 2. 3. 4. 5. 6.	R. She Princi Ajoy (Press. e of Ev Deter diffe Deter Optic Anal diffra	evgaonkar, Electromagnetic Waves, 2005, 1st Edition, Tata M ples of Electromagnetics, Matthew N.O. Sadiku, 2010, Fourth Ghatak and K. Thyagarajan, Introduction to Fiber Optics, 20 aluation: CAT / Assignment / Quiz / FAT / Project / Seminar List of Experiments rmination of Planck's constant using electroluminescence pro- ron diffraction rmination of wavelength of laser source (He -Ne laser and dio rent wavelengths) using diffraction technique rmination of size of fine particle using laser diffraction rmination of the track width (periodicity) in a written CD cal Fiber communication (source + optical fiber + detector) ysis of crystallite size and strain in a nano -crystalline film usi action	n Edition, Oxford. 10, Cambridge University cess 2 hrs 2 hrs de lasers of 2 hrs 2		
8. Mod <u>1.</u> 2. 3. <u>4.</u> <u>5.</u> <u>6.</u> 7.	R. She Princi Ajoy (Press. e of Ev Deter differ Deter Deter Optic Anal diffra	evgaonkar, Electromagnetic Waves, 2005, 1st Edition, Tata M ples of Electromagnetics, Matthew N.O. Sadiku, 2010, Fourth Ghatak and K. Thyagarajan, Introduction to Fiber Optics, 20 aluation: CAT / Assignment / Quiz / FAT / Project / Seminar List of Experiments rmination of Planck's constant using electroluminescence pro- ron diffraction rmination of wavelength of laser source (He -Ne laser and dio rent wavelengths) using diffraction technique rmination of size of fine particle using laser diffraction rmination of the track width (periodicity) in a written CD cal Fiber communication (source + optical fiber + detector) ysis of crystallite size and strain in a nano -crystalline film using erical solutions of Schrödinger equation (e.g. particle in a box	n Edition, Oxford. 10, Cambridge University cess 2 hrs 2 hrs de lasers of 2 hrs 2		
8. Mod <u>1.</u> 2. 3. <u>4.</u> <u>5.</u> <u>6.</u> 7.	R. She Princi Ajoy (Press. e of Ev Deter differ Deter Deter Optic Anal diffra Num (can	evgaonkar, Electromagnetic Waves, 2005, 1st Edition, Tata M ples of Electromagnetics, Matthew N.O. Sadiku, 2010, Fourth Ghatak and K. Thyagarajan, Introduction to Fiber Optics, 20 aluation: CAT / Assignment / Quiz / FAT / Project / Seminar List of Experiments rmination of Planck's constant using electroluminescence pro- ron diffraction rmination of wavelength of laser source (He -Ne laser and dio rent wavelengths) using diffraction technique rmination of size of fine particle using laser diffraction rmination of the track width (periodicity) in a written CD cal Fiber communication (source + optical fiber + detector) ysis of crystallite size and strain in a nano -crystalline film using action erical solutions of Schrödinger equation (e.g. particle in a box be given as an assignment)	n Edition, Oxford. 10, Cambridge University cess 2 hrs 2 hrs de lasers of 2 hrs 2		
8. Mod <u>1.</u> 2. 3. <u>4.</u> 5. <u>6.</u> 7. 8. 9.	R. She Princi Ajoy (Press. e of Ev Deter diffe Deter Optic Anal diffra Num (can Lase	evgaonkar, Electromagnetic Waves, 2005, 1st Edition, Tata M ples of Electromagnetics, Matthew N.O. Sadiku, 2010, Fourth Ghatak and K. Thyagarajan, Introduction to Fiber Optics, 20 aluation: CAT / Assignment / Quiz / FAT / Project / Seminar List of Experiments rmination of Planck's constant using electroluminescence pro- ron diffraction rmination of wavelength of laser source (He -Ne laser and dio rent wavelengths) using diffraction technique rmination of size of fine particle using laser diffraction rmination of the track width (periodicity) in a written CD cal Fiber communication (source + optical fiber + detector) ysis of crystallite size and strain in a nano -crystalline film usin action erical solutions of Schrödinger equation (e.g. particle in a box be given as an assignment) r coherence length measurement	n Edition, Oxford. 10, Cambridge University cess 2 hrs 2 hrs de lasers of 2 hrs 2 hrs 2 hrs 2 hrs 2 hrs 2 hrs 2 hrs 3 hrs 2 hrs		
8. Mod 1. 2. 3. 4. 5. 6. 7. 8. 9. 10.	R. She Princi Ajoy (Press. e of Ev Deter differ Deter Deter Optic Anal diffra Num (can Laser Proo	evgaonkar, Electromagnetic Waves, 2005, 1st Edition, Tata M ples of Electromagnetics, Matthew N.O. Sadiku, 2010, Fourth Ghatak and K. Thyagarajan, Introduction to Fiber Optics, 20 aluation: CAT / Assignment / Quiz / FAT / Project / Seminar List of Experiments rmination of Planck's constant using electroluminescence pro- ron diffraction rmination of wavelength of laser source (He -Ne laser and dio rent wavelengths) using diffraction technique rmination of size of fine particle using laser diffraction rmination of the track width (periodicity) in a written CD cal Fiber communication (source + optical fiber + detector) ysis of crystallite size and strain in a nano -crystalline film usi action erical solutions of Schrödinger equation (e.g. particle in a box be given as an assignment) r coherence length measurement f for transverse nature of E.M. waves	n Edition, Oxford. 10, Cambridge University cess 2 hrs 2 hrs de lasers of 2 hrs 2 hrs 2 hrs 2 hrs 2 hrs 2 hrs ing X-ray 2 hrs x problem) 2 hrs 2		
8. Mod <u>1.</u> 2. 3. <u>4.</u> 5. <u>6.</u> 7. 8. 9.	R. She Princi Ajoy (Press. e of Ev Deter diffe Deter Optic Anal diffra Num (can Laser Proof	evgaonkar, Electromagnetic Waves, 2005, 1st Edition, Tata M ples of Electromagnetics, Matthew N.O. Sadiku, 2010, Fourth Ghatak and K. Thyagarajan, Introduction to Fiber Optics, 20 aluation: CAT / Assignment / Quiz / FAT / Project / Seminar List of Experiments rmination of Planck's constant using electroluminescence pro- ron diffraction rmination of wavelength of laser source (He -Ne laser and dio rent wavelengths) using diffraction technique rmination of size of fine particle using laser diffraction rmination of the track width (periodicity) in a written CD cal Fiber communication (source + optical fiber + detector) ysis of crystallite size and strain in a nano -crystalline film usin action erical solutions of Schrödinger equation (e.g. particle in a box be given as an assignment) r coherence length measurement	n Edition, Oxford. 10, Cambridge University cess 2 hrs 2 hrs de lasers of 2 hrs 2		

13.	13. Determination of divergence of a laser beam					
14.	14. Determination of crystalline size for nanomaterial (Computer simulation)					
15.	15. Demonstration of phase velocity and group velocity (Computer simulation)				2 hrs	
Total Laboratory Hours					30 hrs	
Mod	Mode of evaluation: CAT / FAT					
Reco	Recommended by Board of Studies 04-06-2019					
Approved by Academic CouncilNo. 55Date13-06-2019						

	Course title	
PHY1999	Introduction to Innovative Project	
Pre-requisite	None	Syllabus version
		1.
Course Objectiv		
	rered to the students in the 1 Year of B.Tech. in o	order to orient them towards
	emic thinking and be innovative.	
	ents confident enough to handle the day to day issu	
	e "Thinking Skill" of the students, especially Crea	tive Thinking Skills
	tudents to be innovative in all their activities	
	project report on a socially relevant theme as a solu	ition to the existing issues
-	e Outcome: Students will be able to	
_	I the various types of thinking skills.	
-	innovative and creative ideas.	
3. Analyze a su	itable solution for socially relevant issues	
Module:1 A Se		1 hour
	elf – Johari Window –SWOT Analysis – Self Este	em – Being a contributor –
Case		
Study		
Project : Explor	ring self, understanding surrounding, thinking about	at how s(he) can be a
Project : Explor contributor		
Project : Explor contributor for the society, (Creating a big picture of being an innovator – writi	ng a 1000 words imaginary
Project : Explor contributor for the society, C autobiography o		ng a 1000 words imaginary
Project : Explor contributor for the society, (autobiography o hours)	Creating a big picture of being an innovator – writi of self – Topic "Mr X – the great innovator of 2015	ng a 1000 words imaginary " and upload. (4 non- contact
Project : Explorcontributorfor the society, (autobiography ohours)Module:1 B	Creating a big picture of being an innovator – writi of self – Topic "Mr X – the great innovator of 2015 hinking Skill	ng a 1000 words imaginary " and upload. (4 non- contact 1 hour
Project : Explorcontributorfor the society, (autobiography ohours)Module:1 BThinking and Be	Creating a big picture of being an innovator – writi of self – Topic "Mr X – the great innovator of 2015	ng a 1000 words imaginary " and upload. (4 non- contact 1 hour
Project : Explorcontributorfor the society, (autobiography ohours)Module:1 BThinking and BeCreative,	Creating a big picture of being an innovator – writi of self – Topic "Mr X – the great innovator of 2015 hinking Skill ehaviour – Types of thinking– Concrete – Abstract	ng a 1000 words imaginary " and upload. (4 non- contact <u>1 hour</u> , Convergent, Divergent,
Project : Explorcontributorfor the society, (autobiography ohours)Module:1 BThinking and BeCreative,Analytical, Seque	Creating a big picture of being an innovator – writi of self – Topic "Mr X – the great innovator of 2015 hinking Skill	ng a 1000 words imaginary " and upload. (4 non- contact <u>1 hour</u> , Convergent, Divergent,
Project : Explorcontributorfor the society, (autobiography ohours)Module:1 BThinking and BeCreative,Analytical, SequCase Study.	Creating a big picture of being an innovator – writi of self – Topic "Mr X – the great innovator of 2015 hinking Skill ehaviour – Types of thinking– Concrete – Abstract tential and Holistic thinking – Chunking Triangle -	ng a 1000 words imaginary " and upload. (4 non- contact <u>1 hour</u> , Convergent, Divergent, - Context Grid – Examples –
Project : Explorcontributorfor the society, (autobiography ohours)Module:1 BThinking and BeCreative,Analytical, SequCase Study.Project : Meetin	Creating a big picture of being an innovator – writi of self – Topic "Mr X – the great innovator of 2015 hinking Skill ehaviour – Types of thinking– Concrete – Abstract tential and Holistic thinking – Chunking Triangle – ng at least 50 people belonging to various strata of	ng a 1000 words imaginary " and upload. (4 non- contact <u>1 hour</u> , Convergent, Divergent, - Context Grid – Examples – life and talk to them / make
Project : Explorcontributorfor the society, (autobiography ohours)Module:1 BThinking and BeCreative,Analytical, SequeCase Study.Project : Meetinfield visits to ide	Creating a big picture of being an innovator – writi of self – Topic "Mr X – the great innovator of 2015 hinking Skill ehaviour – Types of thinking– Concrete – Abstract uential and Holistic thinking – Chunking Triangle – ng at least 50 people belonging to various strata of entify a min of100 society related issues, problems	ng a 1000 words imaginary " and upload. (4 non- contact <u>1 hour</u> , Convergent, Divergent, - Context Grid – Examples – life and talk to them / make for which they need solutions
Project : Explorcontributorfor the society, (autobiography ohours)Module:1 BThinking and BeCreative,Analytical, SequeCase Study.Project : Meetinfield visits to ide	Creating a big picture of being an innovator – writi of self – Topic "Mr X – the great innovator of 2015 hinking Skill ehaviour – Types of thinking– Concrete – Abstract tential and Holistic thinking – Chunking Triangle – ng at least 50 people belonging to various strata of	ng a 1000 words imaginary " and upload. (4 non- contact <u>1 hour</u> , Convergent, Divergent, - Context Grid – Examples – life and talk to them / make for which they need solutions
Project : Explorcontributorfor the society, (autobiography ohours)Module:1 BTIThinking and BeCreative,Analytical, SequCase Study.Project : Meetinfield visits to ideand categories thcontact hours)	Creating a big picture of being an innovator – writi of self – Topic "Mr X – the great innovator of 2015 hinking Skill ehaviour – Types of thinking– Concrete – Abstract tential and Holistic thinking – Chunking Triangle – ng at least 50 people belonging to various strata of entify a min of100 society related issues, problems hem and upload along with details of people met an	ng a 1000 words imaginary " and upload. (4 non- contact <u>1 hour</u> , Convergent, Divergent, - Context Grid – Examples – life and talk to them / make for which they need solutions
Project : Explorcontributorfor the society, (autobiography ohours)Module:1 BThinking and BeCreative,Analytical, SequeCase Study.Project : Meetinfield visits to ideand categories thcontact hours)Module:1 CLast	Creating a big picture of being an innovator – writi of self – Topic "Mr X – the great innovator of 2015 hinking Skill ehaviour – Types of thinking– Concrete – Abstract uential and Holistic thinking – Chunking Triangle – ng at least 50 people belonging to various strata of entify a min of100 society related issues, problems nem and upload along with details of people met ar ateral Thinking Skill	ng a 1000 words imaginary " and upload. (4 non- contact 1 hour , Convergent, Divergent, - Context Grid – Examples – life and talk to them / make for which they need solutions nd lessons learnt. (4 non- 1 hour
Project : Explorcontributorfor the society, (autobiography ohours)Module:1 BThinking and BeCreative,Analytical, SequeCase Study.Project : Meetinfield visits to ideand categories thcontact hours)Module:1 CLast	Creating a big picture of being an innovator – writi of self – Topic "Mr X – the great innovator of 2015 hinking Skill ehaviour – Types of thinking– Concrete – Abstract tential and Holistic thinking – Chunking Triangle – ng at least 50 people belonging to various strata of entify a min of100 society related issues, problems hem and upload along with details of people met an	ng a 1000 words imaginary " and upload. (4 non- contact 1 hour , Convergent, Divergent, - Context Grid – Examples – life and talk to them / make for which they need solutions nd lessons learnt. (4 non- 1 hour
Project : Explorcontributorfor the society, (autobiography ohours)Module:1 BTIThinking and BeCreative,Analytical, SequCase Study.Project : Meetinfield visits to ideand categories thcontact hours)Module:1 CLaBlooms TaxonoExamples	Creating a big picture of being an innovator – writi of self – Topic "Mr X – the great innovator of 2015 hinking Skill ehaviour – Types of thinking– Concrete – Abstract uential and Holistic thinking – Chunking Triangle – ng at least 50 people belonging to various strata of entify a min of100 society related issues, problems nem and upload along with details of people met ar ateral Thinking Skill	ng a 1000 words imaginary " and upload. (4 non- contact 1 hour , Convergent, Divergent, - Context Grid – Examples – life and talk to them / make for which they need solutions nd lessons learnt. (4 non- <u>1 hour</u> teral thinking model –
Project : Explore contributor for the society, (autobiography of hours) Module:1 B TI Module:1 B TI Thinking and Be Creative, Analytical, Sequ Case Study. Project : Meetin field visits to ide and categories th contact hours) Module:1 C La Blooms Taxono Examples Project : Last w Module:2 A	Creating a big picture of being an innovator – writi of self – Topic "Mr X – the great innovator of 2015 hinking Skill ehaviour – Types of thinking– Concrete – Abstract mential and Holistic thinking – Chunking Triangle – ing at least 50 people belonging to various strata of entify a min of100 society related issues, problems mem and upload along with details of people met an ateral Thinking Skill my – HOTS – Outof the box thinking – deBono lat weeks - incomplete portion to be done and uploaded reativity	ng a 1000 words imaginary " and upload. (4 non- contact 1 hour , Convergent, Divergent, - Context Grid – Examples – life and talk to them / make for which they need solutions nd lessons learnt. (4 non- 1 hour teral thinking model – 1 hour
Project : Explorcontributorfor the society, (autobiography ohours)TModule:1 BTThinking and BeCreative,Analytical, SequCase Study.Project : Meetinfield visits to ideand categories thcontact hours)Module:1 CLaBlooms TaxonoExamplesProject : Last wModule:2 AC	Creating a big picture of being an innovator – writi of self – Topic "Mr X – the great innovator of 2015 hinking Skill ehaviour – Types of thinking– Concrete – Abstract nential and Holistic thinking – Chunking Triangle – ng at least 50 people belonging to various strata of entify a min of100 society related issues, problems nem and upload along with details of people met ar ateral Thinking Skill my – HOTS – Outof the box thinking – deBono lat veeks - incomplete portion to be done and uploaded reativity	ng a 1000 words imaginary " and upload. (4 non- contact 1 hour , Convergent, Divergent, - Context Grid – Examples – life and talk to them / make for which they need solutions nd lessons learnt. (4 non- 1 hour teral thinking model – 1 hour nples
Project : Explore contributor for the society, (autobiography of hours) Module:1 B T Thinking and Be Creative, Analytical, Seque Case Study. Project : Meetin field visits to ide and categories th contact hours) Module:1 C La Blooms Taxono Examples Project : Last w Module:2 A Creativity Mode Project : Select	Creating a big picture of being an innovator – writi of self – Topic "Mr X – the great innovator of 2015 hinking Skill ehaviour – Types of thinking– Concrete – Abstract uential and Holistic thinking – Chunking Triangle – ng at least 50 people belonging to various strata of entify a min of100 society related issues, problems hem and upload along with details of people met ar ateral Thinking Skill my – HOTS – Outof the box thinking – deBono lat veeks - incomplete portion to be done and uploaded reativity els – Walla – Barrons – Koberg & Begnall – Exan ting 5 out of 100 issues identified for future wor	ng a 1000 words imaginary " and upload. (4 non- contact 1 hour , Convergent, Divergent, - Context Grid – Examples – life and talk to them / make for which they need solutions nd lessons learnt. (4 non- 1 hour teral thinking model – 1 1 hour nples rk. Criteria based approach
Project : Explore contributor for the society, Q autobiography of hours) Module:1 B TI Thinking and Be Creative, Analytical, Sequ Case Study. Project : Meetin field visits to ide and categories th contact hours) Module:1 C La Blooms Taxono Examples Project : Last w Module:2 A Ch Creativity Mode Project : Select for prioritisation	Creating a big picture of being an innovator – writi of self – Topic "Mr X – the great innovator of 2015 hinking Skill ehaviour – Types of thinking– Concrete – Abstract mential and Holistic thinking – Chunking Triangle – ing at least 50 people belonging to various strata of entify a min of100 society related issues, problems mem and upload along with details of people met ar ateral Thinking Skill my – HOTS – Outof the box thinking – deBono lat veeks - incomplete portion to be done and uploaded reativity els – Walla – Barrons – Koberg & Begnall – Exan ting 5 out of 100 issues identified for future wor n, use of statistical tools & upload . (4 non- conta	ng a 1000 words imaginary " and upload. (4 non- contact 1 hour , Convergent, Divergent, - Context Grid – Examples – life and talk to them / make for which they need solutions nd lessons learnt. (4 non- 1 hour teral thinking model – 1 hour nples rk. Criteria based approach (ct hours)
Project : Explorcontributorfor the society, (autobiography ohours)Module:1 BTIThinking and BeCreative,Analytical, SequCase Study.Project : Meetinfield visits to ideand categories thcontact hours)Module:1 CLaBlooms TaxonoExamplesProject : Last wModule:2 ACreativity ModeProject : Selecfor prioritisationModule:2 BB	Creating a big picture of being an innovator – writi of self – Topic "Mr X – the great innovator of 2015 hinking Skill ehaviour – Types of thinking– Concrete – Abstract nential and Holistic thinking – Chunking Triangle – ing at least 50 people belonging to various strata of entify a min of100 society related issues, problems hem and upload along with details of people met ar ateral Thinking Skill my – HOTS – Outof the box thinking – deBono lat veeks - incomplete portion to be done and uploaded reativity els – Walla – Barrons – Koberg & Begnall – Exan ting 5 out of 100 issues identified for future wor n, use of statistical tools & upload . (4 non- conta rainstorming	ng a 1000 words imaginary " and upload. (4 non- contact 1 hour , Convergent, Divergent, - Context Grid – Examples – life and talk to them / make for which they need solutions nd lessons learnt. (4 non- 1 hour teral thinking model – 1 1 hour nples rk. Criteria based approach
Project : Explorcontributorfor the society, (autobiography ohours)Module:1 BTThinking and BeCreative,Analytical, SequCase Study.Project : Meetinfield visits to ideand categories thcontact hours)Module:1 CLaBlooms TaxonorExamplesProject : Last wModule:2 ACreativity ModeProject : Selectfor prioritisationModule:2 BBa25 brainstorming	Creating a big picture of being an innovator – writi of self – Topic "Mr X – the great innovator of 2015 hinking Skill ehaviour – Types of thinking– Concrete – Abstract nential and Holistic thinking – Chunking Triangle – ng at least 50 people belonging to various strata of entify a min of100 society related issues, problems hem and upload along with details of people met ar ateral Thinking Skill my – HOTS – Outof the box thinking – deBono lat veeks - incomplete portion to be done and uploaded reativity els – Walla – Barrons – Koberg & Begnall – Exan ting 5 out of 100 issues identified for future wor n, use of statistical tools & upload . (4 non- conta rainstorming g techniques and examples	ng a 1000 words imaginary " and upload. (4 non- contact 1 hour , Convergent, Divergent, - Context Grid – Examples – life and talk to them / make for which they need solutions nd lessons learnt. (4 non- 1 hour teral thinking model – 1 hour nples rk. Criteria based approach <u>ict hours)</u> 1 hour
Project : Explorcontributorfor the society, (autobiography ohours)Module:1 BTIThinking and BeCreative,Analytical, SequeCase Study.Project : Meetinfield visits to ideand categories thcontact hours)Module:1 CLaBlooms TaxonoExamplesProject : Last wModule:2 ACreativity ModeProject : Selectfor prioritisationModule:2 BBi25 brainstormingProject : Brainstorming	Creating a big picture of being an innovator – writi of self – Topic "Mr X – the great innovator of 2015 hinking Skill ehaviour – Types of thinking– Concrete – Abstract nential and Holistic thinking – Chunking Triangle – ng at least 50 people belonging to various strata of entify a min of100 society related issues, problems hem and upload along with details of people met an ateral Thinking Skill my – HOTS – Outof the box thinking – deBono lat veeks - incomplete portion to be done and uploaded reativity els – Walla – Barrons – Koberg & Begnall – Exan ting 5 out of 100 issues identified for future wor n, use of statistical tools & upload . (4 non- conta rainstorming g techniques and examples storm and come out with as many solutions as pos-	ng a 1000 words imaginary " and upload. (4 non- contact 1 hour , Convergent, Divergent, - Context Grid – Examples – life and talk to them / make for which they need solutions nd lessons learnt. (4 non- 1 hour teral thinking model – 1 hour nples rk. Criteria based approach <u>ict hours)</u> 1 hour
Project : Explore contributor for the society, (autobiography of hours) Module:1 B TI Thinking and Be Creative, Analytical, Seque Case Study. Project : Meetin field visits to ide and categories th contact hours) Module:1 C La Blooms Taxono Examples Project : Last w Module:2 A Ch Creativity Mode Project : Selector for prioritisation Module:2 B Bh 25 brainstorming Project : Brains identified & uple	Creating a big picture of being an innovator – writi of self – Topic "Mr X – the great innovator of 2015 hinking Skill ehaviour – Types of thinking– Concrete – Abstract nential and Holistic thinking – Chunking Triangle – ng at least 50 people belonging to various strata of entify a min of100 society related issues, problems hem and upload along with details of people met ar ateral Thinking Skill my – HOTS – Outof the box thinking – deBono lat veeks - incomplete portion to be done and uploaded reativity els – Walla – Barrons – Koberg & Begnall – Exan ting 5 out of 100 issues identified for future wor n, use of statistical tools & upload . (4 non- conta rainstorming g techniques and examples	ng a 1000 words imaginary " and upload. (4 non- contact 1 hour , Convergent, Divergent, - Context Grid – Examples – life and talk to them / make for which they need solutions nd lessons learnt. (4 non- 1 hour teral thinking model – 1 hour nples rk. Criteria based approach <u>ict hours)</u> 1 hour

Mind Mapping techniques and guidelines. Drawing a mind map	
Project : Using Mind Maps get another set of solutions for he next 5 iss	ues (issue 6 – 10) . (4
non- contact hours)	
Module:4 A Systems thinking	1 hour
Systems Thinking essentials – examples – Counter Intuitive condemns	
Project : Select 1 issue / problem for which the possible solutions ar	e available with you.
Apply Systems Thinking process and pick up one solution [explanation sho	
other possible solutions have been left out]. Go back to the custo	
acceptability and upload (4 non- contact hours)	
Module:4 B Design Thinking	1 hour
Design thinking process – Human element of design thinking – case study	
Project : Apply design thinking to the selected solution, apply the engineer	ing & scientific tinge
to it. Participate in "design week" celebrations upload the weeks learning or	ut come.
Module:5 A Innovation	1 hour
Difference between Creativity and Innovation – Examples of innovation –I	Being innovative.
Project: A literature searches on prototyping of your solution finalized. Pre	epare a prototype
model or process and upload (4 non- contact hours)	
Module:5 B Blocks for Innovation	1 hour
Identify Blocks for creativity and innovation – overcoming obstacles – C	
Project : Project presentation on problem identification, solution, innovati	ons-expected
results – Interim review with PPT presentation (4 non- contact hours)	
Module:5 C Innovation Process	1 hour
Steps for Innovation – right climate for innovation	
Project: Refining the project, based on the review report and uploading the	e text (4 non-
contact hours)	
Module:6 AInnovation in India	1 hour
Stories of 10 Indian innovations	
Project: Making the project better with add ons. (4 non- contact hours)	
Module:6 B JUGAAD Innovation	1 hour
Frugal and flexible approach to innovation - doing more with less Indian	
Project: Fine tuning the innovation project with JUGAAD principles	and uploading
(Credit for JUGAAD implementation) . (4 non- contact hours)	
Module:7 A Innovation Project Proposal Presentation	1 hour
Project proposal contents, economic input, ROI – Template	
Project: Presentation of the innovative project proposal and upload . (4 n	on- contact hours)
Module:8 A Contemporary issue in Innovation	1 hour
Contemporary issue in Innovation	
Project: Final project Presentation, Viva voce Exam (4 non- contact hour	·s)
Total Lecture hours: 15 hours	
Text Book(s)	1
1. How to have Creative Ideas, Edward debone, Vermilon publication, UK	, 2007
2. The Art of Innovation, Tom Kelley & Jonathan Littman, Profile Books	
Reference Books	, ,
	Jb; 2000
1. Creating Confidence, Meribeth Bonct, Kogan Page India Ltd, New De	
 Lateral Thinking Skills, Paul Sloane, Keogan Page India Ltd, New Delh Indian Innovators, Akhat Agrawal, Jaico Books, Mumbai, 2015 	1, 2008
3 Lindian Innovators Akhat Agrawal Jaico Books Mumbai 2015	
	1 1 7 11
4. JUGAAD Innovation, Navi Radjou, Jaideep Prabhu, Simone Ahuja Ran	dom house India,
	dom house India,

Mode of Evaluation: CAT / Assignment / Quiz / FAT / Project / Seminar

Three reviews with weightage of 25 : 25 : 50 along with reports

Recommended by Board of Studies	15-12-2015		
Approved by Academic Council	No. 39	Date	17-12-2015

STS100	ode 1		rse title on to Soft skills	L T P J C 3 0 0 0 1
Pre-requis		Nor		Syllabus version
- 1				1
Course Obj	ectives:			
		he ability to plan better and we		
		learning ability and to acquire		ls
3. To ec	lucate th	e habits required to achieve s	uccess	
Expected Co			interest better with calf and	anvinanmant
• Enab	ing stud	lents to know themselves and	Interact better with sen and	environment
Module:1	Lesson	s on excellence		10 hour
Ethics and	integri	ty :Importance of ethics in	life, Intuitionism vs Con	sequentialism, Nor
consequentia	ılism, V	irtue ethics vs situation ethic	cs, Integrity - listen to cons	cience, Stand up fo
what is rig	ht. Cha	nge management: Who m	noved my cheese?, Tolera	nce of change an
uncertainty,	Joining	the bandwagon, Adapting cha	inge for growth - overcoming	g inhibition
How to pick	c up ski	lls faster?: Knowledge vs ski	ill, Skill introspection, Skill	acquisition, "10,00
hours rule"	and the	converse .Habit formation	: Know your habits, How	habits work? - Th
scientific ap	proach,	How habits work? - The ps	sychological approach, Hab	oits and professiona
success, "Th	e Habit	Loop", Domino effect, Unlear	rning a bad habit	
Analytic an	d resea	rch skills: Focused and targe	eted information seeking, H	low to make Googl
work for you	ı, Data a	ssimilation		
Module:2	Team s	kille		11 hou
		RT goals, Action plans, O) bstacles -Failure managen	
	-	motivational factors, Maslo	-	
		tion: Planning and sequenci	•	
		learning cycle, Facilitating th		
-		ngths and weakness, Nurture	—	
		e building. Trust and colla		
-		ring responsibilities		2,
Dereguing,				
	Tree +	nal Intelligence		12 hou
Module:3			g, Ego states, Life positions.	D
Module:3 Transaction	al Anal			e
Module:3 Transaction Individual B	al Anal rainstori	ning, Group Brainstorming, S		writing, Crawford's
Module:3 Transaction Individual B Slip writing	al Anal rainstori approac	ning, Group Brainstorming, S h, Reverse brainstorming, Star	r bursting, Charlette procedu	writing, Crawford's are, Round robin
Module:3 Transaction Individual B Slip writing brainstormin	al Anal rainstorr approact ag. Psycl	ning, Group Brainstorming, S h, Reverse brainstorming, Star nometric Analysis :Skill Test	r bursting, Charlette procedu	writing, Crawford's are, Round robin
Module:3 Transaction Individual B Slip writing brainstormin	al Anal rainstorr approact ag. Psycl	ning, Group Brainstorming, S h, Reverse brainstorming, Star	r bursting, Charlette procedu	writing, Crawford's are, Round robin
Module:3 Transaction Individual B Slip writing brainstormin Solving: Mo	al Anal rainstorr approact ag. Psycl	ning, Group Brainstorming, S h, Reverse brainstorming, Star nometric Analysis : Skill Test one answer, Unique ways	r bursting, Charlette procedu	writing, Crawford's are, Round robin
Module:3 Transaction Individual B Slip writing brainstormin Solving: Mo Module:4	al Anal rainstorn approact g. Psycl ore than Adapta	ning, Group Brainstorming, S h, Reverse brainstorming, Star nometric Analysis :Skill Test one answer, Unique ways bility	r bursting, Charlette procedu t, Personality Test . Rebus P	writing, Crawford's ure, Round robin Puzzles/Problem 12 hour
Module:3 Transaction Individual B Slip writing s brainstormin Solving: Mo Module:4 Theatrix: M	al Anal rainstorn approact g. Psycl ore than Adapta Iotion Pi	ning, Group Brainstorming, S h, Reverse brainstorming, Star nometric Analysis :Skill Test one answer, Unique ways bility cture, Drama, Role Play, Diff	r bursting, Charlette procedu t, Personality Test . Rebus P ferent kinds of expressions.	writing, Crawford's ure, Round robin Puzzles/Problem 12 hour Creative expressio
Module:3 Transaction Individual B Slip writing brainstormin Solving: Mo Module:4 Theatrix: M Writing, Gra	al Anal rainstorn approact g. Psycl ore than Adapta Iotion Pi aphic A	ning, Group Brainstorming, S h, Reverse brainstorming, Star nometric Analysis : Skill Test one answer, Unique ways bility cture, Drama, Role Play, Diff rts, Music, Art and Dance	r bursting, Charlette procedu t, Personality Test . Rebus P ferent kinds of expressions. (, Flexibility of thought: 7	writing, Crawford's ire, Round robin Puzzles/Problem 12 hour Creative expression The 5'P' framewor
Module:3 Transaction Individual B Slip writing s brainstormin Solving: Mo Module:4 Theatrix: M Writing, Gra (Profiling,	al Anal rainstorn approact g. Psyclore than Adapta Iotion Pi aphic A prioritiz	ning, Group Brainstorming, S h, Reverse brainstorming, Star nometric Analysis : Skill Test one answer, Unique ways bility cture, Drama, Role Play, Diff rts, Music, Art and Dance	r bursting, Charlette procedu t, Personality Test . Rebus P ferent kinds of expressions. , Flexibility of thought: 7 problem solving, plan	writing, Crawford's ure, Round robin Puzzles/Problem 12 hour Creative expressio The 5'P' framewor ning). Adapt 1

			Total Lecture ho	ours:	45 hours					
Tex	Text Book(s)									
1.	Chip He	eath, How to Change Things	When Change Is	Hard (H	Hardcover),20	010,First				
	Edition	,Crown Business.								
2.	Karen k	Kindrachuk, Introspection, 2	010, 1 st Edition.							
3.	-	Hough, The Improvisation E k, 2011, Berrett-Koehler Pu	U	ilding	Trust and Rad	dical Collaboration				
Ref	ference l	Books								
1.	<u>Gideon</u>	Mellenbergh, A Conceptu	al Introduction to	Psych	nometrics: De	evelopment, Analysis				
	and Ap	plication of Psychological a	nd Educational Te	ests,20	11, Boom Ele	ven International.				
2.	Phil Lapworth, An Introduction to Transactional Analysis, 2011, Sage Publications (CA)									
Mo	Mode of Evaluation: FAT, Assignments, Projects, Case studies, Role plays, 3 Assessments with									
Ter	Term End FAT (Computer Based Test)									
Rec	commen	ded by Board of Studies	09/06/2017							
Ap	proved b	y Academic Council	No. 45 th AC	Date	15/06/20	17				

=	de	Course title		L T P J C		
STS1002		unication	3 0 0 0 1			
Pre-requis	site		Syllabus version			
<u>a ar</u> :						
Course Obje			• .•			
		n overview of Prerequisites to Business Co				
		ne problem solving skills and improve the he thoughts and develop effective writing states and develop effective writing states and the second states and the second states are states and the second states are		cal skills		
Expected Co	0	<u> </u>	561115			
		ents enhance knowledge of relevant topics	and evaluate the	e information		
Module:1	Study s	kills		10 hour		
M 4	1	s: Relation between memory and brain,	Charman 11 and the alter			
v	-	5	•	1 0		
mistake, Ima	ige-nam	e association, Sharing knowledge, Visual	lization. Concep	pt map:Mind Map		
Algorithm N	Mapping	g, Top down and Bottom Up Appro	oach. Time m a	anagement skills		
		e Busters, Procrastination, Scheduling,				
		-	mannasking, M	working working		
under pressu	re and a	dhering to deadlines				
Module:2	Emotio	nal Intelligence (Self Esteem)		6 hour		
		Empathy and Cognitive Empathy . Sympa	athy : Level of s			
		eximity, Compassion fatigue)		Jinpunij (Spunu		
proximity, be		mining; compassion rangac)				
Module:3	Busines	ss Etiquette				
Module:3	Busines	ss Etiquette		9 hour		
		-	τη Γαρσιμάσε Τι			
Social and	Cultura	al Etiquette: Value, Manners, Customs		radition. Writin		
Social and Company B	Cultur logs : B	al Etiquette: Value, Manners, Customs uilding a blog, Developing brand message,	FAQs', Assessin	radition. Writin		
Social and Company Bl Internal Co	Cultura logs : B	al Etiquette: Value, Manners, Customs uilding a blog, Developing brand message, ications: Open and objective Comm	FAQs', Assessin nunication, Tw	radition. Writin ng Competition 20 way dialogue		
Social and Company Bl Internal Co	Cultura logs : B	al Etiquette: Value, Manners, Customs uilding a blog, Developing brand message, ications: Open and objective Comm	FAQs', Assessin nunication, Tw	radition. Writin ng Competition 70 way dialogue		
Social and Company Bl Internal Co Understandin	Cultura logs : B ommun ng the	al Etiquette: Value, Manners, Customs uilding a blog, Developing brand message, ications: Open and objective Comm audience. Planning: Identifying, C	FAQs', Assessin nunication, Tw Bathering Infor	radition. Writin ng Competition 70 way dialogue rmation, Analysis		
Social and Company Bl Internal Co Understandin Determining,	Cultura logs : B ommun ng the , Selecti	al Etiquette: Value, Manners, Customs uilding a blog, Developing brand message, ications: Open and objective Comm audience. Planning: Identifying, Co ing plan, Progress check, Types of plan	FAQs', Assessin nunication, Tw Bathering Infor ning . Writing	radition. Writin ng Competition 70 way dialogue rmation, Analysis press release and		
Social and Company Bl Internal Co Understandin Determining, meeting not	Cultura logs : B ommun ng the , Selecti es:Write	al Etiquette: Value, Manners, Customs uilding a blog, Developing brand message, ications: Open and objective Comm audience. Planning: Identifying, C ing plan, Progress check, Types of plann e a short, catchy headline, Get to the Poi	FAQs', Assessin nunication, Tw Bathering Infor ning . Writing	radition. Writin ng Competition 70 way dialogue rmation, Analysis press release and		
Social and Company Bl Internal Co Understandin Determining, meeting not	Cultura logs : B ommun ng the , Selecti es:Write	al Etiquette: Value, Manners, Customs uilding a blog, Developing brand message, ications: Open and objective Comm audience. Planning: Identifying, Co ing plan, Progress check, Types of plan	FAQs', Assessin nunication, Tw Bathering Infor ning . Writing	radition. Writin ng Competition o way dialogue mation, Analysis press release an		
Social and Company Bl Internal Co Understandin Determining, meeting not first paragrap	Cultura logs : Ba ommun ng the , Selecti es:Write oh, Body	al Etiquette: Value, Manners, Customs uilding a blog, Developing brand message, ications: Open and objective Comm audience. Planning: Identifying, C ing plan, Progress check, Types of plann e a short, catchy headline, Get to the Poi 7 – Make it relevant to your audience	FAQs', Assessin nunication, Tw Bathering Infor ning . Writing	radition. Writin ng Competition o way dialogue mation, Analysis press release an		
Social and Company Bl Internal Co Understandin Determining, meeting not first paragrap	Cultura logs : Ba ommun ng the , Selecti es:Write oh, Body	al Etiquette: Value, Manners, Customs uilding a blog, Developing brand message, ications: Open and objective Comm audience. Planning: Identifying, C ing plan, Progress check, Types of plann e a short, catchy headline, Get to the Poi	FAQs', Assessin nunication, Tw Bathering Infor ning . Writing	radition. Writin ng Competition o way dialogue mation, Analysis press release an		
Social and Company Bl Internal Co Understandin Determining, meeting not first paragrap Module:4	Cultura logs : B ommun ng the , Selecti es:Write oh, Body Quanti	al Etiquette: Value, Manners, Customs uilding a blog, Developing brand message, ications: Open and objective Comm audience. Planning: Identifying, C ing plan, Progress check, Types of plann e a short, catchy headline, Get to the Poi v – Make it relevant to your audience tative Ability	FAQs', Assessin nunication, Tw Bathering Infor ning . Writing nt –summarize	radition. Writin ng Competition vo way dialogue mation, Analysis press release an your subject in th 4 hour		
Social and Company Bl Internal Co Understandin Determining, meeting not first paragrap Module:4 Numeracy	Cultura logs : B ommun ng the , Selecti es:Write oh, Body Quantit	al Etiquette: Value, Manners, Customs uilding a blog, Developing brand message, ications: Open and objective Comm audience. Planning: Identifying, C ing plan, Progress check, Types of plann e a short, catchy headline, Get to the Poi v – Make it relevant to your audience tative Ability s: Fractions, Decimals, Bodmas, Simp	FAQs', Assessin nunication, Tw Bathering Infor ning . Writing nt –summarize	radition. Writin ng Competition to way dialogue mation, Analysis press release an your subject in th <u>4 hour</u> F, LCM, Tests of		
Social and Company Bl Internal Co Understandin Determining, meeting not first paragrap Module:4 Numeracy of divisibility.	Cultura logs : Ba ommun ng the , Selecti es:Write oh, Body Quantit concept Beginni	al Etiquette: Value, Manners, Customs uilding a blog, Developing brand message, ications: Open and objective Comm audience. Planning: Identifying, C ing plan, Progress check, Types of plan e a short, catchy headline, Get to the Poi v – Make it relevant to your audience tative Ability s: Fractions, Decimals, Bodmas, Simp ing to Think without Ink: Problems s	FAQs', Assessin nunication, Tw Bathering Infor ning . Writing nt –summarize g	radition. Writin ng Competition o way dialogue mation, Analysis press release an your subject in th <u>4 hour</u> F, LCM, Tests of echniques such as		
Social and Company Bl Internal Co Understandin Determining, meeting not first paragrap Module:4 Numeracy of divisibility. I Percentage,	Cultura logs : B ommun ng the , Selecti es:Write oh, Body Quantit concept Beginni Proport	 al Etiquette: Value, Manners, Customs uilding a blog, Developing brand message, ications: Open and objective Commaudience. Planning: Identifying, Company plan, Progress check, Types of plante a short, catchy headline, Get to the Pointe – Make it relevant to your audience tative Ability s: Fractions, Decimals, Bodmas, Simping to Think without Ink: Problems stionality, Support of answer choices, State St	FAQs', Assessin nunication, Tw Bathering Infor ning . Writing nt –summarize y lifications, HCF solving using te ubstitution of	radition. Writin ng Competition vo way dialogue mation, Analysis press release an your subject in th 4 hour F, LCM, Tests c echniques such as convenient values		
Social and Company Bl Internal Co Understandin Determining, meeting not first paragrap Module:4 Numeracy of divisibility. Percentage, Bottom-up ap	Cultura logs : B ommun ng the , Selecti es:Write oh, Body Quanti concept Beginni Proport pproach	al Etiquette: Value, Manners, Customs uilding a blog, Developing brand message, ications: Open and objective Comm audience. Planning: Identifying, C ing plan, Progress check, Types of plann e a short, catchy headline, Get to the Poi v – Make it relevant to your audience tative Ability s: Fractions, Decimals, Bodmas, Simp ing to Think without Ink: Problems s ionality, Support of answer choices, S etc. Math Magic: Puzzles and brain tease	FAQs', Assessin nunication, Tw Bathering Infor- ning . Writing nt –summarize y lifications, HCH solving using te ubstitution of the rs involving mat	radition. Writin ng Competition to way dialogue mation, Analysis press release and your subject in th <u>4 hour</u> F, LCM, Tests c echniques such as convenient values thematical concept		
Social and Company Bl Internal Co Understandin Determining, meeting not first paragrap Module:4 Numeracy of divisibility. Percentage, Bottom-up ap	Cultura logs : B ommun ng the , Selecti es:Write oh, Body Quanti concept Beginni Proport pproach	 al Etiquette: Value, Manners, Customs uilding a blog, Developing brand message, ications: Open and objective Commaudience. Planning: Identifying, Company plan, Progress check, Types of plante a short, catchy headline, Get to the Pointe – Make it relevant to your audience tative Ability s: Fractions, Decimals, Bodmas, Simping to Think without Ink: Problems stionality, Support of answer choices, State St	FAQs', Assessin nunication, Tw Bathering Infor- ning . Writing nt –summarize y lifications, HCH solving using te ubstitution of the rs involving mat	radition. Writin ng Competition to way dialogue mation, Analysis press release an your subject in th <u>4 hour</u> F, LCM, Tests of echniques such as convenient values thematical concept		
Social and Company Bl Internal Co Understandin Determining, meeting not first paragrap Module:4 Numeracy of divisibility. Percentage, Bottom-up ap	Cultura logs : B ommun ng the , Selecti es:Write oh, Body Quanti concept Beginni Proport pproach	al Etiquette: Value, Manners, Customs uilding a blog, Developing brand message, ications: Open and objective Comm audience. Planning: Identifying, C ing plan, Progress check, Types of plann e a short, catchy headline, Get to the Poi v – Make it relevant to your audience tative Ability s: Fractions, Decimals, Bodmas, Simp ing to Think without Ink: Problems s ionality, Support of answer choices, S etc. Math Magic: Puzzles and brain tease	FAQs', Assessin nunication, Tw Bathering Infor- ning . Writing nt –summarize y lifications, HCH solving using te ubstitution of the rs involving mat	radition. Writin ng Competition to way dialogue mation, Analysis press release and your subject in th <u>4 hour</u> F, LCM, Tests c echniques such as convenient values thematical concept		
Social and Company Bl Internal Co Understandin Determining, meeting not first paragrap Module:4 Numeracy divisibility. Percentage, Bottom-up ap Speed Calcu	Cultura logs : B ommun ng the , Selecti es:Write oh, Body Quantit Concept Beginni Proport proach lations:	al Etiquette: Value, Manners, Customs uilding a blog, Developing brand message, ications: Open and objective Comm audience. Planning: Identifying, C ing plan, Progress check, Types of plann e a short, catchy headline, Get to the Poi v – Make it relevant to your audience tative Ability s: Fractions, Decimals, Bodmas, Simp ing to Think without Ink: Problems s ionality, Support of answer choices, S etc. Math Magic: Puzzles and brain tease	FAQs', Assessin nunication, Tw Bathering Infor- ning . Writing nt –summarize y lifications, HCH solving using te ubstitution of the rs involving mat	radition. Writin ng Competition to way dialogue mation, Analysis press release an your subject in th 4 hour F, LCM, Tests c echniques such as convenient values thematical concept s techniques		
Social and Company Bl Internal Co Understandin Determining, meeting not first paragrap Module:4 Numeracy of divisibility. Percentage, Bottom-up ap Speed Calcu Module:5	Cultura logs : B ommun ng the , Selecti es:Write oh, Body Quanti Concept Beginni Proport pproach lations:	al Etiquette: Value, Manners, Customs uilding a blog, Developing brand message, ications: Open and objective Comm audience. Planning: Identifying, C ing plan, Progress check, Types of plann e a short, catchy headline, Get to the Poi v – Make it relevant to your audience tative Ability s: Fractions, Decimals, Bodmas, Simp ing to Think without Ink: Problems s ionality, Support of answer choices, S etc. Math Magic: Puzzles and brain tease s Square roots, Cube roots, Squaring numb	FAQs', Assessin nunication, Tw Bathering Infor- ning . Writing nt –summarize y lifications, HCH solving using te ubstitution of the ers involving mat	radition. Writin ng Competition vo way dialogue mation, Analysis press release and your subject in th <u>4 hour</u> F, LCM, Tests of echniques such as convenient values thematical concept s techniques 3 hour		
Social and Company Bl Internal Co Understandin Determining, meeting not first paragrap Module:4 Numeracy of divisibility. Percentage, Bottom-up ap Speed Calcu Module:5 Interpreting	Cultura logs : B ommun ng the , Selecti es:Write oh, Body Quantit Concept Beginni Proport pproach llations: Reason ; Diagra	al Etiquette: Value, Manners, Customs uilding a blog, Developing brand message, ications: Open and objective Comm audience. Planning: Identifying, C ing plan, Progress check, Types of plant e a short, catchy headline, Get to the Poi v – Make it relevant to your audience tative Ability s: Fractions, Decimals, Bodmas, Simp ing to Think without Ink: Problems s ionality, Support of answer choices, S etc. Math Magic: Puzzles and brain tease s Square roots, Cube roots, Squaring numb ing Ability mming and sequencing information: Pice	FAQs', Assessin nunication, Tw Bathering Infor ning .Writing nt –summarize g lifications, HCF solving using te ubstitution of ours involving mathers, Vedic mathers cture analogy, Ou	radition. Writin ng Competition vo way dialogue mation, Analysis press release and your subject in th <u>4 hour</u> F, LCM, Tests of echniques such as convenient values thematical concept s techniques <u>3 hour</u> dd picture, Picture		
Social and Company Bl Internal Co Understandin Determining, meeting not first paragrap Module:4 Numeracy of divisibility. Percentage, Bottom-up ap Speed Calcu Module:5 Interpreting sequence, Pic	Cultura logs : Bi ommun ng the , Selecti es:Write oh, Body Quantit Concept Beginni Proport proach llations: Reason ; Diagra cture for	al Etiquette: Value, Manners, Customs uilding a blog, Developing brand message, ications: Open and objective Comm audience. Planning: Identifying, C ing plan, Progress check, Types of plann e a short, catchy headline, Get to the Poi v – Make it relevant to your audience tative Ability s: Fractions, Decimals, Bodmas, Simp ing to Think without Ink: Problems s ionality, Support of answer choices, S etc. Math Magic: Puzzles and brain tease s Square roots, Cube roots, Squaring number ing Ability mming and sequencing information: Pic mation, Mirror image and water image. Lo	FAQs', Assessin nunication, Tw Bathering Infor ning .Writing nt –summarize g lifications, HCF solving using te ubstitution of ours involving mathers, Vedic mathers cture analogy, Ou	radition. Writin ng Competition vo way dialogue mation, Analysis press release and your subject in th <u>4 hour</u> F, LCM, Tests of echniques such as convenient values thematical concept s techniques <u>3 hour</u> dd picture, Picture		
Social and Company Bl Internal Co Understandin Determining, meeting not first paragrap Module:4 Numeracy of divisibility. Percentage, Bottom-up ap Speed Calcu Module:5 Interpreting sequence, Pic	Cultura logs : Bi ommun ng the , Selecti es:Write oh, Body Quantit Concept Beginni Proport proach llations: Reason ; Diagra cture for	al Etiquette: Value, Manners, Customs uilding a blog, Developing brand message, ications: Open and objective Comm audience. Planning: Identifying, C ing plan, Progress check, Types of plant e a short, catchy headline, Get to the Poi v – Make it relevant to your audience tative Ability s: Fractions, Decimals, Bodmas, Simp ing to Think without Ink: Problems s ionality, Support of answer choices, S etc. Math Magic: Puzzles and brain tease s Square roots, Cube roots, Squaring numb ing Ability mming and sequencing information: Pice	FAQs', Assessin nunication, Tw Bathering Infor ning .Writing nt –summarize g lifications, HCF solving using te ubstitution of ours involving mathers, Vedic mathers cture analogy, Ou	radition. Writin ng Competition yo way dialogue mation, Analysis press release an your subject in th <u>4 hour</u> F, LCM, Tests of echniques such a convenient value thematical concept s techniques <u>3 hour</u> dd picture, Picture		
Social and Company Bl Internal Co Understandin Determining, meeting not first paragrap Module:4 Numeracy divisibility. Percentage, Bottom-up ap Speed Calcu Module:5 Interpreting sequence, Pic questions-bas	Cultura logs : B ommun ng the , Selecti es:Write oh, Body Quantit Concept Beginni Proport proach lations: Reason g Diagra cture for sed on n	al Etiquette: Value, Manners, Customs uilding a blog, Developing brand message, ications: Open and objective Comm audience. Planning: Identifying, C ing plan, Progress check, Types of plann e a short, catchy headline, Get to the Poi v – Make it relevant to your audience tative Ability s: Fractions, Decimals, Bodmas, Simp ing to Think without Ink: Problems s ionality, Support of answer choices, S etc. Math Magic: Puzzles and brain tease s Square roots, Cube roots, Squaring number ing Ability mming and sequencing information: Pic mation, Mirror image and water image. Lo	FAQs', Assessin nunication, Tw Bathering Infor ning .Writing nt –summarize g lifications, HCF solving using te ubstitution of ours involving mathers, Vedic mathers cture analogy, Ou	radition. Writin ng Competition yo way dialogue mation, Analysis press release an your subject in th <u>4 hour</u> F, LCM, Tests of echniques such as convenient value thematical concept s techniques <u>3 hour</u> dd picture, Picture		

Strengthening Grammar Fundamentals : Parts of speech, Tenses, Verbs(Gerunds and infinitives): **Reinforcements of Grammar concepts :** Subject Verb Agreement, Active and Passive Voice, Reported Speech

Mo	dule:7	Communication and Att	itude			10 hours		
Writing : Writing formal & informal letters, How to write a blog & knowing the format,								
Effe	Effective ways of writing a blog, How to write an articles & knowing the format, Effective ways							
of v	of writing an articles, Designing a brochures, Speaking skills: How to present a JAM, Public							
	-	elf managing: Concepts of	_	-	-			
-	-	ords, Giving feedback, Tak	-			, , ,		
		, , , , , , , , , , , , , , , , , , , ,	8					
			Total Lecture h	ours:	45 hours			
Tex	t Book(s)				1		
1.	FACE,	Aptipedia, Aptitude Encyc	lopedia, 2016, Firs	st Edit	ion, Wiley Pul	olications, Delhi.		
2.	ETHN	US, Aptimithra, 2013, First	Edition, McGraw-	-Hill E	Education Pvt.	Ltd.		
Ref	erence]	Books						
1.	Alan B	ond and Nancy Schuman,	300+ Successful H	Busine	ss Letters for	All Occasions, 2010,		
		dition, Barron's Educationa				, ,		
2.	Josh Ka	ufman, The First 20 Hours:	How to Learn Any	/thing	Fast . 2014.	First Edition.		
		n Books, USA.			<u></u> , ,	,		
Mo	U	valuation: FAT, Assignmer	nts, Projects, Case	studie	s, Role plays,			
		nts with Term End FAT (C			, I J ^a ,			
		ded by Board of Studies	09/06/2017	/				
		y Academic Council	No. 45 th AC	Date	15/06/20	017		
		<i>.</i>	1		1			

Course cod	e	Course title	
STS2001	4-	Reasoning Skill Enhancer	
Pre-requisi	te	None	Syllabus versio
Course Ob	jectives:		
		n the social network by the effective use of	social media and social
inter	actions.		
	•	wn true potential and build a very good pe	rsonal branding
3. To e	nhance t	he Analytical and reasoning skills.	
Expected C			
		g the various strategies of conflict resolution	on among peers and supervisors
and	respond	appropriately	
Module:1	Social 1	Interaction and Social Media	6 hou
Effective 11	se of sou	cial media: Types of social media, Mode	rating personal information Soci
		fession, Communicating diplomatically,	
		with social media, How to advertise on a	
		methods, Effective techniques for better	
		and influence people, Building relationshi	
	when sta	kes are high, Conflict resolution: Definit	ion and strategies, Styles of confi
resolution			
Module:2		erbal Communication	6 hou
Module:2 Proximecs:	Types of	of proximecs, Rapport building ,Reports	and Data Transcoding: Types of
Module:2 Proximecs: reports, Neg	Types of		and Data Transcoding: Types of
Module:2 Proximecs: reports, Neg	Types of	of proximecs, Rapport building ,Reports	and Data Transcoding: Types of
	Types of gotiation	of proximecs, Rapport building ,Reports	and Data Transcoding: Types of
Module:2 Proximecs: reports, Neg conflicts Module:3	Types ogotiation	of proximecs, Rapport building , Reports Skill : Effective negotiation strategies, C ersonal Skill	and Data Transcoding: Types of onflict Resolution: Types of 8 hou
Module:2 Proximecs: reports, Neg conflicts Module:3 Social Inter	Types of gotiation	of proximecs, Rapport building , Reports Skill : Effective negotiation strategies, C ersonal Skill Interpersonal Communication,Peer Comm	and Data Transcoding: Types of onflict Resolution: Types of 8 hour nunication, Bonding,Types of soci
Module:2 Proximecs: reports, Neg conflicts Module:3 Social Inter interaction,	Types of gotiation Interport raction : Respon	of proximecs, Rapport building , Reports Skill : Effective negotiation strategies, C ersonal Skill Interpersonal Communication,Peer Comm	and Data Transcoding: Types of onflict Resolution: Types of 8 hour nunication, Bonding,Types of soci oral and personal responsibilitie
Module:2 Proximecs: reports, Neg conflicts Module:3 Social Inter interaction, Networking	Types of gotiation Interport raction : Resport g :Comp	of proximecs, Rapport building , Reports Skill : Effective negotiation strategies, C ersonal Skill Interpersonal Communication,Peer Communication,Peer Communication, Peer Communication, Content sharing, Peer etition , Collaboration, Content sharing, Peer	and Data Transcoding: Types of onflict Resolution: Types of 8 hour nunication, Bonding,Types of soci oral and personal responsibilitie ersonal Branding :Image Buildin
Module:2 Proximecs: reports, Neg conflicts Module:3 Social Inter interaction, Networking Grooming,	Types of gotiation Interport raction : Resport g :Comp Using s	of proximecs, Rapport building , Reports Skill : Effective negotiation strategies, C ersonal Skill Interpersonal Communication,Peer Communication,Peer Communication, Peer Communication, Content sharing, Pe etition, Collaboration, Content sharing, Pe ocial media for branding, Delegation a	and Data Transcoding: Types of onflict Resolution: Types of 8 hou nunication, Bonding,Types of soci oral and personal responsibilitie ersonal Branding :Image Buildin
Module:2 Proximecs: reports, Neg conflicts Module:3 Social Inter interaction, Networking Grooming,	Types of gotiation Interport raction : Resport g :Comp Using s	of proximecs, Rapport building , Reports Skill : Effective negotiation strategies, C ersonal Skill Interpersonal Communication,Peer Communication,Peer Communication, Peer Communication, Content sharing, Peer etition , Collaboration, Content sharing, Peer	and Data Transcoding: Types of onflict Resolution: Types of 8 hou nunication, Bonding,Types of soci oral and personal responsibilitie ersonal Branding :Image Buildin
Module:2 Proximecs: reports, Neg conflicts Module:3 Social Inter interaction, Networking Grooming, responsibilit	Types of gotiation Interport raction : Resport g :Comp Using sty, Grant	of proximecs, Rapport building , Reports Skill : Effective negotiation strategies, C ersonal Skill Interpersonal Communication,Peer Communication, Peer Communication, Peer Communication, Content sharing, Pe etition, Collaboration, Content sharing, Pe ocial media for branding, Delegation a of authority, Creation of accountability	and Data Transcoding: Types of onflict Resolution: Types of 8 hou nunication, Bonding,Types of soci oral and personal responsibilitie ersonal Branding :Image Buildin and compliance: Assignment an
Module:2 Proximecs: reports, Neg conflicts Module:3 Social Inter interaction, Networking Grooming, responsibilit	Types of gotiation Interport raction : Respon g :Comp Using s ty, Grant Quanti	of proximecs, Rapport building , Reports a Skill : Effective negotiation strategies, C ersonal Skill Interpersonal Communication,Peer Comm asibility: Types of responsibilities, Mo etition, Collaboration, Content sharing, Pe tocial media for branding, Delegation a to of authority, Creation of accountability tative Ability	and Data Transcoding: Types of onflict Resolution: Types of 8 hour nunication, Bonding,Types of soci oral and personal responsibilitie ersonal Branding :Image Buildin and compliance: Assignment ar 10 hours
Module:2 Proximecs: reports, Neg conflicts Module:3 Social Inter interaction, Networking Grooming, responsibility Module:4 Number pr	Types of gotiation Interper raction : Respor g :Comp Using s ty, Grant Quanti operties	of proximecs, Rapport building , Reports Skill : Effective negotiation strategies, C ersonal Skill Interpersonal Communication,Peer Communication, Peer Communication, Peer Communication, Collaboration, Content sharing, Personal Methods etition, Collaboration, Content sharing, Personal Methods of authority, Creation of accountability tative Ability : Number of factors, Factorials, Remainde	and Data Transcoding: Types of onflict Resolution: Types of 8 hour nunication, Bonding,Types of soci oral and personal responsibilitie ersonal Branding :Image Buildin and compliance: Assignment ar 10 hours r Theorem, Unit digit position, Ter
Module:2 Proximecs: reports, Neg conflicts Module:3 Social Inter interaction, Networking Grooming, responsibilit Module:4 Number pr digit positio	Types of gotiation Interport raction : Resport g :Comp Using s ty, Grant Quanti coperties on, Aver	of proximecs, Rapport building , Reports Skill : Effective negotiation strategies, C ersonal Skill Interpersonal Communication,Peer Communication, Peer Communication, Peer Communication, Collaboration, Content sharing, Pe etition, Collaboration, Content sharing, Pe ocial media for branding, Delegation a to of authority, Creation of accountability tative Ability : Number of factors, Factorials, Remainder ages: Averages, Weighted Average, Pro	and Data Transcoding: Types of onflict Resolution: Types of 8 hour nunication, Bonding,Types of soci oral and personal responsibilitie ersonal Branding :Image Buildin and compliance: Assignment ar 10 hours r Theorem, Unit digit position, Ter gressions: Arithmetic Progressio
Module:2 Proximecs: reports, Neg conflicts Module:3 Social Inter interaction, Networking Grooming, responsibility Module:4 Number pr digit positic Geometric I	Types of gotiation Interport raction : Respon g :Comp Using s ty, Grant Quanti roperties on, Aver Progressi	of proximecs, Rapport building , Reports Skill : Effective negotiation strategies, C ersonal Skill Interpersonal Communication,Peer Communication, Peer Communication, Peer Communication, Collaboration, Content sharing, Personal Methods etition, Collaboration, Content sharing, Personal Methods of authority, Creation of accountability tative Ability : Number of factors, Factorials, Remainde	and Data Transcoding: Types of onflict Resolution: Types of 8 hou nunication, Bonding,Types of soci oral and personal responsibilitie ersonal Branding :Image Buildin and compliance: Assignment an 10 hours r Theorem, Unit digit position, Ter gressions: Arithmetic Progressio
Module:2 Proximecs: reports, Neg conflicts Module:3 Social Inter interaction, Networking Grooming, responsibilit Module:4 Number pr digit positio Geometric I increase, R	Types of gotiation Interportion raction : Resport g :Comp Using s ty, Grant Quanti roperties on, Aver Progressi atios : T	of proximecs, Rapport building , Reports Skill : Effective negotiation strategies, C ersonal Skill Interpersonal Communication,Peer Communication, Peer Communication, Peer Communication, Collaboration, Content sharing, Pe etition, Collaboration, Content sharing, Pe cocial media for branding, Delegation a to of authority, Creation of accountability tative Ability : Number of factors, Factorials, Remainde rages: Averages, Weighted Average, Pro ion, Harmonic Progression, Percentages: ypes of ratios and proportions	and Data Transcoding: Types of onflict Resolution: Types of 8 hour nunication, Bonding,Types of soci oral and personal responsibilitie ersonal Branding :Image Buildin and compliance: Assignment ar 10 hours r Theorem, Unit digit position, Ter gressions: Arithmetic Progressio Increase & Decrease or successiv
Module:2 Proximecs: reports, Neg conflicts Module:3 Social Inter interaction, Networking Grooming, responsibilit Module:4 Number pr digit positic Geometric I increase, R Module:5	Types of gotiation Interport raction : Respon g :Comp Using s ty, Grant Quanti roperties on, Aver Progressi atios : T Reason	of proximecs, Rapport building , Reports Skill : Effective negotiation strategies, C ersonal Skill Interpersonal Communication,Peer Communication, Peer Communication, Peer Communication, Content sharing, Pe toticon, Collaboration, Content sharing, Pe toticon, Collaboration, Content sharing, Pe toticon and for branding, Delegation and toticon authority, Creation of accountability tative Ability : Number of factors, Factorials, Remainder ages: Averages, Weighted Average, Pro ion, Harmonic Progression, Percentages: ypes of ratios and proportions ting Ability	and Data Transcoding: Types of onflict Resolution: Types of 8 hour nunication, Bonding,Types of soci oral and personal responsibilitie ersonal Branding :Image Buildin and compliance: Assignment ar 10 hours r Theorem, Unit digit position, Ter gressions: Arithmetic Progressio Increase & Decrease or successiv 8 hours
Module:2 Proximecs: reports, Neg conflicts Module:3 Social Inter interaction, Networking Grooming, responsibilit Module:4 Number pr digit positic Geometric I increase, R Module:5 Analytical	Types of gotiation Interpe- raction : Respor g :Comp Using s ty, Grant Operties on, Aver Progressi atios : T Reason Reason	of proximecs, Rapport building , Reports Skill : Effective negotiation strategies, C ersonal Skill Interpersonal Communication,Peer Communication, Peer Communication, Peer Communication, Collaboration, Content sharing, Pe etition, Collaboration, Content sharing, Pe cocial media for branding, Delegation a to of authority, Creation of accountability tative Ability : Number of factors, Factorials, Remainde rages: Averages, Weighted Average, Pro ion, Harmonic Progression, Percentages: ypes of ratios and proportions	and Data Transcoding: Types of onflict Resolution: Types of 8 hour nunication, Bonding,Types of soci oral and personal responsibilitie ersonal Branding :Image Buildin and compliance: Assignment ar 10 hours r Theorem, Unit digit position, Ter gressions: Arithmetic Progressio Increase & Decrease or successiv 8 hours ar & Cross Variable Relationship

Mo	dule:6	Verbal Ability	7 hours						
Voc	cabulary	Building: Synonyms & Antonyms, One word	substitutes, W	ord Pairs, Spellings,					
Idio	Idioms, Sentence completion, Analogies								
	Total Lecture hours:45 hours								
Tex	t Book(s)							
1.	FACE,	Aptipedia Aptitude Encyclopedia, 2016, First Editi	on, Wiley Publ	ications, Delhi.					
2.	ETHN	US, Aptimithra, 2013, First Edition, McGraw-Hill E	Education Pvt.L	.td.					
3.	Mark G	6. Frank, David Matsumoto, Hyi Sung Hwang, Non	verbal Commu	inication: Science					
	and Ap	plications, 2012, 1 st Edition, Sage Publications, New	v York.						
Ref	erence l	Books							
1.	Arun S	harma, Quantitative aptitude, 2016, 7 th edition, Mcg	graw Hill Educa	ation Pvt. Ltd.					
2.	Kerry F	Patterson, Joseph Grenny, Ron McMillan, Al Switzl	er, Crucial Con	versations: Tools					
	for Tall	king When Stakes are High, 2001,1 st edition McGra	w Hill Contem	porary, Bangalore.					
3.	Dale (Carnegie, How to Win Friends and Influence Pe	ople. Latest E	dition 2016 Gallery					
		New York.	opie, Lucest L						
Mo	de of ev	aluation: FAT, Assignments, Projects, Case studies	Role plays						
		nts with Term End FAT (Computer Based Test)	s, itole plays,						
		led by Board of Studies 09/06/2017							
		y Academic Council No. 45 th AC Date	15/06/20	17					
App		y Academic Council No. 45 AC Date	13/00/20	17					

Pre-requisite None Syllabus v Course Objectives:	se code		Course title				JU
Course Objectives: Ito analyze social psychological phenomena in terms of impression management. 2. To control or influence other people's perceptions. 3. 3. To enhance the problem solving skills Expected Course Outcome: Creating in the students an understanding of decision making models and generating alternat using appropriate expressions. Impression Management Module:1 Impression Management 8 Types and techniques Importance of impression management, Types of impression management, Techniques and or studies, Making a good first impression in an interview (TEDOS technique) , How to recove from a bad impressions/experience, Making a good first impression and Gestures, Body language (Kines Non-verbal communication and body language Dressing, Appearance and Grooming, Facial expression and Gestures, Body language (Kines Keywords to be used, Voice elements (tone, pitch and pace) 4 Module:2 Thinking Skills 4 Module:3 Beyond Structure 4 Art of questioning:How to frame questions, Blooms questioning pyramid, Purpose of que Etiquette: Business, Telephone etiquette, Cafeteria etiquette, Elevator etiquette, Email etit					~		0 1
1. To analyze social psychological phenomena in terms of impression management. 2. To control or influence other people's perceptions. 3. To enhance the problem solving skills Expected Course Outcome: Creating in the students an understanding of decision making models and generating alternat using appropriate expressions. Module:1 Impression Management 8 Types and techniques Importance of impression management, Types of impression management, Techniques and cstudies, Making a good first impression in an interview (TEDOS technique) , How to recove from a bad impressions/experience, Making a good first impression of line Non-verbal communication and body language Dressing, Appearance and Grooming, Facial expression and Gestures, Body language (Kines Keywords to be used, Voice elements (tone, pitch and pace) Module:2 Thinking Skills 4 Introduction to problem solving process : Steps to solve the problem, Simplex prodientification to implementation, Decision making model Module:3 Beyond Structure 4 Art of questioning:How to frame questions, Blooms questioning pyramid, Purpose of que Etiquette: Business, Telephone etiquette, Cafeteria etiquette, Elevator etiquette, Email etitiette:	equisite			Sy	llabus ve	rsion	
1. To analyze social psychological phenomena in terms of impression management. 2. To control or influence other people's perceptions. 3. To enhance the problem solving skills Expected Course Outcome: Creating in the students an understanding of decision making models and generating alternat using appropriate expressions. Module:1 Impression Management 8 Types and techniques Importance of impression management, Types of impression management, Techniques and cstudies, Making a good first impression in an interview (TEDOS technique) , How to recove from a bad impressions/experience, Making a good first impression of line Non-verbal communication and body language Dressing, Appearance and Grooming, Facial expression and Gestures, Body language (Kines Keywords to be used, Voice elements (tone, pitch and pace) Module:2 Thinking Skills 4 Introduction to problem solving process : Steps to solve the problem, Simplex prodientification to implementation, Decision making model Module:3 Beyond Structure 4 Art of questioning:How to frame questions, Blooms questioning pyramid, Purpose of que Etiquette: Business, Telephone etiquette, Cafeteria etiquette, Elevator etiquette, Email etic	a Objectives						4
2. To control or influence other people's perceptions. 3. To enhance the problem solving skills Expected Course Outcome: Creating in the students an understanding of decision making models and generating alternat using appropriate expressions. Module:1 Impression Management Module:1 Impression Management 8 Types and techniques Importance of impression management, Types of impression management, Techniques and c studies, Making a good first impression in an interview (TEDOS technique), How to recove from a bad impression/experience, Making a good first impression online Non-verbal communication and body language Dressing, Appearance and Grooming, Facial expression and Gestures, Body language (Kines Keywords to be used, Voice elements (tone, pitch and pace) Module:2 Thinking Skills 4 Introduction to problem solving process : Steps to solve the problem, Simplex profintroduction to decision making and decision making process : Steps involved identification to implementation, Decision making model Module:3 Beyond Structure 4 Art of questioning:How to frame questions, Blooms questioning pyramid, Purpose of que Etiquette: Business, Telephone etiquette, Cafeteria etiquette, Elevator etiquette, Email etic	v		omena in terms of in	nression mana	gement		
3. To enhance the problem solving skills Expected Course Outcome: Creating in the students an understanding of decision making models and generating alternat using appropriate expressions. Module:1 Impression Management Module:1 Impression Management Types and techniques 8 Importance of impression management, Types of impression management, Techniques and c 8 Studies, Making a good first impression in an interview (TEDOS technique), How to recove from a bad impressions/experience, Making a good first impression online 8 Non-verbal communication and body language Dressing, Appearance and Grooming, Facial expression and Gestures, Body language (Kines Keywords to be used, Voice elements (tone, pitch and pace) 4 Module:2 Thinking Skills 4 Introduction to problem solving process : Steps to solve the problem, Simplex profintroduction to implementation, Decision making model 4 Module:3 Beyond Structure 4 Art of questioning:How to frame questions, Blooms questioning pyramid, Purpose of que Etiquette: Business, Telephone etiquette, Cafeteria etiquette, Elevator etiquette, Email etitiette				ipression mana	gement.		
Creating in the students an understanding of decision making models and generating alternat using appropriate expressions. Module:1 Impression Management 8 Types and techniques 8 Importance of impression management, Types of impression management, Techniques and c studies, Making a good first impression in an interview (TEDOS technique), How to recove from a bad impressions/experience, Making a good first impression online Non-verbal communication and body language Dressing, Appearance and Grooming, Facial expression and Gestures, Body language (Kines Keywords to be used, Voice elements (tone, pitch and pace) Module:2 Thinking Skills 4 Introduction to problem solving process : Steps to solve the problem, Simplex process identification to implementation, Decision making model 4 Module:3 Beyond Structure 4 Art of questioning:How to frame questions, Blooms questioning pyramid, Purpose of que Etiquette: Business, Telephone etiquette, Cafeteria etiquette, Elevator etiquette, Email etion							
Creating in the students an understanding of decision making models and generating alternat using appropriate expressions. Module:1 Impression Management 8 Types and techniques Importance of impression management, Types of impression management, Techniques and c studies, Making a good first impression in an interview (TEDOS technique), How to recove from a bad impressions/experience, Making a good first impression online 8 Non-verbal communication and body language Dressing, Appearance and Grooming, Facial expression and Gestures, Body language (Kines Keywords to be used, Voice elements (tone, pitch and pace) 4 Module:2 Thinking Skills 4 Module:3 Beyond Structure 4 Art of questioning:How to frame questions, Blooms questioning pyramid, Purpose of que Etiquette: Business, Telephone etiquette, Cafeteria etiquette, Elevator etiquette, Email etio							
Creating in the students an understanding of decision making models and generating alternat using appropriate expressions. Module:1 Impression Management 8 Types and techniques Importance of impression management, Types of impression management, Techniques and c studies, Making a good first impression in an interview (TEDOS technique), How to recove from a bad impressions/experience, Making a good first impression online 8 Non-verbal communication and body language Dressing, Appearance and Grooming, Facial expression and Gestures, Body language (Kines Keywords to be used, Voice elements (tone, pitch and pace) 4 Module:2 Thinking Skills 4 Module:3 Beyond Structure 4 Art of questioning:How to frame questions, Blooms questioning pyramid, Purpose of que Etiquette: Business, Telephone etiquette, Cafeteria etiquette, Elevator etiquette, Email etio		2.4					
using appropriate expressions. Module:1 Impression Management Types and techniques Importance of impression management, Types of impression management, Techniques and c studies, Making a good first impression in an interview (TEDOS technique), How to recove from a bad impressions/experience, Making a good first impression online Non-verbal communication and body language Dressing, Appearance and Grooming, Facial expression and Gestures, Body language (Kines Keywords to be used, Voice elements (tone, pitch and pace) Module:2 Thinking Skills Module:3 Beyond Structure Module:3 Beyond Structure 4 Art of questioning:How to frame questions, Blooms questioning pyramid, Purpose of que Etiquette: Business, Telephone etiquette, Cafeteria etiquette, Elevator etiquette, Email etio	cted Course (Jutcome:					
Module:1 Impression Management 8 Types and techniques Importance of impression management, Types of impression management, Techniques and or studies, Making a good first impression in an interview (TEDOS technique), How to recove from a bad impressions/experience, Making a good first impression online Non-verbal communication and body language Dressing, Appearance and Grooming, Facial expression and Gestures, Body language (Kines Keywords to be used, Voice elements (tone, pitch and pace) 4 Module:2 Thinking Skills 4 Introduction to problem solving process : Steps to solve the problem, Simplex proditection to implementation, Decision making model 4 Module:3 Beyond Structure 4 Art of questioning:How to frame questions, Blooms questioning pyramid, Purpose of que Etiquette: Business, Telephone etiquette, Cafeteria etiquette, Elevator etiquette, Email etimes	ing in the stud	ents an understandir	ng of decision making	g models and ge	enerating	g alternativ	ves
Types and techniques Importance of impression management, Types of impression management, Techniques and c studies, Making a good first impression in an interview (TEDOS technique), How to recove from a bad impressions/experience, Making a good first impression online Non-verbal communication and body language Dressing, Appearance and Grooming, Facial expression and Gestures, Body language (Kines Keywords to be used, Voice elements (tone, pitch and pace) Module:2 Thinking Skills Module:2 Thinking Skills Module:3 Beyond Structure 4 Art of questioning:How to frame questions, Blooms questioning pyramid, Purpose of que	appropriate ex	xpressions.					
Types and techniques Importance of impression management, Types of impression management, Techniques and c studies, Making a good first impression in an interview (TEDOS technique), How to recove from a bad impressions/experience, Making a good first impression online Non-verbal communication and body language Dressing, Appearance and Grooming, Facial expression and Gestures, Body language (Kines Keywords to be used, Voice elements (tone, pitch and pace) Module:2 Thinking Skills Module:2 Thinking Skills Module:3 Beyond Structure 4 Art of questioning:How to frame questions, Blooms questioning pyramid, Purpose of que							
Types and techniques Importance of impression management, Types of impression management, Techniques and c studies, Making a good first impression in an interview (TEDOS technique), How to recove from a bad impressions/experience, Making a good first impression online Non-verbal communication and body language Dressing, Appearance and Grooming, Facial expression and Gestures, Body language (Kines Keywords to be used, Voice elements (tone, pitch and pace) Module:2 Thinking Skills Module:2 Thinking Skills Module:3 Beyond Structure 4 Art of questioning:How to frame questions, Blooms questioning pyramid, Purpose of que							
Types and techniques Importance of impression management, Types of impression management, Techniques and c studies, Making a good first impression in an interview (TEDOS technique), How to recove from a bad impressions/experience, Making a good first impression online Non-verbal communication and body language Dressing, Appearance and Grooming, Facial expression and Gestures, Body language (Kines Keywords to be used, Voice elements (tone, pitch and pace) Module:2 Thinking Skills Module:2 Thinking Skills Module:3 Beyond Structure 4 Art of questioning:How to frame questions, Blooms questioning pyramid, Purpose of que							
Types and techniques Importance of impression management, Types of impression management, Techniques and c studies, Making a good first impression in an interview (TEDOS technique), How to recove from a bad impressions/experience, Making a good first impression online Non-verbal communication and body language Dressing, Appearance and Grooming, Facial expression and Gestures, Body language (Kines Keywords to be used, Voice elements (tone, pitch and pace) Module:2 Thinking Skills Module:2 Thinking Skills Module:3 Beyond Structure 4 Art of questioning:How to frame questions, Blooms questioning pyramid, Purpose of que	ulaul Tuunua	asian Managamant					
Importance of impression management, Types of impression management, Techniques and c studies, Making a good first impression in an interview (TEDOS technique), How to recove from a bad impressions/experience, Making a good first impression online Non-verbal communication and body language Dressing, Appearance and Grooming, Facial expression and Gestures, Body language (Kines Keywords to be used, Voice elements (tone, pitch and pace) Module:2 Thinking Skills Introduction to problem solving process : Steps to solve the problem, Simplex production to decision making and decision making process : Steps involved identification to implementation, Decision making model Module:3 Beyond Structure 4 4 Art of questioning:How to frame questions, Blooms questioning pyramid, Purpose of que Etiquette: Business, Telephone etiquette, Cafeteria etiquette, Elevator etiquette, Email etiquette	ne:1 Impre	ssion Management				8 h	our
Introduction to problem solving process : Steps to solve the problem, Simplex production to decision making and decision making process : Steps involved identification to implementation, Decision making model Module:3 Beyond Structure Art of questioning:How to frame questions, Blooms questioning pyramid, Purpose of que Etiquette: Business, Telephone etiquette, Cafeteria etiquette, Elevator etiquette, Email etiquette	es, Making a g a bad impressi verbal comm	ood first impression ions/experience, Ma unication and body	in an interview (TEI king a good first imp v language	DOS technique) ression online	, How t	to recover	
Introduction to problem solving process : Steps to solve the problem, Simplex process involved identification to decision making and decision making process : Steps involved identification to implementation, Decision making model Module:3 Beyond Structure Art of questioning:How to frame questions, Blooms questioning pyramid, Purpose of que Etiquette: Business, Telephone etiquette, Cafeteria etiquette, Elevator etiquette, Email etiquette	es, Making a g a bad impressi verbal commu- ing, Appearan	ood first impression ions/experience, Mai unication and body ice and Grooming, F	in an interview (TEI king a good first imp language Facial expression and	DOS technique) ression online	, How t	to recover	
Introduction to decision making and decision making process : Steps involved identification to implementation, Decision making model Module:3 Beyond Structure Art of questioning:How to frame questions, Blooms questioning pyramid, Purpose of que Etiquette: Business, Telephone etiquette, Cafeteria etiquette, Elevator etiquette, Email etiquette, Elevator etiquette, Elevator etiquette, Email etiquette, Elevator etiquette, Elevator etiquette, Email etiquette, Elevator etiquette	es, Making a g a bad impressi verbal commu- ing, Appearan vords to be use	ood first impression ions/experience, Mai unication and body ace and Grooming, F ed, Voice elements (t	in an interview (TEI king a good first imp language Facial expression and	DOS technique) ression online	, How t	to recover ge (Kinesi	cs),
Module:3 Beyond Structure 4 Art of questioning:How to frame questions, Blooms questioning pyramid, Purpose of que Etiquette: Business, Telephone etiquette, Cafeteria etiquette, Elevator etiquette, Email etiquette, Elevator etiquette, Email etiquette, Elevator etiquette, Email etiquette, Elevator etiquette, Elevator etiquette, Elevator etiquette, Email etiquette, Elevator etiquette, Elevat	es, Making a g a bad impressi verbal commu- ing, Appearan vords to be use	ood first impression ions/experience, Mai unication and body ace and Grooming, F ed, Voice elements (t	in an interview (TEI king a good first imp language Facial expression and	DOS technique) ression online	, How t	to recover ge (Kinesi	cs),
Art of questioning:How to frame questions, Blooms questioning pyramid, Purpose of que Etiquette: Business, Telephone etiquette, Cafeteria etiquette, Elevator etiquette, Email etiquette, Elevator etiquette, Elevator etiquette, Elevator etiquette, Email etiquette, Elevator e	es, Making a g a bad impressi verbal commu- ing, Appearan ords to be use ule:2 Think duction to p duction to p	ood first impression ions/experience, Mai unication and body ice and Grooming, F ed, Voice elements (t ing Skills roblem solving pr decision making a	in an interview (TEI king a good first imp language Facial expression and tone, pitch and pace)	DOS technique) ression online Gestures, Body	, How t languag	to recover ge (Kinesi 4 h	cs), nour
Art of questioning:How to frame questions, Blooms questioning pyramid, Purpose of que Etiquette: Business, Telephone etiquette, Cafeteria etiquette, Elevator etiquette, Email etiquette, Elevator etiquette, Elevator etiquette, Elevator etiquette, Email etiquette, Elevator e	es, Making a g a bad impressi verbal commu- ing, Appearan ords to be use ule:2 Think duction to p duction to p	ood first impression ions/experience, Mai unication and body ice and Grooming, F ed, Voice elements (t ing Skills roblem solving pr decision making a	in an interview (TEI king a good first imp language Facial expression and tone, pitch and pace)	DOS technique) ression online Gestures, Body	, How t languag	to recover ge (Kinesi 4 h	cs), nour
Art of questioning:How to frame questions, Blooms questioning pyramid, Purpose of que Etiquette: Business, Telephone etiquette, Cafeteria etiquette, Elevator etiquette, Email etiquette, Elevator etiquette, Email etiquette, Elevator etiquette, Email etiquette, Elevator etiquette, Elevator etiquette, Elevator etiquette, Email etiquette, Elevator	es, Making a g a bad impressi verbal commu- ing, Appearan ords to be use ule:2 Think duction to p duction to p	ood first impression ions/experience, Mai unication and body ice and Grooming, F ed, Voice elements (t ing Skills roblem solving pr decision making a	in an interview (TEI king a good first imp language Facial expression and tone, pitch and pace)	DOS technique) ression online Gestures, Body	, How t languag	to recover ge (Kinesi 4 h	cs), nour
Etiquette: Business, Telephone etiquette, Cafeteria etiquette, Elevator etiquette, Email etiq	es, Making a g a bad impressi verbal commu- ing, Appearan ords to be use ule:2 Think duction to p duction to p	ood first impression ions/experience, Mat unication and body ice and Grooming, F ed, Voice elements (t ing Skills problem solving pr decision making a plementation, Decisi	in an interview (TEI king a good first imp language Facial expression and tone, pitch and pace)	DOS technique) ression online Gestures, Body	, How t languag	to recover ge (Kinesi 4 h pplex proc involved	cs), nour fror
Etiquette: Business, Telephone etiquette, Cafeteria etiquette, Elevator etiquette, Email etiq	es, Making a g a bad impressi verbal commu- ing, Appearan ords to be use ule:2 Think duction to p duction to p	ood first impression ions/experience, Mat unication and body ice and Grooming, F ed, Voice elements (t ing Skills problem solving pr decision making a plementation, Decisi	in an interview (TEI king a good first imp language Facial expression and tone, pitch and pace)	DOS technique) ression online Gestures, Body	, How t languag	to recover ge (Kinesi 4 h pplex proc involved	cs), nour
	es, Making a g a bad impressi verbal commu- ing, Appearan vords to be use ule:2 Think duction to p duction to imp ule:3 Beyon	ood first impression ions/experience, Mai unication and body ice and Grooming, F ed, Voice elements (t ing Skills problem solving pr decision making a plementation, Decisi d Structure	in an interview (TEI king a good first imp Janguage Facial expression and tone, pitch and pace) Focess : Steps to so and decision maki ion making model	DOS technique) ression online Gestures, Body olve the proble ng process :	, How t	to recover ge (Kinesi 4 h pplex proc involved 4 h	cs), nour eess fror
Module:4 Quantitative Ability	es, Making a g a bad impressiverbal commu- ing, Appearan vords to be use ule:2 Think duction to p duction to of fication to imp ule:3 Beyon of questioning uette: Busines	ood first impression ions/experience, Matunication and body ice and Grooming, F ed, Voice elements (t ing Skills roblem solving pr decision making a plementation, Decisi d Structure :How to frame ques s, Telephone etique	in an interview (TEI king a good first imp language Facial expression and tone, pitch and pace) rocess : Steps to so and decision making ion making model	DOS technique) ression online Gestures, Body olve the proble ng process :	, How t languag	to recover ge (Kinesi 4 h uplex proc involved 4 h se of quest	cs), iour cess fror iour
9	es, Making a g a bad impressiverbal commu- ing, Appearan- vords to be use ule:2 Think: duction to p duction to of fication to imp ule:3 Beyon of questioning uette: Business l media etique	ood first impression ions/experience, Matunication and body ice and Grooming, F ed, Voice elements (t ing Skills problem solving pr decision making a plementation, Decisi d Structure ;How to frame quest s, Telephone etiquet ette	in an interview (TEI king a good first imp language Facial expression and tone, pitch and pace) rocess : Steps to so and decision making ion making model	DOS technique) ression online Gestures, Body olve the proble ng process :	, How t languag	to recover ge (Kinesi 4 h uplex proc involved 4 h se of quest	cs), nour ress fror nour tions

Profit and Loss :Cost Price & Selling Price, Margins & Markup, **Interest Calculations:** Simple Interest, Compound Interest, Recurring, **Mixtures and solutions :**Ratio & Averages, Proportions, **Time and Work:** Pipes & Cisterns, Man Day concept, Division Wages, **Time Speed and Distance:**Average speed, Relative speed, Boats and streams. **Proportions & Variations**

Module:5	Reasoning A	bility						11 hours
Logical R	easoning:	Sequence	and	series,	Coding	and	decoding,	Directions ,
Visual Rea	soning : Abstr	act Reasoning,	Input	Type D	iagramma	atic Re	easoning, Spa	atial reasoning,
Cubes Data	a Analysis An	d Interpretation	on DI	-Tables/	Charts/Te	xt		
	X7 1 1 4 1 9 1 9	4						0.1

Module:6Verbal Ability9 hoursGrammar: Spot the Errors, Sentence Correction, Gap Filling Exercise, Sentence Improvisations,
Misc. Grammar Exercise

			Total Lecture hou	rs: 4	5 hours	
Te	xt Book(s)				
1.		l Kallet, Think Smarter: Cr	6	-		lving and Decision-
	Making	g Skills, April 7, 2014, 1st E	Edition, Wiley, New	Jersey.		
2.	MK Se	hgal, Business Communica	tion, 2008, 1 st Editic	on, Exco	el Books, In	dia.
3.	FACE,	Aptipedia Aptitude Encycl	opedia, 2016, First H	Edition,	Wiley Pub	lications, Delhi.
4.	ETHN	JS, Aptimithra, 2013, First	edition, McGraw-H	ill Edu	cation Pvt. I	td, Banglore.
Re	ference 1	Books				
1.						
		ew J. DuBrin, Imp	U			· · · · · · · · · · · · · · · · · · ·
	Resea	arch, Theory and P	ractice, 2010, 1	l st ed	lition, Ro	outledge.
2.	Arun S	harma, Manorama Sharm	a, Quantitative apti	tude, 2	2016, 7 th ec	lition, McGraw Hill
		on Pvt. Ltd, Banglore.				
3.	M. Nei	l Browne, Stuart M. Keele	y, Asking the right	questio	ons, 2014, 1	1 th Edition, Pearson,
	Londor	l.				
Mo	ode of Ev	valuation: FAT, Assignmer	nts, Projects, Case st	udies, l	Role plays,	
		nts with Term End FAT (C	- · · · · · · · · · · · · · · · · · · ·)		
		led by Board of Studies	09/06/2017			
Ap	proved b	y Academic Council	No. 45 th AC	Date	15/06/20	17

Course code	Course title	L T P J C
STS3001	Preparedness for external opportunities	3 0 0 1
Pre-requisite	None	Syllabus version
Course Obje		
prospective er 2. To check if	ely tackle the interview process, and leave a positive impression nployer by reinforcing your strength, experience and appropri candidates have the adequate writing skills that are needed in the problem solving skills.	ateness for the job.
	irse Outcome:	
1. Enablin educat	ng students acquire skills for preparing for interviews, presentation	ations and higher
Module:1 I	nterview Skills	3 hour
	nterview Skills rview: Structured and unstructured interview orientation, Close	
preparation	b face remote interviews: Video interview, Recorded feedbace ew : Tips to customize preparation for personal interview, Pra	
Module:2 H	Resume Skills	2 hour
Customizing	me: Quiz on types of resume resume : Frequent mistakes in customizing resume, Layout - bany's requirement, Digitizing career portfolio	Understanding
Module:3 H	Presentation Skills	6 hour
	esentation : tips to prepare PowerPoint presentation, Outlinin	
of Color, Strat Maintaining captivate your Dealing with	Test naterials: Blue sky thinking, Introduction, body and conclusi regic presentation and preparing visual aids: Importance and types of visual ai raudience, Design of posters questions: Setting out the ground rules, Dealing with interrup questions, Handling difficult questions	ds, Animation to
Module:4	Quantative Ability	14 hour
Probability: (Geometry an Trigonometry Logarithms:	Combinations : Counting, Grouping, Linear Arrangement, C Conditional Probability, Independent and Dependent Events d Mensuration: Properties of Polygon, 2D & 3D Figures, Arc y: Heights and distances, Simple trigonometric functions Introduction, Basic rules troduction, Basic rules quations: Understanding Quadratic Equations, Rules & proba	ea & Volumes

Module:5	Reasoning Ability			7 hours
	asoning : Syllogisms, Binar			
	ysis and Interpretation: Da	ata Sufficiency Data in	terpretation-Ad	vanced Interpretation
tables, pie o	charts & bar chats			
Module:6	Verbal Ability			8 hours
Comprehe	nsion and Logic: Reading of	comprehension Para Ju	mbles Critical I	Reasoning :
	d Conclusion, Assumption &			
Module:7	Writing Skills			5 hours
	ng What is note making, Di			
	iting What is report writing,	, How to write a report	Writing a repo	ort & work sheet
D 1 / ¹				
		duct, Understanding i	t's features, Wi	riting a product
description		_		
description		_		
description		ortance, Writing sample	e research paper	
description		_	e research paper	
description		ortance, Writing sample	e research paper	
description Research p Text Book	paper Research and its impo	ortance, Writing sample	e research paper	r
description Research p Text Book	paper Research and its impo	ortance, Writing sample	e research paper	r
description Research p Text Book 1. Michae Paul.	paper Research and its impo	Total Lecture hours Cover letter Book, 201	e research paper 45 hours 1, 1 st Edition, 3	r JIST Editors, Saint
description Research p Text Book 1. Michae Paul.	Daper Research and its importance (s) el Farra, Quick Resume & C Flage, An Introduction to C	Total Lecture hours Cover letter Book, 201	e research paper 45 hours 1, 1 st Edition, 3	r JIST Editors, Saint
description Research p Text Book 1. Michae Paul. 2. Daniel Reference	Daper Research and its importance (s) el Farra, Quick Resume & O Flage, An Introduction to C Books	Total Lecture hours Cover letter Book, 201 Critical Thinking, 2002	e research paper 45 hours 1, 1 st Edition, 3 1 st Edition, Pea	r JIST Editors, Saint arson, London.
description Research p Text Book 1. Michae Paul. 2. Daniel Reference 1. FACE	Daper Research and its importance (s) el Farra, Quick Resume & C Flage, An Introduction to C	Total Lecture hours Total Lecture hours Cover letter Book, 201 Critical Thinking, 2002 opedia, 2016, 1 st Editio	e research paper 45 hours 1, 1 st Edition, 3 1 st Edition, Pea on, Wiley Public	r JIST Editors, Saint arson, London. cations, Delhi.
description Research p Text Book 1. Michae Paul. 2. Daniel Reference 1. FACE 2. ETHN	paper Research and its imposed (s) el Farra, Quick Resume & G Flage, An Introduction to C Books , Aptipedia Aptitude Encycl	Total Lecture hours Total Lecture hours Cover letter Book, 201 Critical Thinking, 2002 opedia, 2016, 1 st Editio dition, McGraw-Hill E	e research paper 45 hours 1, 1 st Edition, 3 1 st Edition, Per on, Wiley Public ducation Pvt. L	r JIST Editors, Saint arson, London. cations, Delhi. td.
description Research p Text Book 1. Michae Paul. 2. Daniel Refrence 1. FACE 2. ETHN Mode of E	paper Research and its importance (s) el Farra, Quick Resume & O Flage, An Introduction to O Books , Aptipedia Aptitude Encycl US, Aptimithra, 2013, 1 st Eo	Total Lecture hours Total Lecture hours Cover letter Book, 201 Critical Thinking, 2002 opedia, 2016, 1 st Edition dition, McGraw-Hill E nts, Projects, Case stud	e research paper 45 hours 1, 1 st Edition, 3 1 st Edition, Per on, Wiley Public ducation Pvt. L	r JIST Editors, Saint arson, London. cations, Delhi. td.
description Research p Text Book 1. Michae Paul. 2. Daniel Reference 1. FACE 2. ETHN Mode of E 3 Assessment	(s) el Farra, Quick Resume & C Flage, An Introduction to C Books , Aptipedia Aptitude Encycl US, Aptimithra, 2013, 1 st Ec valuation: FAT, Assignmen	Total Lecture hours Total Lecture hours Cover letter Book, 201 Critical Thinking, 2002 opedia, 2016, 1 st Edition dition, McGraw-Hill E nts, Projects, Case stud	e research paper 45 hours 1, 1 st Edition, 3 1 st Edition, Per on, Wiley Public ducation Pvt. L	r JIST Editors, Saint arson, London. cations, Delhi. td.

		Course title				LIPJO
STS3005		Code Mithra	a			3 0 0 0 1
Pre-requisite	None				Sy	llabus versio
Course Objective						
	cs which will help th				C.	
	design a graphical u					
	ntroduction to databa			ith an empha	asis or	n how to
organize, maintai	and retrieve - effici	ently, and effective	ly.			
Expected Course		~				
Enabling students	to write coding in C	,C++,Java and DBN	MS conc	epts		
	•					15 1
	ogramming				<u> </u>	15 hou
	Execution and Struc	-		•• •		
Statements, Loop	ing, Arrays, Structure	e, Pointers, Memor	y Manag	ement in C,	Funct	lions.
	D					15 1
	Programming			0 T 1	1	15 hou
	-+, Need for OOP, C					
• •	lation, Access Speci	iners, Relationship,	Polymo	rpnism, Exc	eptior	n Handling,
Abstract Classes,	Interfaces.					
Module:3 JAV	Δ					10 hou
	1					
	va Data Types and C	Derators Control 9	Statemer	nts Looning	Arra	
Introduction to Ja	va, Data Types and C jects. Create C++ &					ys, Need for
Introduction to Ja OOP, Class & Ob	jects, Create C++ &	Java class and show	v the sim	nilarity Enca	psulat	ys, Need for tion, Access
Introduction to Ja OOP, Class & Ob		Java class and show	v the sim	nilarity Enca	psulat	ys, Need for tion, Access
Introduction to Ja OOP, Class & Ob Specifiers, Relatio	jects, Create C++ & onship, Polymorphism	Java class and show	v the sim	nilarity Enca	psulat	ys, Need for tion, Access
Introduction to Ja OOP, Class & Ob Specifiers, Relation	jects, Create C++ & onship, Polymorphism	Java class and shown, Exception Handl	v the sim	nilarity Enca stract Classe	psulat	ys, Need for tion, Access orfaces.
Introduction to Ja OOP, Class & Ob Specifiers, Relation	jects, Create C++ & onship, Polymorphism base	Java class and shown, Exception Handl	v the sim	nilarity Enca stract Classe	psulat	ys, Need for tion, Access orfaces.
Introduction to Ja OOP, Class & Ob Specifiers, Relation	jects, Create C++ & onship, Polymorphism base	Java class and shown, Exception Handl	v the sim ling, Abs CT, Join	nilarity Enca stract Classe	psulat	ys, Need for tion, Access orfaces.
Introduction to Ja OOP, Class & Ob Specifiers, Relation	jects, Create C++ & onship, Polymorphism base	Java class and shown, Exception Handl	v the sim ling, Abs CT, Join	nilarity Enca stract Classe	psulat	ys, Need for tion, Access orfaces.
Introduction to Ja OOP, Class & Ob Specifiers, Relation Module:4 Data Introduction to da	jects, Create C++ & onship, Polymorphism base	Java class and shown, Exception Handl	v the sim ling, Abs CT, Join	nilarity Enca stract Classe	psulat	ys, Need for tion, Access orfaces.
Introduction to Ja OOP, Class & Ob Specifiers, Relation Module:4 Data Introduction to da Reference Books	jects, Create C++ & onship, Polymorphism base	Java class and shown, Exception Handl Manipulation, SELE Total Lecture ho	v the sim ling, Abs CT, Joir ours: 4	hilarity Enca stract Classe is. 5 hours	psulat s, Inte	ys, Need for tion, Access orfaces. 5 hou
Introduction to Ja OOP, Class & Ob Specifiers, Relation Module:4 Data Introduction to da Reference Books 1. Data Structur	jects, Create C++ & onship, Polymorphism base tabase, DDL, Data M es and Algorithms: h	Java class and show m, Exception Handl Manipulation, SELE Total Lecture ho https://ece.uwaterloo	v the sim ling, Abs CT, Joir ours: 4 o.ca/~dw	hilarity Enca stract Classe hs. 5 hours harder/aads	psulat s, Inte	ys, Need for tion, Access orfaces. 5 hou ure_materials/
Introduction to Ja OOP, Class & Ob Specifiers, Relation Module:4 Data Introduction to da Reference Books 1. Data Structur 2. C Programm	jects, Create C++ & onship, Polymorphism base tabase, DDL, Data N	Java class and show m, Exception Handl Manipulation, SELE Total Lecture ho https://ece.uwaterloo	v the sim ling, Abs CT, Joir ours: 4 o.ca/~dw	hilarity Enca stract Classe hs. 5 hours harder/aads	psulat s, Inte	ys, Need for tion, Access orfaces. 5 hou ure_materials/
Introduction to Ja OOP, Class & Ob Specifiers, Relation Module:4 Data Introduction to da Reference Books 1. Data Structur 2. C Programm Dean Miller	jects, Create C++ & onship, Polymorphism base tabase, DDL, Data N es and Algorithms: h ing: C Programming	Java class and show m, Exception Handl Manipulation, SELE Total Lecture ho https://ece.uwaterloo g Absolute Beginne	v the sim ling, Abs CT, Joir ours: 4 o.ca/~dw	hilarity Enca stract Classe hs. 5 hours harder/aads	psulat s, Inte	ys, Need for tion, Access orfaces. 5 hou ure_materials/
Introduction to Ja OOP, Class & Ob Specifiers, Relation Module:4 Data Introduction to da Reference Books 1. Data Structur 2. C Programm Dean Miller 3. Java: Thinkir	jects, Create C++ & onship, Polymorphism base tabase, DDL, Data M es and Algorithms: h ing: C Programming ng in Java, 4th Editio	Java class and show m, Exception Handl Manipulation, SELE Total Lecture ho https://ece.uwaterloo g Absolute Beginne	v the sim ling, Abs CT, Joir ours: 4 o.ca/~dw	hilarity Enca stract Classe hs. 5 hours harder/aads	psulat s, Inte	ys, Need for tion, Access orfaces. 5 hou ure_materials/
Introduction to Ja OOP, Class & Ob Specifiers, Relation Module:4 Data Introduction to da Reference Books 1. Data Structur 2. C Programm Dean Miller 3. Java: Thinkir	jects, Create C++ & onship, Polymorphism base tabase, DDL, Data N es and Algorithms: h ing: C Programming	Java class and show m, Exception Handl Manipulation, SELE Total Lecture ho https://ece.uwaterloo g Absolute Beginne	v the sim ling, Abs CT, Joir ours: 4 o.ca/~dw	hilarity Enca stract Classe hs. 5 hours harder/aads	psulat s, Inte	ys, Need for tion, Access orfaces. 5 hou ure_materials/
Introduction to Ja OOP, Class & Ob Specifiers, Relation Module:4 Data Introduction to da Reference Books 1. Data Structur 2. C Programm Dean Miller 3. Java: Thinkir 4. Websites: w	jects, Create C++ & onship, Polymorphism base tabase, DDL, Data N es and Algorithms: h ing: C Programming og in Java, 4th Editio ww.eguru.ooo	Java class and show m, Exception Handl Manipulation, SELE Total Lecture ho https://ece.uwaterloo g Absolute Beginne n	v the sim ling, Abs CT, Joir ours: 4	hilarity Enca stract Classe is. 5 hours /harder/aads de (3rd Edit	psulat s, Inte /Lectu ion) t	ys, Need for tion, Access orfaces. 5 hour ure_materials/ by Greg Perry
Introduction to Ja OOP, Class & Ob Specifiers, Relation Module:4 Data Introduction to da Reference Books 1. Data Structur 2. C Programm Dean Miller 3. Java: Thinkir 4. Websites: w	jects, Create C++ & onship, Polymorphism base tabase, DDL, Data M es and Algorithms: h ing: C Programming ng in Java, 4th Editio	Java class and show m, Exception Handl Manipulation, SELE Total Lecture ho https://ece.uwaterloo g Absolute Beginne n	v the sim ling, Abs CT, Joir ours: 4	hilarity Enca stract Classe is. 5 hours /harder/aads de (3rd Edit	psulat s, Inte /Lectu ion) t	ys, Need for tion, Access orfaces. 5 hour ure_materials/ by Greg Perry
Introduction to Ja OOP, Class & Ob Specifiers, Relation Module:4 Data Introduction to da Reference Books 1. Data Structur 2. C Programm Dean Miller 3. Java: Thinkir 4. Websites: w Mode of Evaluation Based Test)	jects, Create C++ & onship, Polymorphism base tabase, DDL, Data M es and Algorithms: h ing: C Programming og in Java, 4th Editio ww.eguru.ooo on: FAT, Assignmen	Java class and show m, Exception Handl Manipulation, SELE Total Lecture ho attps://ece.uwaterloo g Absolute Beginne n ts, Projects 3 Asses	v the sim ling, Abs CT, Joir ours: 4	hilarity Enca stract Classe is. 5 hours /harder/aads de (3rd Edit	psulat s, Inte /Lectu ion) t	ys, Need for tion, Access orfaces. 5 hour ure_materials/ by Greg Perry
Introduction to Ja OOP, Class & Ob Specifiers, Relation Module:4 Data Introduction to da Reference Books 1. Data Structur 2. C Programm Dean Miller 3. Java: Thinkir 4. Websites: w	jects, Create C++ & onship, Polymorphism base tabase, DDL, Data N es and Algorithms: h ing: C Programming og in Java, 4th Editio ww.eguru.ooo on: FAT, Assignmen Board of Studies	Java class and show m, Exception Handl Manipulation, SELE Total Lecture ho https://ece.uwaterloo g Absolute Beginne n	v the sim ling, Abs CT, Joir ours: 4	hilarity Enca stract Classe is. 5 hours /harder/aads de (3rd Edit	psulat s, Inte /Lectu ion) t	ys, Need for tion, Access orfaces. 5 hour ure_materials/ by Greg Perry

PROGRAM CORE

Course code		Course Title	-	L T P J C
CSE2003		DATA STRUCTURES AND ALGO	ORITHMS	
Pre-requisite	e	NIL		Syllabus version
Course Ohio				v1.0
Course Obje		having compares of data atmostration and algorithm	~	
		e basic concepts of data structures and algorithm w the choice of data structures and algorithm des		ts the performance
	ograms.	w the enoice of data structures and argorithm de.	sign methods impac	is the performance
		n insight into the intrinsic nature of the problem	n and to develop so	oftware systems of
	ng com		ľ	•
Expected Co				
	•	nd providing suitable techniques for solving a p	roblem using basic	properties of Data
	tures.		4	
		berformance of algorithms using asymptotic nota knowledge of basic data structures and legal ope		
		ferent types of algorithmic approaches to prob		sess the trade-offs
invol		area offers of angentamine approaches to pro-		
		c graph algorithms, operations and application	s through a structu	red (well-defined)
		pproach.		
		e feasibility and limitations of solutions to real-		
7. Provi	ide effic	ient algorithmic solution to real-world problems		
Module:1	Introd	uction to Data structures and Algorithms	1 hour	
		ance of algorithms and data structures, Stages of		
		the problem, Identifying a suitable technique, De		m, Proof of
Correctness o	of the Al	gorithm, Computing the time complexity of the	Algorithm.	
Module:2	Analy	sis of Algorithms	3 hours	
		and their significance, Running time of an algo		exity of an
		ce analysis of an algorithm, Analysis of iterative		
theorem (with				-
	D 1 0			
Module:3		tructures	7 hours	D' (1
Importance of Tree, Heaps.	f data st	ructures, Arrays, Stacks, Queues, Linked list, Tr	ees, Hashing table,	Binary Search
Tiee, Tieaps.				
Module:4	Algori	thm Design Paradigms	8 hours	
	0	Brute force, Greedy, Recursive Backtracking an		nming.
			· · · · ·	-
Module:5	<u> </u>	Algorithms	4 hours	
		(BFS), Depth First Search (DFS), Minimum Spa	nning Tree (MST),	Single Source
Shortest Paths	s.			
Module:6	Comm	utational Complexity classes	5 hours	
		able Problems, Decidable and Undecidable problems		l complexity
		P complete - Cooks Theorem (without proof),3		
		Problem, Reduction of 3-CNF-SAT to Subset su		,
	•		• 	
Module:7		tTrends	2 hours	
Algorithms re	elated to	Search Engines		

		Total Lecture hours:		30 h	ours	
Тех	t Book(s)				
1.	Thomas	H. Cormen, C.E. Leiserson, MIT Press, 2009.	R L.Rivest and C. Ste	ein, Introduc	tion to Al	gorithms, Third
Ref	erence B	ooks				
1.		Dasgupta, C.Papadimitriou an				
2.	A. V. A 2002	ho, J.E. Hopcroft and J. D. Ul	lman, Data Strucures	s and Algori	thms ,Pear	son India, Ist Edition,
3.		ho, J.E. Hopcroft and J. D. Ul n,1st edition, 2006.	lman, The Design an	d Analysis o	of Comput	er Algorithms
4.		ase , Allen Van Gelder, Comp Wesley Longman Publishing		roduction to	Design ar	nd Analysis, 3rd
Mo	de of Eva	luation: CAT / Assignment /	Quiz / FAT / Project	/ Seminar		
List	t of Chal	lenging Experiments (Indica	tive)			
1.		t the features based on various	color models and ap	ply on imag	e and vide	20
	retrieva					
2.		, loops and Lists				2 hours
3.		and Queues				2 hours
4.		ing and Sorting				3 hours
5.		List and operations				4 hours
6.		Force technique				2 hours
7.		/ Technique				2 hours
8.	Backtr	e				2 hours
9.		nic Programming				2 hours
10.		and Tree Operations				3 hours
11.		nd DFS				2 hours
12.		um Spanning Tree				2 hours
		tory Hours				26 hours
		essment: Project/Activity				
		ed by Board of Studies	04-04-2014			
App	proved by	Academic Council	No. 37	Date	16-06-201	5

Course Code	Course Title		L	Т	P	J	С
ECE1017	ELECTROMAGNETIC FIELD THEO	RY AND	3	0	0	0	3
	TRANSMISSION LINES						
Pre-requisite	ů ů ř				Ver	sion	:1
Course object							
The course is a							
	e students with basic concepts and properties of E						
-	students to understand the propagation of EM way	-					
	to analyze the EM Wave propagation in different					edia.	•
-	students to comprehend the concept of transmissi						
	nes and to design different transmission lines and	matching cir	cuits ı	using	, Sm	ith	
chart							
Course Outco							
	he course, the student will be able to						
	d analyse Electric Fields & Electric Potential due		harge	dist	ribut	ions.	•
-	d analyze magnetic fields in different material me						
	the propagation of EM wave through time varying		-				
1	d the EM wave propagation in conducting as well			terial	s.		
	ower of an EM wave while propagating through di						
	e wave mechanism in different transmission lines	at high freque	encies	usin	g		
transmission li	1						
7. Design Imp	edance matching circuits using Smith chart.						
Module:1	Electrostatics	6 hours					
	aw, Electric Fields due to Different Charge		n a (and
	Electrostatic Potential and Equipotential surface						
	ations; Capacitance – Parallel Plate, Coaxial,						
	ection and Conduction currents, Continuity Equa						
Analogy betwe				me,	Jour		u w,
	Magnetostatics	6 hours					
	Law, Ampere's Circuital Law and Applications, N		Dens	ity. I	Maxy	well'	's
	s for Magnetostatic Fields, Magnetic Scalar and						
	ls, Ampere's Force Law, Inductances and Magnet			-,			
<u> </u>	Maxwell's Equations (Time Varying Fields)	6 hours					
	and Transformer emf, Inconsistency of Amper	e's Law and	Displ	acem	nent	Curr	ent
•	well's Equations in Different Final Forms and		-				
•	ace : Dielectric-Dielectric and Dielectric-Conduct						
	EM Wave Characteristics - I	7 hours					
Wave Equatio	ns for Conducting and Perfect Dielectric Media,	Uniform Plan	e Wa	ves -	– De	finiti	ion,
	Between E & H, Sinusoidal Variations, W						
Conducting M	edia, Conductors & Dielectrics – Characterization	n, Wave Prop	agatic	on in	Goo	d	
Conductors an	d Good Dielectrics, Polarization, Illustrative Prob	lems.					
Module:5	EM Wave Characteristics – II	7 hours					
	l Refraction of Plane Waves - Normal and Ob	-					
	l Perfect Dielectrics, Brewster Angle, Critical A	-					
-	ance, Poynting Vector and Poynting Theorem – A	Applications,	Powe	r Los	ss in	a Pla	ane
	istrative Problems.						
Module:6	Transmission Lines - I	6 hours					

Types, Parameters, Transmission Line Equations, Primary & Secondary Constants, Expressions for Characteristic Impedance, Propagation Constant, Phase and Group Velocities, Infinite Line Concepts, Losslessness/Low Loss Characterization, Distortion – Condition for Distortionlessness and Minimum Attenuation, Loading - Types of Loading, Illustrative Problems.

	in Precentation, Louding Types of Louding, mast	1441/011001	emor
Module:7	Transmission Lines – II	5 hours	
Input Impeda	ance Relations, SC and OC Lines, Reflection C	Coefficient,	VSWR, UHF Lines as
Circuit Elem	ents : $\lambda/4$, $\lambda 2$, $\lambda/8$ Lines – Impedance Transforma	tions, Signi	ficance of Z_{min} and Z_{max}
Smith Chart	- Configuration and Applications, Single and I	Double Stu	b Matching, Illustrative
Problems.			
Module:8	Contemporary issues:	2 hours	
		Total L	ecture Hours: 45 hours
Text Book(s))		
1. Matth	new N.O. Sadiku, Elements of Electromagnetics, 20	014, 6th Edi	ition, Oxford University
Press,	, India		
2. E.C. J	Jordan and K.G. Balmain, Electromagnetic Waves	and Radiati	ng Systems, 2015, 2 nd
Editic	on, PEI, India		
Reference B	ooks		
1. Umesł	h Sinha, Transmission Lines and Networks, 2010, S	Satya Prakas	sh Publication, New
Delhi		-	
Mode of Eve	Instignt Continuous Assessment Test Digital Assi	annant OI	

Mode of Evaluation: Continuous Assessment Test	t, Digital Assignment, QU	IZ, FAT
Recommended by Board of Studies :	26-11-2016	
Approved by Academic Council : No: 43	Date :	12-12-2016

Course Co			L T P J C
ECE1018		PROCESSIN	
Pre-requisi	8		Version : 1
Course Obj			
	s aimed at making the students to		
	nding the fundamental characteristics of signal	•	
	izing the signals and systems both in time and	l transform doi	mains to gain further insights
into their an	•		
-	nathematical skills to solve problems involvin	g convolution	and sampling.
-	ourse Outcome:		
	f the course, student will be able to:		
	d the various types of signals and systems, an		roperties.
	the system response of a Linear Time Invaria	•	
	stem properties based on Impulse response a		lysis.
	d and use the concepts of correlation and con-		
	place Transform for analysis of CT signals and	•	
	ansform for analysis of DT signals and system		
	learnt mathematical tools in solving problem	ms in a variety	y of signal processing
applications	with the aid of simulation software.		
Module:1	Introduction to Signals and systems	3 hours	
	time and Discrete-time Signals, Transform		pendent variables. Shifting
	ponential and sinusoidal signals, Unit impuls		
	and discrete time systems. Basic system prope		-
Module:2	Linear Time-Invariant (LTI) Systems	3 hours	5.
	e LTI systems: The convolution sum, Cont		TI systems: The convolution
	perties of LTI systems- The commutative pro-		
0	property, The commutative property, Causalit	1 · ·	
Module:3	Fourier Analysis of Continuous-time	4 hours	
Wiouule.5	Signals:	4 Hours	
Orthogonal	Function, Approximation using Orthogona	l Function, F	ourier series, Evaluation of
	fficients, Gibbs Phenomenon, Continuous-tr		
Parseval's th	neorem, Inverse Fourier transform		· · ·
Module:4	Frequency Domain Analysis of Discrete	4 hours	
	Time Signals		
Fourier seri	es representation of discrete time periodic	signals, Proper	rties of discrete time Fourier
	S), Representation of discrete time Fourier tra		
Module:5	Concept of Convolution and Correlation	4 hours	
Introduction	to correlation, Relation between convolut		lation. Correlation of energy
	perties of cross-correlation and auto correlation		
signals.		···· , · · ·	I I I I I I I I I I I I I I I I I I I
Module:6	Laplace transform	5 hours	
	phy of Transform Methods, Differences be		e and Fourier transform. The
	nsform, Properties of Laplace Transform, I	-	
-	Partial-Fraction Expansions, Region of conve	-	-
Module:7	System Analysis using z-Transform	5 hours	
	ween DTFT and z-transform, z-transforms o		sequence, unit step sequence
	inusoidal and exponential sequence. ROC o		
	nverse z-transform, Stability analysis.		1,
Module:8	Contemporary issues:	2 hours	

	Total Lecture hours: 30 hours	
Tex	tt Book(s).	
1	Alan. V. Oppenheim, Alan. S. Willsk, S. Hamid Nawab, Signals and systems, 20 edition, PHI learning Pvt. Ltd., New Delhi	013, second
Ref	erence Books	
1	Sanjit K. Mitra, Signals & Systems (The Oxford Series in Electrical	and Computer
	Engineering), 2016, Edition-1, Oxford University Press, India	
2	Simon Haykin and Barry Van Veen, Signals & Systems, 2011, John Wiley and	Sons Inc., New
	Delhi.	
3	P. Ramesh Babu, R. Anandanatarajan, Signals and systems, 2011, fourth edition	n, Scitech. New
	Delhi.	
4	P. Rama Krishna Rao and Shankar Prakriya, Signals and Systems, 2013, second	d edition Mc-
	Graw Hill, India	
	de of Evaluation: Continuous Assessment Test, Quiz, Digital Assignment, Final As	ssessment Test
	t of Challenging Experiments (Indicative)	
1.	Time domain representation of continuous time (CT) and Discrete time (DT)	4 hours
	signals:	
	Study the concept of basic signals and apply to generate the complex	
	signals. For example: $Asin(2*pi*t)+Bcos(4*pi/2*t), x_1[n]=u[n]-u[n-4],$	
	$x_2[n] = \delta[n] + 2\delta[n-1] + 4\delta[n-2] - 6\delta[n-3], x_3[n] = r[n-2], x_4[n] = square wave with$	
	frequency 4Hz, duty cycle 50%, $x_5[n]$ =Sawtooth wave with frequency 3Hz and	
-	peak is halfway through the period	
2.	Operation on CT and DT Signals:	4 hours
	Generate arbitrary signals $x_1[n] \& x_2[n]$ and perform all the basic signal	
	operations. For example: Addition/Subtraction, Time shifting, Time scaling,	
-	Amplitude Scaling, Odd/Even part of the signal etc.,	
3.	LTI System Analysis in time –domain:	4 hours
	Detect the signal similarities and Find a signal of interest hidden in a long	
	data record, measure delays between signals to synchronize them. Compute the	
4	response of to any input signal.	<u> </u>
4.	Frequency domain analysis of the signal:	6 hours
	Analyze how the signal's energy is distributed over a range of frequencies.	
~	Magnitude/Phase spectrum, Apply FFT to filtering applications.	<u>(1</u>
5.	Frequency domain analysis of the system	6 hours
	Analysis of LTI system through Pole-zero mapping and Z-transform,	
6	convolution/deconvolution, Transfer function and impulse response analysis	6 h a
6.	Signal processing in hardware to do projects with audio/speech signals	6 hours
14	Total Laboratory Hours	30 hours
	de of Evaluation: Challenging Tasks, Continuous Assessment Test, Final Assessm	ent Test
Ty	pical Projects	

- 1. Consider an audio song with instrumental music and design a filter circuit to separate the voice signal and the instrumental
- 2. Design and implement an encryption and decryption algorithm for audio signals which can be used for secured communication.
- 3. Design a Hardware system to control a DC motor speed by using voice signal as an input and apply this concept for Robotics applications
- 4. Develop a Voice controlled Home automation system for controlling the Home appliances in terms of switch on, switch off and etc.
- 5. Develop a Speaker Verification system for biometric Security Applications. This project should be designed like fingerprint or Face recognition
- 6. Design the following modules for Analog to Digital conversiona. Sampling; b. Quantization; c. Encoding
- 7. Develop a system for noise cancellation. This system has to separate/filter the noise and the original signal.
- 8. Analyze an ECG signal for medical diagnosis applications.
- 9. Design and implement a DTMF signaling scheme for various controlling applications.
- 10. Design a motion detector circuit for intruder alarm, home automation system and etc.
- 11. Develop an algorithm for audio watermarking and implement the same in MATLAB
- 12. Develop an algorithm for speech signal Denoising and compression method for Communication.

Mode of Evaluation: Reviews, Project	et Competition	A / Make -a- thon	
Recommended by Board of Studies :		20-11-2016	
Approved by Academic Council :	43	Date:	12-12-2016

	Course title	L	Т	Р	J	C
ECE1033	Basics of Sensors and Wearable Technology	2	0	2	0	3
Pre-requisite	None	S	yllab	us V	⁷ ersi	on
				1.0		
Course Objecti	ves:					
,	de the basic understanding of measurement and instrume	ntation	svste	ems a	and t	he
	f the resistive sensors and its applications in real life.		5,500			
	duce the concept of the reactive sensors and self-generatir	ig sense	ors a	nd it	S	
applicati	ons in real life.					
	iarize the characteristics, working principle and application	on of sp	ecia	l pur	pose	
transduc						
	rt the importance of smart sensors, sensor interface stand					
	ons and to provide a brief overview of the wearable techn	nology	and	its in	npac	t or
social lif						
	basic idea of measurements, characteristics and the error	's assoc	iatec	l wit	h	
measure		1.0		1 1.0		
	trate the concept of resistive sensors which can be employed	byed to	or rea	1 1116	e	
applicati	ons he concept of reactive sensors employed for real life appl	iontion	9			
	and the working principle of special purpose sensors and			r des	velor	ing
smart se		the net	u 10	i uc i	ciop	E
	the taxonomy of the wearable devices and its design co	onstrair	nts fo	or me	easui	ing
	and biological signals.					C
6. Able to	lesign and perform experiments on the sensors and devel	op the	proje	ects b	based	l on
the custo	omer needs.					
Module:1	Introduction to Measurements and Sensors 6 ho					
			md (1000	fice	tion
	nents of a Measurement System and Instruments, Applica Types of measured Quantities, Measures of Dispersion					
		, Dann		c v iu		
samme mean. U	nits and standards. Calibration and errors. General conc	epts an	d ter	min	ology	
-	nits and standards, Calibration and errors. General conc s, Transducers classification-sensors and actuators,	+			<u> </u>	y of
Sensor system	nits and standards, Calibration and errors. General conc s, Transducers classification-sensors and actuators, Static and dynamic characteristics of measurement system	Gene			<u> </u>	y of
Sensor system	s, Transducers classification-sensors and actuators,	Gene			<u> </u>	y of
Sensor system	s, Transducers classification-sensors and actuators,	Gene			<u> </u>	y of
Sensor system configurations, Module:2	s, Transducers classification-sensors and actuators, Static and dynamic characteristics of measurement system Resistive Sensors 4 hor	Gene	eral	inpu	it-ou	y of tpu
Sensor system configurations, Module:2 Resistive senso	s, Transducers classification-sensors and actuators, Static and dynamic characteristics of measurement system	Gene I. urs), resis	stive	inpu tem	it-ou pera	y of tpu
Sensor system configurations, (Module:2 Resistive senso detectors (RTI	s, Transducers classification-sensors and actuators, Static and dynamic characteristics of measurement system Resistive Sensors 4 hor rs- Potentiometers, strain gages (piezo-resistive effect	Gene urs), resis	stive	inpu tem R),	pera resis	y o: tpu
Sensor system configurations, Module:2 Resistive senso detectors (RTE hygrometers, re	s, Transducers classification-sensors and actuators, Static and dynamic characteristics of measurement system Resistive Sensors 4 hours- rs- Potentiometers, strain gages (piezo-resistive effect b), thermistors, magnetoresistors, light dependent re	Gene urs), resis	stive	inpu tem R),	pera resis	y of tpu ture
Sensor system configurations, a Module:2 Resistive senso detectors (RTE hygrometers, re Physiological si	s, Transducers classification-sensors and actuators, Static and dynamic characteristics of measurement system Resistive Sensors 4 how rs- Potentiometers, strain gages (piezo-resistive effect b), thermistors, magnetoresistors, light dependent re sistive gas sensors. Wearable applications: Strain sens gnals, body movement.	Gene u rs), resis sistor or for	stive	inpu tem R),	pera resis	y of tpu
Sensor system configurations, Module:2 Resistive senso detectors (RTE hygrometers, re Physiological si Module:3	s, Transducers classification-sensors and actuators, Static and dynamic characteristics of measurement system Resistive Sensors 4 hord rs- Potentiometers, strain gages (piezo-resistive effect o), thermistors, magnetoresistors, light dependent re sistive gas sensors. Wearable applications: Strain sens gnals, body movement. 4 hord	Gene), resis sistor or for urs	stive (LD) mon	tem R), itori	pera resis ng	y of tpu ture tive
Sensor system configurations, Module:2 Resistive senso detectors (RTE hygrometers, re Physiological si Module:3 Inductive senso	s, Transducers classification-sensors and actuators, Static and dynamic characteristics of measurement system Resistive Sensors 4 hord rs- Potentiometers, strain gages (piezo-resistive effect 0), thermistors, magnetoresistors, light dependent resistive gas sensors. Wearable applications: Strain sense gnals, body movement. Reactive Sensors: 4 hord rs - variable reluctance sensors, Hall effect, Eddy current	Gene J, resis sistor or for urs sensors	stive (LD) mon	tem R), itori	pera resis ng varia	y of tpu ture tive
Sensor system configurations, a Module:2 Resistive senso detectors (RTE hygrometers, re Physiological si Module:3 Inductive senso differential tran	s, Transducers classification-sensors and actuators, Static and dynamic characteristics of measurement system Resistive Sensors 4 hord rs- Potentiometers, strain gages (piezo-resistive effect 0), thermistors, magnetoresistors, light dependent resistive gas sensors. Wearable applications: Strain sense gnals, body movement. Reactive Sensors: 4 hord rs - variable reluctance sensors, Hall effect, Eddy current sformers (LVDT), variable transformers, magneto-elastic	Gene Gene Gene Urs), resis sistor or for Urs sensors , magn	stive (LD) mon s, Lin eto-r	tem R), itori	pera resis ng varia ive,	y of tpu ture ture tive
Sensor system configurations, f Module:2 Resistive senso detectors (RTE hygrometers, re Physiological si Module:3 Inductive senso differential tran magnetostrictive	s, Transducers classification-sensors and actuators, Static and dynamic characteristics of measurement system Resistive Sensors 4 how rs- Potentiometers, strain gages (piezo-resistive effect b), thermistors, magnetoresistors, light dependent re sistive gas sensors. Wearable applications: Strain sens gnals, body movement. Reactive Sensors: 4 how rs - variable reluctance sensors, Hall effect, Eddy current sformers (LVDT), variable transformers, magneto-elastic e sensors. Capacitive sensors- variable capacitor, different	Gene Gene Gene Urs), resis sistor or for Urs sensors , magn	stive (LD) mon s, Lin eto-r	tem R), itori	pera resis ng varia ive,	y of tpu ture ture tive
Sensor system configurations, f Module:2 Resistive senso detectors (RTE hygrometers, re Physiological si Module:3 Inductive senso differential tran magnetostrictive	s, Transducers classification-sensors and actuators, Static and dynamic characteristics of measurement system Resistive Sensors 4 hord rs- Potentiometers, strain gages (piezo-resistive effect 0), thermistors, magnetoresistors, light dependent resistive gas sensors. Wearable applications: Strain sense gnals, body movement. Reactive Sensors: 4 hord rs - variable reluctance sensors, Hall effect, Eddy current sformers (LVDT), variable transformers, magneto-elastic	Gene Gene Gene Urs), resis sistor or for Urs sensors , magn	stive (LD) mon s, Lin eto-r	tem R), itori	pera resis ng varia ive,	y or tpu ture ture tive
Sensor system configurations, f Module:2 Resistive senso detectors (RTE hygrometers, re Physiological si Module:3 Inductive senso differential tran magnetostrictive	s, Transducers classification-sensors and actuators, Static and dynamic characteristics of measurement system Resistive Sensors 4 how rs- Potentiometers, strain gages (piezo-resistive effect b), thermistors, magnetoresistors, light dependent re sistive gas sensors. Wearable applications: Strain sens gnals, body movement. Reactive Sensors: 4 how rs - variable reluctance sensors, Hall effect, Eddy current sformers (LVDT), variable transformers, magneto-elastic e sensors. Capacitive sensors- variable capacitor, different	Gene Gene Gene Urs), resis sistor or for Urs sensors , magn tial cap	stive (LD) mon s, Lin eto-r	tem R), itori	pera resis ng varia ive,	y or tpu ture ture tive

Thermoelectric sensors, piezoelectric sensors, pyroelectric sensors, photovoltaic sensors, electrochemical sensors, Wearable applications: temperature sensitive fabric, electrochemical sensors.

Module:5	Mechanical transducers:	4 hours	
Acceleromete	ers: Characteristics and working principle,	Types- Capacitiv	ve, Piezoresistive
piezoelectric;	Gyroscopes: Characteristics and working princ	ciple, Rotor Gyro	scope; Diaphragr
	sor –resistive & capacitive type (micro press sens		
sensors for fa	Il detection, hemiplegic and PD (Parkinson's dis	sease) patients.	•
		· ·	
Module:6	Smart Sensors and Applications	4 hours	
Integrated an	d Smart sensors, IEEE 1451 standard & Transd	lucer Electronic D	Datasheets (TEDs)
Overview of	various smart sensors: Digital temperature sensors	or (DS1621, TMI	P36GZ), Humidit
sensor (DHT	11, DHT22, FC28), IR sensor (FC51), Gas ser	nsor (MQ2,MQ8)	, Pressure sensor
(DMD100) A			
(BMP180), A	Accelerometers (ADXL335), etc; Structural heal	lth monitoring ser	nsors, Introductio
	Accelerometers (ADXL335), etc; Structural heal l Flexible sensors.	lth monitoring ser	nsors, Introductio
		Ith monitoring ser	nsors, Introductio
to MEMSand		lth monitoring ser	nsors, Introductio
to MEMSand Module:7	Scope of Wearable Devices	4 hours	
to MEMSand Module:7 Role of Wear	Scope of Wearable Devices rables, Attributes of Wearables, The Meta Wearables	4 hours ables – Textiles an	nd clothing, Socia
to MEMSand Module:7 Role of Wear Aspects: Inter	Scope of Wearable Devices rables, Attributes of Wearables, The Meta Weara rpretation of Aesthetics, Adoption of Innovation	4 hours ables – Textiles an 1, On-Body Intera	nd clothing, Socia ction; Case Study
to MEMSand Module:7 Role of Wear Aspects: Inter Google Glass	Scope of Wearable Devices rables, Attributes of Wearables, The Meta Wearables	4 hours ables – Textiles an 1, On-Body Intera	nd clothing, Socia ction; Case Study
to MEMSand Module:7 Role of Wear Aspects: Inter	Scope of Wearable Devices rables, Attributes of Wearables, The Meta Weara rpretation of Aesthetics, Adoption of Innovation	4 hours ables – Textiles an 1, On-Body Intera	nd clothing, Socia ction; Case Study
to MEMSand Module:7 Role of Wear Aspects: Inter Google Glass	Scope of Wearable Devices rables, Attributes of Wearables, The Meta Weara rpretation of Aesthetics, Adoption of Innovation	4 hours ables – Textiles an 1, On-Body Intera	nd clothing, Socia ction; Case Study

1.	B. C. Nakra, K.K. Choudhury, "Instrumentation, Measurement and Analysis" -3 rd Edition,
	Tata McGraw, 2009
2.	Jacob Fraden, "Hand Book of Modern Sensors: physics, Designs and Applications", 3rd ed.,
	Springer, 2010.

	Spinger, 2010.
3.	Edward Sazonov, Michael R Neuman, "Wearable Sensors: Fundamentals, Implementation
	and Applications" Elsevier, 2014

Reference Books:

1.	A.K. Sawhney, "Electrical and Electronic Measurements and Instrumentation", DhanpatRai.
2.	Er. R.K. Rajput, "Electronic Measurements and Instrumentation", S. Chand & Company Ltd. 3 rd Edition.
3.	Bentley, John P., "Principles of Measurement Systems", 4 th edition, Pearson/Prentice Hall, 2005.
4.	Jon. S. Wilson, "Sensor Technology Hand Book", Elsevier Inc., 2005.
5.	Subhas C. Mukhopadhyay, "Wearable Electronics Sensors-For Safe and Healthy Living", Springer International Publishing, 2015.

List of Challenging Experiments (Indicative)

1. Strain gauge sensors for measure	1. Strain gauge sensors for measurement of normal strain.8 hours					
2. Strain gauge sensors for measure	ement of Shear strain	and Ang	gle of twist.			
3. Displacement measurement usin	ig LVDT					
4. Displacement measurement usin	g Hall effect sensor					
5. Displacement measurement usin	ig LDR					
6. Temperature measurement using	g RTD					
7. Temperature measurement using	g Thermistor					
8. Temperature measurement using	g Thermocouple					
9. Static and Dynamic characteristics for Piezoelectric sensors						
Mode of evaluation : Continues Assessment Test, Quiz, Digital Assignment, Final Assessment						
Test						
Recommended by Board of Studies 23-02-2018						
Approved by Academic Council	49	Date	15-03-2018			

	Course Title		L T P J C
ECE2010	Control Systems		3 0 0 4 4
Pre-requisite	ECE1004 -Signals and Systems		Syllabus version
	MAT2002 - Applications of Differential and	Difference	
	Equations		
Course Object			2.0
Course Objecti	rstand the use of transfer function models for	the analysis of ph	vaical austama and
	uce the components of control system.	the analysis of ph	ysical systems and
 To provi analysis a To introd 	de adequate knowledge in the time respons along with the understanding of closed loop at luce the design of compensators and controlle duce state variable representation of physic	nd open loop in fr rs for the stability	equency domain. analysis.
Expected Cours	se Outcomes:		
<u> </u>	tiate real-time applications as open loop or clo	sed loop systems.	
	the system from the transfer function.		
	f compensators and controllers and find the st		
	o compute steady state and transient response	of the different of	order of the system
	to analyze its error coefficients.		
	the frequency domain response of the control		
	rious control systems concepts to analyze an	d find the stability	y of control
systems.	a i i'i'a ca a ' a a i i'		
7. Analyze	the observability of the system in state modeli	ng.	
Module:1 In	troduction to Control Systems	3 hours	
	gram of control system, Control schemes		and closed loop
Applications and		open loop	und erosed roop,
	hematical Modeling of Physical Systems	8 hours	
Module:2 Mat			
		information and	their properties -
Uncertainty, self	<i>E</i> -information, average information, mutual ormation rate of Markov sources - Information		
Uncertainty, self	-information, average information, mutual		
Uncertainty, self Entropy and info variables.	-information, average information, mutual		
Uncertainty, self Entropy and information variables. Module:3 Con Controllers – P, time domain and compensator, In	E-information, average information, mutual ormation rate of Markov sources - Information ntroller and Compensator Design PI, PID controllers, Realization of basic com d frequency domain, Feedback compensation troduction to control system components: I	8 hours pensators, Cascad, Design of lag, lo	continuous random le compensation in ead, lag-lead series
Uncertainty, self Entropy and info variables. Module:3 Con Controllers – P, time domain and compensator, In motor and Synch	E-information, average information, mutual ormation rate of Markov sources - Information ntroller and Compensator Design PI, PID controllers, Realization of basic com d frequency domain, Feedback compensation troduction to control system components: In nros.	8 hours pensators, Cascad, Design of lag, lo	continuous random le compensation in ead, lag-lead series
Uncertainty, self Entropy and infor- variables. Module:3 Con Controllers – P, time domain and compensator, In motor and Synch Module:4 Tin	E-information, average information, mutual ormation rate of Markov sources - Information ntroller and Compensator Design PI, PID controllers, Realization of basic com d frequency domain, Feedback compensation troduction to control system components: In nos. ne Domain Response	8 hours pensators, Cascad Design of lag, lo DC and AC Serv 6 hours	continuous random le compensation in ead, lag-lead series to motors, Steppen
Uncertainty, self Entropy and info variables. Module:3 Con Controllers – P, time domain and compensator, In motor and Synch Module:4 Tin Steady state and	E-information, average information, mutual ormation rate of Markov sources - Information ntroller and Compensator Design PI, PID controllers, Realization of basic com d frequency domain, Feedback compensation attroduction to control system components: I mos. ne Domain Response transient response, Time domain specification	8 hours pensators, Cascador, Design of lag, la DC and AC Server 6 hours ns, Types of test in	continuous random le compensation in ead, lag-lead series o motors, Stepper nputs, Response of
Uncertainty, self Entropy and info variables. Module:3 Con Controllers – P, time domain and compensator, In motor and Synch Module:4 Tin Steady state and	E-information, average information, mutual ormation rate of Markov sources - Information ntroller and Compensator Design PI, PID controllers, Realization of basic com d frequency domain, Feedback compensation troduction to control system components: In nos. ne Domain Response	8 hours pensators, Cascador, Design of lag, la DC and AC Server 6 hours ns, Types of test in	continuous random le compensation in ead, lag-lead series o motors, Stepper nputs, Response of
Uncertainty, self Entropy and info variables. Module:3 Con Controllers – P, time domain and compensator, In motor and Synch Module:4 Tin Steady state and first order and coefficient.	E-information, average information, mutual ormation rate of Markov sources - Information ntroller and Compensator Design PI, PID controllers, Realization of basic com d frequency domain, Feedback compensation troduction to control system components: I mos. ne Domain Response transient response, Time domain specification second order systems, Steady state error,	8 hours pensators, Cascad , Design of lag, la DC and AC Serv 6 hours ns, Types of test i error constants,	continuous random le compensation in ead, lag-lead series o motors, Stepper nputs, Response of
Uncertainty, self Entropy and info variables. Module:3 Con Controllers – P, time domain and compensator, In motor and Synch Module:4 Tin Steady state and first order and coefficient. Module:5 Characteristics	E-information, average information, mutual ormation rate of Markov sources - Information ntroller and Compensator Design PI, PID controllers, Realization of basic com d frequency domain, Feedback compensation troduction to control system components: In nos. ne Domain Response transient response, Time domain specification second order systems, Steady state error, aracterization of Systems	8 hours pensators, Cascad , Design of lag, la DC and AC Serv 6 hours ns, Types of test i error constants, 4 hours	continuous random le compensation in ead, lag-lead series to motors, Stepper nputs, Response of generalized error
Uncertainty, self Entropy and info variables. Module:3 Con Controllers – P, time domain and compensator, In motor and Synch Module:4 Tin Steady state and first order and coefficient. Module:5 Cha Stability – Conc	E-information, average information, mutual ormation rate of Markov sources - Information ntroller and Compensator Design PI, PID controllers, Realization of basic com d frequency domain, Feedback compensation troduction to control system components: I mos. ne Domain Response transient response, Time domain specification second order systems, Steady state error,	8 hours pensators, Cascad , Design of lag, la DC and AC Serv 6 hours ns, Types of test i error constants, 4 hours	continuous random le compensation ir ead, lag-lead series to motors, Stepper nputs, Response o generalized erro
Uncertainty, self Entropy and info variables. Module:3 Con Controllers – P, time domain and compensator, In motor and Synch Module:4 Tin Steady state and first order and coefficient. Module:5 Cha Stability – Conc locus analysis.	E-information, average information, mutual ormation rate of Markov sources - Information ntroller and Compensator Design PI, PID controllers, Realization of basic com d frequency domain, Feedback compensation ttroduction to control system components: I mos. ne Domain Response transient response, Time domain specification second order systems, Steady state error, aracterization of Systems rept and definition, Poles, Zeros, Order and T	ion measures of a 8 hours pensators, Cascaa , Design of lag, la DC and AC Serv 6 hours ns, Types of test i error constants, 4 hours Fype of systems;	continuous random le compensation ir ead, lag-lead series to motors, Stepper nputs, Response o generalized erro
Uncertainty, self Entropy and info variables. Module:3 Con Controllers – P, time domain and compensator, In motor and Synch Module:4 Tin Steady state and first order and coefficient. Module:5 Cha Stability – Conc locus analysis. Module:6 Fre	 information, average information, mutual ormation rate of Markov sources - Information introller and Compensator Design PI, PID controllers, Realization of basic comendation of frequency domain, Feedback compensation to control system components: Introduction to control system components: Intros. interpote Domain Response transient response, Time domain specification second order systems, Steady state error, aracterization of Systems cept and definition, Poles, Zeros, Order and Tequency Domain Response 	8 hours 9 hours pensators, Cascad , Design of lag, la DC and AC Server 6 hours ns, Types of test if error constants, 4 hours Fype of systems; 8 hours	continuous random le compensation in ead, lag-lead series to motors, Stepper nputs, Response o generalized erro R-H criteria, Roo
Uncertainty, self Entropy and info variables. Module:3 Con Controllers – P, time domain and compensator, In motor and Synch Module:4 Tin Steady state and first order and coefficient. Module:5 Cha Stability – Conc locus analysis. Module:6 Fre Frequency respo	E-information, average information, mutual ormation rate of Markov sources - Information ntroller and Compensator Design PI, PID controllers, Realization of basic com d frequency domain, Feedback compensation ttroduction to control system components: I mos. ne Domain Response transient response, Time domain specification second order systems, Steady state error, aracterization of Systems rept and definition, Poles, Zeros, Order and T	8 hours 9 ensators, Cascad , Design of lag, le DC and AC Serv 6 hours ns, Types of test i error constants, 4 hours Type of systems; 8 hours ency domain, Pha	continuous random le compensation in ead, lag-lead series to motors, Stepper nputs, Response o generalized erro R-H criteria, Roo se margin and gain

Concept of state and state variable, Modeling of systems using state variables, Coordinate					
transformations and canonical realizations, Solution of state variables, Controllability and					
obs	ervabilit	у.			
Module:8Contemporary Issues2 hours					
			Total Lec	ture Hours:	45 hours
Tex	xt Book(s)			
	,	, ,			
1.	Norma	n S. Nise, "Control Systems	s Engineer	ing", 2014, 7 th	^h Edition, John Wiley & Sons, New
	Jersey,	USA	U	0	•
1.	I.J. Na	garth and M. Gopal, "Con	ntrol Syste	ems Engineeri	ing", 2017, 6 th Edition, New Age
	Interna	tional, New Delhi, India.	•	C	
2.	Farid C	Golnaraghi and Benjamin	C Kuo, "A	Automatic Co	ntrol Systems", 2014, 9 th Edition,
	Wiley 1	India Pvt. Ltd, New Delhi,	India.		•
Mo	de of Ev	valuation: Continuous Ass	essment T	est –I (CAT-I), Continuous Assessment Test –II
(CA	AT-II), D	igital Assignments/ Quiz /	Completio	n of MOOC, F	Final Assessment Test (FAT).
Rec	commend	led by Board of Studies	_	13.12.2015	
	11	y Academic Council	No. 40	Date	18-03-2016

Course Code	Course Title		L T P J C				
ECE2024 PRINCIPLES OF COMMUNICATION ENGINEERING 2 0 0 0							
Pre-requisite	Pre-requisite ECE1013 - Electronic Circuits Version : 1.1						
Course Objectiv	es:						
The course is aimed at making the students to							
1. Study about the elements and the types of communication systems.							
	e concepts of synchronization schemes in commu		1				
	h the concepts of spread spectrum technique	•					
Expected Cours							
At the end of the	course, the Students will be able to						
1. Acquionte the	spectrum of amplitude modulated signals and des	sign systems for	generation and				
	amplitude modulated signals.		-				
	importance of power efficient amplitude modula	ation schemes a	nd use them for				
analog data trans	nission						
3. Familiarize wi	h fundamental concepts and design issues in mo	dulation and der	nodulation process of				
angle modulation							
4. Know about di	gital modulation techniques and apply them for d	ligital data trans	mission.				
	nificance of synchronization technique in comm						
6. Study the conc	epts behind spread spectrum communication syst	tems.					
		-					
	plitude Modulation	4 hours					
	ed for modulation- Elements of Communication						
	lation (AM) – frequency spectrum of AM– Powe						
	w modulator, switching modulator, AM demodu	lation - Envelop	e and square law				
demodulation.		1					
	ver Efficient in AM system	3 hours					
	C and VSB modulation- generation and demodul	lation. Power an	d bandwidth				
	ear modulation systems.	1 = -					
	gle Modulation and Demodulation	5 hours					
	ency Modulation (FM) and Phase Modulation (I						
1 2	ation, Bandwidth of FM – Narrow band and wide		,				
-	detectors – Phase discriminators – Ratio detector	s - Phase Locke	ed Loop (PLL)- Pre-				
emphasis and de-	1						
,	ital Transmission	3 hours					
	npling – Quantization - PCM – Differential Puls		tion (DPCM) -Delta				
	- Adaptive Delta Modulation (ADM)-Compandi						
J	ital Modulation Scheme	5 hours					
	thogonalization procedure –Generation and Dete		nt system (BASK,				
	PSK, MSK) – Error performance- Correlation Re						
	chronization Techniques	4 hours					
-	nization- Time and Frequency synchronization t	echniques- PLL	- Network and Frame				
	Early Late Gate synchronization- Costas Loop.	41.	1				
	ead Spectrum Communication	4 hours					
	properties- Design principles- Direct sequence (D						
	Code Division Multiple Access (CDMA) - RAK		tures-SSTDK.				
	ntemporary issues:	2 hours					
Tot	al Lecture hours:	30 hours					
Text Book(s)	Communication Grateries 2012 (th E 1'd) M						
1.511100 Haykins	, Communication Systems, 2013, 4 th Edition, Wi	iey, USA.					

Reference Books						
1. John G. Proakis, Digital Communication, 2014, 5 th Edition, McGraw-Hill, India.						
2. Sklar, Digital Communications: Fundar	nentals an	d Applications, 2009, 2 nd I	Edition, Pearson			
Education, India.						
Mode of Evaluation :Continuous assessme	ent test, D	igital Assignment, Quiz an	d Final Assessment Test			
Recommended by Board of Studies : 20-11-2016						
Approved by Academic Council :	43	Date :	12-12-2016			

Course Code	Course Title		L	T P J C			
ECE2026	DIGITAL CIRCUIT DESI	GN	2	0 2 4 4			
Pre-requisite	ECE1013 - Electronic Circuits		V	ersion : 1.1			
Course Objective							
•	The course is aimed at						
	concepts of digital and binary systems.						
	and analysis of combinational and sequential	logic circuits	5.				
	oftware tools for the design and implementat			d systems.			
Expected Course							
The students will b	be able to						
1. Understand the	number systems and concepts of digital logic	families to de	elve into its	s hardware			
aspects.							
2. Use Boolean alg	ebra in digital logic circuit design.						
3. Design and anal	yze combinational logic and sequential logic	digital circuit	S				
4. Understand the	basic software tools for the design and impler	nentation of d	ligital circu	iits and			
systems.							
	yze sequential logic circuits.						
	Description Language in the design and implement	mentation of c	digital circ	uits, both			
combinational and	•						
	y and techniques related to digital circuits and	systems through	ugh experi	ments and			
work on rudimenta	ary projects.						
	c Families & Programmable Logics	3 hours					
	umber Systems, Digital Logic Gates and its e						
	ECL, CMOS families, PAL, PLD, CPLD and		ic Architec	cture.			
	ean algebra &Gate-Level Minimization	3 hours					
	Axiomatic Definition of Boolean Algebra,						
	Boolean Functions, Canonical and Standard						
	nd Sum of Products Simplification, NAND and	_	ementation	1			
	gn of Combinational Logic Circuits	4 hours					
	re, Binary Adder-Subtractor, Paralle						
0 1	ator-4 bit, Decoders, Encoders, Multiplexer	s, De-multiple	exer, Parit	y generator			
	cation of Mux and Demux.						
	Iware description Language (HDL)	6 hours					
	ns, Ports and Modules, Gate Level Modeling	g, Operators,	Data Flow	Modeling,			
	Iodeling, Testbench.		1				
	gn of Sequential Logic Circuits:	6 hours					
· •	ps-SR, D, JK & T, Shift Registers-SISO, S		· ·				
•	uential circuits- State table and state diagra	-		s-Modulo-n,			
	p/Down, Design of Mealy and Moore FSM -S		ction.				
	eling of Combinational Logic Circuits	3 hours					
,	g HDL						
	ators, 8-bit Carry Look Ahead adders and Arr		,				
Module:7 Mod HDL	eling of Sequential Logic Circuits using	3 hours					
Sequence detector	and vending machine design using FSM.						
Module:8 Cor	temporary issues:	2 hours					
	Total Lecture hours:	30 hours					
Text Book(s)							

1. M. Morris R. Mano and Michael D. Ciletti , Digital Design With an Introduction to the Verilog HDL,2014, 6th Edition, Prentice Hall of India Pvt. Ltd., India.

	Cerence Books	
	Pedroni V.A, Circuit Design and Simulation With VHDL, 2011, 2 nd Edition, Pres	ntice Hall India
2.5	Samir Palnitkar, Verilog HDL: A Guide to Digital Design and Synthesis, 2010, 2	nd Edition
	ntice Hall of India Pvt. Ltd., India.	Lantion,
	de of Evaluation :Continuous assessment test, Digital Assignment, Quiz and Fin	al Assessment
Tes		ai Assessment
	t of Challenging Experiments (Indicative)	
		1 1. 0.1.40
1.	Implementation of Full adder, Full subtractor using MUX/Decoder ICs (Hardware)	4 hours
		<u>(</u>]
2.	Design of Universal shift register, based on the control input it should	6 hours
	function as anyone of the following shift registers, Serial in Serial out, Serial	
	in serial out, Parallel in Parallel out and Parallel in Serial out.	<u></u>
3.	Design 4 bit adder and 4 bit array Multiplier using basic logic gates and implement the design in Altera FPGA	6 hours
4.	Design a FSM that has an input w and output z . The machine is a sequence	6 hours
	detector that produces $z = 1$ when the previous two values of w were 00 or	
	11 otherwise $z = 0$	
5.	Design of a circuit that controls the traffic lights at the intersection of two	8 hours
	roads. The circuit generates the outputs G1, Y1, R1 and G2, Y2, R2. These	
	outputs represent the states of the green, yellow, and red lights, respectively,	
	on each road.	
	(a) Give an ASM chart that describes the traffic-light controller. Assume that	
	two down counters exist, one that is used to measure the t1 delay and another	
	that is used to measure t2. Each counter has parallel-load and enable inputs.	
	These inputs are used to load an appropriate value representing either the t1	
	or t2 delay and then allow the counter to count down to 0. (b) Give an ASM	
	chart for the control circuit for the traffic-light controller. (c)Write complete	
	Verilog code for the traffic-light controller, including the control circuit from	
	part (a) and counters to represent t1 and t2. Use any convenient clock	
	frequency to clock the circuit and assume convenient count values to	
	represent t1 andt2. Give simulation results that illustrate the operation of	
	your circuit.	
	Total Laboratory Hours	30 hours
Mo	de of Evaluation :Continuous assessment test and Final Assessment Test	
	pical Projects	
JI	1. Design a Voting Machine using verilog HDL and implement the system	on FPGA. The
	system should support to add upto ten candidates and should take the numb	
	display the result after providing a passcode	
	2. Design and implement a 7 segment LED matrix based display system, wh	ich is developed
	to display information regularly or the message in scrolling form. The system	1
	directly from the keyboard and the typed message is displayed.	tern takes input
	3. Design a 24 hour Digital Clock that has a format of HH:MM:SS using Ver	ilog HDI Code
	using counters.	
	4. Design a calculator using verilog HDL which will be able to perform unsig	mad and signed
	4. Design a calculator using verific HDL which will be able to perform using addition/subtraction, multiplication of unsigned and signed numbers with 8	
Mo	de of Evaluation : Continuous Assessment Reviews	on inputs.
	commended by Board of Studies : 20-11-2016	6
AD	proved by Academic Council :43 Date : 12-12-201	0

					-	C
ECE2028		ANALOG CIRCUITS	2	0 2		4
Pre-requisi	te	EEE1001 - Basic Electrical and Electronics Engineering	Syll		Vers	sion
				2	2.0	
Course Object			<u> </u>			
1. Analys: amplifi		operation of BJT, MOSFET, I_V characteristics and the biasing techniques uits.	s for E	3JT b	ased	
2. Discuss amplifi		nall-signal analysis of amplifier circuits using hybrid models and the frequ	lency	resp	onse	of
*		oncept of feedback, types and its application in different amplifier and osci	illator	· circ	uits.	
		peration of a differential amplifier with dc characteristics and small-signal				
Expected Cour						
The students v	vill be	able to				
1. Design	n and	analyze the basic characteristics of BJT and MOSFET in differ	ent c	onfi	gurat	tions,
		e biasing techniques and be able to use hybrid models of BJT and M			2	,
		he small signal parameters of amplifiers in CE and CS mode u			auiv	alent
		use it for frequency response.	~0		-1	
		the need for multistage amplifiers and be able to suggest a suitabl	e cor	ıfion	ratio	n for
-		ications.		iiigu	iuno	11 101
-		the different classes of power amplifier circuits, their designs and	nou	or c	onvo	reion
efficier		the different classes of power amplifier circuits, then designs and	pow		JIIVE	151011
		the feedback concepts feedback topologies and design of essellate				
		the feedback concepts, feedback topologies and design of oscillator		1	•	. 1
		ne dc characteristics of MOSFET differential amplifier, small sign	iai ai	larys	is ar	id its
-	•	sponse.				
U		conduct experiments using BJT, MOSFET, to analyze the character	ristics	s and	1nte	erpret
1		as amplifiers and oscillators.				
8. Design	n and i	mplement an idea suitable for a specified application.				
Module:1	DITD	iosing and DIT amplificate			A `	hound
		iasing and BJT amplifiers				hours
follower,hybrid		V Characteristics of BJT in CE mode, Q-point, Self Bias-CE,CE at	mpiii	er a	naen	muer
10110wer,frybrid	I-IIIOUC					
Module:2	MOSE	FET Biasing and MOSFET amplifiers			4	hours
		ET (Enhancement mode), DC Characteristics of MOSFET, Self bia	ac of	CC		
			as of	CS	noue	3, CS
ampimer and	Source	e follower circuit, hybrid model of MOSFET				
Module:3	Small	signal analysis of amplifians			2	hound
		signal analysis of amplifiers	d a6		3	hours
		of amplifiers in CE mode and CS mode: voltage and current gain, input an response of CE and CS amplifiers.	aout	put		
impedance, rice	quency	response of CE and CS amplifiers.				
Module:4	Multic	tage amplifiers			3	hours
			widt	h of		
		of a two stage RC coupled amplifier (BJT & MOSFET), band	wiau	1 01	case	aueu
ampimers, con	icept (of wide band amplifier and Darlington pair.				
Modular	Foodl	ack Amplifians & Oscillators	— - I		F	hours
		ack Amplifiers & Oscillators	has!	D		hours
	1	negative & positive feedback, voltage/current, series/shunt feed	JUACK	, ва	гкпа	usen
criterion, Colp	mus, H	lartley's, Phase shift, Wein bridge and crystal oscillators.				
Module:5	Dowor	amplifiers			<u> </u>	hours
		ge signal amplifiers, Class A, B, AB, C, Conversion efficiency, Tung	ed or	nnlif		nours
Classification	or larg	ge signal amplitiers, Class A, D, AD, C, Conversion enticiency, Tune	eu an	.ipin		
Module:7	MOST	TT differential amplifiers	— I		5	hours
Module:7	WI05F	ET differential amplifiers			3	hours

Basic MOSFET differential pair, DC characteristics of differential amplifier, small signal analysis of differential amplifier, frequency response of differential amplifier.

Module:8	Contemporary issues:				2 hours		
	Total Lecture hours:				30 hours		
	Total Lecture nours:				30 hours		
Text Book(s)							
	. Sedra& Kenneth C. Smith, Microelectronic	Circuits, 20)17, 7 th edition, Ox	ford Universi	ty Press, USA.		
Reference B							
1. D. A. N	Neamen, "Electronic Circuit Analysis and De	sign" 3/e, T	'ata McGraw-Hill,	New Delhi, 2	.007.		
2004	T. F. Boghart, J. S. Beasley and G. Rico, Electronic Devices and Circuits, Pearson Education, 6/e, Delhi, 2004						
Educat	L. Boylestad& Louis Nashelsky, Electronic ion, India.		2				
Test, Additi and more)	aluation: Theory: Continuous Assessme onal Learning (MOOC / Conference, Jo						
	enging Experiments (Indicative)						
the effe	of small signal BJT and MOSFET amplifier ect of capacitors on voltage gain and frequence	cy response	of the amplifiers.	• •	6 hours		
enhanc	Design of Multistage amplifiers to improve the frequency response, input impedance and enhance the voltage gain using two stage RC coupled amplifier, Cascode amplifier and Darlington pair.6 hours						
3. Design the nor	Design of Power amplifiers using BJT/MOSFET for high power applications and analyzing the non - linear distortions occurring in those amplifiers. Suggesting suitable technique to eliminate the distortions and also to improve the power conversion efficiency.6 hours						
4. Design mismat	of differential amplifier circuits to improve t the in the load resistance and transconductance	the CMRR a	and estimating the	effect of	6 hours		
List of Proje							
capad	gn of a regulated DC power supply system of citors and resistors.						
	gn a system that will automatically sense the				automobiles.		
4. Desig level	gn of smart Home automation system using b gn of an Electronic code lock circuit using tra security.	nsistors and	l basic discrete con	nponents that			
6. Desig	gn of a public addressing system employing s gn an automatic temperature sensing and cont l conditioning circuit.						
	led by Board of Studies :	23-02-20	18				
	Academic Council :	49	Date	15-03-2018			

Pre-requisite Basics of Sensors and Wearable Technology Syllabus Versio 1. Course Objectives: 1. 2. Comprehend the design and development of various wearable inertial sensors and wearable bio electrode and physiological activity monitoring devices for use in healthcare applications. 3. 3. Discuss the usage of various biochemical and gas sensors as wearable devices. 4. 4. Acquaint various wearable locomotive sensors as assistive devices for tracking and navigation. Course Outcome: 1. Identify and understand the need for development of wearable devices and its influence or various sectors. 2. 2. Discuss the applications of various wearable inertial sensors for biomedical applications. 3. 3. Comprehend the design and development of various wearable bio-electrode an physiological activity monitoring devices for use in healthcare applications. 4. 4. Discuss and analyze the usage of various biochemical and gas sensors as wearable devices. 5. 5. Identify the use of various wearable locomotive tools for safety and security, navigation. 6. 6. Acquaint the usage of wearable devices as assistive devices, diagnostic devices and othe modern applications. 7. 7. Design and develop various wearable devices for detection of biochemical and physiologica body signals, environmental mon		L	Τ	P J	(
I. Identify the need for development of wearable devices and its implications on various sectors. 2. Comprehend the design and development of various wearable inertial sensors and wearable bio electrode and physiological activity monitoring devices for use in healthcare applications. 3. Discuss the usage of various biochemical and gas sensors as wearable devices. 4. Acquaint various wearable locomotive sensors as assistive devices for tracking and navigation. Course Outcome: 1. Identify and understand the need for development of wearable devices and its influence or various sectors. 2. Discus the applications of various wearable inertial sensors for biomedical applications. 3. Comprehend the design and development of various wearable bio-electrode an physiological activity monitoring devices for use in healthcare applications. 4. Acquaint the use of various wearable locomotive tools for safety and security, navigation. 6. Acquaint the usage of various wearable devices as assistive devices, diagnostic devices and othe modern applications. 7. Design and develop various wearable devices for detection of biochemical and physiologica body signals, environmental monitoring, safety and navigational assistive devices. Module:1 Introduction to Wearable Devices 3 hour Module:2 Wearable Inertial Sensors - Accelerometers, Gyroscopic sensors and Magnetic sensors; Modality c Mearable Bioelectro's overview - sports, healthcare, Fashion and entertainment, military, environment monitoring, mining industry, public sector and safety.					2 0 2 0 3		
Course Objectives: 1. Identify the need for development of wearable devices and its implications on various sectors. 2. Comprehend the design and development of various wearable inertial sensors and wearable bio electrode and physiological activity monitoring devices for use in healthcare applications. 3. Discuss the usage of various biochemical and gas sensors as wearable devices. 4. Acquaint various wearable locomotive sensors as assistive devices for tracking and navigation. Course Outcome: 1. Identify and understand the need for development of wearable devices and its influence or various sectors. 2. Discus the applications of various wearable inertial sensors for biomedical applications. 3. Comprehend the design and development of various wearable bio-electrode an physiological activity monitoring devices for use in healthcare applications. 4. Discuss and analyze the usage of various biochemical and gas sensors as wearable devices. 5. Identify the use of various wearable devices as assistive devices, diagnostic devices and othe modern applications. 7. Design and develop various wearable devices for detection of biochemical and physiologica body signals, environmental monitoring, safety and navigational assistive devices. Module:1 Introduction to Wearable Devices 3 hour Module:2 Wearable Inertial Sensors - Accelerometers, Gyroscopic sensors and Magnetic sensors; Modality o Measurement - Wearable Sensors, In-Shoe Force and Pressur Measurement: Applications: Fall Risk Assessment, Fall Detection , Gait	Pre-requisite	Syllabus Version					
 Identify the need for development of wearable devices and its implications on various sectors. Comprehend the design and development of various wearable inertial sensors and wearable bio electrode and physiological activity monitoring devices for use in healthcare applications. Discuss the usage of various biochemical and gas sensors as wearable devices. Acquaint various wearable locomotive sensors as assistive devices for tracking and navigation. Course Outcome: Identify and understand the need for development of warious everable devices. Discuss the applications of various wearable inertial sensors for biomedical applications. Discus the applications of various wearable inertial sensors for biomedical applications. Comprehend the design and development of various wearable bio-electrode an physiological activity monitoring devices for use in healthcare applications. Discuss and analyze the usage of various biochemical and gas sensors as wearable devices. Identify the use of various wearable locomotive tools for safety and security, navigation. Acquaint the usage of wearable devices as assistive devices, diagnostic devices and othe modern applications. Design and develop various wearable devices for detection of biochemical and physiologica body signals, environmental monitoring, safety and navigational assistive devices. Module:1 Introduction to Wearable Devices The emergence of wearable computing an wearable electronics, Types of wearable consors: Invasive, Non-invasive; Intelligent clothing, Industry sectors' overview – sports, healthcare, Fashion and entertainment, military, environment monitoring, mining industry, public sector and safety. Module:2 Wearable Inertial Sensors - Accelerometers, Gyroscopic sensors and Magne		·				1.	
 2. Comprehend the design and development of various wearable inertial sensors and wearable bio electrode and physiological activity monitoring devices for use in healthcare applications. 3. Discuss the usage of various biochemical and gas sensors as wearable devices. 4. Acquaint various wearable locomotive sensors as assistive devices for tracking and navigation. Course Outcome: 1. Identify and understand the need for development of wearable devices and its influence or various sectors. 2. Discus the applications of various wearable inertial sensors for biomedical applications. 3. Comprehend the design and development of various wearable bio-electrode an physiological activity monitoring devices for use in healthcare applications. 4. Discuss and analyze the usage of various biochemical and gas sensors as wearable devices. 5. Identify the use of various wearable devices as assistive devices, diagnostic devices and othe modern applications. 7. Design and develop various wearable devices for detection of biochemical and physiologica body signals, environmental monitoring, safety and navigational assistive devices. Module:1 Introduction to Wearable Devices, The emergence of wearable computing an (mustry out), public sector and safety. Module:2 Wearable Inertial Sensors Module:3 Sensors - Accelerometers, Gyroscopic sensors and Magnetic sensors; Modality of Measurement. Applications: Fall Risk Assessment, Fall Detection, Gait Analysis, Quantitative Evaluation of Hemiplegic and Parkinson's Discasepatients. Physical Activity monitoring: Huma Kinetics, Cardiac Activity, Energy Expenditure measurement: Pedometers, Actigraphs. Module:3 Wearable Devices for Healthcare-1 5 hour Status and Magnetic sensors; Modality of Measurement. Wearable Devices for Gaunai cskin re	Course Objectiv	es:					
Course Outcome: 1. Identify and understand the need for development of wearable devices and its influence or various sectors. 2. Discus the applications of various wearable inertial sensors for biomedical applications. 3. Comprehend the design and development of various wearable bio-electrode an physiological activity monitoring devices for use in healthcare applications. 4. Discuss and analyze the usage of various biochemical and gas sensors as wearable devices. 5. Identify the use of various wearable locomotive tools for safety and security, navigation. 6. Acquaint the usage of wearable devices as assistive devices, diagnostic devices and othe modern applications. 7. Design and develop various wearable devices for detection of biochemical and physiologica body signals, environmental monitoring, safety and navigational assistive devices. Module:1 Introduction to Wearable Devices 3 hour Motivation for development of Wearable Devices, The emergence of wearable computing and wearable electronics, Types of wearable sensors:Invasive, Non-invasive:Intelligent clothing, Industry sectors' overview – sports, healthcare, Fashion and entertainment, military, environmen monitoring, mining industry, public sector and safety. Module:2 Wearable Inertial Sensors 5 hour Wearable Inertial Sensors - Accelerometers, Gyroscopic sensors and Magnetic sensors; Modality evaluation of Hemiplegic and Parkinson's Discasepatients.Physical Activity monitoring: Huma Kinetics, Cardiac Activity, Energy Expenditure measurement: Pedometers, Actigraphs. Mo	 Comprehend t electrode and phy Discuss the usa 	ne design and development of various wearable inertial sensors siological activity monitoring devices for use in healthcare appli ge of various biochemical and gas sensors as wearable devices.	and cation	wean ns.	rable		
 various sectors. Discus the applications of various wearable inertial sensors for biomedical applications. Comprehend the design and development of various wearable bio-electrode an physiological activity monitoring devices for use in healthcare applications. Discuss and analyze the usage of various biochemical and gas sensors as wearable devices. Identify the use of various wearable locomotive tools for safety and security, navigation. Acquaint the usage of wearable devices as assistive devices, diagnostic devices and othe modern applications. Design and develop various wearable devices for detection of biochemical and physiologica body signals, environmental monitoring, safety and navigational assistive devices. Module:1 Introduction to Wearable Devices 7 the emergence of wearable computing and wearable electronics, Types of wearable bevices, The emergence of wearable clothing, Industry sectors' overview – sports, healthcare, Fashion and entertainment, military, environment monitoring, mining industry, public sector and safety. Module:2 Wearable Inertial Sensors Shour Measurement; Applications: Fall Risk Assessment, Fall Detection , Gait Analysis, Quantitative Evaluation of Hemiplegic and Parkinson's Diseasepatients.Physical Activity monitoring: Huma Kinetics, Cardia Activity, Energy Expenditure measurement: Pedometers, Actigraphs. Module:3 Wearable Devices for Healthcare-1 5 hour wearable EEGdevices: Basics of ECG and its design, Electrode and the Electrode-skin Interface sensors: Invasible Collares and the Electrode skin Interface wearable ECGdevices: Basics of ECG and its design, Electrodes and the Electrode-skin Interface rehabilitation; Wearable ECG devices: Basics of ECG and its design, Electrodes and the Electrode-skin Interface measurement is the sensors: Electrode sensors: Ender SEMG Signal Conditioning, Applications, Smart textile for neurological rehabilitation system (NRS),	Course Outcome	:					
Motivation for development of Wearable Devices, The emergence of wearable computing and wearable electronics, Types of wearable sensors:Invasive, Non-invasive;Intelligent clothing, Industry sectors' overview – sports, healthcare, Fashion and entertainment, military, environmen monitoring, mining industry, public sector and safety. Module:2 Wearable Inertial Sensors 5 hour Wearable Inertial Sensors - Accelerometers, Gyroscopic sensors and Magnetic sensors; Modality of Measurement- Wearable Sensors, Invisible Sensors,In-Shoe Force and Pressur Measurement; Applications: Fall Risk Assessment, Fall Detection , Gait Analysis, Quantitative Evaluation of Hemiplegic and Parkinson's Diseasepatients.Physical Activity monitoring: Huma Kinetics, Cardiac Activity, Energy Expenditure measurement: Pedometers, Actigraphs. Module:3 Wearable Devices for Healthcare-1 5 hour Wearable ECGdevices: Basics of ECG and its design, Electrodes and the Electrode-Skin Interface Wearable EEGdevices: Principle and origin of EEG, Basic Measurement set-up, electrodes and instrumentation; Wearable EMG devices: EMG/ SEMG Signals, EMG Measurement – wearabl surface electrodes, SEMG Signal Conditioning, Applications. Smart textile for neurological rehabilitation system (NRS), Study of flexible and wearable EMG sensors.Epidermal electronic systems.	 Comprehe physiolog Discuss at Identify th Acquaint modern aj Design an 	nd the design and development of various wearable cal activity monitoring devices for use in healthcare applications ad analyze the usage of various biochemical and gas sensors as w e use of various wearable locomotive tools for safety and securit the usage of wearable devices as assistive devices, diagnostic pplications. d develop various wearable devices for detection of biochemical	bio-e s. vearat ty, na devie l and	lectrole d viga ces a phys	ode evicestion. and o	s. the	
Motivation for development of Wearable Devices, The emergence of wearable computing and wearable electronics, Types of wearable sensors:Invasive, Non-invasive;Intelligent clothing, Industry sectors' overview – sports, healthcare, Fashion and entertainment, military, environmen monitoring, mining industry, public sector and safety. Module:2 Wearable Inertial Sensors 5 hour Wearable Inertial Sensors - Accelerometers, Gyroscopic sensors and Magnetic sensors; Modality of Measurement- Wearable Sensors, Invisible Sensors,In-Shoe Force and Pressur Measurement; Applications: Fall Risk Assessment, Fall Detection , Gait Analysis, Quantitative Evaluation of Hemiplegic and Parkinson's Diseasepatients.Physical Activity monitoring: Huma Kinetics, Cardiac Activity, Energy Expenditure measurement: Pedometers, Actigraphs. Module:3 Wearable Devices for Healthcare-1 5 hour Wearable ECGdevices: Basics of ECG and its design, Electrodes and the Electrode-Skin Interface Wearable EEGdevices: Principle and origin of EEG, Basic Measurement set-up, electrodes and instrumentation; Wearable EMG devices: EMG/ SEMG Signals, EMG Measurement – wearabl surface electrodes, SEMG Signal Conditioning, Applications. Smart textile for neurological rehabilitation system (NRS), Study of flexible and wearable EMG sensors.Epidermal electronic systems.	Module:1 Intr	oduction to Wearable Devices			3 ha	ur	
Wearable Inertial Sensors - Accelerometers, Gyroscopic sensors and Magnetic sensors; Modality of Measurement- Wearable Sensors, Invisible Sensors,In-Shoe Force and Pressur Measurement;Applications: Fall Risk Assessment, Fall Detection , Gait Analysis, Quantitative Evaluation of Hemiplegic and Parkinson's Diseasepatients.Physical Activity monitoring: Humar Kinetics, Cardiac Activity, Energy Expenditure measurement: Pedometers, Actigraphs. Module:3 Wearable Devices for Healthcare-1 5 hour Electrode – design, geometry,material; Fabrication of interdigitated (IDE) electrodes, choice of substrate, sensing film; Wearable Bioelectric impedance devices for Galvanic skin response; Wearable ECGdevices: Basics of ECG and its design, Electrodes and the Electrode–Skin Interface Wearable EEGdevices: Principle and origin of EEG, Basic Measurement set-up, electrodes and instrumentation; Wearable EMG devices: EMG/ SEMG Signals, EMG Measurement – wearable surface electrodes, SEMG Signal Conditioning, Applications. Smart textile for neurological rehabilitation system (NRS), Study of flexible and wearable EMG sensors.Epidermal electronic systems.				mn	•		
Wearable Inertial Sensors - Accelerometers, Gyroscopic sensors and Magnetic sensors; Modality of Measurement- Wearable Sensors, Invisible Sensors,In-Shoe Force and Pressur Measurement;Applications: Fall Risk Assessment, Fall Detection , Gait Analysis, Quantitative Evaluation of Hemiplegic and Parkinson's Diseasepatients.Physical Activity monitoring: Huma Kinetics, Cardiac Activity, Energy Expenditure measurement: Pedometers, Actigraphs. Module:3 Wearable Devices for Healthcare-1 5 hour Electrode – design, geometry,material; Fabrication of interdigitated (IDE) electrodes, choice of substrate, sensing film; Wearable Bioelectric impedance devices for Galvanic skin response; Wearable ECGdevices: Basics of ECG and its design, Electrodes and the Electrode–Skin Interface Wearable EEGdevices: Principle and origin of EEG, Basic Measurement set-up, electrodes and instrumentation; Wearable EMG devices: EMG/ SEMG Signals, EMG Measurement – wearabl surface electrodes, SEMG Signal Conditioning, Applications. Smart textile for neurological rehabilitation system (NRS), Study of flexible and wearable EMG sensors.Epidermal electronic systems.	wearable electron Industry sectors'	nics, Types of wearable sensors:Invasive, Non-invasive;Intellioverview – sports, healthcare, Fashion and entertainment, mil	igent	clot	hing,		
Electrode – design, geometry, material; Fabrication of interdigitated (IDE) electrodes, choice o substrate, sensing film; Wearable Bioelectric impedance devices for Galvanic skin response; Wearable ECGdevices: Basics of ECG and its design, Electrodes and the Electrode–Skin Interface Wearable EEGdevices: Principle and origin of EEG, Basic Measurement set-up, electrodes and instrumentation; Wearable EMG devices: EMG/ SEMG Signals, EMG Measurement – wearable surface electrodes, SEMG Signal Conditioning, Applications. Smart textile for neurological rehabilitation system (NRS), Study of flexible and wearable EMG sensors.Epidermal electronic system (EES), Study of Multiparametric(ECG, EEG, EMG) Epidermal Electronics Systems.	wearable electron Industry sectors' monitoring, minin	nics, Types of wearable sensors:Invasive, Non-invasive;Intelli overview – sports, healthcare, Fashion and entertainment, mil ng industry, public sector and safety.	igent	clot	hing, ⁄ironn	ien	
substrate, sensing film; Wearable Bioelectric impedance devices for Galvanic skin response; Wearable ECGdevices: Basics of ECG and its design, Electrodes and the Electrode–Skin Interface Wearable EEGdevices: Principle and origin of EEG, Basic Measurement set-up, electrodes and instrumentation; Wearable EMG devices: EMG/ SEMG Signals, EMG Measurement – wearable surface electrodes, SEMG Signal Conditioning, Applications. Smart textile for neurological rehabilitation system (NRS), Study of flexible and wearable EMG sensors.Epidermal electronic system (EES), Study of Multiparametric(ECG, EEG, EMG) Epidermal Electronics Systems.	wearable electron Industry sectors' monitoring, minin Module:2 Wearable Inertial Measurement- Measurement;Ap Evaluation of He	hics, Types of wearable sensors:Invasive, Non-invasive;Intelli overview – sports, healthcare, Fashion and entertainment, mile industry, public sector and safety. Table Inertial Sensors Sensors - Accelerometers, Gyroscopic sensors and Magnetic sec Wearable Sensors, Invisible Sensors,In-Shoe Force plications: Fall Risk Assessment, Fall Detection , Gait Analysis emiplegic and Parkinson's Diseasepatients.Physical Activity n	igent litary, ensors ar , Qua nonito	clot env s; M nd ntita	hing, ironn 5 hc odalit Pres tive	our y c	
	wearable electron Industry sectors' monitoring, minin Module:2 Wearable Inertial Measurement- Measurement;Ap Evaluation of He Kinetics, Cardiac	 Types of wearable sensors:Invasive, Non-invasive;Intellicoverview – sports, healthcare, Fashion and entertainment, mileg industry, public sector and safety. Trable Inertial Sensors Sensors - Accelerometers, Gyroscopic sensors and Magnetic sector and sensors, Invisible Sensors,In-Shoe Force polications: Fall Risk Assessment, Fall Detection , Gait Analysis emiplegic and Parkinson's Diseasepatients.Physical Activity n Activity, Energy Expenditure measurement: Pedometers, Actigr 	igent litary, ensors ar , Qua nonito	clot env s; M nd ntita	hing, rironm 5 ho odalit Pres tive g: Hun	our y o sur	
	wearableelectronIndustrysectors'monitoring,minitModule:2WearableWearableInertialMeasurement-Measurement;Measurement;AppendixEvaluationof HerKinetics,CardiacModule:3WearableElectrodedesisubstrate,sensingWearableEEGdeWearableEEGdeinstrumentation;surfacesurfaceelectroderehabilitationsys	hics, Types of wearable sensors:Invasive, Non-invasive;Intellie overview – sports, healthcare, Fashion and entertainment, mile industry, public sector and safety. Trable Inertial Sensors Sensors - Accelerometers, Gyroscopic sensors and Magnetic sector Wearable Sensors, Invisible Sensors,In-Shoe Force plications: Fall Risk Assessment, Fall Detection , Gait Analysis emiplegic and Parkinson's Diseasepatients.Physical Activity n Activity, Energy Expenditure measurement: Pedometers, Actigr Trable Devices for Healthcare-1 gn, geometry,material; Fabrication of interdigitated (IDE) ele film; Wearable Bioelectric impedance devices for Galvanic skir vices: Basics of ECG and its design, Electrodes and the Electroc vices: Principle and origin of EEG, Basic Measurement set- Wearable EMG devices: EMG/ SEMG Signals, EMG Measures s, SEMG Signal Conditioning, Applications. Smart textile for tem (NRS), Study of flexible and wearable EMG sensors.Epi	igent itary, ensors ar , Qua nonitc aphs. ctrod n resp ode–S up, e remer neur derm	clot env s; M nd ntita oring es, o onsee kin lectr nt – olog al el	hing, vironm 5 ho odalit Pres tive g: Hun 5 ho choice ; Interfa odes weara ical	our y c sur na our ace ano abl	

Wearable Blood Pressure (BP) Measurement: Cuff-Based Sphygmomanometer, Cuffless Blood Pressure Monitor.Study of flexible and wearable Piezoresistive sensors for cuffless blood pressure measurement.

Wearable sensors for Body Temperature: Intermittent and Continuous temperature monitoring, Detection principles – thermistor, infrared radiation, thermopile, Modality of measurement-wearable, adhesive/tattoo type. Conductive textile electrodes, Knitted PiezoresistiveFabric (KPF) sensors.

-	dule:5Wearable Biochemical and Gas Sensors5 hou					
	arable Biochemical Sensors: Parameters of interest, System Design –Textile based, Microneed					
bas	ed; Types: Noninvasive Glucose Monitoring Devices, GlucoWatch [®] G2 Biograph					
	$coTrack^{TM}$; Pulse oximeter, Portable Pulse Oximeters, wearable pulse oximeter; Wearab					
-	nometer for monitoring of expired carbon dioxide.					
	arable gas sensors: Metal Oxide (MOS) type, electrochemical type, new materials-CNT					
gra	phene,Zeolites;Detection of atmospheric pollutants.					
Mo	dule:6 Wearable Cameras and Microphones for Navigation 3 hou					
	neras in wearable devices, Applications in safety and security, navigation, Enhancing spor					
	dia, Automatic digital diary. Cameras in smart-watches; Use of Wearable Microphones: MEN					
	prophones, Bioacoustics, Microphones and AI for respiratory diagnostics and clinical trials.					
	arable Assistive Devices for the Blind - Hearing and Touch sensation, Assistive Devices f					
	gers and Hands, Assistive Devices for wrist, for earmandfeet, vests and belts, head-mount					
	ices.					
Mo	dule:7 Other Wearable Devices 3 hou					
We	arable devices with Global Positioning System (GPS) integration for tracking and navigation.					
	arable Optical Sensors -chemical sensors, optical glucose sensors, UV exposure indicators,					
	ech recognition using lasers; Photoplethysmography (PPG), 3D imaging and motion capture.					
1						
Mo	dule:8 Contemporary issues 2 hou					
1.120						
	Total Lecture hours: 30hours					
Tex	xt Book					
1.	"Seamless Healthcare Monitoring", Toshiyo Tamura and Wenxi Chen, Springer 2018					
2.	"Wearable Sensors -Fundamentals, Implementation and Applications", by Edward Sazonov					
	and Michael R. Neuman, Elsevier Inc., 2014.					
3.	"Wearable and Autonomous Biomedical Devices and Systems for Smart Environment", by					
	Aimé Lay-Ekuakille and Subhas Chandra Mukhopadhyay, Springer 2010					
Ref	erence Books/ Research Articles					
1.	"Wearable Electronics Sensors - For Safe and Healthy Living", Subhas Chandra					
	Mukhopadhyay, Springer 2015					
2.	"Environmental, Chemical and Medical Sensors", by Shantanu Bhattacharya, A K Agarwal,					
	NripenChanda, Ashok Pandey and Ashis Kumar Sen, Springer Nature Singapore Pte Ltd. 2018					
3.	M. Mardonova and Y. Choi, "Review of Wearable Device Technology and Its Applications					
	to the Mining Industry," Energies, vol. 11, p. 547, 2018.					
4.	N. Luo, W. Dai, C. Li, Z. Zhou, L. Lu, C. C. Y. Poon, et al., "Flexible Piezoresistive Sensor					
	Patch Enabling Ultralow Power Cuffless Blood Pressure Measurement," Advanced					
	Functional Materials, vol. 26, pp. 1178-1187, 2016.					
· .						

5. S. Yang, Y.-C. Chen, L. Nicolini, P. Pasupathy, J. Sacks, B. Su, et al., "Cut-and-Paste" Manufacture of Multiparametric Epidermal Sensor Systems," Advanced Materials, vol. 27, pp. 6423-6430, 2015.

Experiments:

1. Study of Textile based electrodes as temperature sensors&strain sensors.

2. Study of Wearable ECG electrodes: Design and measurement of electrical activity of heart.

3. Study of Wearable EEG electrodes: Design and measurement of electrical activity of brain.

4. Study of Wearable EMG electrodes: Design and measurement of electrical activity of muscle cells.

5. Study of Wearable motion sensors using textile based MEMS accelerometer.

6. Study of Wearable body temperature sensors.

7. Study of Wearable Galvanic Skin Response monitoring system.

8. Study of Wearable PPG and SPO2 monitoring system.

9. Kinematic monitoring using wearable FBG sensors.

Mode of Evaluation: CAT, Digital Assignment, Quiz, LAB CAT and FAT

Recommended by Board of Studies	05-09-2018		
Approved by Academic Council	53	Date	13-12-2018

Course Code	Course Title		L T P J C
ECE2033	INTRODUCTION TO DATA ANAL	YTICS	2 0 2 0 3
Pre-requisite	Signal Analysis and Processing		Version :2
Course Objective	s:		
The course is aime	ed at		
1. Introducing the	e methods and approaches of analyzing data an	d to convert in	nformation into
useful knowledge.			
-	dents to understand the establishment of mathem		different
	scuss the advantages and drawbacks of different a		
	ith a set of well-known supervised, semi-supervis	ed and unsuper	vised learning
algorithms.			
Expected Course			
	ourse, the student will be able to		
	- of-the art big data platforms and data analytic te	chniques	
	ing statistical techniques.		
	ut the techniques of data pre-processing and visua		
-	orld applications that can be tackled with technique	ues from machi	ne learning and
Neural Networks.			
	eries data analysis using recurrent model, autoreg		
	timization techniques, predominantly used in data		
7. Design and imp	lement efficient data analytic solutions for real wo	orld application	s.
Module:1	Introduction	2 hours	
-	data- potential challenges, intelligent data analys	is, analytic proc	cesses and
tools, analysis Vs 1		41	
Module:2	Statistical concepts	4 hours	
	tribute: Mean, Median, Mode; Range, Variance, S		
1	ariance, probability distributions, sampling distrib	butions, measur	es of similarity
Module:3	nulti-dimensional vector spaces Data pre-processing and visualisation	4 hours	
			n data
	g: types of error and error handling, filtering, data ualization: - plots and projection methods- 2D and		
	is, histogram, spectral analysis-amplitude, phase s		
transform	is, instogram, spectral analysis-amplitude, phase s	pectra, cosine a	
Module:4	Introduction to Machine Learning	5 hours	
	orithmic and model based frameworks, Regressio		Ridge
	egression, K Nearest Neighbor regression and cla		
	ysis, logistic regression		
Module:5	Supervised and Unsupervised Techniques	6 hours	
	ve Bayesian classifier, Back propagation neural ne		trees support
	zzy decision trees; Clustering- K Nearest Neighbo		
Deep learning con		51, 11 1010uii5, 1	ully C mound,
Module:6	Time-series data analysis	4 hours	
	nd autocorrelation, finite state machines, recurren		gressive
models		, uutore,	<u> </u>
Module:7	Optimization methods	3 hours	
	descent, simulated annealing, Genetic algorithms		1
Module:8	Contemporary issues:	2 hours	
	Total Lecture hours:	30 hours	1
Text Book(s)		~	

1. Thomas A Runkler, Data Analytics: Models and Algorithms for Intelligent Data Analysis,
Springer, 2012
Reference Books
1. Montgomery, Douglas C., and George C. Runger. Applied Statistics and Probability for
Engineers. John Wiley & Sons, 2010
2. Kevin P. Murphy & Francis Bach, Machine Learning: A probabilistic perspective, MIT
Press, 2012
3. Trevor Hastie, Robert Tibshirani & Jerome Friedman, The Elements of Statistical
Learning: Data Mining, Inference, and Prediction, Springer, 2017
4. Shai Shalev-Shwartz, Shai Ben-David, Understanding Machine Learning: From Theory to
Algorithms, Cambridge University Press, 2014
Mode of Evaluation :Continuous assessment test, Digital Assignment, Quiz and Final Assessment
Test
List of Experiments (indicative) 8 hours
Programming with Data analytic tools: WEKA, R Tool, python and SPSS
1. Using R for Introductory Statistics
2. Creating and customizing applications to analyse data.
3. Exploring the data and pre-processing the data using WEKA tool
4. Data Visualization
5. Apply Regression and different classification techniques for classifying the given data:
i) Linear regression, ii) Logistic regression, iii) Neural networks,
iv) SVM, v) Decision tree, vi) Naïve Bayes
6. Apply various clustering techniques to cluster the data:
i) K Nearest Neighbour, ii) K-Means
iii) Fuzzy C Means, iv) Self-organizing map
7. Apply various associative rule mining algorithms
8. Apply Deep learning for extracting complex patterns from big data.
Framework and application of ARIMA model- Build the model and make prediction in the future
time points Recommended by Board of Studies: 31-08-2018
$ \mathbf{N} = (1 + 1) + (1 + $

Recommended by Board of Studies:		31-08-2018		
Approved by Academic Council :	53 rd	Date :	13-12-2018	

ECE3029	Course title		L	Т	Р	J	0
ECES02)	Graphical System Design for Communication Engin	eers	L	-	•	J	
			0	0	4	0	2
Prerequisite	ECE 2024 Principles of Communication Engineering			Ve	ersio	n :	
Course Object					1.1		
The course is a							
-	idents in virtual instrumentation tools like Lab View						
1 0	ands – on training in developing various analog commun		•				
	ne fundamental concepts of Communication in Virtual In	strumei	ntati	on			
Course Outco	ome:						
	he course the student should be able to						
	iew program for Amplitude modulation.						
	e simulation of Single Sideband Transmission and its cha	aracteris	stics				
	iew program for Frequency modulation.						
~	Harmonics of modulated waveforms.						
•	ulate and analyse Super heterodyne receiver.						
	PPM and PWM signals.						
/. Simulate an	d carry out a study on TDM and FDM systems.						
<u></u>							
Task:1	odulation and demodulation						
(i) m<1 (ii) m=1 (iii) m>1							
Task:2							
1 asn.2	8 hours						
Single sidebar a)Design and a (i) Time doma (ii) Frequency	d Transmission analyze the performance of Single Side Band (SSB) Tran in domain	smissic	on.				
Single sidebar a)Design and a (i) Time doma (ii) Frequency b) Compare an	nd Transmission analyze the performance of Single Side Band (SSB) Tran in domain nd analyze the performance of AM, AM-SSB and VSB.	smissic	on.				
Single sidebar a)Design and a (i) Time doma (ii) Frequency b) Compare ar Task:3	and Transmission analyze the performance of Single Side Band (SSB) Tran in domain ad analyze the performance of AM, AM-SSB and VSB. 8 hours	smissic	on.				
Single sidebar a)Design and a (i) Time doma (ii) Frequency b) Compare ar Task:3 Frequency Mo	and Transmission analyze the performance of Single Side Band (SSB) Tran in domain ad analyze the performance of AM, AM-SSB and VSB. 8 hours odulation and demodulation	smissic	on.				
Single sidebar a)Design and a (i) Time doma (ii) Frequency b) Compare ar Task:3 Frequency Mo a) Design	and Transmission analyze the performance of Single Side Band (SSB) Tran in domain and analyze the performance of AM, AM-SSB and VSB. 8 hours odulation and demodulation and analyze the performance of FM receiver	smissic	on.				
Single sidebar a)Design and a (i) Time doma (ii) Frequency b) Compare ar Task:3 Frequency Mo a) Design b) Compa	and Transmission analyze the performance of Single Side Band (SSB) Tran domain and analyze the performance of AM, AM-SSB and VSB. 8 hours odulation and demodulation and analyze the performance of FM receiver are and analyze the performance of AM and FM.	smissic	on.				
Single sidebar a)Design and a (i) Time doma (ii) Frequency b) Compare ar Task:3 Frequency Mc a) Desigr b) Compa Task:4	and Transmission analyze the performance of Single Side Band (SSB) Tran in domain ad analyze the performance of AM, AM-SSB and VSB. 8 hours odulation and demodulation and analyze the performance of FM receiver are and analyze the performance of AM and FM. 8 hours	smissic	on.				
Single sidebar a)Design and a (i) Time doma (ii) Frequency b) Compare ar Task:3 Frequency Mc a) Design b) Compa Task:4 Pulse Modular a) Design an demodular	and Transmission analyze the performance of Single Side Band (SSB) Tran in domain ad analyze the performance of AM, AM-SSB and VSB. 8 hours odulation and demodulation a and analyze the performance of FM receiver are and analyze the performance of AM and FM. 8 hours tion Scheme and analyze the performance of Pulse Amplitude Modulat analyze the performance of Pulse Amplitude Modulat	ion (PA	 AM)				
Single sidebar a)Design and a (i) Time doma (ii) Frequency b) Compare ar Task:3 Frequency Mo a) Design b) Compa Task:4 Pulse Modular a) Design ar demodula b) Using	and Transmission analyze the performance of Single Side Band (SSB) Tran domain and analyze the performance of AM, AM-SSB and VSB. 8 hours bodulation and demodulation and analyze the performance of FM receiver are and analyze the performance of AM and FM. 8 hours tion Scheme and analyze the performance of Pulse Amplitude Modulat and analyze the performance of Pulse Amplitude Modulat	ion (PA	 AM)		gnal.		
Single sidebar a)Design and a (i) Time doma (ii) Frequency b) Compare an Task:3 Frequency Mo a) Design b) Compa Task:4 Pulse Modular a) Design an demodula b) Using Task:5	and Transmission analyze the performance of Single Side Band (SSB) Tran- in domain ad analyze the performance of AM, AM-SSB and VSB. 8 hours odulation and demodulation a and analyze the performance of FM receiver are and analyze the performance of AM and FM. 8 hours tion Scheme ad analyze the performance of Pulse Amplitude Modulat and analyze the performance of Pulse Amplitude Modulat ation (To detect the original message signal) PAM design Pulse Position Modulation (PPM) and detect 8 hours	ion (PA	 AM)		gnal.		
Single sidebar a)Design and a (i) Time doma (ii) Frequency b) Compare ar Task:3 Frequency Mo a) Design b) Compa Task:4 Pulse Modular a) Design ar demodula b) Using Task:5 Sampling and a) Analyze t (i) Sinu	and Transmission analyze the performance of Single Side Band (SSB) Tran- in domain ad analyze the performance of AM, AM-SSB and VSB. 8 hours odulation and demodulation a and analyze the performance of FM receiver are and analyze the performance of AM and FM. 8 hours tion Scheme ad analyze the performance of Pulse Amplitude Modulat analyze the performance of Pulse Amplitude Modulat ition (To detect the original message signal) PAM design Pulse Position Modulation (PPM) and detect 8 hours Quantization the performance of Sampling, Quantization and Encoding asoidal Signal	tion (PA	AM)		gnal.		
Single sidebar a)Design and a (i) Time doma (ii) Frequency b) Compare an Task:3 Frequency Mo a) Design b) Compa Task:4 Pulse Modular a) Design an demodula b) Using Task:5 Sampling and a) Analyze t (i) Sinu	and Transmission analyze the performance of Single Side Band (SSB) Tran domain and analyze the performance of AM, AM-SSB and VSB. 8 hours odulation and demodulation and analyze the performance of FM receiver are and analyze the performance of AM and FM. 8 hours tion Scheme and analyze the performance of Pulse Amplitude Modulat and analyze the performance of Sampling Pulse Position Amplitude Modulat and analyze the performance of Samplitude Modulat	tion (PA	AM)		gnal.		

Pulse Code Modulation								
a) Design a system which coverts analog signal	into digital and vice versa	ì.						
(i) Sinusoidal signal								
(ii) Voice signal								
Task:7	4 hours							
a) Multiplexing Scheme								
(i) Design and analyze the performance of								
(ii) Time Division Multiplexing (TDM)								
(iii) Frequency Division Multiplexing (FDM)								
Task:8	8 hours							
Spread Spectrum Communication								
a) Design the Pseudo Noise (PN) sequence gene	rator (minimum 4 stage s	hift register) and verify						
its properties.								
Design and analyze the performance of Direct Seq		(DS-SS).						
Total Practical	Hours: 60 hours							
Text Book(s)								
(1) Ian Fairweather, Anne Brumfield, LabVIE	W: A Developer's Guide	to Real World						
Integration, 2011, CRC Press, USA.								
Reference Books								
1. Lisa K Wells, LabVIEW for Everyone, 199								
2. Barry E Paton, Sensor, Transducers and La	bVIEW, 2000, Reprint, F	Prentice Hall, New						
Delhi.								
3. Sanjay Gupta and Joseph John, Virtual Inst	trumentation Using LabV	IEW, 2010, Reprint,						
Tata McGraw-Hill Co. Ltd., India.								
4. Travis, Travis Jeffrey, LabVIEW For Ever		ming Made Easy And						
Fun, 2017, 3rd Edition, Pearson Education								
Mode of Evaluation : Continuous assessment and								
	26-02-17							
Approved by Academic Council : 44	Date:	16-03-2017						

Course Cod	e Course Title		L T P J C
ECE3030	PRINCIPLES OF COMPUTER COMM	IUNICATION	
Pre-requisite			Version : 1.1
Course Obje	-	88	
The course is			
	ne students the basic terminologies and concepts o	f OSI, TCP/IP	reference model and
functions of v	• •	,	
	e students to understand the protocols, design and	performance is	ssues associated with
-	g of LANs and WLANs.	•	
3. Introducing	the students to queuing models and basic concep	ts of network s	ecurity.
Expected Ou	tcomes:		
At the end of	the course, the student will be able to		
1. Explain th	e functions of the OSI, TCP/IP reference models	and different	iate between various
switching tech	hniques and internetworking devices		
•	e performance of data link layer protocols, LAN a	nd WLAN star	ndards
•	nets using routing techniques		
	te the functioning of TCP and UDP		
	performance of queuing models		
	issues related to network security		
	the analysis the performance of internetworking	devices, variou	is LAN, WLAN and
routing proto	cols using simulation tools		
			Γ
	Introduction to Data Communication and Networking Devices	7 hours	
	data Networks – Switching Techniques – Network	Topologies –	Categories of
	SO/OSI Reference Model – TCP/IP Model – Inter		
Hubs – Switc	hes – Bridges: Transparent Bridges, Spanning tree	algorithm.	_
	Data Link Layer	6 hours	
Logical Link	Control - Error Detection Techniques (only CRC	and checksun	n) – ARQ protocols–
Framing – HI to MAC.	DLC. Medium Access Control – Random access	Protocols – Sc	heduling approaches
	Local Area Networks	6 hours	
	rtual LAN – Wireless LAN-Zigbee		
	Network layer	6 hours	
	ing – IP Addressing – Subnetting – IPv4 and IPv		Distance Vector and
	outing – Routing Protocols.	0	
	Fransport Layer	6 hours	
	riented and Connectionless Service – User Da		col – Transmission
Control Proto		e	
Module:6	Queueing models	6 hours	
Markov chair	theory - Queueing model basics and Little's law	- M/M/1 and	its variants - M/G/1,
	, WFQ and priority queues.		
Module:7	Network Security	6 hours	
Basic concep	ts: confidentiality, integrity, availability, security	policies, securi	ty mechanisms,
	Transposition/Substitution, Caesar Cipher, Int		
	symmetric crypto primitives, and Hash functions:		• • • •
	Contemporary issues:	2 hours	
	Total Lecture:	45 hours	
Text Book(s)		-	
1.Alberto Leo	on-Garcia, Communication Networks, 2012, Ninth	Reprint, Tata	McGraw-Hill, India.

Ref	ference Books	
1. F	Robert Gallager, Data Networks, 2010, 2 nd edition, Prentice Hall, India.	
2. V	W. Stallings, Data and Computer Communications, 2004, Prentice Hall, Indi	a.
3. E	Behrouz A. Foruzan, Cryptography and Network Security, 2007, Tata McGr	aw-Hill, India.
Mo	de of Evaluation: Continuous assessment test, Digital Assignment, Quiz	, Final Assessment
Tes	t	
Lis	t of Challenging Experiments (Indicative)	
1.	Analyze the Performance of a Local Area Network interconnected by	6 hours
	switches and Hubs	
2.	Analyze and evaluate the performance of the data packet using CSMA-CA	6 hours
	and CSMA-CD	
3.	Estimate the shortest path from source to destination using Routing	6 hours
	Information Protocol.	
4.	Design and analyze the performance of Queuing Disciplines (M/M/1 and	6 hours
	M/G/1)	
5.	Analyze the performance of 802.11g with different nodes	6 hours
	Total Laboratory Hou	urs 30 hours
Mo	de of Evaluation: Continuous assessment task, Final Assessment Test	
Rec	commended by Board of Studies : 26-02-2017	
Ap	proved by Academic Council: 44 Date : 16-	03-2017

Course Code	Course Title	L	Τ	P	J	С		
ECE3031	MICROCONTROLLER AND EMBEDDED SYSTEMS	2	0	2	4	4		
Pre-requisite	ECE2026 - Digital Circuit Design			Vers	ion :	1.1		
Course Objecti	ives:							
The course is air								
	students with the basic concepts of architecture 8085, 8086			-				
and 8051 micr	rocontroller - with its organization and architecture and	also	the	RAN	Л-RO	DM		
organization.								
U	e students to work with 8051 microcontroller and its in	struct	ion	set a	as w	ell		
	to accomplish simple tasks about? explain							
	ng about timer, ports, serial communication and periph	nerals	inte	erruj	pts			
available in 80								
-	bout the peripherals interfaced with 8051 microcontrol							
	m design for simple applications using 8051 and others. State	ment	is im	prop	er			
Course Outcon								
	e course, the student should be able to							
	the various microprocessor and microcontroller architectures		11					
	echniques for accessing data from RAM/ ROM of 8051 micro							
	various 8051 instructions and addressing modes for sui	tably	pro	grai	nmı	ng		
	roller for a task.				1	c		
-	the operation of timer and ports, peripherals in 8051 with	n var	ious	mo	des	OI		
-	at different baud rates							
•	he various 8051 interrupts and their uses.							
6. Know the methodology to handle data conversion: Analog to Digital (A/D) and vice -								
versa.								
versa.) and	l vic	e -		
versa. 7. Acquire the c	overview of various embedded system design using 8051 and) and	l vic	e -		
versa. 7. Acquire the o microcontrollers	overview of various embedded system design using 8051 and s targeting simple applications	other	•					
versa. 7. Acquire the o microcontrollers 8. Write efficien	overview of various embedded system design using 8051 and s targeting simple applications nt codes and be able to interface the hardware with 8051 micro	other	oller	s. Sh				
versa. 7. Acquire the c microcontrollers 8. Write efficient be able to design	overview of various embedded system design using 8051 and s targeting simple applications	other	oller	s. Sh				
versa. 7. Acquire the o microcontrollers 8. Write efficien	overview of various embedded system design using 8051 and s targeting simple applications nt codes and be able to interface the hardware with 8051 micro	other	oller	s. Sh				
versa. 7. Acquire the c microcontrollers 8. Write efficient be able to design	overview of various embedded system design using 8051 and s targeting simple applications nt codes and be able to interface the hardware with 8051 micro	other	oller	s. Sh				
versa. 7. Acquire the c microcontrollers 8. Write efficient be able to design component.	overview of various embedded system design using 8051 and s targeting simple applications nt codes and be able to interface the hardware with 8051 micro	other	oller	s. Sh				
versa. 7. Acquire the ormicrocontrollers 8. Write efficient be able to design component. Module:1 Introduction to I	overview of various embedded system design using 8051 and s targeting simple applications int codes and be able to interface the hardware with 8051 micro n a real time project prototypes which includes 8051 as one of ntroduction to Processors 2 hours Microprocessors and Microcontrollers, 8-bit/16-bit/32-bit Mic	other ocontr the h	oller	s. Sh vare				
versa. 7. Acquire the comic microcontrollers 8. Write efficient be able to design component. Module:1 Introduction to I Architectures 80	overview of various embedded system design using 8051 and s targeting simple applications int codes and be able to interface the hardware with 8051 micro in a real time project prototypes which includes 8051 as one of ntroduction to Processors 2 hours Microprocessors and Microcontrollers, 8-bit/16-bit/32-bit Mic 085, 8086, ARM.	other ocontr the h	oller	s. Sh vare				
versa. 7. Acquire the ormicrocontrollers 8. Write efficient be able to design component. Module:1 Introduction to I Architectures 80 Module:2 80	overview of various embedded system design using 8051 and stargeting simple applications int codes and be able to interface the hardware with 8051 micro int a real time project prototypes which includes 8051 as one of introduction to Processors 2 hours Microprocessors and Microcontrollers, 8-bit/16-bit/32-bit Microprocessors and Microcontrollers, 8-bit/16-bit/32-bit Microprocessors 051 Architecture 4 hours	other ocontr f the h	oller	s. Sh vare				
versa. 7. Acquire the officient microcontrollers 8. Write efficient be able to design component. Module:1 Introduction to I Architectures 80 Module:2 80 8051 -organizati	overview of various embedded system design using 8051 and stargeting simple applications ot codes and be able to interface the hardware with 8051 micro n a real time project prototypes which includes 8051 as one of Image: star in the project prototypes which includes 8051 as one of Image: star in the project prototypes which includes 8051 as one of Image: star in the project prototypes which includes 8051 as one of Image: star in the project prototypes which includes 8051 as one of Image: star in the project prototypes which includes 8051 as one of Image: star in the project prototypes which includes 8051 as one of Image: star in the project prototypes which includes 8051 as one of Image: star in the project prototypes which includes 8051 as one of Image: star in the project prototypes which includes 8051 as one of Image: star in the project prototypes which includes 8051 as one of Image: star in the project prototypes which includes 8051 as one of Image: star in the project prototypes which includes 8051 as one of Image: star in the project prototypes which includes 8051 as one of Image: star in the project prototypes which includes 8051 as one of Image: star in the project prototypes which includes 8051 as one of Image: star in the project prototypes which includes 8051 as one of Image: star in the project prototypes which includes 8051 as one o	other ocontr f the h	oller	s. Sh vare				
versa. 7. Acquire the c microcontrollers 8. Write efficient be able to design component. Module:1 Introduction to I Architectures 80 Module:2 80 8051 -organizati Module:3 8	overview of various embedded system design using 8051 and stargeting simple applications nt codes and be able to interface the hardware with 8051 micro n a real time project prototypes which includes 8051 as one of Introduction to Processors 2 hours Microprocessors and Microcontrollers, 8-bit/16-bit/32-bit Micro 085, 8086, ARM. 4 hours ion and architecture. RAM-ROM organization, Machine cycle 051 Instruction set 8 hours	other ocontr the h	oller	s. Sh vare				
versa. 7. Acquire the ormicrocontrollers 8. Write efficient be able to design component. Module:1 Introduction to I Architectures 80 Module:2 8 8051 -organizati Module:3 8 Data Processing	overview of various embedded system design using 8051 and stargeting simple applications int codes and be able to interface the hardware with 8051 micro int codes and be able to interface the hardware with 8051 micro in a real time project prototypes which includes 8051 as one of introduction to Processors 2 hours Microprocessors and Microcontrollers, 8-bit/16-bit/32-bit Micro 085, 8086, ARM. 051 Architecture 4 hours ion and architecture. RAM-ROM organization, Machine cycle 051 Instruction set 8 hours g-Stack, Arithmetic, Logical ; Branching-unconditional, conditional	other ocontr the h	oller	s. Sh vare				
versa.7. Acquire the microcontrollers8. Write efficientbe able to designbe able to designcomponent.Introduction to aArchitecturesModule:28051-organizatiModule:380Data ProcessingModule:480	overview of various embedded system design using 8051 and stargeting simple applications int codes and be able to interface the hardware with 8051 micro int codes and be able to interface the hardware with 8051 micro in a real time project prototypes which includes 8051 as one of introduction to Processors 2 hours Microprocessors and Microcontrollers, 8-bit/16-bit/32-bit Micro 085, 8086, ARM. 051 Architecture 4 hours ion and architecture. RAM-ROM organization, Machine cycle 051 Instruction set 8 hours g-Stack, Arithmetic, Logical ; Branching-unconditional, condit 051 Peripherals: Timer and ports 3 hours	other ocontr the h	oller	s. Sh vare				
versa.7. Acquire the origination of the second controllers8. Write efficientbe able to design component.be able to design component.Module:1InIntroduction to a Architectures80Module:2808051 - organization80Module:380Data Processing80Module:480Peripherals: I/O	overview of various embedded system design using 8051 and stargeting simple applications int codes and be able to interface the hardware with 8051 micror in a real time project prototypes which includes 8051 as one of introduction to Processors 2 hours Microprocessors and Microcontrollers, 8-bit/16-bit/32-bit Microps, 8086, ARM. 051 Architecture 4 hours ion and architecture. RAM-ROM organization, Machine cycle 051 Instruction set 8 hours g-Stack, Arithmetic, Logical ; Branching-unconditional, condit 051 Peripherals: Timer and ports 3 hours Ports, Timers-Counters 3 hours	other ocontr the h	oller	s. Sh vare				
versa.7. Acquire t⊨microcontrollers8. Write efficierbe able to designcomponent.be able to designcomponent.Introduction to IArchitectures 80Module:28051 -organizatiModule:380Data ProcessingModule:480Peripherals: I/OModule:581	overview of various embedded system design using 8051 and stargeting simple applications int codes and be able to interface the hardware with 8051 micro in a real time project prototypes which includes 8051 as one of introduction to Processors 1 1	other ocontr the h	oller	s. Sh vare				
versa. 7. Acquire the officients 8. Write efficients be able to design component. Module:1 Introduction to I Architectures 80 Module:2 80 8051 -organizati Module:3 80 Data Processing Module:4 80 Peripherals: I/O Module:5 80 Peripherals: Ser	overview of various embedded system design using 8051 and stargeting simple applications int codes and be able to interface the hardware with 8051 micron in a real time project prototypes which includes 8051 as one of microprocessors and Microcontrollers, 8-bit/16-bit/32-bit Micro 2 hours Microprocessors and Microcontrollers, 8-bit/16-bit/32-bit Micro 2085, 8086, ARM. 051 Architecture 4 hours ion and architecture. RAM-ROM organization, Machine cycleto 3-Stack, Arithmetic, Logical ; Branching-unconditional, conditional,	other ocontr the h	oller	s. Sh vare				
versa.7. Acquire the origination of the second controllers8. Write efficientbe able to design component.be able to design component.Module:1Introduction to the second control of th	overview of various embedded system design using 8051 and stargeting simple applications int codes and be able to interface the hardware with 8051 micror in a real time project prototypes which includes 8051 as one of microprocessors and Microcontrollers, 8-bit/16-bit/32-bit Micro 2 hours Microprocessors and Microcontrollers, 8-bit/16-bit/32-bit Micro 2085, 8086, ARM. 051 Architecture 4 hours ion and architecture. RAM-ROM organization, Machine cycle 051 Instruction set 8 hours g-Stack, Arithmetic, Logical ; Branching-unconditional, condit 051 Peripherals: Timer and ports 3 hours Ports, Timers-Counters 3 hours ial Communication, Interrupts 6 hours	other pcontr the h eropro		or				
versa. 7. Acquire t⊨ microcontrollers 8. Write efficier be able to design be able to design component. Module:1 In Introduction to I Architectures 80 Module:2 80 B051 -organization 80 Module:3 80 Peripherals: I/O 10 Module:5 80 Peripherals: Ser 10 Module:6 10	overview of various embedded system design using 8051 and stargeting simple applications at codes and be able to interface the hardware with 8051 micror an a real time project prototypes which includes 8051 as one of Introduction to Processors 2 hours Microprocessors and Microcontrollers, 8-bit/16-bit/32-bit Microprocessors and Microcontrollers, 8-bit/16-bit/32-bit Microps, 8086, ARM. 051 Architecture 4 hours ion and architecture. RAM-ROM organization, Machine cycle 051 Instruction set 8 hours g-Stack, Arithmetic, Logical ; Branching-unconditional, conditional, conditional, conditional 051 Peripherals: Timer and ports 3 hours Ports, Timers-Counters 3 hours 051 Peripherals: Serial and Interrupt 3 hours ial Communication, Interrupts 6 hours op, LED, Keypad, ADC, DAC ,SENSOR with Signal Condition	other pcontr the h eropro		or				
versa.7. Acquire the microcontrollers8. Write efficient be able to design component.be able to design component.Module:1In Introduction to the ArchitecturesModule:288051 - organizati Module:38Data Processing Module:58Peripherals: $\downarrow \bigcirc$ 9Module:58Peripherals: $\downarrow \bigcirc$ 9Interfaces: $L \subset D$ 9Module:78E9Module:58Module:69Interfaces: $L \subset D$ 9Module:76	overview of various embedded system design using 8051 and stargeting simple applications nt codes and be able to interface the hardware with 8051 micror n a real time project prototypes which includes 8051 as one of Introduction to Processors 2 hours Microprocessors and Microcontrollers, 8-bit/16-bit/32-bit Microprocessors and Microcontrollers, 8-bit/16-bit/32-bit Microps (State (Stat	other pcontr the h eropro		or				
versa.7. Acquire the microcontrollers8. Write efficterbe able to designbe able to designcomponent.Module:1Introduction to aArchitecturesModule:28051 - organizatiModule:38051 - organizatiModule:380Peripherals: VOModule:48Peripherals: VOModule:58Peripherals: VOModule:6PInterfaces: LCDModule:7Embedded system	overview of various embedded system design using 8051 and stargeting simple applications at codes and be able to interface the hardware with 8051 micron a real time project prototypes which includes 8051 as one of introduction to Processors 2 hours Microprocessors and Microcontrollers, 8-bit/16-bit/32-bit Microprocessors and Microcontrollers, 8-bit/16-bit/32-bit Microps, 8086, ARM. 051 Architecture 4 hours ion and architecture. RAM-ROM organization, Machine cycletor 051 Instruction set 8 hours g-Stack, Arithmetic, Logical ; Branching-unconditional, conditional, conditio	other pcontr the h eropro		or				
versa.7. Acquire themicrocontrollers8. Write efficientbe able to designbe able to designcomponent.Introduction toArchitecturesModule:1Module:28051 - organizatiModule:38051 - organizatiModule:380Peripherals: VOModule:480Peripherals: VOModule:580Peripherals: VOModule:6PInterfaces: LCDModule:7Embedded system	overview of various embedded system design using 8051 and stargeting simple applications nt codes and be able to interface the hardware with 8051 micror n a real time project prototypes which includes 8051 as one of Introduction to Processors 2 hours Microprocessors and Microcontrollers, 8-bit/16-bit/32-bit Microprocessors and Microcontrollers, 8-bit/16-bit/32-bit Microps (State (Stat	other pcontr the h eropro		or				

Dofor	Microcontroller and Embedded Systems, 2014, Pearson Education Limited, In ence Books	ndia.
	ence Books Swapnil Mahtre, Microprocessors and Interfacing Techniques, 2012, Navigator S	orios
1.	Mumbai University, India	series,
2	Douglas V. Hall, Microprocessors and interfacing: Programming and hardware, 2	2011 Tata
4.	McGraw Hill, India	2011, 1au
3.	Soumitra Kumar Mandal Microprocessors And Microcontrollers Architecture,	
01	Programming & Interfacing Using 8085, 8086 And 8051, 2011, Tata McGraw H	ill. India
Mode	of Evaluation: Continuous assessment test, Digital Assignment, Quiz, Final Asse	
Test		
List o	f Challenging Experiments (Indicative)	
Ι.	Write an 8051 ALP to transfer a string of data from code space starting at	6 hours
	address 200H to RAM locations starting at 40H. The data is as shown below:	
	0200H:DB VIT UNIVERSITY using the simulator, single-step through the	
	program and examine the data transfer and registers. Add the following	
	subroutine to the program ,single-step through the subroutine and examine the	
	RAM locations. After data has been transferred from ROM space into RAM,	
	the subroutine should copy the data from RAM locations starting at 40H to	
_	RAM locations starting at 60H.	
2.	Write an 8051 ALP to add two multi-byte BCD numbers together and store the	4 hours
	result in RAM locations 40H - 44H. The two multi-byte items are stored in the	
	ROM space starting at 120H and 150H. See the following example data.	
	ORG 120H	
	DATA_1: DB 54H,76H,65H,98H ;number 98657654H	
	DATA_2 DB 93H,56H,77H,38H ;number 38775693H Dick your own data for your program. Notice that you must first bring the data	
	Pick your own data for your program. Notice that you must first bring the data from ROM space into the CPU's RAM and then add them together. Use a	
	simulator to single-step the program and examine the data.	
3.	Write an 8051 ALP using interrupts to do the following:	4 hours
	(a) Receive data serially and sent it to P0,	Thour
	(b) Have port P1 read and transmit serially, and a copy is given to P2,	
	(c) Make timer 0 generate a square wave of 5kHz frequency on P3.1.	
	Assume that XTAL-11.0592MHZ. Set the baud rate at 4800.	
4.	Write and assemble a program to toggle all the bits of P0, P1, and P2	4 hours
	continuously by sending 55H and AAH to these ports. Put a time delay	
	between the on and off states. Then, using the simulator, single-step through	
	the program and examine the ports. Do not single-step through the time delay	
	call. Get the Data From Port P1 and Send it to Port P2,Note:P1 as input Port	
	and P2 as Output Port	
5.	Write a program to send the message 'India is our Country' to a serial port.	4 hours
	Assume a SW is connected to pin P1.2.Monitor its status and set the baud rate	
	as Follows:	
	SW = 0,4800 baud rate	
	SW = 1,9600 baud rate	
6	Assume $XTAL = 11.0592$ MHz, 8-bit data, and 1 stop bit.	A 1-
5.	Write an 8051 ALP using interrupts to do the following:	4 hours
	(a) Receive data serially and sent it to P0, (b) Have P2 port read and transmitted serially, and a copy given to P1	
	(b) Have P2 port read and transmitted serially, and a copy given to P1,(c) Make timer 1 generate a square wave of 3Khz frequency on P3.5.	
	(c) make timer 1 generate a square wave of Sixing frequency of 1.5.5.	

7.	Assume that the 8051 serial p IBM PC P1 and P2 of the 80			es	4 hours			
	IBM PC, P1 and P2 of the 8051 are connected to LEDs and switches, respectively.							
	Write an 8051 assembly program to							
	(a) send to PC the message W	Ve Are Ready	Ϊ,					
	(b) receive any data send by l	PC and put it	on LEDs connected to P	1, and				
	(c) get data on switches conn	ected to P2 an	nd send it to PC serially.					
	•		Total La	ooratory Hour	s: 30 hours			
Mode	de of Evaluation: Continuous assessment task, Final Assessment Test							
Recor	ecommended by Board of Studies : 20-11-2016							
Appro	oved by Academic Council :	43	Date :	12-12-2016				

Course Code	Course Title	L	Τ	Р	J	С				
ECE3032	SENSOR TECHNOLOGY		2	0	2	0	3			
Pre-requisite	ECE2023 - Principles of Sensors and Data A	Acquisition	Ve	rsio	1:1					
Course Object	tives:		·							
The course is a	imed at making the students to									
	rious developments in sensor technology.									
2. Familiarize	with the basics of optimal system layout, partition	ning and dev	vice scal	ling.						
	3. Know various thick film and thin film techniques used for sensor development.									
	rious sensor technologies for the measurement of	-		cele	ratio	n,				
vibration a		,	,			, ,				
Course Outco										
	he course the student should be able to									
	sics of sensor technology and the various sensors									
•	the basics of optimal system layout, partitioning a		caling.							
	th various thick and thin film techniques used in		-	t.						
	various sensor technologies for flow and level m									
	arious sensor technologies for Force, Pressure an		-							
Torque me	•									
-	sensor for acceleration, vibration and shock meas	urement.								
•	with the fabrication techniques for packaging of s									
	egrated knowledge on the sensors, work with and		ne data d	obtai	ned	from				
various sensor		* merpret d	ie aata (Jotui						
various sensor										
Module:1	Developments in Sensor Technology	4 hours								
	sensors, smart sensors, micro sensors, fiber option		amical	conc	org	hio				
sensors, TEDs.	-		lennear	sens	015,	010				
	Sensor Design and Packaging	4 hours								
	ayout, technology constraints, scaling, compatibil									
	Thick film Technology	4 hours								
			anananat		o fi	ad				
	cessing-screen printing, Lasering of substrates, cu									
	sing, wire bonding. Micro machining, IOC (Integ	grated Optic	al circu	it) Ia	Drica	uion				
process. Module:4	Thin Film Tashnalagy	4 hours								
	Thin Film Technology		1	•	. 1	1				
	ation and characterization- sol-gel method, chem	-	-		•					
	ion, sputtering, plasma/Ion beam deposition, stru-	-	•							
	Thin films for microelelctronics, MEMS, optical of	coatings, ph	otodete	ctors	, sm	art				
sensors.		4.1								
	Sensor Technologies for Flow and Level	4 hours								
	Measurement	1	1 .		<u></u>					
	essure- primary element options, mechanical and									
	I maintenance, selection and sizing, recent develo				sign	,				
	acteristics, installation considerations, application		ITacture	rs.						
	Sensor Technologies for Force, Pressure and Forque Measurement	4 hours								
Load cell- bend	ding beam, column and shear-web, elastic diaphra	agm, torsior	n bar- m	ateri	als,					
characteristics,	design considerations and mounting procedures,	application	s and m	anuf	actu	rers.				
	Sensor Technologies for Acceleration, Vibration and Shock Measurement	4 hours								
		ring accolor	ometoro	0.00	lice	hle				
	ystem, sensing technologies, selecting and specify facing and design, applications and manufactures	-	ometers	, app	mca	Jie				

	dule:8		emporary issues	5:		2 hours		
	al Lectu		ırs :30					
	kt Book(s							
			n, Sensor Techno	logy Handboo	ok, 2005, Else	evier Inc., U	SA.	
Ref	erence B							d
			K K Choudhry,	Instrumentati	ion Measurem	nent and An	alysis, 2010, 3	^d ed.,
			wHill, India.					
			n, Hand Book of	Modern Sens	ors: Physics,	Designs and	d Applications,	2010, 3 ^{rc}
			r, USA.	-				~ ~
			oster, Measureme	nt, Instrumen	tation and sen	isor Handbo	ook, 2014, CRC	Press,
	USA.			.				
			The Science and					cond
			ford University I					
			: Continues Ass		Quiz, Digital	Assignmer	it, Challenging	
			Assessment Test					
			g Experiments (1			.1 0 11	1 • • • • •	
1.			measurement sys					8 hours
			tion. Deform the					
		0	the beam and cre	0		•	0	
			the strain along			0	0 0	
			oridge configurati			-		
			cantilever beam	•				
			a function of the					
			r regression) to o	obtain the besi	first-order re	lationship c	etween the	
2.	Force/V	T		C		1	-4:	0 h avera
Ζ.			of mechanical po					8 hours
			a shaft without d					
			ow aluminium sh					
			twisting moment.					
			ift is twisted. Figund telescope arra					
	-		e angle of twist fr	-		-	-	
			ial. Devise a met		-			
			ges bonded to the		U		0	
3.			ess involved in so					7 hours
5.	-	1	Interdigitated co	1 0		,		/ 110013
			which can be use	• 1	•			
			asure the actual e					
			es on the substrat				surface	
4.			e dip coating / spi			A	y) how are	7 hours
1.			developing thin f	-				7 110015
			film layer of Tin of					
			y of the coated th					
			i, propose how it	-				
Tot			burs : 30 hours		or a chemical	sensing ap	incarions.	1
		-	a: Continuous As	sessment and	Final Assess	nent Test		
			Board of Studies		26-02-2017			
			emic Council:	44	Date :		16-03-2017	
4 1 P	JUNCU DY	y ricaut	mie Council.	-7-7	Duit.		10 03-2017	

Course code	e	Course Title		L T P J C				
ECE 3037		Wireless Sensor Networks an	nd IoT	2 0 0 4 3				
Pre-requisit	te	ECE 3026 IoT for System Architecture		Version:1.1				
Course Obj	ectives	5:						
The course i	s aime	d at						
1. Understar	1. Understanding the implementation, challenges and design constraints of WSN.							
2. Knowing about the MAC layer and routing protocols in WSN								
3. Modeling	of WS	N for interfacing with IoT platform.						
Expected C	ourse	Outcome:						
		ourse, the student should be able to						
		lications, challenges, and constraints of WSI	N.					
	-	Processor and Communication subsystems.						
		edium Access Control and Network Lay	yers.					
4. Gain knowledge about Power Management of WSNs.								
5. Integrate WSN to Cloud Services for IoT								
	d the n	etwork architecture for WSNs and understan	d the design st	rategies of sensor				
layer.	<u>.</u>							
7. Design an	efficie	ent routing protocol in WSN for IoT based re	al time applica	tions.				
Module:1		ration for a Network of Wireless Sensor	5 hours					
	Nodes		<u> </u>					
	Definitions and Background - Challenges and Constraints: Energy, Self-Management, Wireless							
		ntralized Management, Design Constraints,						
	-	Traffic Control, Health Care, Pipeline Mon	itoring, Precisi	on Agriculture,				
		nderground Mining	2 hound					
		Architecture	3 hours	Ductotypes				
		stem, The Processor Subsystem, Communica	5 hours	, Prototypes				
		MAC Protocols in Sensor Networks, (MAC Protocola				
		MAC Protocols, Hybrid MAC Protocols	contention-Fre	e MAC Protocols,				
			5 hours					
Module:4		Tooding and Gossiping, Data-Centric Routing	5 hours	Pouting On Domand				
-		cal Routing, Location-Based Routing, QoS-F	•	-				
-		r Management	3 hours	10100015				
		gement Aspects, Dynamic Power Manageme		Architactura				
		ration of WSN to IoT	3 hours	Alchilecture				
	-	iches – stack based approaches, topology bas		- SCADA network				
		irity Challenges	eu approaches	- SCADA lietwork				
		ration of WSN to Cloud Services for IoT	4 hours					
		ture, Sensor Layer Design, Coordination 1		IOWPAN Cotowoy				
		Lightweight Secure constrained application r	•	LUWIAN Galeway,				
Module:8		temporary issues:	2 hours					
mouule.0	COIL	Total Lecture hours:	30 hours					
		Total Lecture nours:	50 11001 8					
Text Book(s	5)							
	<i>'</i>	Poellabauer, Fundamentals of Wireless Ser	nsor Networks	2010. Wiley USA				
U		d Andreas Willig, Protocols and Architect		•				
Networks, 2		•	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,					
Iterefence L	Reference Books							

 Ian F. Akyildiz, and Mehmet Can Vuran, Wireless Sensor Networks, 2010, Wiley, USA.
 IBM Bluemix: The Cloud Platform for Creating and Delivering Applications, http://www.redbooks.ibm.com/redpapers/pdfs/redp5242.pdf

Mode of Evaluation: Continuous Assessment Test, Digital Assignment, Quiz, Final Assessment Test

Typical Projects

- 1. Analysis of link quality between sender and receiver (Different types of nodes)
- 2. Impact of dynamic channel selection by pan coordinator on the network by restarting the pan coordinator
- 3. Performance analysis of MAC based routing (mbr) and level based routing (lbr) in multi hop network.
- 4. Performance analysis of WLAN gateway based wireless interface for connectivity between WSN and IoT
- 5. QoS analysis in routing protocol.

Mode of Evaluation: Continuous Assessment Reviews						
Recommended by Board of Studies :	26-02-2017					
Approved by Academic Council : 44	4 Date :	16-03-2017				

Course Code								
ECE3042	Data Acquisition Techniques	3	0		0	4	4	0.70
Pre-requisite	Analog Circuits	3 y			$\frac{15}{v1}$		ersi	on
Course Object	ives:				V I	.0		
	uss the principles of operational amplifiers and the type of	sig	nal	C	on	idi	tio	ning
	for a specific sensor output	5151	iui	U	on		uo	inng
	the the principles of analog to digital and digital to analog conve	ersio	n t	ec	chn	nic	jue	s for
data acq								
3. To com	pare the communication standards, PC buses and the functionin	ng o	f di	ist	trit	JU	ted	and
	ne loggers used in data acquisition							
	duce students to virtual instrumentation and the hardware interf	acir	g					
Expected Cour	rse Outcomes:							
The students wi	ll be able to							
	nend the principles of operational amplifiers and their applications							
	te the type of signal conditioning needed for a specific sensor output							
	the analog to digital and digital to analog conversion techniques							
	the communication standards and PC buses for data acquisition							
	the functioning of distributed and standalone loggers							
	ne virtual instrumentation and write software for data acquisition fro	om c	rcı	JIT	s.			
7. Develop	a device to measure physical parameters for specific application							
Module:1 Or	perational Amplifier and its applications			Т		-(6 h	ours
	Differential Amplifier, CMRR, Open & Closed loop circui	ts i	nv	er	tin			
	fiers, voltage follower/buffer circuit. DC characteristics and A					-		
	comparator, Instrumentation amplifiers and Schmitt trigger.							5 01
op unp, nader,	comparator, moralionation ampiritors and seminit differi							
	esign of Signal Conditioning Circuit			Τ			5 h	ours
U 1	rs, analog filters, digital and pulse train conditioning, distributed	1 I/C), r	10	ise	;		
reduction and is	solation							
Madalar 2	nales 4. Distal Community			Т			4 1-	
	nalog to Digital Conversion	Δ.						
	ADC, Sampling and Holding, Quantizing and Encoding,							
• •	es of A/D converters, Plug-in data acquisition boards- paramet	er s	etti	ng	g- ;	Sa	ımp	oling
strategies for m	ulti-channel analog inputs- speed vs throughput.							
Module:4 Di	gital to Analog Conversion			Τ		4	4 h	ours
Introduction to	DAC, Types of DACs, D/A boards-parameter setting - tim	ing	ci	rc	uit	rv	'- O U	itput
	- bus interface, Digital I/O boards. Counter-timer I/O boards.	0				-)		- P
1	, , , , , , , , , , , , , , , , , , , ,							
Module:5 Int	terface Standards and PC buses			Т			ζh,	ours
	RS485, GPIB, RJ 11, RJ 45, USB, Firewire; Backplane buses	- P(T	⊥ P	CL			
	ress, VME, VXI; Ethernet –TCP/IP protocols.	1	∕⊥,	•	U 1	-	·ΔΡ1	,
, 2np	, , , , , , , , , , , , , , , , , , ,							
Module:6 Dis	stributed and Stand-alone Loggers			Τ		1	2 h	ours
	nd logging data using PCMCIA cards- stand-alone operation	- di	rec	x	an			
						—		

connection to host PC, Host software- data loggers vs internal systems

Mo	odule:7 Virtual Instrumentation		4 hours
	tual instrument and traditional instrument, Hardware and software for virt	ual instr	
	tual instrumentation for test, control, and design, Graphical programming.	uur moti	amentation,
Mo	odule:8 Contemporary Issues		2 hours
	Total Le	atura	20 hours
		cture:	30 hours
	xt Book(s)		
1.	Sergio Franco, Design with Operational Amplifiers & Analog Integrated edition, McGraw Hill Higher Education, United States.		
2.	Ramon Pallas-Areny and John G Webster, Sensors and Signal Conditio Wiley India Pvt. Ltd.	ning, 20	012, 2 nd ed.,
3.	John Park and Steve Mackay, Practical Data acquisition for Instrumen 2011, 1 st ed., Newness publishers, Oxford, UK.	tation a	nd Control,
Re	ference Books		
1.	Maurizio Di Paolo Emilio, Data Acquisition systems- from fundamentals 2013, 1 st ed., Springer, New York.		-
2.	Robert H King, Introduction to Data Acquisition with LabVIEW, 2012, 2 ^r New York.	nd ed., M	cGraw Hill,
3.	Robert F. Coughlin and Frederick F. Driscoll, Operational Amplifiers an Circuits, 2015, 6 th edition, Pearson Education, London.	id Linea	r Integrated
Mo	ode of Evaluation: Theory: Continuous Assessment Test, Quiz, Digital Assi	gnment,	Final
	sessment Test, Additional Learning (MOOC / Conference, Journal Publicat	ions / M	lake a thon /
	pject competition and more)		
	st of Projects: (Indicative)		
	Design of differential amplifier and instrumentation amplifier:	4	hours
	ild a sensor bridge circuit using Multisim, having $1k\Omega$ elements and		
	sitivity of 10mV/V with 5V excitation circuit.		
	full scale, sensors in the bridge exhibit 1% change in resistance value.		
	sign the following amplifier circuits so that the full scale output of the $rlification 5V$		
	plifier is 5V. Single op amp differential amplifier.		
· ·	Three op amp instrumentation amplifier.		
	nulate the above circuits to measure the voltage at its full scale.		
	Design of signal conditioning circuit for RTD:		hours
	sign a RTD based temperature measurement circuit to convert 0° C to 80°	4	nouis
	into 0 - 5V. Error should not exceed ± 1 °C. The given RTD has the		
	lowing specifications: RRTD at 0° C is 100Ω , and temperature coefficients		
	resistance a is 0.004Ω / °C. Build the circuit in Multisim and simulate it.		
	Building temperature measurement system using NI Elvis:	4	hours
	sign a thermocouple based temperature measurement circuit to convert 0°		
	to 50 °C into 0- 5V. If the temperature exceeds 60 °C then a LED alarm		
	ould glow. Build the circuit using NI ELVIS board. Test the performance		
	the circuit.		

4. Design of cold junction compensation while us	0 1
A K type thermocouple is to be used in the meas	•
provide an output of 2V at 200 °C. A solid stat	
will be used to provide a reference temperate	1
sensor has three terminals: supply, output voltag	
varies as 8mV/ [°] C. Sensitivity of K-type thermoc	ple is 50μ V/° C at 200 °C.
Build the circuit in multisim and simulate it.	
5. Programming with LabVIEW: Signal acquisiti	n and generation: 5 hours
Create a simple VI that simulates an analog signa	and plots it on a waveform
graph. The VI will give user control of the freq	ency and amplitude of this
wave. Configure the following DAQ cards: i) NI	ELVIS, ii) myDAQ and iii)
cDAQ to generate the signal simulated by the si	1 0
DAQ cards to acquire the generated signal and di	play it on waveform graph.
6. Measuring strain, temperature, pressure (va	ous physical parameters) 4 hours
using LabVIEW:	
7. Design of LabVIEW system using Hall effect	
a) Using NI ELVIS tools study the properties of	· · · · · · · · · · · · · · · · · · ·
a simple gauss-meter and a position measurement	
effect sensor. Plot the Hall voltage versus distance	
b) Using NI ELVIS tools study the properties	
LED light intensity controller, i.e switching or	
LDR as a sensor. When there is light available t	e LED should be off but at
night it should be on.	
c) LabVIEW interface for ultrasonic based distant	
	Total Laboratory Hours30 hours
Mode of Evaluation: Theory: Continuous Ass	
Assessment Test, Additional Learning (MOOC /	Conference, Journal Publications / Make a thon /
Project competition and more)	
Recommended by Board of Studies :	23-02-2018
Approved by Academic Council 49 th	Date: 15-03-2018

Course Co	ode	Course Title	L	Τ	P	J	С
ECE304	14	WEARABLE TECHNOLOGY AND IOT	2	0	0	4	3
Pre-requi	site	ECE3031-Microcontroller and Embedded Systems		Sy	llabı	is Ve	rsion
							1.0
Course Obje	ectives:						
1. To pro	ovide a	basic understanding of evolution of IoT and its functional mod	dules				
2. To de	velop sl	killset to implement IoT systems for wearable applications.					
Expected Co	ourse O	utcome:					
The students							
-		evelop IoT end points for wearable applications.					
		ne real world problem and give IoT solutions.					
3. To an	alyse ar	nd select appropriate protocols, wireless techniques for the pro	blem	1.			
	DI					- 1	
Module:1		of IoT in wearable devices					ours
	•	and Big picture of IoT-smart devices, networks, Wireless ter	chno	logie	s an	d nee	d for
data analysis.							
		le technology, Wearable IoT use cases- Smart watches , Andre	oid v	vear,	Sma	rt glas	sses,
fitness tracke	rs, heal	th care devices, cameras, smart clothing etc					
Module:2	loT s basics	upported technologies: Internet/Web and networking				4 h	ours
OSI model (nsfer referred with OSI model, IP Addressing, point to point	nt da	ta tr	ancfe	r noi	int to
		ansfer & network topologies, sub-nets, network topolog					
-		servers and cloud computing	105		leu	** 1011	
Module:3	IoT s	upported technologies: Hardware platforms:				4 h	ours
		poard computers (Raspberry pi/Beagle bone black), ARM Cort	ex P	roces	sors		
		als: Overview and working principle of wired and wireless ne					
		cess points, and hubs. Networking configurations in Linux			-	-	
device files ir					0		
Madada 4	XX 75					21	
Module:4		less communication standards:			- 4 :		ours
		02.15.1, Wireless LAN- IEEE 802.11(WiFi), Near Field c		iunic	ation	i, W1	vlax-
IEEE 802.10,	, LK-W	PAN- IEEE 802.15.4 (Zigbee), 6LoWPAN, mobile network, C	JPS				
Module:5	IOT	architecture:				4 h	ours
		rements, building blocks, IoT architecture layers, cloud and	fog	hase	d ar		
	-	Machine architecture, Web of Things, physical layer, MAC la	-				
aspects in IoT		waenne arenteetare, web or rinngs, physical layer, write la	yer,	OLU		11 500	unity
	<u> </u>						
Module:6	IOT A	Application Development:				4 h	ours
		Is: MQTT, REST/HTTP, CoAP, MySQL Back-end Applicatio	n De	signi	ing: /		
		uests, PHP & MySQL for data processing, MongoDB Object		<u> </u>	0	-	
		I Designing, JSON lib for data processing, Security & Priva					
		ment for mobile Platforms: Overview of Android / IOS App I					,
Module:7	Wear	able IoT				4 h	ours

B.TECH (ECE with Sensor and Wearable Technology)

Case studies – Health care, fitness and sports, industrial, defence and security, home automation, gaming, fashion and apparel.

Moo	dule:8	Contemporary issues:				2 hours
					1	T
				Total Lecture hours:	30 hours	
T	4 D l-(-)					
1 ex	t Book(s)	lro Bassi, Martin Bauer, Marti	n Eigdlan	Thoraton Vrome Dob you V	nononhung Cabo	ation
1.		tefan Meissner, "Enabling thi				
	•	e Model", Springer Open, 20	0	- Designing for solutions w		niceture
Ref	erence Bo		15			
1.		rnet of Things: How Smart T	Vs. Smart	Cars. Smart Homes and Sn	nart Cities Are (Thanging
		d 1st Edition	, s, sinure			511411-5111-5
2.						
3.	Jan Holl	er, VlasiosTsiatsis, Catherine	Mulligan,	StamatisKarnouskos, Stefa	n Avesand, Davi	id Boyle,
	"From M	Iachine to Machine to Internet	t of Things	s", Elsevier Publications, 201	4.	•
4		andards Association Working			for the Internet	of
	-	IoT) (P2413) - http://grouper.i		*		
5		of Things – Architecture – Fir	nal Archite	ectural Reference Model for t	he IoT v3.0,	
	1	vw.iot-a.eu/public				
		luation: Theory: Continuous		~ 0 0		
		nal Learning (MOOC / Cont	terence, Jo	ournal Publications / Maketh	ion / Project coi	npetition
	more)	oota				
	oical Proj	t of IoT enabled				
	eropmen art watch	l of for enabled				
	neras					
	rt cloths					
Glov						
Diag	gnostic ja	cket				
Fitn	ess meter					
Pati	ent monit	oring systems				
Rec	ommende	d by Board of Studies :		23-02-2018		
App	roved by	Academic Council	49	Date	15-03-2018	

Course code	Course Title	L T P J C
EEE1001	Basic Electrical and Electronics Engineering	2 0 2 0 3
Pre-requisite	NIL	Syllabus version
		v. 1.
Course Objectiv	25:	
1. To understand	the various laws and theorems applied to solve electric circu	its and networks
	students with an overview of the most important concepts in	
	eering which is the basic need for every engineer	
Expected Course	Outcome:	
1. Solve basic ele	ctrical circuit problems using various laws and theorems	
2. Analyze AC po	wer circuits and networks, its measurement and safety conce	erns
3. Classify and co	mpare various types of electrical machines	
4. Design and imp	plement various digital circuits	
5. Analyze the ch	aracteristics of semiconductor devices and comprehend the v	various modulation
	munication engineering	
6. Design and cor	duct experiments to analyze and interpret data	
Module:1 DC	zircuits	5 hou
Basic circuit elem	ents and sources, Ohms law, Kirchhoff's laws, series and pa	rallel connection of
circuit elements, I	Node voltage analysis, Mesh current analysis, Thevenin's and	d Maximum power
transfer theorem		•
Module:2 AC	circuits	6 hou
Alternating voltag	es and currents, AC values, Single Phase RL, RC, RLC Se	ries circuits, Power
	ower Factor- Three Phase Systems - Star and Delta Conr	
Power Measurem	ent - Electrical Safety - Fuses and Earthing, Residential wiri	ng
Module:3 Elec		7 hou
Construction, Wo	rking Principle and applications of DC Machines, Transfe	ormers, Single phas
and Three-phase	Induction motors, Special Machines-Stepper motor, Serv	o Motor and BLD
motor		
0	tal Systems	5 hour
	t concepts, Representation of Numerical Data in Binary F	orm- Combinationa
logic circuits, Syr	thesis of logic circuits	
· · · ·	iconductor devices and Circuits	
Conduction in Se	niconductor materials, PN junction diodes, Zener diodes, B.	Ts, MOSFETs,
Conduction in Se Rectifiers, Feedba	niconductor materials, PN junction diodes, Zener diodes, B. ick Amplifiers using transistors. Communication Engineerin	Ts, MOSFETs,
Conduction in Se Rectifiers, Feedba	niconductor materials, PN junction diodes, Zener diodes, B.	Ts, MOSFETs,
Conduction in Se Rectifiers, Feedba	niconductor materials, PN junction diodes, Zener diodes, B. ock Amplifiers using transistors. Communication Engineerin mplitude and Frequency Modulation	Ts, MOSFETs,
Conduction in Se Rectifiers, Feedba	niconductor materials, PN junction diodes, Zener diodes, B. ick Amplifiers using transistors. Communication Engineerin	Ts, MOSFETs,
Conduction in Se Rectifiers, Feedba Demodulation - A	niconductor materials, PN junction diodes, Zener diodes, B. ock Amplifiers using transistors. Communication Engineerin mplitude and Frequency Modulation	Ts, MOSFETs,
Conduction in Se Rectifiers, Feedba Demodulation - A Text Book(s)	niconductor materials, PN junction diodes, Zener diodes, B. ack Amplifiers using transistors. Communication Engineerin mplitude and Frequency Modulation Total Lecture hours: 30 hours	g: Modulation and
Conduction in Se Rectifiers, Feedba Demodulation - A Text Book(s)	niconductor materials, PN junction diodes, Zener diodes, B. ock Amplifiers using transistors. Communication Engineerin mplitude and Frequency Modulation	Ts, MOSFETs, g: Modulation and
Conduction in Se Rectifiers, Feedba Demodulation - A Text Book(s)	niconductor materials, PN junction diodes, Zener diodes, B. ck Amplifiers using transistors. Communication Engineerin mplitude and Frequency Modulation Total Lecture hours: 30 hours I, 'Electrical circuit theory and technology ', Newnes pu	Ts, MOSFETs, g: Modulation and
Conduction in Se Rectifiers, Feedba Demodulation - A Text Book(s) 1. 1. John Bird	niconductor materials, PN junction diodes, Zener diodes, B. ack Amplifiers using transistors. Communication Engineerin mplitude and Frequency Modulation Total Lecture hours: 30 hours I, 'Electrical circuit theory and technology ', Newnes pro-).	Ts, MOSFETs, g: Modulation and

	First Impression, 6/e, 2013					
2.	Simon Haykin, 'Communication S	ystems', John Wil	ey & Sons	5, 5 t h Edition.	2009.	
		5	- j	, ,		
3.	Charles K Alexander, Mathew N C) Sadiku, 'Fundam	nentals of I	Electric Circuits	s', Tata	
	McGraw Hill, 2012.					
4.	Batarseh, 'Power Electronics Circuits', Wiley, 2003					
5.	H. Hayt, J.E. Kemmerly and S. M.	Durbin 'Engineer	ring Circui	it Analysis' 6/	Tata McGraw	
5.	Hill, New Delhi, 2011.	Duronn, Englice		it Allarysis, 0/6	, Tala MCOTaw	
	Hill, New Dellil, 2011.					
7.	Fitzgerald, Higgabogan, Grabel, 'H	Basic Electrical En	gineering'	, 5t h edn, McC	Graw Hill, 2009.	
8.	S.L.Uppal, 'Electrical Wiring Estin	nating and Costing	g ', Khann	a publishers, N	ewDelhi, 2008.	
			/ 0	•		
Moc	le of Evaluation: CAT / Assignmen	t / Quiz / FAT / Pi	roject / Sei	minar		
List	of Challenging Experiments (Ind	licative)				
1.	Thevenin's and Maximum Power		is – Imped	ance	2 hours	
	matching of source and load		is imped		2 110 0115	
2.	Sinusoidal steady state Response	of RLC circuits			2 hours	
3.	Three phase power measurement	for ac loads			2 hours	
4	Stainage mining ainsuit lavaut fan				2 h aurra	
4.	Staircase wiring circuit layout for	multi storey build	ing		2 hours	
5.	Fabricate and test a PCB layout for	or a rectifier circui	t		2 hours	
			-			
6.	Half and full adder circuits.				2 hours	
				-		
7.	Full wave Rectifier circuits used i		ies. Study	the	2 hours	
0	characteristics of the semiconduct		1		2.1	
8.	Regulated power supply using zer Zener diode used	ier diode. Study th	e characte	ristics of the	2 hours	
9.	Lamp dimmer circuit (Darlington	pair circuit using	transistors) used in cars	2 hours	
).	Study the characteristics of the tra		1 4115151015	j useu in cars.	2 110015	
10.	Characteristics of MOSFET				2 hours	
- • •						
	•		Total Lab	oratory Hours	20 hours	
Mod	le of assessment: Assignment / FA	Т				
	ommended by Board of Studies	29-05-2015				
App	proved by Academic Council	37	Date	16-06-2015		

Course code	Course	title	\mathbf{L}	Т	Р	J	С
MAT2002	Applications of Differe	ntial and Differen	ce 3	0	2	0	4
	Equat						
Pre-requisite	MAT1011 - Calcul	us for Engineers		Sy	llabu	ıs Ve	rsio
-					1.	0	
Course Objecti	ves:						
The course is ai							
1. Presenting th	e elementary notions of Four	er series, which is v	vital in p	racti	cal ha	armor	nic
analysis	5	,	1				
•	knowledge of eigenvalues ar	d eigen vectors of n	natrices	and	the tr	ansfo	rm
	lve linear systems, that arise						
	initial and boundary value pr		0			0	
	nowledge and application o		ons and	the	Z-tra	nsfor	m i
	, that are inherent in natural a						
	,						
Expected Cour	se Outcomes:						
<u> </u>	e course the student should be	able to					
	ools of Fourier series to find		ic funct	ions	from	the	
tabulated values			10 101100			une	
	cepts of eigenvalues, eigen v	ectors and diagonal	isation i	n lin	ear sy	vstem	s
	nniques of solving differentia		is u tion i		cui sj	stem	5
	e series solution of differentia		ling eige	en va	lues	eiger	1
	im-Liouville's problem	a equations and mit		, , , , , , , , , , , , , , , , , , ,		eigen	
	ransform and its application i	n population dynam	ics and	dioit	al sio	nal	
processing	unstorm und its upprouton i	in population dynam	ies and	aigit	ui 515	iiui	
	MATLAB programming for a	engineering problem	IS				
	Fourier series	ingineering problem	15			61	our
	Euler's formulae - Dirichlet's	conditions - Chang	e of inte	rval	- Hal		
	lue – Parseval's identity – Co			1 vai	IIai	i i ang	,c
			Jines				
Module:2	Matrices					61	iour
	Eigen vectors - Properties	of eigenvalues ar	d eiger	Ve	otore		
	em - Similarity of transforma						
quadratic form	in - Similarity of transforma	tion - Orthogonal t	ansion	latio	II and	1 matt	
quadratic form							
Modulo.2	Solution of ordinary different	ntial equations				61	our
WINNING'S		-		•	- C		
		ation with constan	t coaffi	nonte	s – ວ		
Linear second of	rder ordinary differential eq						ints
Linear second of homogenous ar	rder ordinary differential equation of the second sec	ns - Method of u	ndetern	nined	coe		
Linear second of homogenous an method of varia	rder ordinary differential equation of parameters – Solution	ns - Method of u	ndetern	nined	coe		
Linear second of homogenous ar	rder ordinary differential equation of parameters – Solution	ns - Method of u	ndetern	nined	coe		
Linear second of homogenous ar method of varia differential equa	rder ordinary differential equation and non-homogenous equation tion of parameters – Solution tions	ns - Method of u as of Cauchy-Euler	ndetern	nined	coe	ndre	
Linear second of homogenous ar method of varia differential equa Module:4	rder ordinary differential equation and non-homogenous equation tion of parameters – Solution tions	ns - Method of u s of Cauchy-Euler tions through	ndetern	nined	coe	ndre	nour
Linear second of homogenous an method of varia differential equation Module:4	rder ordinary differential equation and non-homogenous equation tion of parameters – Solution tions Solution of differential equation Laplace transform and mat	ns - Method of u as of Cauchy-Euler tions through rix method	ndeterm and Cau	ined ichy-	Lege	ndre	nour
Linear second of homogenous an method of varia differential equa Module:4	rder ordinary differential equation and non-homogenous equation tion of parameters – Solution tions Solution of differential equation Laplace transform and mate E's - Nonhomogeneous terms	ns - Method of u as of Cauchy-Euler tions through rix method involving Heavisid	ndeterm and Cau e functio	hined Ichy-	Lege	ndre 81 se fun	nour
Linear second of homogenous ar method of varia differential equa Module:4	rder ordinary differential equation and non-homogenous equation tion of parameters – Solution tions Solution of differential equation Laplace transform and mate E's - Nonhomogeneous terms mogeneous system using Lap	ns - Method of u as of Cauchy-Euler tions through rix method involving Heavisid place transform – R	ndeterm and Cau e function	on, In	coe Lege	ndre 8 l se fun rder	nour ctio
Linear second of homogenous ar method of varia differential equa Module:4	rder ordinary differential equation and non-homogenous equation tion of parameters – Solution tions Solution of differential equation Laplace transform and mate E's - Nonhomogeneous terms	ns - Method of u as of Cauchy-Euler tions through rix method involving Heavisid place transform – R	ndeterm and Cau e function	on, In	coe Lege	ndre 8 l se fun rder	nour ctio
Linear second of homogenous ar method of varia differential equa Module:4 Solution of ODI - Solving nonho differential equa	rder ordinary differential equation and non-homogenous equation tion of parameters – Solution tions Solution of differential equation Laplace transform and mate E's - Nonhomogeneous terms mogeneous system using Lap ation to first order system -	ns - Method of u as of Cauchy-Euler tions through rix method involving Heavisid place transform – R	ndeterm and Cau e function	on, In	coe Lege	ndre 8 l se fun rder	nour ction
Linear second of homogenous an method of varia differential equa Module:4 Solution of ODI - Solving nonho differential equa	rder ordinary differential equation and non-homogenous equation tion of parameters – Solution tions Solution of differential equation Laplace transform and mate E's - Nonhomogeneous terms mogeneous system using Lap ation to first order system -	ns - Method of u as of Cauchy-Euler tions through rix method involving Heavisid place transform – R	ndeterm and Cau e function	on, In	coe Lege	ndre 8 l se fun rder	nour ctio
Linear second of homogenous ar method of varia differential equa Module:4	rder ordinary differential equation and non-homogenous equation tion of parameters – Solution tions Solution of differential equation Laplace transform and mate E's - Nonhomogeneous terms mogeneous system using Lap ation to first order system -	ns - Method of u as of Cauchy-Euler tions through rix method involving Heavisid blace transform – R Solving nonhomoge	ndeterm and Cau e function	on, In	coe Lege	ndre 8 I se fun rder first	nour ctio

	series Solutions	
The	Strum-Liouville's Problem - Orthogonality o	of Eigen functions - Series solutions of
	erential equations about ordinary and regular	
	ation - Bessel's differential equation	
1.100	· · · · · · · · · · · · · · · ·	
Mod	ule:6 Z-Transform	6 hour
	ansform -transforms of standard functions - In	
	convolution method	inverse Z-transform. By partial fractions
anu	convolution method	
Mod	ule:7 Difference equations	5 hour
	1	
	erence equation - First and second order difference	
	nacci sequence - Solution of difference equation	
-	ral by the method of undetermined coefficien	as - Solution of simple difference equation
using	g Z-transform	
N 1		
	ule:8 Contemporary Issues	2 hours
Indus	stry Expert Lecture	
		ecture hours: 45 hour
	Book(s)	
	Advanced Engineering Mathematics, Erwin	n Kreyszig, 10 th Edition, John Wiley
	India, 2015	
Refe	rence Books	
1.	Higher Engineering Mathematics, B. S. Grew	wal, 43 rd Edition, Khanna Publishers,
	India, 2015	
	Advanced Engineering Mathematics by Mich	hael D. Greenberg 2 nd Edition, Pearson
	Education, Indian edition, 2006	
	e of Evaluation	
	al Assignments (Solutions by using soft	skills) Continuous
	ssment Tests, Quiz, Final Assessment Test	skins), Conunuous
		ns arising in 2 hours
1.	Solving Homogeneous differential equation	is arising in 2 hours
~	engineering problems	
2.	Solving non-homogeneous differential equa	ations and Cauchy, 2 hours
	Legendre equations	
3.	Applying the technique of Laplace transform	m to solve 2 hours
	differential equations	
	Applications of Second order differential ec	quations to Mass 2 hours
4.		
4.	spring system (damped, undamped, Forced	
4.	spring system (damped, undamped, Forced circuits etc.	
4.	circuits etc.	
	circuits etc. Visualizing Eigen value and Eigen vectors	oscillations), LCR 2 hours
5.	circuits etc. Visualizing Eigen value and Eigen vectors Solving system of differential equations aris	oscillations), LCR 2 hours
<u>5.</u> 6.	circuits etc. Visualizing Eigen value and Eigen vectors Solving system of differential equations aris applications	oscillations), LCR 2 hours sing in engineering 2 hours
5.	circuits etc. Visualizing Eigen value and Eigen vectors Solving system of differential equations aris applications Applying the Power series method to solve	oscillations), LCR 2 hours ising in engineering 2 hours differential 2 hours
5. 6. 7.	circuits etc. Visualizing Eigen value and Eigen vectors Solving system of differential equations aris applications Applying the Power series method to solve equations arising in engineering application	oscillations), LCR2 hourssing in engineering2 hoursdifferential1s
<u>5.</u> 6.	circuits etc. Visualizing Eigen value and Eigen vectors Solving system of differential equations aris applications Applying the Power series method to solve equations arising in engineering application Applying the Frobenius method to solve differentiation	oscillations), LCR2 hourssing in engineering2 hoursdifferential1s
5. 6. 7. 8.	circuits etc. Visualizing Eigen value and Eigen vectors Solving system of differential equations aris applications Applying the Power series method to solve equations arising in engineering application Applying the Frobenius method to solve dif arising in engineering applications	oscillations), LCR2 hourssing in engineering2 hoursdifferential ns2 hoursfferential equations2 hours
5. 6. 7. 8. 9.	circuits etc. Visualizing Eigen value and Eigen vectors Solving system of differential equations aris applications Applying the Power series method to solve equations arising in engineering application Applying the Frobenius method to solve dif arising in engineering applications Visualising Bessel and Legendre polynomia	oscillations), LCR2 hourssing in engineering2 hoursdifferential ns2 hoursfferential equations2 hoursals2 hours
5. 6. 7. 8.	circuits etc. Visualizing Eigen value and Eigen vectors Solving system of differential equations aris applications Applying the Power series method to solve equations arising in engineering application Applying the Frobenius method to solve dif arising in engineering applications Visualising Bessel and Legendre polynomia Evaluating Fourier series-Harmonic series	oscillations), LCR2 hourssing in engineering2 hoursdifferential ns2 hoursfferential equations2 hoursals2 hours2 hours
5. 6. 7. 8. 9.	circuits etc. Visualizing Eigen value and Eigen vectors Solving system of differential equations aris applications Applying the Power series method to solve equations arising in engineering application Applying the Frobenius method to solve dif arising in engineering applications Visualising Bessel and Legendre polynomia	oscillations), LCR2 hourssing in engineering2 hoursdifferential ns2 hoursfferential equations2 hoursals2 hours2 hours

12.	Solving Difference equations arisin applications	2 hours			
		24 hours			
Mode	e of Evaluation: Weekly Assessmen	t, Final Assessmen	t Test		
Recor	Recommended by Board of Studies 25-02-2017				
Appro	oved by Academic Council	No. 47	Date	05-10-2017	

Course Code	Course title		L	Τ	P	J	С
MAT-3004	Applied Linear Algebra		3	2		0	4
Pre-requisite	MAT2002 Applications of Differential and		Sylla	abus	Ve	rsi	on
	Difference Equations						
				1	.0		
Course Objecti		~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~	d			1	
applications to c 2. apply the conspaces in engine	g basic concepts of linear algebra to illustrate it omputer science and Engineering. ncepts of vector spaces, linear transformations, r ering. as in cryptography, computer graphics and wavelet	matrices	and				-
Expected Cours	se Outcomes						
 the abstract of methods the basic notiins apply the constraint of graphics and innoised and inno	s course the students are expected to learn concepts of matrices and system of linear equation on of vector spaces and subspaces ncept of vector spaces using linear transforms er product spaces if inner product spaces in cryptography et in image processing.	_		_	-		
	I						
Module:1 Sys	stem of Linear Equations:		6	hour	•6		
	ation and Gauss Jordan methods - Elementary mat	rices- pe				triz	x -
	- System of linear equations LU factorizations.						
Module:2 Ve	ctor Spaces			6 h	ours		
The Euclidean dependent-indep	space and vector space- subspace –linear c endent- bases - dimensions-finite dimensional vec			span	-line	arl	у
Module:3 Sul	bspace Properties:			6	hou	rc	
	n spaces -Rank and nullity – Bases for subspace –	invertib	ility				n in
interpolation.				P			
Module:4 Lin	near Transformations and applications		7	' hou	irs		
Linear transform	nations – Basic properties-invertible linear transfo	rmation	- m	atric	<u>es 0</u>	f li	near
	- vector space of linear transformations – change of						iicai
Module:5 Inn	er Product Spaces:		6	hour	S		
	d inner products – the lengths and angles of vector Gram-Schmidt orthogonalisation	rs – matri	ix re	prese	entat	ion	is of
Module:6 Ap	plications of Inner Product Spaces:		6	hour	'S		
QR factorization	n- Projection - orthogonal projections – relations utions in Computer Codes	of funda				pac	es –
Module:7 Ap	plications of Linear equations :		6	hour	·s		

An Introduction to coding - Classical Cryptosystems –Plain Text, Cipher Text, Encryption, Decryption and Introduction to Wavelets (only approx. of Wavelet from Raw data)

Module:8	Contemporary Issues:			2 hours
Industry Ex	pert Lecture			
		Total L	ecture hour	rs: 45 hours
Tutorial	• A minimum of 1			
I utoriai	out by students in	-		
	 Another 5 problem 	•		he
	given as home wo	-		
Text Book		лк.		
(Toj 2. Intro Hill	pics in the Chapters 1,3,4 & oductory Linear Algebra- A , 9 th Edition Pearson Educa	k5) An applied fi		Second edition Springer(2004). Sernard Kolman and David, R.
Reference 2				
	nentary Linear Algebra, St	ephen Andri	Ill and Davi	d Hecker, 5th Edition,
	demic Press(2016)		, D'I and	
	lied Abstract Algebra, Ruc			
	temporary linear algebra, I			
		, Gilbert Stra	ang, 5 ^m Edi	tion, Cengage Learning (2015).
Mode of E				
0	ignments, Continuous Ass			nent Test
	ded by Board of Studies	25-02-2017		
Approved b	y Academic Council	No. 47	Date	05-10-2017

 R^n

PROGRAM ELECTIVE

Course code	Course title	L T P J C
CSE3019	DATA MINING	
Pre-requisite	Nil	Syllabus version
Course Objection		v. 1.0
Course Objectives		
	te the concept of Data Mining and Data Prep the knowledge for application of the mining	
clustering	the knowledge for application of the mining	argorithms for association,
0	the algorithms for mining data streams and th	ne features of recommendation
systems.		
Expected Course	Outcome:	
-	ontribution of data warehousing and data min	ing to the decision-support systems
-	ous classifications techniques to find the simi	U 11 U
3. Design the mod	del to sample, filter and mine the Streaming of	lata
	analysis and frequent item-set algorithms to	identify the entities on the real
world data		
	eport the results of the recommended systems	
	rious data mining tasks and the principle algo	
7. Create the wor	king model as a team to solve the challenging	g data mining problems
Module:1 INTR	RODUCTION	3 hours
	a ware housing-OLAP-Data Preprocessing	0 110015
	SSIFICATION TECHNIQUES AND DING SIMILAR ITEMS	5 hours
Classification Tech	nniques: Decision Tree, ID3, K-Nearest Neigh	bour Classifier, Naive Bayes- Near
	- Shingling of Documents - Similarity Prese	
(LSH) – Applicatio	n and Variance of LSH – Distance Measures	 High degrees of similarity
	ING DATA STREAMS	4 hours
	l - Sampling Data in a Stream – Filtering Stre	
in a stream – Estim	nating Moments – Counting Ones in a windo	w – Decaying windows
		41
Module:4 LINK		4 hours
rage Kank – Link	Spam – Hubs and Authorities	
Module:5 FREO	QUENT ITEM SETS	4 hours
	del – A-priori Algorithm – Handling larger d	
	ted Pass Algorithms	anasons – Counting Prequent items
Module:6 CLU	STERING	4 hours
	ering – K-means Algorithm – Clustering in N	
for Streams and Pa		
	OMMENDATION SYSTEMS	4 hours
Content based – Co	ollaborative Filtering – Dimensionality reduc	tion-Case study
Module:8 Con	temporary issues:	2 hours

	Total Lecture hours: 30 hours	
Tex	t Book(s)	
1.	Ian H. Witten, Eibe Frank, Mark A. Hall, Data Mining: Practical Machine Lear	rning Tools and
	Techniques, Morgan Kaufmann, 2011	
Ref	erence Books	
1.	Jiawei Han, Micheline Kamber and Jian Pei, Data Mining: Concepts and Tech Kaufmann 2011	niques, Morgan
2.	J. Leskovec, A. Rajaraman, and Jeffrey D. Ullman. Mining of Massive Dataset University Press, 2014.	ts. Cambridge
Mo	de of Evaluation: CAT / Assignment / Quiz / FAT / Project / Seminar	
Lis	t of Challenging Experiments (Indicative)	
1.	Introduction to exploratory data analysis using R	1 hours
2.	Demonstrate the Descriptive Statistics for a sample data like mean, median, variance and correlation etc.,	1 hours
3.	Demonstrate Missing value analysis and different plots using sample data.	1 hours
4.	Demonstration of apriori algorithm on various data sets with varying confidence (%) and support (%).	2 hours
5.	Demo on Classification Techniques using sample data Decision Tree, ID3 or CART.	2 hours
6.	Demonstration of Clustering Techniques K-Mean and Hierarchical.	2 hours
7.	Simulation of Page Rank Algorithm and Demonstration on Hubs and Authorities.	2 hours
8.	Demo on Classification Technique using KNN.	2 Hours
9.	Demonstration on Document Similarity Techniques and measurements.	2 hours
10.	Design and develop a recommendation engine for the given application.	2 hours
	Total Laboratory Hours	15 hours
Mo	de of evaluation: Project/Activity	
	commended by Board of Studies 04-04-2014	
Ap	broved by Academic Council No. 37 Date 16-06-2015	

Course Code	Course Title		L	Т	Р	J	С
CSE4033	Cloud Computing and Security	7	2	0	2	0	3
Pre-requisite	ECE 3026 IoT System Architecture	,		v		sion	-
Course Objecti					. 61	51011	
	med at making the students to						
	stry-leading systems and technologies for publi	c and private c	loud	infra	stru	cture	-
	loud orchestration to support elasticity and avail		1044			oture	•
	oud features to secure and harden the cloud infr						
Course Outcon							
	e course, the student will be able to						
	ics of cloud computing, cloud models and its ap	nlications					
	loud technologies, its services and platforms.	phounons.					
	use Public Cloud Services and to build applicat	ions					
	applications and analyse the design consideration		dolog	ries			
-	the division of responsibility in Cloud environ		-		in t	he	
Cloud architectu			ging	115K5	111 U		
	he security concepts and ability to design a resil	ient cloud arel	nitect	ure			
	with the concepts of Operating System and Netw		meet	ure.			
	orm-specific tools and management consoles to		mon		loud	1	
infrastructure.	orm-specific tools and management consoles to	configure and	mana	age c	loud	L	
infrastructure.							
36 3 3 4 7		4 77					
	ntroduction to cloud computing	4 Hours		~	~ ~	~	
	of Cloud computing – Cloud Models – Cloud Se	ervices – IaaS,	PaaS	, Saa	iS, L	aaS-	-
	vices and applications,						
	echnologies, Services and Platforms	4 Hours					
	Load Balancing, Scalability, Elasticity, Deployn						
	d Networking, Network function Virtualization,	, Mapreduce, A	Acces	s ma	nage	emen	t
and Service leve							
	loud Services and Platforms	4 Hours					
	es, Storgae Services, Database services, Application					very	
	tics Services, Deployment and Management Ser						
	vices : Amazon Web Services, Google Cloud P	latform, Wind	ows A	Azur	e		
Module:4 C	loud Application Design	4 Hours					
Design consider	ations – Reference Architectures – Design Meth	nodologies – S	ata S	torag	ge		
Approaches							
Module:5 R	isk Analysis and Division of Responsibility	4 Hours					
Managing Risks	in the Cloud. Dividing Operational Responsibi	lity and Visibi	lity. F	Retai	ning		
Information Sec	urity Accountability. Managing User Authentic	ation and Auth	noriza	tion			
Negotiating Sec	urity Requirements with Vendors. Identifying N	leeded Securit	y Me	asure	es.		
Establishing a S	ervice Level Agreement (SLA). Ensuring SLAs	Meet Security	Req	uirer	nent	s.	
	ecuring the Cloud Infrastructure.	4 Hours					
Securing the Pla	tform. Restricting Network Access through Sec	urity Groups.	Confi	guri	ng		
0	ic User Access Control. Integrating Cloud Auth	• 1		0	0	tems	5.
-	zing Access To Protect Data Confidentiality an				-		
	a at Rest. Identifying Your Security Perimeter.						
	loud Computing Architecture and Security Con						•
-	ient Cloud Architectures.	1					
	perating System and Network Security	4 Hours					

Locking Down Cloud Servers. Scanning for and	Patching Vulner	abilities.	Controlling and
Verifying Configuration Management. Leveragi			
Security Groups To Control Access. Filtering Tr	• •		• • •
Provider's Built-In Security. Protecting Archived			
Module:3 Contemporary Issues		2 Hours	
		J	Fotal Lecture Hours :30
Text Book(s):			
1. Arshdeep Bahga, Vijay Madisetti, "Cloud Co APPROACH Text Book series, 2013.	mputing: A Han	ds-On App	proach", A HANDSON
Reference Books:			
1. John R. Vacca, "Cloud Computing Security:	Foundations and	l Challeng	es", CRC Press, 2016.
2. Pearson, Siani, Yee, George, "Privacy and S	ecurity for Cloud	l Computi	ng", Springer, 2013.
3. Nick Antonopoulos, Lee Gillam, Cloud Con	puting: Principle	es, System	s and Applications,
Springer, 2010			
4. Toby Velte, Anthony Velte, Robert Elsenpet	er , Cloud Comp	outing, A P	ractical Approach,
McGraw Hill, 2010			•
List of Challenging Experiments:			
1. Case study: Google Cloud			
2. Virtualization Tools – KVM, Virtual Box, Xe	n		
3. Case study: Windows Azure			
4. Case study: Amazon Web services			
5. Case Study: IBM Bluemix			
6. Cuckoo Sandobox – open source cloud securi	ty tool(malware	analysis)	
7. SLA – Use Cases			
8. Deployment of end to end IoT Application			
9. Build a mobile messaging Application			
10. Interfacing to Raspberry Pi or Intel Galileo			
Recommended by Board of Studies :	31-08-2018		
Approved by Academic Council : 53	Date :		13-12-2018

Course Code	Course Title		L	Т	P	J	C
CSE4034	IoT Edge Nodes and its Applications		2	0	2	0	3
Pre-requisite	ECE3026 - IoT System Architecture				Ver	sion	:1
Course Objecti							
The course is air							
-	ne basic concepts of Physical & Logical design of IoT	and ana	lyse	s of	Macl	hine	to
Machine Conce							
	lents to the usage of Protocol Standardization for IoT w	vith IoT	Edg	e and	1 Gat	tewa	y
	Communication protocols						
	students to know the basics of protocol stacks for the e	dge dev	ices	and	desig	gn	
challenges.				1.	C		
-	Solutions with sensor based application through embe	edded sy	stem	plat	form	1	
Course Outcom							
	e course the student should be able to	design	f Io'	г			
-	and analysis concepts of Physical design and Logical	0	01 10	1			
	oonse analysis of Machine to Machine Concepts of IoT. the Protocol Standardization for IoT with Efforts of M		ws	N Dr	otoc	പ	
_	the operation of IoT Edge and Gateway Network with						c
-	ie issues on Development challenges and Security chall				prou	0001	3
	the ideas of Developing IoT Solutions	ienges n	1 10 1	•			
	ble solution for domain specific applications of IoT						
	ractice IoT enabling Technologies.						
Module:1 Ir	ntroduction to IoT 4 Hou	irs					
	haracteristics of IoT; Physical design of IoT; Logical d		IoT	Fur	ictio	nal	
<u> </u>	Communication models & API's Actuators; Controllers	-					
	oT PROTOCOLS 4 Hou						
Protocol Standar	rdization for IoT; Efforts of M2M and WSN Protocols;	SCADA	A an	d RF	ĪD		
	ed Data Standards; Protocols – IEEE 802.15.4; Networ	k layer;					
6LowPAN;MQ							
Module:4 Io	oT Edge and Gateway Network 6 Hou	irs					
ē	introduction; What and where is the "edge"; Edge /Fog	-	<u> </u>				
-	g data local; An edge-first approach; The power of edg				<u> </u>		
	Communication protocols and protocol stacks for the e	0					
_	in IoT; Implementation of IoT Edge Gateway; Edge An						L
	d Computing Framework Femto Clouds; Leveraging M						
	t the Edge Fast; Scalable and Secure Onloading of Edg		ons	Usin	<u>g</u> A11	r Bo	X
	hallenges in IoT 3 Hou						
	es; Development challenges; Security challenges; Othe		nges	•			
	eveloping IoT Solutions 4 Hou				1	1	
	to T tools; Developing applications through IoT tools; D						
	ugh embedded system platform; Edge Analytics, Edge	Security	and	AIU	.11C1a	.1	
Intelligence(AI) Module:7 D		irc					
	omain specific applications of IoT3 Houon; Industry applications; Surveillance applications; Otl		nnl	cati	ane		
	ontemporary Issues 2 Hou		appu	cati(<u>,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,</u>		
		al Lectu	1 P 0 1	10111	c. 2 (H-	1116
Text Books:	100	ai Letti	nel	iour	5. 30	, 110	u15
	ga, Vijay Madisetti, "Internet of Things – A hands-on a	annroach	1" I	Inive	rsiti	es	
Press, 2015.	$g_{\mu\nu}$, g_{μ	"PP10ael	. , c	/ 1 1 I V (.15111	-0	
, _0101							

2. Ovidiu Vermesan, Peter Friess, "Internet of Things – From research and innovation to market deployment", 2014, River Publishers Series in Communication, USA.

3. David Boswarthick, "M2M Communications - A Systems Approach", 2012, Wiley, USA.

4..Waltenegus Dargie, Christian Poellabauer, "Fundamentals of Wireless Sensor Networks: Theory and Practice" Wiley Publications 2010

Reference Books:

1. Internet of Things: Converging Technologies for Smart Environments and Integrated Ecosystems, Dr. Ovidiu Vermesan, Dr. Peter Friess, River Publishers 2013.

2. Interconnecting Smart Objects with IP: The Next Internet, Jean-Philippe Vasseur, Adam Dunkels, Morgan Kuffmann, Elsevier, 2010.

3. 6LoWPAN: The Wireless Embedded Internet, Zach Shelby, Carsten Bormann, Wiley Publications 2010

4. Ian F. Akyildiz, and Mehmet Can Vuran, Wireless Sensor Networks, 2010, Wiley, USA IBM Bluemix: The Cloud Platform for Creating and Delivering Applications, 2010 John Wiley & Sons Ltd.

Mode of Evaluation: Continuous Assessment Test + Digital Assignment +Quiz + Final Assessment Test

List of Challenging Experiments (Indicative):

1.LoWPAN for IoT gateway functions to send Ipv6 packets over IEEE802.15.4 based networks.

2. Implementation of edge nodes & edge gateways

3.Edge Analytics with (WISE3) IoT Platform

4.Design and analyse the data transmission between zigbee nodes with no path loss and analyse the throughput based on IEEE 802.15.4

5. Implementation of clustered based wireless sensor network and analysis on Residual energy and throughput.

5. To develop a case study for IoT based systems.

6. Implement Sample Edge Gateway based IoT Solution

Mode of Evaluation: Continuous Assessment Task + Final Assessment Test

Recommended by Board of Studies :		31-08-2018	
Approved by Academic Council :	53	Date :	13-12-2018

Course Code			L	Τ	P	J	(
CSE4035	Mobile App Development for IoT		2	0	0	4	
Pre-requisite	•		Ve	rsior	n :1		
Course obje	ctives (CoB):						
The course is	aimed at						
1. Acquaintir	g students with the basic concepts in web app crea	ation					
2. Introducin	g students to key concepts of multimedia in androi	id system					
3. Teaching t	he students optimization techniques and schedulin	ng approache	S				
Course Outo	comes (CO):						
At the end of	the course the student should be able to						
1. Discuss ab	out mobile interfaces and applications.						
2. Design mu	ltimedia application in android platform.						
-	nd the various scheduling techniques and memory	mapping tec	chnique	s for	emb	edde	ed
android syste		11 0	-				
4. Implement	the different models and optimization techniques	using SQLit	e, data s	storag	ge.		
-	e Power Optimizations with Loop Scheduling.	0					
	nd the basic concepts of Mobile Cloud Computing	5					
	Big Data Processing techniques	-					
8. Develop a	Mobile App for IoT applications.						
1							
Module:1	Overview of Mobile App and Mobile	2 Hours					
	Interface						
Mobile Syste	m – Mobile Interface and Applications – Mobile (Cloud					
Module:2	Introduction of Key Concepts and 2D	5 Hours					
	Graphics and Multimedia in Android of						
	Android						
APP Compos	nents – APP Resources – APP Mainfest – Introduc	tion of 2D C	Graphics	Tec	hnia	ues -	_
	Design – Audio implementations in Android – Ex						
Module:3	Mobile Embedded System Architecture	4 Hours					
	lgorithms – Memory Technology – Mobile Embe		ıs – Me	ssaoi	no ai	nd	
	ion Mechanisms		15 1010	ssugi	ing ui	.10	
Module:4	Data Storage and SQLite Operations and	5 Hours					
in our i	Mobile Optimization by Dynamic	C Hours					
	Programming						
Local Data -	Sqlite Database – Content Provider – Fixed Time	Model – Pro	babilis	tic Ti	me l	Mod	e1
-	Squite Database Content Provider Place Place	Widden Th	Jouonns		inte i	nou	
Nondetermin	istic Polynomial Time Problems						
Module:5	Mobile Optimizations by Loop Scheduling	4 Hours					
	- Basic Graph Models and Techniques – Fundame		Optimi	zatio	ns –	Tim	ie
	ptimizations with Loop Scheduling		opuin	20010			
Module:6	Mobile Cloud Computing in Mobile	4 Hours					
iniouule.o	Applications Deployment	4 Hours					
Introduction	- Concepts of Mobile Cloud Computing – Main T	L Techniques o	f Mobil	e Clo	nd		
	Mobile Cloud Computing Architecture	conniques 0			au		
Computing -	Efficient Data Synchronization on Mobile	4 Hours					
		4 Hours					
Computing – Module:7	•						
Module:7	Devices in Big Data	ta Storage					
Module:7 Overview of	Devices in Big Data Big Data – Big Data Processing – Mobile Big Dat						
Module:7 Overview of Module:8	Devices in Big Data	ta Storage 2 Hours					

1. Meikang Qiu, Wenyun Dai, and Keke Gai, "Mobile Applications Development With Android Technologies and Algorithms", Chapman and Hall/CRC Publication, 2016

References:

2. Jon Duckett, Gilles Ruppert, and Jack Moore, "JavaScript and Jquery: Interactive Front-End Web Development", CreateSpace Independent Publishing Platform, 2017

3. Jeff McWherter and Scott Gowell, "Professional Mobile Application Development", John Wiley & Sons, 2012

4. Nishith Pathak, Anurag Bhandari, "IoT, AI, and Blockchain for .NET: Building a Next-Generation Application from the Ground Up", Apress, 2018

Mode of Evaluation: Continuous Assessment Tests, Quiz, Digital Assignment, Final Assessment Test

Typical Projects for J component	
----------------------------------	--

1. Develop an application that uses GUI components, Font and Colors.

2. Develop an application that uses Layout Managers and event listeners.

3. Develop a native calculator application.

4. Write an application that draws basic graphical primitives on the screen.

5. Develop an application that makes use of database.

6. Develop an application that makes use of RSS Feed.

7. Implement an application that implements Multi threading.

8. Develop a native application that uses GPS location information.

Mode of evaluation: Continuous Assessment Reviews

Recommended by Board of Studies	5:	31-08-2018	
Approved by Academic Council :	53	Date :	13-12-2018

	Course Title		L	Т	Р	J	(
ECE2025	PROBABILITY AND STATISTICAL TH	IEORY OI	7 1	0	2	0	2
	COMMUNICATION						
Pre-requisite	ECE1018 – Signal Analysis and Processing			V	⁷ ersi	on :	1.
Course objectiv							
The course is ai							
	tudents with the basic concepts of random varia		dom pro	ocess	•		
	he basics of information theory and channel capa						
	cal hypothesis and estimation theory for parameter	ter estimation	on.				
Course Outcon							
	e course the student should be able to						
-	the basics probability and random variables und	erstand.					
	e two-dimensional random variables.	~		_			
-	he different types of random processes like stati	onary, Gau	ssian rai	ndon	n pro	ocess	
etc.							
-	rmation measure and channel capacity						
	oonse of correlator in receiver and matched filter		N. T. N.			r	
	us statistical hypothesis testing methods including	ng LR test,	M1m-M	ax te	st, N	leym	aı
Pearson test.	(he different estimation (he can in the dire MANGE			. תר		- 4	
-	the different estimation theory including MMSE	2, MAP, MI		кве	stim	ators	•
8. Solve the pro	blems using modern engineering tools						
Module:1 P	robability and Random Variable	2 hours					
	pability, Conditional probability, random varia		hility D	anai	E.	mati	~
-	ard distributions- Uniform, Normal, Exponentia		•	CIISI	Jy I'u	uncu	U
	wo Dimensional Random Variables	2 hours	•				
	ns, Marginal and conditional distributions, Cova		relation	Tra	nefo	rmat	ic
	bles, Central limit theorem		relation	, 114		IIIIat	10
			1				
ivioaille:5 K	andom Process	2 hours					
	andom Process s- Stationarity Independence Gaussian Ra	2 hours	cesses	Lir	ear	SVS	e
Random Proces	s- Stationarity, Independence, Gaussian Ra	2 hours indom Pro	cesses,	Lir	near	syst	e
Random Proces Fundamentals-R	s- Stationarity, Independence, Gaussian Ra andom Signal Response of Linear Systems	ndom Pro	cesses,	Lir	near	syst	e
Random Proces Fundamentals-R Module:4 In	s- Stationarity, Independence, Gaussian Ra andom Signal Response of Linear Systems Information Measure	ndom Pro				-	
Random Proces Fundamentals-R Module:4 In Self-Information	s- Stationarity, Independence, Gaussian Ra andom Signal Response of Linear Systems formation Measure n, Discrete and Continuous Entropy, Entropy	ndom Pro				syst Mut	
Random Proces Fundamentals-R Module:4 In Self-Information Information, Ch	s- Stationarity, Independence, Gaussian Ra andom Signal Response of Linear Systems formation Measure n, Discrete and Continuous Entropy, Entrop annel capacity	ndom Pro 2 hours py of a 1				-	
Random ProcesFundamentals-FModule:4InSelf-InformationInformation, ChModule:5O	s- Stationarity, Independence, Gaussian Ra andom Signal Response of Linear Systems formation Measure n, Discrete and Continuous Entropy, Entropannel capacity ptimum Linear Systems	ndom Pro 2 hours py of a 2 hours	oinary	sour	ce,	-	
Random ProcessFundamentals-RModule:4InSelf-InformationInformation, ChModule:5ODigital Communication	s- Stationarity, Independence, Gaussian Ra andom Signal Response of Linear Systems formation Measure h, Discrete and Continuous Entropy, Entropannel capacity ptimum Linear Systems nication in presence of AWGN-Correlation rece	2 hours py of a 2 hours 2 hours iver, Match	oinary	sour	ce,	-	
Random ProcesFundamentals-FModule:4InSelf-InformationInformation, ChModule:5ODigital CommunicationModule:6T	s- Stationarity, Independence, Gaussian Ra andom Signal Response of Linear Systems formation Measure h, Discrete and Continuous Entropy, Entropannel capacity ptimum Linear Systems hication in presence of AWGN-Correlation recer esting of statistical hypothesis	andomPro2 hourspyofa2 hoursiver, Match2 hours	binary ed filter	sour	rce,	Mut	
Random ProcessFundamentals-RModule:4InSelf-InformationChInformationChModule:5CDigital CommunicationCModule:6TLikelihood ration	s- Stationarity, Independence, Gaussian Ra andom Signal Response of Linear Systems formation Measure n, Discrete and Continuous Entropy, Entrop annel capacity ptimum Linear Systems nication in presence of AWGN-Correlation recer esting of statistical hypothesis test, Baye's test, Probability of error, Mini-Max	andomPro2 hourspyofa2 hoursiver, Match2 hoursa test, Neyn	binary ed filter	sour	rce,	Mut	
Random ProcessFundamentals-RModule:4InSelf-InformationInformationChModule:5ODigital CommunicationModule:6TLikelihood rationModule:7E	s- Stationarity, Independence, Gaussian Ra andom Signal Response of Linear Systems formation Measure n, Discrete and Continuous Entropy, Entrop annel capacity ptimum Linear Systems nication in presence of AWGN-Correlation rece esting of statistical hypothesis test, Baye's test, Probability of error, Mini-Max stimation theory	andomPro2 hourspyofa2 hoursiver, Match2 hoursa test, Neyn2 hoursa test, Neyn	binary ed filter nan Pear	sour rece	rce, iver Test	Mut	
Random ProcessFundamentals-FModule:4InSelf-InformationChInformationChModule:5ODigital CommunicationTLikelihood rationChModule:6TLikelihood rationEMinimum meanCh	s- Stationarity, Independence, Gaussian Ra andom Signal Response of Linear Systems formation Measure n, Discrete and Continuous Entropy, Entropannel capacity ptimum Linear Systems nication in presence of AWGN-Correlation recer esting of statistical hypothesis test, Baye's test, Probability of error, Mini-Max stimation theory n square error estimator, Maximum a posterior	andomPro2 hourspyofa2 hoursiver, Match2 hoursa test, Neyn2 hoursa test, Neyn	binary ed filter nan Pear	sour rece	rce, iver Test	Mut	
Random ProcessFundamentals-RModule:4InSelf-InformationChInformationChModule:5ODigital CommunicationTLikelihood rationTModule:7EMinimum meanestimationCaracteriaCaracteria	s- Stationarity, Independence, Gaussian Ra andom Signal Response of Linear Systems formation Measure h, Discrete and Continuous Entropy, Entropannel capacity ptimum Linear Systems nication in presence of AWGN-Correlation recer esting of statistical hypothesis test, Baye's test, Probability of error, Mini-Max stimation theory n square error estimator, Maximum a posterior ner Rao bound (CRB) for parameter estimation	andomPro2 hourspyofa2 hoursiver, Match2 hoursa test, Neyn2 hoursoriestimate	binary ed filter nan Pear	sour rece	rce, iver Test	Mut	
Random ProcessFundamentals-FModule:4InSelf-Information, ChModule:5ODigital CommunityModule:6TLikelihood rationModule:7EMinimum meanestimation, Crar	s- Stationarity, Independence, Gaussian Ra andom Signal Response of Linear Systems formation Measure n, Discrete and Continuous Entropy, Entropannel capacity ptimum Linear Systems nication in presence of AWGN-Correlation recer esting of statistical hypothesis test, Baye's test, Probability of error, Mini-Max stimation theory n square error estimator, Maximum a posterior	andomPro2 hourspyofa2 hoursiver, Match2 hoursa test, Neyn2 hoursoriestimate1 hours	binary ed filter nan Pear	sour rece	rce, iver Test n lik	Mut	
Random ProcessFundamentals-FModule:4InSelf-Information, ChModule:5ODigital CommunityModule:6TLikelihood rationModule:7EMinimum meanestimation, CrantModule:8C	s- Stationarity, Independence, Gaussian Ra andom Signal Response of Linear Systems formation Measure h, Discrete and Continuous Entropy, Entropannel capacity ptimum Linear Systems nication in presence of AWGN-Correlation recer esting of statistical hypothesis test, Baye's test, Probability of error, Mini-Max stimation theory n square error estimator, Maximum a posterior ner Rao bound (CRB) for parameter estimation	andomPro2 hourspyofa2 hoursiver, Match2 hoursa test, Neyn2 hoursoriestimate1 hours	binary ed filter nan Pear br, Maxi	sour rece	rce, iver Test n lik	Mut	
Random ProcessFundamentals-FModule:4InSelf-Information, ChModule:5ODigital CommunityModule:6TLikelihood rationModule:7EMinimum meanestimation, CrartModule:8CText Book(s)	s- Stationarity, Independence, Gaussian Ra andom Signal Response of Linear Systems formation Measure h, Discrete and Continuous Entropy, Entropannel capacity ptimum Linear Systems hication in presence of AWGN-Correlation recer esting of statistical hypothesis test, Baye's test, Probability of error, Mini-Mas stimation theory h square error estimator, Maximum a posterio ner Rao bound (CRB) for parameter estimation ontemporary issues:	andomPro2 hourspyofa2 hoursiver, Match2 hoursa test, Neyn2 hoursoriestimato1 hours	binary ed filter nan Pear or, Maxi	sour rece son	rce, Test n lik	Mut celiho	
Random ProcessFundamentals-FModule:4InSelf-InformationChInformationChModule:5ODigital CommunityModule:6Module:6TLikelihood rationCModule:7EMinimum meanestimationCrartModule:8CCText Book(s)1. P.Z. Peel	s- Stationarity, Independence, Gaussian Ra andom Signal Response of Linear Systems formation Measure h, Discrete and Continuous Entropy, Entropannel capacity ptimum Linear Systems nication in presence of AWGN-Correlation recer esting of statistical hypothesis test, Baye's test, Probability of error, Mini-Max stimation theory n square error estimator, Maximum a posterior ner Rao bound (CRB) for parameter estimation	andomPro2 hourspyofa2 hoursiver, Match2 hoursa test, Neyn2 hoursoriestimato1 hours	binary ed filter nan Pear or, Maxi	sour rece son	rce, Test n lik	Mut celiho	
Random ProcessFundamentals-FModule:4InSelf-Information, ChModule:5ODigital CommunityModule:6TLikelihood rationModule:7EMinimum meanestimation, CrantModule:8OText Book(s)1. P.Z. PeelTata Mc	s- Stationarity, Independence, Gaussian Ra andom Signal Response of Linear Systems formation Measure n, Discrete and Continuous Entropy, Entropannel capacity ptimum Linear Systems nication in presence of AWGN-Correlation receresting of statistical hypothesis test, Baye's test, Probability of error, Mini-Maximation theory n square error estimator, Maximum a posterion ner Rao bound (CRB) for parameter estimation ontemporary issues: bles, Probability, Random Variablesand Random Graw Hill, India	andomPro2 hourspyofa2 hoursiver, Match2 hoursa test, Neyn2 hoursorioriestimate1 hoursSignal Prince	binary ed filter nan Pear or, Maxi Fotal Lo	sour rece son imun ectur 012,	rce, Test n lik	Mut celiho 5 ho ditio	
Random ProcessFundamentals-FModule:4InSelf-Information, ChModule:5ODigital CommunityModule:6TLikelihood rationModule:7EMinimum meanestimation, CrantModule:8OText Book(s)1. P.Z. PeelTata Mc	s- Stationarity, Independence, Gaussian Ra andom Signal Response of Linear Systems formation Measure h, Discrete and Continuous Entropy, Entro- annel capacity ptimum Linear Systems nication in presence of AWGN-Correlation rece esting of statistical hypothesis test, Baye's test, Probability of error, Mini-Max stimation theory h square error estimator, Maximum a posterior ner Rao bound (CRB) for parameter estimation ontemporary issues: bles, Probability, Random Variablesand Random Graw Hill, India Proakis, Digital Communications, 2014, 5 th Edit	andomPro2 hourspyofa2 hoursiver, Match2 hoursa test, Neyn2 hoursorioriestimate1 hoursSignal Prince	binary ed filter nan Pear or, Maxi Fotal Lo	sour rece son imun ectur 012,	rce, Test n lik	Mut celiho 5 ho ditio	
Random ProcessFundamentals-FModule:4InSelf-Information, ChModule:5ODigital CommunityModule:6TLikelihood rationModule:7EMinimum meanestimation, CrantModule:8OText Book(s)1. P.Z. PeelTata Mc2. John G.Reference Bool1. Simon H	s- Stationarity, Independence, Gaussian Ra andom Signal Response of Linear Systems formation Measure n, Discrete and Continuous Entropy, Entro- annel capacity ptimum Linear Systems nication in presence of AWGN-Correlation rece esting of statistical hypothesis test, Baye's test, Probability of error, Mini-Mas stimation theory n square error estimator, Maximum a posterio ner Rao bound (CRB) for parameter estimation ontemporary issues: bles, Probability, Random Variablesand Random Graw Hill, India Proakis, Digital Communications, 2014, 5 th Editi ss: laykin, Communication Systems, 2012, 5 th Editi	andom Pro 2 hours py py of a 2 hours a iver, Match 2 hours a test, Meyn 2 hours ori estimate 1 hours a Signal Prince a ion, Tata N on, Wiley, a	binary ed filter nan Pear or, Maxi Fotal Lo ciples, 2 IcGraw India.	sour rece son imun ectur 012, Hill,	rce, Test n lik re: 1 4 th ed	Mut celiho 5 ho ditio a.	
Random ProcessFundamentals-FModule:4InSelf-Information, ChModule:5ODigital CommunityModule:6TLikelihood rationModule:7EMinimum meanestimation, CrantModule:8OText Book(s)1. P.Z. PeelTata Mc2. John G.Reference Bool1. Simon H	s- Stationarity, Independence, Gaussian Ra andom Signal Response of Linear Systems formation Measure h, Discrete and Continuous Entropy, Entro- annel capacity ptimum Linear Systems nication in presence of AWGN-Correlation rece esting of statistical hypothesis test, Baye's test, Probability of error, Mini-Max stimation theory a square error estimator, Maximum a posterio ner Rao bound (CRB) for parameter estimation ontemporary issues: bles, Probability, Random Variablesand Random Graw Hill, India Proakis, Digital Communications, 2014, 5 th Edit	andom Pro 2 hours py py of a 2 hours a iver, Match 2 hours a test, Meyn 2 hours ori estimate 1 hours a Signal Prince a ion, Tata N on, Wiley, a	binary ed filter nan Pear or, Maxi Fotal Lo ciples, 2 IcGraw India.	sour rece son imun ectur 012, Hill,	rce, Test n lik re: 1 4 th ed	Mut celiho 5 ho ditio a.	

Mode of Evaluation: Continues Assessment Test, Quiz, Digital Assignment, Challenging	g
Experiments, Final Assessment Test	
List of Challenging Experiments(Indicative)	
 Task I: Computation of Probability Mass (Density) Function (PMF orPDF) 1. Generate 1000 sample points of real numbers uniformly distributed between '0' and '1'. i) Let X be random variable(RV) taking values '0' &'1'. X=0 corresponds to the sample points whose values are less than 0.5. X=1 corresponds to the sample point whose values are between 0.5 and 1. Draw the probability mass function of the RV, X. ii) Repeat part (i) for RV 'Y' taking values 0, 1&2. 0 : sample values between 0&1/3 1: sample values between 1/3&2/3 2: sample values between 2/3 & 1. 	e
 Task II : Computation of PDF and cumulative distribution function(CDF) 1. Draw the graph for the binomial density function for N=6 andp=0.4. Also compute and show it by graph, the binomial cumulative distribution function (CDF). 	4 hours
 Task III: Generation of Histogram of Uniform RV 1. Generate 1000 sample points of real numbers uniformly distributed between 0 & 1 using the Matlab function 'rand'. Compute the Histogram of the above sample points (Take 10 uniform steps between 0 & 1). Redraw the histogram when the sample points are increased to 2000. Also observe it when the steps are increased from 10 to 20. Compare your results with built in Matlab function. 	e e
 Task IV : Generation of Histogram of Gaussian RV 1. Redo the steps Task III with Matlab function 'rand' replaced by 'randn'. 2. Write a Matlab script to compute the mean, mean square, variance and standard deviation for the RVs given and display them on the command prompt Compare your results with the built in functions. 3. Generate 1000 samples of a uniform RV taking values between 0& 2π. Generate the new RV, Y = sin Θ. Plot the p.d.f of Y. Compare this with the theoretical result. 	
 Task 5: Transformation of Uniform pdf to exponential and Rayleigh pdfs 1. Generate 1000 sample points of uniform p.d.f,. Use appropriate transformation to convert uniform p.d.f to i) exponential p.d.f ii) Rayleigh p.d.f. Draw their corresponding p.d.f curves. 2. Generate 1000 samples of a 'Gaussian' random variable X. Use the transformation Y = X². Draw the p.d.f of Y and compare it with theoretical results 	4 hours
Task 6: Probability of error analysis	4 hours
Task 0: 1100a0mty of citor analysis Task 7: Baseband Transmission and Reception schemes	4 hours
Task 7: Daseband Transmission and Reception schemes Task 8: True parameter estimation schemes	4 hours
Total Laboratory Hour	rs: 30 hours
Mode of Evaluation: Continuous and Final Assessment test	
Recommended by Board of Studies : 26-02-2017	
Approved by Academic Council: 44 Date: 16-03-2017	

Course code	Course title		L T P J C			
ECE2027	27 EMC and EMI					
Pre-requisite	ECE1017- Electro Magnetic Field Theory and		Version: 1.2			
	Transmission Lines					
Course Objective						
The course is aime	ed at					
	eledge on the importance of EMC and EMC compliance					
	sure to EMI sources, mitigation, and measurement tecl	nniques/	standards to			
guarantee the corr	ect working modalities.					
3. Providing expos	sure to the guidelines for reduced EMI in PCB design.					
Expected Course	Outcome:					
At the end of the c	course the student should be able to					
1. Understand the	concepts related to EMI and EMC, and differentiate b	etween o	conducted and			
radiated emission.						
	e types of EMI coupling mechanisms					
	EMI control technique for a specific identified EMI pr	roblem.				
4. Design an EMC						
	various Radiated EMI Measurements techniques a	and char	mbers.			
6. Understand the	standards for EMI and EMC					
Module:1	EMI/EMC Concepts	3 hour				
	ions – Units - Sources of EMI: Classification, Lightnir					
	liated emission - Conducted and radiated susceptibility					
	erference - Spectrum conservation - Radiation hazard -	 Specifi 	c Absorption Rate			
(SAR).						
Module:2	EMI Coupling Principles	3 hour				
-	ng: Common-mode, Differential-mode - Inductive co	upling -	Capacitive			
coupling - Radiati						
Module:3	EMI Control Techniques -I	5 hour				
	ng principle, system grounding - Shielding: Shielding					
,	elding integrity at discontinuities, Conductive coatings	·	U,			
	nd material for bond strap - general guidelines for goo	1				
Module:4	EMI Control Techniques -II	5 hour				
	acteristics of filters, Impedance mismatch effects, Lun	1	,			
	esign, Common mode filter, Differential mode filter -	-	-			
-	EMI suppression cables, EMC connectors, EMC gaske	ets, Isola	tion transformers,			
	ge suppression devices.					
Module:5	EMC Design of PCBs	5 hour				
	B - SMD / through hole components, Pins, Basic loops					
	out: Grounds and Power, ground bounce, Power distrib					
-	ply decoupling, Board zoning, Signal traces, Cross tal	k, Trace	e routing - Cables			
and connectors.		41				
Module:6	EMI Measurements	4 hour				
	nce measurements: Open area test site measurement, a					
	g chamber - Conducted interference measurements: Cl					
	ts voltages, Conducted EM noise on power supply line					
	d interference immunity: ESD/EFT, Electrical surge -	Time do	omain EMI			
measurement		23				
Module:7	EMC Standards	3 hour				
Military standards	, IEEE/ ANSI Standards, CISPR/IEC, FCC standards,	Europea	an Standards,			

VDE Standards, Other EMC Standards, Company Standards, EMC compliance for wireless devices, Radio Equipment Directive (RED).

Module:8	Contemporary	v issues:		2 hours	
		,	Fotal Lecture hours:	30 hours	
Text Book(s)	•			•	
1. Henry W.Ott, I	Noise Reduction T	echniques in I	Electronic Systems, 20	11, 2 nd Edition, J	ohn
Wiley & Sons, In	c., Hoboken, New	Jersey.			
Reference Books					
1. Clayton R.Pa	ul, Introduction to	Electromagne	tic compatibility, 2010), 2 nd Edition, Jol	nn Wiley
& Sons, Inc.,	Hoboken, New Je	rsey.			
	dré and Kenneth V ion, SciTech Publi		oubleshooting Cookbo	ok for Product E	Designers
			easurements and Techr	1000000000000000000000000000000000000	nd Edition
IEEE Press, N		i interpres, ivi	cusurements and reem	10105105, 2010,2	Luttion,
		sessment Test.	Quiz, Digital Assignm	ent. Challenging	ŗ
	al Assessment Tes		X		>
	ing Experiments				
0	Analysis of RE/	· ·			7 hours
	e		ormance of Radiated En	mission,	
	tibility with respec				
Task2: Test and	Analysis of CE/	CS			7 hours
Develo	p a test setup and	study the perfo	ormance of Conducted	Emission and	
Conducted Susce	ptibility with respo	ect to various	standards.		
Task 3: Compre	hensive study and	d analysis of l	ESD / EFT / Surge		8 hours
	1	•	ted and conducted effe	cts of	
	charge/EFT and Su	ırge			
Task 4:PCB Des	0				8 hours
			of analog and digital pa		
			analog and digital sec	tions that have	
a common referen	nce point using op				
			l Laboratory Hours		30 hours
	on: Continuous an				
	y Board of Studies		26-02-2017		
Approved by Aca	demic Council :	44	Date :	16-03-2017	

	Program Elective	L	Т	P	J	С
ECE2034	Flexible Electronics and Sensors	3	0	0	0	3
Pre-requisite	Basics of Sensor and Wearable Technology	Syl	labus	Ve	rsio	n 1
Course Object	ives: (COB)					
	an overview of flexible electronics technology.					
2. Underst	and the materials and methods used for fabrication of flexible el	lectro	nics.			
3. Applica	tion of flexible electronics as sensors					
Course Outoor						
Course Outcon The student wil						
	and the trends and technologies of flexible electronics and its ro	ad m	an			
	the materials for flexible electronics application.	au III	ap			
•	and the various thin film deposition methods					
	ride the insight of TFT device structures and its characteristics					
1	te the foil type flexible electronics using solution based patternir	ng me	thods	5.		
	o wearable sensors for healthcare, wellness and environmental a	0				
	ntroduction to Flexible Electronics				5 ho	urs
Background and	d history, trends, emerging technologies, general applications, a	reas c	of rese	earc	h.	
	hin-film Deposition and Processing Methods for Flexible evices				7 ho	urs
	PVD, etching, photolithography, low-temperature process integ	gratio	n			
		/				
Module:3 M	Interials for Flexible Electronics				5 ho	urs
	Iaterials for Flexible Electronics				5 ho Ivma	
Nanowire and	nanoparticle synthesis, transition metal oxides, amorphous t	thin f	films,	po	lym	
Nanowire and	nanoparticle synthesis, transition metal oxides, amorphous t s, structure and property relationships, paper-based electronics,	thin f	films,	po	lym	
Nanowire and semiconductors barrier material	nanoparticle synthesis, transition metal oxides, amorphous t s, structure and property relationships, paper-based electronics,	thin f	films,	po stra	lym	eric
Nanowire and semiconductors barrier material Module:4 T	nanoparticle synthesis, transition metal oxides, amorphous t s, structure and property relationships, paper-based electronics, s.	thin f textil	films, e sub	po stra	lymo tes, 5 ho	eric
Nanowire and semiconductors barrier material Module:4 T Fundamental is	nanoparticle synthesis, transition metal oxides, amorphous t s, structure and property relationships, paper-based electronics, s. hin Film Transistors: device structure and performance sues for low-temperature processing, Low-temperature thin-film	thin f textil	films, e sub	po ostra (De	lymo tes, 5 ho vice	eric urs s,
Nanowire and semiconductors barrier material Module:4 T Fundamental is Device structure	nanoparticle synthesis, transition metal oxides, amorphous t s, structure and property relationships, paper-based electronics, s. hin Film Transistors: device structure and performance	thin f textil	films, e sub	po ostra (De	lymo tes, 5 ho vice	eric urs s,
Nanowire and semiconductors barrier material Module:4 T Fundamental is Device structure	nanoparticle synthesis, transition metal oxides, amorphous t s, structure and property relationships, paper-based electronics, s. hin Film Transistors: device structure and performance sues for low-temperature processing, Low-temperature thin-film es and materials processing, Low-temperature a-Si:Hand a-IGZO	thin f textil	films, e sub	po ostra (De	lymo tes, 5 ho vice	eric urs s,
Nanowire and semiconductors barrier material Module:4 T Fundamental is Device structure device performa	nanoparticle synthesis, transition metal oxides, amorphous t s, structure and property relationships, paper-based electronics, s. hin Film Transistors: device structure and performance sues for low-temperature processing, Low-temperature thin-film es and materials processing, Low-temperature a-Si:Hand a-IGZ0 ance, I-V characteristics, device stability.	thin f textil	films, e sub	po ostra De tra	lymo tes, 6 ho vices nsist	urs s, tor
NanowireandsemiconductorsbarriermaterialModule:4TFundamentalSevicestructuredeviceperformationModule:5Sevice	nanoparticle synthesis, transition metal oxides, amorphous t s, structure and property relationships, paper-based electronics, s. hin Film Transistors: device structure and performance sues for low-temperature processing, Low-temperature thin-film es and materials processing, Low-temperature a-Si:Hand a-IGZC ance, I-V characteristics, device stability.	thin f textil	films, e sub sistor 1-film	po ostra De n tra	lymo tes, 5 ho vices nsist	urs s, tor
NanowireandsemiconductorsbarriermaterialModule:4TFundamentalisDevicestructuredeviceperformationModule:5SetInk-jetprinting	nanoparticle synthesis, transition metal oxides, amorphous t s, structure and property relationships, paper-based electronics, s. hin Film Transistors: device structure and performance sues for low-temperature processing, Low-temperature thin-film es and materials processing, Low-temperature a-Si:Hand a-IGZ0 ance, I-V characteristics, device stability.	thin f textil	films, e sub sistor 1-film	po ostra De n tra	lymo tes, 5 ho vices nsist	urs s, tor
NanowireandsemiconductorsbarriermaterialModule:4TFundamentalisDevicestructuredeviceperformationModule:5SetInk-jetprinting	nanoparticle synthesis, transition metal oxides, amorphous t s, structure and property relationships, paper-based electronics, s. hin Film Transistors: device structure and performance sues for low-temperature processing, Low-temperature thin-film es and materials processing, Low-temperature a-Si:Hand a-IGZC ance, I-V characteristics, device stability. olution-based Patterning Processes g, gravure, imprint lithography, spray pyrolysis, surface energy	thin f textil	films, e sub sistor 1-film	po ostra De n tra	lymo tes, 5 ho vices nsist	urs s, tor
NanowireandsemiconductorsbarriermaterialModule:4TFundamentalisDevicestructuredeviceperformationModule:5SolutionInk-jetprintingpatterning,desi	nanoparticle synthesis, transition metal oxides, amorphous t s, structure and property relationships, paper-based electronics, s. hin Film Transistors: device structure and performance sues for low-temperature processing, Low-temperature thin-film es and materials processing, Low-temperature a-Si:Hand a-IGZC ance, I-V characteristics, device stability. olution-based Patterning Processes g, gravure, imprint lithography, spray pyrolysis, surface energy	thin f textil	films, e sub sistor 1-film	po sstra () De n tra () mu	lymo tes, 5 ho vices nsist	urs s, tor urs
Nanowire and semiconductors barrier material Module:4 T Fundamental is Device structure device performation Module:5 So Ink-jet printing patterning, desi	nanoparticle synthesis, transition metal oxides, amorphous t s, structure and property relationships, paper-based electronics, s. hin Film Transistors: device structure and performance sues for low-temperature processing, Low-temperature thin-film es and materials processing, Low-temperature a-Si:Hand a-IGZC ance, I-V characteristics, device stability. olution-based Patterning Processes g, gravure, imprint lithography, spray pyrolysis, surface energ gn rule considerations.	thin f textil	films, e sub sistor n-film	po sstra ())))))))))))))))))	lymo tes, <u>ó ho</u> vice nsist <u>ó ho</u> ltila	urs s, tor urs
Nanowireand semiconductors barrier materialModule:4TFundamentalisDevice structure device performationSetModule:5SetInk-jet printing patterning, desiFDisplays, sensorSet	nanoparticle synthesis, transition metal oxides, amorphous t s, structure and property relationships, paper-based electronics, s. hin Film Transistors: device structure and performance sues for low-temperature processing, Low-temperature thin-film es and materials processing, Low-temperature a-Si:Hand a-IGZC ance, I-V characteristics, device stability. olution-based Patterning Processes g, gravure, imprint lithography, spray pyrolysis, surface energy gn rule considerations. lexible Electronics Applications	thin f textil	films, e sub sistor n-film	po sstra De tra mu	lymo tes, <u>ó ho</u> vice nsist <u>ó ho</u> ltila	urs s, tor urs
Nanowire and semiconductors barrier material Module:4 T Fundamental is Device structure device performation Module:5 So Ink-jet printing patterning, desi Module:6 F Module:7 F Wearable Sensor F	nanoparticle synthesis, transition metal oxides, amorphous t s, structure and property relationships, paper-based electronics, s. hin Film Transistors: device structure and performance sues for low-temperature processing, Low-temperature thin-film es and materials processing, Low-temperature a-Si:Hand a-IGZ0 ance, I-V characteristics, device stability. olution-based Patterning Processes g, gravure, imprint lithography, spray pyrolysis, surface energy gn rule considerations. lexible Electronics Applications or arrays, memory devices, MEMS, lab-on-a-chip, and flexible so lexible Sensors rs: Flex sensor, pulse oximeter, glucose sensor, ECG sensor, Inertice supervised of the sensor of the se	thin f textil	films, e sub sistor n-film Fects,	po sstra ())))))))))))))))))	iyma tes, <u>5 ho</u> vice nsist <u>5 ho</u> ltila <u>5 ho</u>	urs s, tor urs yer urs
Nanowire and semiconductors barrier material Module:4 T Fundamental is Device structure device performation Module:5 So Ink-jet printing patterning, desi Module:6 F Module:7 F Wearable Sensor F	nanoparticle synthesis, transition metal oxides, amorphous t s, structure and property relationships, paper-based electronics, s. hin Film Transistors: device structure and performance sues for low-temperature processing, Low-temperature thin-film es and materials processing, Low-temperature a-Si:Hand a-IGZC ance, I-V characteristics, device stability. olution-based Patterning Processes g, gravure, imprint lithography, spray pyrolysis, surface energy gn rule considerations. lexible Electronics Applications r arrays, memory devices, MEMS, lab-on-a-chip, and flexible so	thin f textil	films, e sub sistor n-film Fects,	po sstra ())))))))))))))))))	iyma tes, <u>5 ho</u> vice nsist <u>5 ho</u> ltila <u>5 ho</u>	urs s, tor urs yer urs
Nanowire and semiconductors barrier material Module:4 T Fundamental is Device structure device performation Module:5 So Ink-jet printing patterning, desi Module:6 F Displays, senso Module:7 F Wearable Senso sensor, pH senso	nanoparticle synthesis, transition metal oxides, amorphous t s, structure and property relationships, paper-based electronics, s. hin Film Transistors: device structure and performance sues for low-temperature processing, Low-temperature thin-film es and materials processing, Low-temperature a-Si:Hand a-IGZ0 ance, I-V characteristics, device stability. olution-based Patterning Processes g, gravure, imprint lithography, spray pyrolysis, surface energy gn rule considerations. lexible Electronics Applications or arrays, memory devices, MEMS, lab-on-a-chip, and flexible so lexible Sensors rs: Flex sensor, pulse oximeter, glucose sensor, ECG sensor, Inertice supervised of the sensor of the se	thin f textil	films, e sub sistor n-film Fects,	po sstra ())))))))))))))))))	iyma tes, <u>5 ho</u> vice nsist <u>5 ho</u> ltila <u>5 ho</u>	urs s, tor urs urs ion

		1	Sotal Lecture:	45 hours
Tex	t Book(s)		I	
1	William S. Wong, Alberto Salleo, Fle	xible Electronics:	Materials and	Applications, 2011,
	1 st Edition, Springer, New York.			
2	Guozhen Shen, Zhiyong Fan, "Flexibl	e Electronics: Fro	m Materials to	Devices ", 2015, 1 st
	Edition, World Scientific Publishing Co	o, Singapore		
Ref	erence Books			
1	Edward Sazonov, Michael R. Newman,	"Wearable Sensor	rs: Fundament	als,
	Implementation and Applications ", 2	014, 1 st Edition, Ac	ademic Press, C	ambridge.
2	Kate Hartman, "Make: Wearable El			d wear your own
	interactive garments", 2014, 1 st Editio	n, Marker Media, N	Netherlands.	
3	Yugang Sun, John A. Rogers, "Semic	onductor Nanoma	aterials for Fle	xible Technologies:
	From Photovoltaics and Electronics			e (Micro and Nano
	Technologies)", 2011, 1 st Edition, Will	iam Andrew, New `	York.	
Mod	de of Evaluation: CAT, Digital Assignm	ents, Quiz, Online	course, Paper p	oublication, Projects,
Hac	kathon/Makeathon and FAT			
App	roved by Academic Council	54	Date	14-03-2019

Course Code			P J	С					
ECE3002		3 0 2	2 0	4					
Prerequisite:	ECE2003 Digital Logic Design								
Course Object	ivog								
Course Objectives: 1. To understand MOS device characteristics and to implement simple gates using CMOS									
logic style with delay and power constraints									
	erstand the CMOS fabrication process styles including layout desig	n rules							
	gn combinational and sequential circuits using different logic style	•							
	nodern EDA tools to simulate and synthesize VLSI circuits								
Expected Cour									
	nderstanding of fundamental concepts of MOS transistors								
	design simple logic gates using CMOS logic style								
	calculate power and delay of simple CMOS circuits								
	and fabrication processes and their impact on the circuit performa								
	design and validate combinational and sequential circuits usin	g differ	ent lo	ogic					
styles	design VI SI simplify at such system shotmation layed								
	design VLSI circuits at sub-system abstraction level use modern EDA tools to design VLSI circuits								
	ar understanding of the subject related concepts and of contempora	ry issue	<u> </u>						
-	in thinking capability	ii y issue	3						
	bility to design and conduct experiments, as well as to analyze and	l interpr	et dat	a					
	OS Transistor Theory		iours						
	stics, C-V Characteristics, Non ideal I-V effects of MOS Transistor								
Module:2 C	MOS Logic	51	nours						
Basic gates, C	compound Gates, Transmission Gates based combinational and	sequent	ial lo	ogic					
design									
	MOS Circuit characterization and Performance Estimation		ours						
	Characteristics of CMOS inverter, Circuit characterization at ay estimation, Logical effort and Transistor Sizing. Power Diss								
Dynamic Powe		ipation.	Static						
Dynamic I owe									
Module:4 C	MOS Fabrication and Layout	51	iours						
	s Technology N-well, P-well process, Stick diagram for Boolean								
	Layout Design Rule			0					
Module:5 CI	MOS Combinational Circuit Design	71	nours						
Static CMOS,	Ratioed Logic, Cascode voltage Switch Logic, Dynamic circuits,	Pass T	ansis	tor					
Circuits									
	MOS Sequential Circuit Design		ours						
	MOS Latches and Flip Flops, Pulsed Latches, Resettable and Ena	bled Lat	ches	and					
Flip Flops									
Module:7 Su									
winner/ 1 Ni	h System Design	()							
	ib System Design		iours						
Single bit Adde	r, Carry look ahead adder, Carry propagate Adder, Magnitude Co								
Single bit Adde	• 0								

Mo	dule	8 C	ontemproray Issues				2 hours
				,	Total Lecture Ho	urs:	45 hours
Tex	t Bo	oks:					
1.	Neil	H.We	este, Harris, A. Banerjee,	"CMOS VL	SI Design, A c	ircuits	and System
	Pers	pectiv	e", 2014, Fourth Edition, Pea	arson Education	n, Noida, India.		-
Ref	eren	ce Boo	ks:				
1.			baey, Anantha Chadrakasa rspective", 2014, Third Editio			0	d Circuits: A
2.	Yog	esh Cl	nauhan, Darsen Duane Lu, V	/anugopalan Si	riramkumar, Soura	bh Kha	andelwal, Juan
	Dua	rte, Na	avidPayvadosi, Ai Niknejad,	, Chenming Hu	ı, "FinFETModeli	ng for	IC Simulation
	and	Design	n", 2015, Academic Press, El	sevier.			
			ation: Continuous Assessme	· · · · · · · · · · · · · · · · · · ·			
(CA	T-II)), Digit	al Assignments/ Quiz / Com	pletion of MOC	DC, Final Assessm	ent Tes	st (FAT).
<u> </u>	-	.		/ T 10 / 1 ×			1
SI.N			f Challenging Experiemnts				0.1
1		i. 	Cadence EDA Tool Demo			100	8 hours
		ii. 	Basic Cell structure (NMO		sing conventional N	105	
		iii.	Verification with different				
			esign and Analysis of CMOS				
		-	analysis: Power, Delay, NM,	PDP)			
			Design: Sizing)	<u> </u>			0.1
2	2	i.	Cadence EDA Tool Demo	& Hands on -1	Layout & Post Lay	out	8 hours
			Simulation				
		11. 	Basic Cell layout (CMOS)				
		iii.	Fingering and folding	CC (1 1	1		
~	,	1V.	Standard cell design for dif		bgy node		0.1
3)	i.	Adder Design using conver				8 hours
		ii. 	Multiplier using convention				
		iii.	Memory design (SRAM /D				
4	1	iv.	Level converters (Optional)	,			(h anna
4	ł	i. ;;	ALU Design using conven Simple Processor Design u		nal CMOS		6 hours
		ii.	Simple Processor Design u	-		[20 hours
				10	otal Laboratory H	iours:	30 hours
Moo (FA		Evalua	ation: Continuous Assessmer	nt of Challengir	ng experiments / Fi	inal As	sessment Test
	omm	ended	by Board of Studies :		28-02-2016		
· ·	omm	enaca					

Course Co	le Course title	L	Т	P	J	С	
ECE 3010	ANTENNA AND WAVE PROPAGATION	3000Syllabus versi					
Pre-requisi	te ECE2004 – Transmission Lines and Waveguides	Syl	labı	is v	ersi	on	
						1.1	
Course Ob							
radia 2. To u ante 3. To	ntroduce and discuss the mechanism and models for radio-wave p ating principles and fundamental characteristics and parameters of a understand operating principles and design concepts of antenna at nnas. design & analyze microwave frequency antennas and also to b nna applications in various types of communication.	anter rrays	inas , HI	F an	d V	HF	
Expected (ourse Outcomes:						
	tify the type of radio-wave propagation for different communication	n					
	prehend the radiation mechanism of wired antennas and dipoles.						
	tify basic antenna parameters and contrast radiation patterns of diff	feren	t ant	tenn	as.		
	gn and analyze antenna arrays and wire antennas						
	gn and analyze aperture antennas and patch antennas						
	ropriate identification of an antenna for a specific application.						
Module:1	Wave Propagation			hou			
	Mechanism - Reflection, refraction, transmission, Scattering						
	Model- Path Loss, Free space loss - Plane earth Loss - Modelive Propagation, Space wave propagation- tropospheric Prop						
mechanism	- Ionospheric Propagation - Structure of ionosphere, Skip dista Virtual height, Critical frequency, MUF.						
Module: 2	EM Radiation		6	hou	irs		
Radiation in	nechanism-single wire, two wire, dipole and current distribut tegrals and auxiliary potential functions, Radiated field componen ipole, monopole antenna						
Module: 3	Antenna Parameters and Measurements		6	hou	rs		
Radiation p bandwidth, efficiency,	attern, beam width, field region, radiation power density, dir polarization - co polarization and cross polarization level, antenna effective length and area, antenna temperature. Friss Tra e equation. Measurements - radiation pattern- gain- directive nts.	inp nsm	ut issic	imp on fe	edaı orm	nce, ula,	
Module: 4	Linear and Planar Arrays		8	hou	rs		
Two element pattern, patt	nt array, N-element linear array- broadside array, End fire array-D ern multiplication. Non-uniform excitation- Binomial, Chebyshev ar array –array factor, directivity – Phased Array antenna						
Module:	HF and VHF Antennas		5	hou	re		
mouule.		1	5	nou	11.2		

5	
Wire Anter	nnas - long wire, V-Antenna, rhombic antenna, loop antenna-helical antenna, Yagi-Uda
antenna	

Module: 6	UHF and Microwave Anter	nnas		7 hours
	independent antennas - spira arabolic reflector antenna- Mic		antenna- Aperture	e antennas – Horn
Module: 7	Antennas for Modern Wire	less Communication	ons	3 hours
Satellite C	or Terrestrial mobile commun ommunication, Radar system enna, MIMO antenna.			
Module: 8	Contemporary issues			2 hours
		Tota	l Lecture hours	45 hours
Text Book	(s)			
	alanis, "Antenna Theory - A ork, USA.	nalysis and Design	", 2016, 3 rd editio	n, Wiley & Sons,
Reference	Books			
1 Warren	L. Stutzman and Gary A. T.	hiele, "Antenna the	eory and Design",	2013, 3 rd edition,
. Wiley	& Sons, New York, USA.			
	Trauss, R. J. Marhefka and A., Tata McGraw-Hill, New Dell		a and Wave Propa	agation", 2012, 4 th
	Sabban, "Wideband RF Tecl Wiley, New York USA.	hnologies and Ant	ennas in Microwa	we Frequencies",
	valuation: Continuous Assess			
(CAT-II), I	Jighai Assignments/ Quiz / Co		, i mai noocoomen	
	Digital Assignments/ Quiz / Co ded by Board of Studies :	13.12.2015		1 10st (1741).

ECE2011	Course Title			P 2	J	<u>C</u>
ECE3011	Microwave Engineering	3	-	2	4	5
Pre-requisite	ECE2004 – Transmission Lines and Waveguides	Syl	labu	s ve	ersio	
						1.
Course Objec						
	erstand the importance of microwave circuits and applications. prehend operational principles of microwave sources and to c		toriz	0		
	vave networks.	narac	lenzo	e		
	ign and analyze various passive and active microwave circuits.					
	<u>8</u>					
Expected Cou	irse Outcomes:					
<u> </u>	ntify various applications and measurement schemes for microv	wave	circu	iits.		
	mprehend the performance of different microwave sources and	ferrite	e dev	vices	s.	
	alyze microwave circuits using scattering parameters.					
	sign and analyze power dividers and couplers at microwave free	quenc	ies.			
	sign and analyze low pass filters at microwave frequencies.					
	derstand the importance of high frequency transistors to des	sign r	micro	owa	ve	
	plifiers. asure the performance of microwave passive devices using test	henc	h cot	un 4	and a	10
	ulate and analyze microstrip passive and active circuits.	UCIIC	n set	up a		115
	sign the microwave circuits to suit the needs of industry.					
	ficrowave measurements and applications		4 h	loui	ſS	
	equencies (IEEE Standards), microwave measurements - guide	e wav	elen	oth	VSV	VF
applications.			0.1			
	ficrowave Sources		8 h			4 -
	ibes: TWT, Klystron amplifier, Reflex Klystron, Magnet diode, Tunnel diode, IMPATT-TRAPATT-BARITT diodes, P				nauc	lOI
Devices. Oum			iouc.	•		
					rs	
Module:3 N	licrowave Network Analysis		6 h	10U		na
	ficrowave Network Analysis rix - reciprocal networks and lossless networks, generalized	S-para			- sig	
Scattering ma	Č	S-para			- sig	
Scattering ma flow graph – c	rix - reciprocal networks and lossless networks, generalized a ecomposition of signal flow graphs.	S-para	amet	ers		
Scattering ma flow graph – c	rix - reciprocal networks and lossless networks, generalized	S-para		ers		
Scattering ma flow graph – c Module:4 P	rix - reciprocal networks and lossless networks, generalized a ecomposition of signal flow graphs.		amet	ers		
Scattering ma flow graph – c Module:4 F S-matrix analy	rix - reciprocal networks and lossless networks, generalized secomposition of signal flow graphs. ower dividers sis of E-Plane Tee, H-Plane Tee, Magic Tee, Multi-hole directi	onal o	amet 9 h	ers nou	rs	er
Scattering ma flow graph – c Module:4 P S-matrix analy Introduction to	rix - reciprocal networks and lossless networks, generalized a ecomposition of signal flow graphs. ower dividers rsis of E-Plane Tee, H-Plane Tee, Magic Tee, Multi-hole direction of Microstrip lines. T junction and resistive power divider, Wilk	onal c	amet 9 h	ers nou	rs	er
Scattering ma flow graph – c Module:4 P S-matrix analy Introduction to	rix - reciprocal networks and lossless networks, generalized secomposition of signal flow graphs. ower dividers sis of E-Plane Tee, H-Plane Tee, Magic Tee, Multi-hole directi	onal c	amet 9 h	ers nou	rs	er
Scattering ma flow graph – c Module:4 P S-matrix analy Introduction to branch line co	rix - reciprocal networks and lossless networks, generalized a ecomposition of signal flow graphs. ower dividers rsis of E-Plane Tee, H-Plane Tee, Magic Tee, Multi-hole direction of Microstrip lines. T junction and resistive power divider, Wilk	onal c	amet 9 h	ers nou ler. ver o	rs divid	er
Scattering ma flow graph – c Module:4 P S-matrix analy Introduction to branch line co Module:5 N Properties of t	rix - reciprocal networks and lossless networks, generalized a ecomposition of signal flow graphs. ower dividers rsis of E-Plane Tee, H-Plane Tee, Magic Tee, Multi-hole direction Microstrip lines. T junction and resistive power divider, Wilk upler (equal & unequal), Rat Race Coupler (180° hybrid couple	onal c inson r).	9 h coupl pow	ers nou ler. ver o	rs divid	
Scattering ma flow graph – c Module:4 P S-matrix analy Introduction to branch line co Module:5 N Properties of t	rix - reciprocal networks and lossless networks, generalized a ecomposition of signal flow graphs. ower dividers rsis of E-Plane Tee, H-Plane Tee, Magic Tee, Multi-hole direction o Microstrip lines. T junction and resistive power divider, Wilk upler (equal & unequal), Rat Race Coupler (180° hybrid couple ficrowave Ferrite devices	onal c inson r).	9 h coupl pow	ers nou ler. ver o	rs divid	
Scattering ma flow graph – c Module:4 P S-matrix analy Introduction to branch line co Module:5 N Properties of the Shifter.	rix - reciprocal networks and lossless networks, generalized a ecomposition of signal flow graphs. ower dividers rsis of E-Plane Tee, H-Plane Tee, Magic Tee, Multi-hole direction o Microstrip lines. T junction and resistive power divider, Wilk upler (equal & unequal), Rat Race Coupler (180° hybrid couple ficrowave Ferrite devices ferromagnetic materials, principle of faraday rotation, isolator,	onal c inson r).	9 h coupl pow 4 h ilator	ers noun ler. ver o noun r an	rs divid rs d ph	
Scattering ma flow graph – c Module:4 P S-matrix analy Introduction to branch line co Module:5 N Properties of t Shifter.	rix - reciprocal networks and lossless networks, generalized a ecomposition of signal flow graphs. ower dividers sis of E-Plane Tee, H-Plane Tee, Magic Tee, Multi-hole direction of Microstrip lines. T junction and resistive power divider, Wilk upler (equal & unequal), Rat Race Coupler (180° hybrid couple ficrowave Ferrite devices ferromagnetic materials, principle of faraday rotation, isolator, IW Filters (Microstrip line)	onal c inson r).	9 h coupl pow 4 h ilaton	ers noun ler. ver o r an	rs divid rs d ph	as
Scattering ma flow graph – c Module:4 P S-matrix analy Introduction to branch line co Module:5 N Properties of t Shifter. Module:6 N Filter design	rix - reciprocal networks and lossless networks, generalized a ecomposition of signal flow graphs. ower dividers rsis of E-Plane Tee, H-Plane Tee, Magic Tee, Multi-hole direction o Microstrip lines. T junction and resistive power divider, Wilk upler (equal & unequal), Rat Race Coupler (180° hybrid couple ficrowave Ferrite devices ferromagnetic materials, principle of faraday rotation, isolator,	onal c inson r). circu	9 h coupl pow 4 h ilaton	ers noun ler. ver o r an	rs divid rs d ph	as

		Microwave Amplifiers				6 hours
		Transistors: BJT, FET, ME				o port power gains,
stabi	ility of t	he amplifier- design of single	e stage am	plifier for 1	naximum gain.	
Mod	lule: 8	Contemporary issues				2 hours
					-	
				Total L	ecture hours:	45 hours
	t Book(th		
		Pozar, "Microwave engineerin	ng", 2012,	4 th edition	, John Wiley &	Sons, USA
	erence l					nd
1.		t, E. Collin, "Foundations o	f Microw	ave Engin	eering", 2014 (Reprint), 2 nd edition,
		Viley & Sons, USA			the second state	
2.		burna Das and S.K. Das, "Mi	crowave	Engineerin	g", 2017, 3 rd ec	lition, Tata McGraw-
-	Hill, I			<u> </u>	<u> </u>	ord the D
3.		el Y. Liao, "Microwave Dev	vices and	Circuits",	2015 (Reprint)	, 3 rd edition, Pearson
M		tion, UK.	(T		D. C:	
		valuation: Continuous Assess				
		vigital Assignments/ Quiz / Co	-		, Filiai Assessiii	ent lest (FA1).
		llenging Experiments (India	-			
1.	•	sis of S-Parameters for th	e wavegi	uide comp	oonents using	6 hours
•		wave test bench				
2.		m the circuit analysis and e		netic simu	lation of equal	6 hours
2		equal Wilkinson power divid			£ 1	<u>(</u>]
3.	0	and perform the electroma	ignetic si	mulation c	of branch line	6 hours
4		er and Rat-race coupler.		lation for	low noss filton	6 hours
4.		m the circuit and electromag steeped impedance method ar				o nours
5.	0	maximum gain and specific g				6 hours
э.		maximum gain and specific gomagnetic simulation for mici				o nours
	ciccut	magnetic simulation for filler			boratory hours	30 hours
Mod	le of Fu	aluation: Continuous Assessr	nent of Cl			
		led by Board of Studies :		13.12.2015	1	ai Assessinent 10st.
RUU	Jinnen	ice by board of Studies.		13.12.2013	,	
App	roved b	y Academic Council	No. 40		Date	18-03-2016
r r		/	1			

Course Code	e Course Title		L	Т	P	J	C		
ECE3035	RFID AND FLEXIBLE SENSO	RS	3	0	0	0	3		
Pre-requisite	e ECE2023-Principles of Sensors and Data A	cquisition		<u> </u>	Versi	ion :	:1.1		
Course Obje		_	I						
	The course is aimed at making the students to								
	knowledge of different types of materials and met	hods used fo	or fabrio	catio	n of t	flexi	ble		
electronics.	0 11								
2. Understan	d and designing Radio frequency identification	(RFID) sys	stems.	mide	llewa	are			
	for real-world applications.		,						
	road map for transformation of flexible electronics	s from foils t	o textil	es					
	the principle and applications of flexible sensors.								
Course Outco									
	the course, the student will be able to								
	r understanding of the RFID related components,	concents and	1 conte	mnoi	rary i	C C I I C	20		
	F component or a product applying all the relevant						<i>.</i> . .		
-	a rudimentary level.	t standards a	nu wiu	Tica	iistic				
	whedge for use of RF technology for a wide range	o of applicati	ong						
	• • •			on fl	awih1	~			
electronics	d picture of the material related concepts and fabri	ication techn	iques i	or ne	exidi	e			
	t the recent trands in wearship technology								
	t the recent trends in wearable technology.	ainal ahami	1		1	1			
	nowledge of wearable technology for use in biolo	gical, chemic	cal and	mec	nam	cal			
processes.	1 1 1 1 1 1 1 1 1								
	owledge on sensors in electronic textile domain.								
	Overview of RFID Technology	7 hours							
	Core components of RFID systems-RFID Tags- R								
	requency- selection criteria for RFID systems- Au					ıta			
	ns- Smart Tags vs. Barcodes- RFID technology in		1 mana	geme	ent.				
Module:2	RFID Middleware and Information	6 hours							
	Technology Integration		• 1 11	<u> </u>		11			
	ware- Recent focus on middleware- Core function								
	f an RFID system-The EPC architecture- Present		leware	deve	elopr	nent	•		
Module:3	Applications of RFID Technology	6 hours							
U	FID applications: Access control-Transportation 7	0							
	fication- Production line monitoring, Long range		ations:	Supp	ply cl	nain			
	Mail and shipping-Clothing tags-Food production								
Module:4	Materials and Novel patterning methods for	6 hours							
	flexible electronics								
Introduction,	Inorganic semiconductors and dielectrics, organic	semiconduct	tors and	d die	lectri	cs,			
conductors - F	Print processing options for device fabrication: Ov	erview, contr	rol of f	eatur	e siz	es of	f		
jet printed liqu	uids, jet printing for etch mask patterning, method	s for minimiz	zing fe	ature	size	,			
printing of act	ive materials.								
Module:5	Wearable Haptics	6 hours							
World of wea	rables - Attributes of wearables - Textiles and clot	hing: The me	eta wea	arabl	e -				
	d opportunities - Future of wearables - Need for w					egor	ies		
of wearable h		1				U			
Module:6	Wearable Bio, Chemical and Inertial	6 hours							
	sensors								
Introduction-S	Systems design - Challenges in chemical and bioch	hemical sensi	ing - A	pplic	cation	1 are	eas		
	rtial sensors - obtained parameters from inertial se								
	rs - Practical considerations for wearable inertial se								
metion sensor									

From fibers to textile ser monitoring - Biomechan	ectronic tex	tilog			
monitoring - Biomechan		uies		6 hours	
-	sors - Interla	ced network	-Textile senso	ors for phys	siological state
•	cal sensing -	• Noninvasive	e sweat monito	oring by tex	xtile sensors and other
applications.	-				
Module:8 Contempo	orary issues:			2 hours	
· · · ·			·	Total I	Lecture hours: 45 hours
Text Book(s)					
1. Amin Rida and Ma	anos M. Tent	zeris, RFID-	Enabled Senso	or Design a	and Applications
(Artech House In	tegrated Mic	rosystems), 2	2011, 1 st editio	n, Artech l	House Publishers, UK.
Reference Books					
1. Min-Chen, and S				ternet of T	hings (Wireless
Network), 2016,	1 st edition, S ₁	pringer, USA			
			an Stojmenovi	c, RFID S	ystems: Research Trends
and Challenges, 2		•			
		lleo, Flexible	Electronics: N	Aterials a	nd Applications, 2011,
1 st ed., Springer,					
	• •			Materials	to Devices, 2015, 1st
Edition, World S		•			
5. Yugang Sun, Joh	•				0
					(Micro and Nano
Technologies), 20					
Mode of Evaluation: Con	ntinuous Asse	essment Tests	s, Quiz, Digita	l Assignm	ent, Final Assessment
Test					
Recommended by Board			26-02-2017		-
Approved by Academic	Council :	44	Date :		16-03-2017

Course code	Course title		L T P J C
ECE 3036	SENSORS FOR STRUCTURAL HEA	LTH	2 0 0 4 3
	MONITORING		
Pre-requisite	ECE2023 Principles of Sensors and Data Acquis	ition	Version:1
Course Objective			
The course is aim			
	rview of sensors their principles and applications in		
	areness of a variety of challenges that structural hea	lth monitoring	environment
presents to the ser			
	the future technologies in the structural health moni	toring.	
Expected Course			
	course, the student should be able to		
1. Aware structura	al health monitoring applications and technical chall	lenges	
2. Gain knowledg	e on Vibration based Techniques for SHM		
3. Understand abo	out SHM using Piezoelectric Sensors, Fiber Optic Se	ensors and Elec	ctrical
resistance			
4. Relate Low Fre	equency Electromagnetic Techniques for SHM		
5. Relate Capaciti	ve Methods for SHM in Civil Engineering		
6. Develop a nove	el prototype models for health monitoring of various	structure.	
7. Understand abo	ot fiber optic sensors for phase modulation and wave	elength based s	ensor
Module:1	Introduction	4 hours	
Need for structura	l health monitoring, technical challenges, potential	applications in	civil, naval,
	ufacture engineering. definition of damage, structura		
smart materials			
Module:2	Vibration based Techniques for SHM	3 hours	
Basic vibration an	nd modal analysis- Frequency domain methods, time	e domain metho	ods, mode
shape methods. Li	imitations of vibration based damage detection tech	niques.	
Module:3	SHM using Piezoelectric Sensors	5 hours	
Lamb wave struct	ure interrogation, sensor technology, localized dam	age with guide	d waves in
composite materia	als, electro-mechanical impedance in defect detection	on in metallic a	nd composite
parts.			
Module:4	SHM using Electrical Resistance	4 hours	
Composite damag	e, electrical resistance of unloaded composite, influ	ence of temper	ature,
composite strain a	and damage monitoring-piezoresistivity and strain se	ensing, damage	localization,
Corrosion sensors			
Module:5	Low Frequency Electromagnetic Techniques	5 hours	
Maxwell's equation	on, dipole radiation, surface impedance, diffraction,	eddy current, p	oolarization of
	cations to NDE/NDT domain- Application to SHM		
electric method, h	ybrid method.	-	
Module:6	Capacitive Methods for SHM in Civil	3 hours	
	Engineering		
Principle, capacita	ance probe for cover concrete, applications for exter	nal post-tensio	ned cable,
capacitance probe	for moisture monitoring in historic buildings.		
Module:7	Fiber Optic Sensors	4 hours	
Intensity based, pl	hased modulated or interferometers, wavelength bas	sed or Fiber Bra	agg gratings.
FBG as strain and	temperature sensor, FBGs as damage sensors for co	omposites, app	lications in
aeronautics and ci			
Module:8	Contemporary issues:	2 hours	
L	Total Lecture hours:	30 hours	i

Text Book(s)

1. Daniel Balageas, Claus-Peter Fritzen and Alfredo Güemes, Structural Health Monitoring, 2010, John Wiley & sons, USA

Reference Books

- 1. Victor Giurgiutiu, Structural Health Monitoring with Piezoelectric wafer Active Sensors, 2014, 2nd edition, Academic Press, USA
- 2. Branko Glisic, Daniele Inaudi, Fiber Optic Methods for Structural Health Monitoring, 2008, Wiley, USA
- 3. D Huston, Structural Sensing, Health Monitoring and Performance Evaluation, 2010, CRC Press, USA

Mode of Evaluation: Continuous Assessment Tests, Quiz, Digital Assignment, Final Assessment Test

Typical Projects:

- 1. Design and develop a structural load measurement system using strain gages
- 2. Implement a Health monitoring system using fiber optic sensors in suspended structures
- 3. Develop a Wireless acoustic emission sensor system for bridge monitoring
- 4. Structural deformation detection using wireless sensor network
- 5. Detection of internal corrosion caused by water seepage
- 6. Health monitoring of submersible navy composites
- 7. Develop a Damage detection system in aerospace structure

Mode of Evaluation: Continuous Assessment Reviews

Recommended by Board of Studies:		26-02-2017		
Approved by Academic Council :	44	Date :	16-03-2017	

ECE3038 MEMS AND NANOSENSORS 3 0 </th <th>Course Co</th> <th>de</th> <th>Course Title</th> <th>LT</th> <th>Р</th> <th>JC</th>	Course Co	de	Course Title	LT	Р	JC
Pre-requisite ECE 2023 - Principles of Sensors and Data Acquisition Version : 1.1 Course Objectives: The course is aimed at 1. Introducing and discuss the historical background of evolution of MEMS and Microsystems and their applications as miniaturized sensors and actuators 2. Educating on the rudiments of various materials used in MEMS fabrication and discuss scaling effects in miniaturizing devices. 3. Comprehendingvarious modern Micro-Nano fabrication techniques, device integration, packaging and bonding and highlight the applications of MEMS and Nano sensors to disciplines beyond Electrical and Mechanical engineering. Expected Course Outcome: At the end of the course, the student should be able to 1. 1. Understand the historical background of evolution of MEMS and Microsystems to the students. 2. Comprehend the various micro sensing and actuating units were provided to the students. 2. Comprehend the various micro sensing and actuating units were provided to the students. 3. Discuss about scaling effects in different Physical domains on miniaturizing devices was done with the students. 4. Rudiments of silicon and various polymer materials for MEMS fabrication was discussed with students. 5. Explore latest micromachining techniques for complete device integration, packaging and bonding. 6. Acquaint the students with Basics of Nanotechnology and its approaches towards nano-device realization. Module1 Introduction to Microsystems technology,				3 0		03
Course Objectives: The course is aimed at 1. Introducing and discuss the historical background of evolution of MEMS and Microsystems and their applications as miniaturized sensors and actuators 2. Educating on the rudiments of various materials used in MEMS fabrication and discuss scaling effects in miniaturizing devices. 3. Comprehendingvarious modern Micro-Nano fabrication techniques, device integration, packaging and bonding and highlight the applications of MEMS and Nano sensors to disciplines beyond Electrical and Mechanical engineering. Expected Course Outcome: At the end of the course, the student should be able to 1. Understand the historical background of evolution of MEMS and Microsystems to the students. 2. Opprehend the various micro sensing and actuating units were provided to the students. 3. Discuss about scaling effects in different Physical domains on miniaturizing devices was done with the students. 4. Rudiments of silicon and various polymer materials for MEMS fabrication was discussed with students. 5. Explore latest micromachining techniques for complete device integration, packaging and bonding. 6. Acquain the students with Basics of Nanotechnology and its approaches towards nano-device realization. Module:1 Introduction to Microsystems technology, Microsystems and Miniaturization, The multi disciplinary nature of MEMS, Smart materials, Structures and Systems, RF MEMS, MOEMS, BioMEMS, Applications of MEMS in various industries. Module:2 Micro Sensors and Actuators 6				Versio	n:	1.1
The course is aimed at 1. Introducing and discuss the historical background of evolution of MEMS and Microsystems and their applications as miniaturized sensors and actuators 2. Educating on the rudiments of various materials used in MEMS fabrication and discuss scaling effects in miniaturizing devices. 3. Comprehending various modern Micro-Nano fabrication techniques, device integration, packaging and bonding and highlight the applications of MEMS and Nano sensors to disciplines beyond Electrical and Mechanical engineering. Expected Course Outcome: At the end of the course, the student should be able to 1. Understand the historical background of evolution of MEMS and Microsystems to the students. 2. Comprehend the various micro sensing and actuating units were provided to the students. 3. Discuss about scaling effects in different Physical domains on miniaturizing devices was done with the students. 4. Rudiments of silicon and various polymer materials for MEMS fabrication was discussed with students. 5. Explore latest micromachining techniques for complete device integration, packaging and bonding. 6. Acquaint the students with Basics of Nanotechnology and its approaches towards nano-device realization. Module:1 Introduction to Microsystems technology, Microsystems and Miniaturization, The multi disciplinary nature of MEMS, smart materials, Structures and Systems, RF MEMS, MOEMS, BioMEMS, Applications of MEMS in various industries. Module:3 Scaling Laws in Miniaturization 6 hours Module:4 Materials for Mems and Microsystems 6 hours Module:5 Fabrication Process 6 hours Module:5 Fabrication Process 6 hours 6 hours 6 hours 7 houl:6 Micro System And Microsystems 7 hours 7 houle Asserted and series of the students and Microsystems 7 houle 4 haterials for Mems and Microsystems 7 houle 4 haterials for Mems and Microsystems 7 hours 7 houle:9 Micro Sensors and Actuators 7 hours 7 hour	_					
their applications as miniaturized sensors and actuators 2. Educating on the rudiments of various materials used in MEMS fabrication and discuss scaling effects in miniaturizing devices. 3. Comprehending various modern Micro-Nano fabrication techniques, device integration, packaging and bonding and highlight the applications of MEMS and Nano sensors to disciplines beyond Electrical and Mechanical engineering. Expected Course Outcome: At the end of the course, the student should be able to 1. Understand the historical background of evolution of MEMS and Microsystems to the students. 2. Comprehend the various micro sensing and actuating units were provided to the students. 3. Discuss about scaling effects in different Physical domains on miniaturizing devices was done with the students. 4. Rudiments of silicon and various polymer materials for MEMS fabrication was discussed with students. 5. Explore latest micromachining techniques for complete device integration, packaging and bonding. 6. Acquaint the students with Basics of Nanotechnology and its approaches towards nano-device realization. 7 Module:1 Introduction to Microsystems technology, Microsystems and Miniaturization, The multi disciplinary nature of MEMS in various industries. Module:2 Micro Sensors and Actuators 6 hours Module:3 Scaling Laws in Miniaturization 6 hours 1 Module:3 Scaling Laws in Miniaturization 1 Module:3 Scaling Laws in Miniaturization 1 Module:3 Scaling Laws in Miniaturization 1 Module:4 Materials for Mems and Microsystems 6 hours 2 Module:5 Fabrication Process 6 hours 2 Module:5 Fabrication Process 6 hours 2 Module:6 Micro System Manufacturing 6 hours 2 Module:7 Nano Scaling in Mechanical Domain, Electrostatic Domain, Magnetic Domain 2 And Thermal Domain 2 Module:7 Mano Scaling in Mechanical Domain, Electrostatic Domain, Magnetic Domain 2 Module:7 Materials for Mems and Microsystems 8 of hours 2 Module:7 Materials for Mems and Microsystems 9 of microacelectric materials, Projecelectric materials, Polymers 9 Module:7 Materials for Mems	•					
their applications as miniaturized sensors and actuators 2. Educating on the rudiments of various materials used in MEMS fabrication and discuss scaling effects in miniaturizing devices. 3. Comprehending various modern Micro-Nano fabrication techniques, device integration, packaging and bonding and highlight the applications of MEMS and Nano sensors to disciplines beyond Electrical and Mechanical engineering. Expected Course Outcome: At the end of the course, the student should be able to 1. Understand the historical background of evolution of MEMS and Microsystems to the students. 2. Comprehend the various micro sensing and actuating units were provided to the students. 3. Discuss about scaling effects in different Physical domains on miniaturizing devices was done with the students. 4. Rudiments of silicon and various polymer materials for MEMS fabrication was discussed with students. 5. Explore latest micromachining techniques for complete device integration, packaging and bonding. 6. Acquaint the students with Basics of Nanotechnology and its approaches towards nano-device realization. 7 Module:1 Introduction to Microsystems technology, Microsystems and Miniaturization, The multi disciplinary nature of MEMS in various industries. Module:2 Micro Sensors and Actuators 6 hours Module:3 Scaling Laws in Miniaturization 6 hours 1 Module:3 Scaling Laws in Miniaturization 1 Module:3 Scaling Laws in Miniaturization 1 Module:3 Scaling Laws in Miniaturization 1 Module:4 Materials for Mems and Microsystems 6 hours 2 Module:5 Fabrication Process 6 hours 2 Module:5 Fabrication Process 6 hours 2 Module:6 Micro System Manufacturing 6 hours 2 Module:7 Nano Scaling in Mechanical Domain, Electrostatic Domain, Magnetic Domain 2 And Thermal Domain 2 Module:7 Mano Scaling in Mechanical Domain, Electrostatic Domain, Magnetic Domain 2 Module:7 Materials for Mems and Microsystems 8 of hours 2 Module:7 Materials for Mems and Microsystems 9 of microacelectric materials, Projecelectric materials, Polymers 9 Module:7 Materials for Mems	1. Introducin	g and	discuss the historical background of evolution of MEMS and I	Microsyst	ems	and
 2. Educating on the rudiments of various materials used in MEMS fabrication and discuss scaling effects in miniaturizing devices. 3. Comprehendingvarious modern Micro-Nano fabrication techniques, device integration, packaging and bonding and highlight the applications of MEMS and Nano sensors to disciplines beyond Electrical and Mechanical engineering. Expected Course Outcome: At the end of the course, the student should be able to 1. Understand the historical background of evolution of MEMS and Microsystems to the students. 2. Comprehend the various micro sensing and actuating units were provided to the students. 3. Discuss about scaling effects in different Physical domains on miniaturizing devices was done with the students. 4. Rudiments of silicon and various polymer materials for MEMS fabrication was discussed with students. 5. Explore latest micromachining techniques for complete device integration, packaging and bonding. 6. Acquaint the students with Basics of Nanotechnology and its approaches towards nano-device realization. Module:1 Introduction to Microsystems [7 hours] Overview of microelectronics and Microsystems technology, Microsystems and Miniaturization, The multi disciplinary nature of MEMS, smart materials, Structures and Systems, RF MEMS, MOEMS, BioMEMS, Applications of MEMS in various industries. Module:2 Micro Sensors and Actuators 6 hours Working principle of Microsystems - micro actuation techniques - micro avalves - micro actuators - types - microaccelerometers. Module:3 Scaling Laws in Miniaturization 6 hours Module:3 Iscaling Laws in Miniaturization - Oxidation - Chemical Vapour Deposition (CVD) - Physical vapor deposition - Diffusion - Oxidation - Chemical Vapour Deposition (CVD) - Physical vapor deposition - Deposition epitaxy - etching process. Module:5 Fabrication		-	-	5		
effects in miniaturizing devices. 3. Comprehendingvarious modern Micro-Nano fabrication techniques, device integration, packaging and bonding and highlight the applications of MEMS and Nano sensors to disciplines beyond Electrical and Mechanical engineering. Expected Course Outcome: At the end of the course, the student should be able to 1. Understand the historical background of evolution of MEMS and Microsystems to the students. 2. Comprehend the various micro sensing and actuating units were provided to the students. 3. Discuss about scaling effects in different Physical domains on miniaturizing devices was done with the students. 4. Rudiments of silicon and various polymer materials for MEMS fabrication was discussed with students. 5. Explore latest micromachining techniques for complete device integration, packaging and bonding. 6. Acquaint the students with Basics of Nanotechnology and its approaches towards nano-device realization. Module:1 Introduction to Microsystems technology, Microsystems and Miniaturization, The multi disciplinary nature of MEMS in various industries. Module:2 Micro Sensors and Actuators 6 forums Working principle of Microsystems - micro actuation techniques - micro sensors - types - Micro grippers - micro accelerometers. Module:3 Sealing Laws in Miniaturization Module:4 Materials for Mems and Microsystems 6 hours Module:5 Fabrication Process Module:6 Micro System And Microsystems 6 hours Module:6 Micro System And Microsystems 6 hours Module:7 Nano Seating in Mechanical Domain, Electrostatic Domain, Magnetic Domain and Thermal Domain CVCVD) - Physical top deposition - Deposition - Diffusion - Oxidation - Chemical Vapour Deposition (CVD) - Physical vapor deposition - Deposition - Diffusion - Chemical Vapour Deposition CVD) - Physical vapor deposition - Deposition - Diffusion - Chemical Vapour Deposition - CVD) - Physical vapor deposition - Deposition - Diffusion - Chemical Vapour Deposition CVD) - Physical vapor deposition - Deposition - Diffusion - Chemical Vapour Deposition - CVD)	11			d discuss	scal	ing
 3. Comprehendingvarious modern Micro-Nano fabrication techniques, device integration, packaging and bonding and highlight the applications of MEMS and Nano sensors to disciplines beyond Electrical and Mechanical engineering. Expected Course Outcome: At the end of the course, the student should be able to 1. Understand the historical background of evolution of MEMS and Microsystems to the students. 2. Comprehend the various micro sensing and actuating units were provided to the students. 3. Discuss about scaling effects in different Physical domains on miniaturizing devices was done with the students. 4. Rudiments of silicon and various polymer materials for MEMS fabrication was discussed with students. 5. Explore latest micromachining techniques for complete device integration, packaging and bonding. 6. Acquaint the students with Basics of Nanotechnology and its approaches towards nano-device realization. Module:1 Introduction to Microsystems technology, Microsystems and Miniaturization, The multi disciplinary nature of MEMS, Smart materials, Structures and Systems, RF MEMS, MOEMS, BioMEMS, Applications of MEMS in various industries. Module:2 Micro Sensors and Actuators 6 hours Module:3 Scaling Laws in Miniaturization 6 hours Introduction to scaling, Scaling in Mechanical Domain, Electrostatic Domain, Magnetic Domain and Thermal Domain Module:3 Fabrication Process 6 hours Module:4 Materials for Mens and Microsystems – enticro actuation – chenical Vapour Deposition (CVD) - Physical vapor deposition – Diffusion – Oxidation – Chemical Vapour Deposition (CVD) - Physical vapor deposition – Diffusion – Oxidation – Chemical V						0
packaging and bonding and highlight the applications of MEMS and Nano sensors to disciplines beyond Electrical and Mechanical engineering. Expected Course Outcome: At the end of the course, the student should be able to 1. Understand the historical background of evolution of MEMS and Microsystems to the students. 2. Comprehend the various micro sensing and actuating units were provided to the students. 3. Discuss about scaling effects in different Physical domains on miniaturizing devices was done with the students. 4. Rudiments of silicon and various polymer materials for MEMS fabrication was discussed with students. 5. Explore latest micromachining techniques for complete device integration, packaging and bonding. 6. Acquaint the students with Basics of Nanotechnology and its approaches towards nano-device realization. Module:1 Introduction to Microsystems 7 hours Overview of microelectronics and Microsystems technology, Microsystems and Miniaturization, The multi disciplinary nature of MEMS, Smart materials, Structures and Systems, RF MEMS, MOEMS, BioMEMS, Applications of MEMS in various industries. Module:2 Micro Sensors and Actuators Module:3 Scaling Laws in Miniaturization Introduction to scaling, Scaling in Mechanical Domain, Electrostatic Domain, Magnetic Domain and Thermal Domain Module:5 Fabrication Process Module:5 Fabrication Process Module:5 Fabrication Process Module:5 Fabrication Process Module:6 Micro System Manufacturing Folosilthography – Ion implantation – Diffusion – Oxidation – Chemical Vapour Deposition (CVD) - Physical vapor deposition - Deposition epitaxy - etching process. Module:6 Micro System Manufacturing Fichning isotropic and anisotrophic, Wet and Dry Etching of Silicon – Plasma Etching – Deep Reaction Ion Etching (DRIE), Bulk Micro manufacturing - surface micro machining – LIGA – SLIGA - Micro System Making materials - die level - device level - system level - packaging techniquees - die preparation – surface bonding - wire bonding - sealing. Modu			e	egration,		
beyond Electrical and Mechanical engineering. Expected Course Outcome: At the end of the course, the student should be able to 1. Understand the historical background of evolution of MEMS and Microsystems to the students. 2. Comprehend the various micro sensing and actuating units were provided to the students. 3. Discuss about scaling effects in different Physical domains on miniaturizing devices was done with the students. 4. Rudiments of silicon and various polymer materials for MEMS fabrication was discussed with students. 5. Explore latest micromachining techniques for complete device integration, packaging and bonding. 6. Acquaint the students with Basics of Nanotechnology and its approaches towards nano-device realization. Module:1 Introduction to Microsystems 7 hours Overview of microelectronics and Microsystems technology, Microsystems and Miniaturization, The multi disciplinary nature of MEMS, Smart materials, Structures and Systems, RF MEMS, MOEMS, BioMEMS, Applications of MEMS in various industries. Module:2 Microsors and Actuators 6 hours Working principle of Microsystems - micro actuation techniques - micro acues – micro grippers – micro accelerometers. Module:3 Scaling Laws in Miniaturization 6 hours Introduction to scaling, Scaling in Mechanical Domain, Electrostatic Domain, Magnetic Domain and Thermal Domain Module:4 Materials for Mems and Microsystems </td <td>-</td> <th>-</th> <td></td> <td>-</td> <td>plin</td> <td>es</td>	-	-		-	plin	es
Expected Course Outcome: At the end of the course, the student should be able to 1. Understand the historical background of evolution of MEMS and Microsystems to the students. 2. Comprehend the various micro sensing and actuating units were provided to the students. 3. Discuss about scaling effects in different Physical domains on miniaturizing devices was done with the students. 4. Rudiments of silicon and various polymer materials for MEMS fabrication was discussed with students. 5. Explore latest micromachining techniques for complete device integration, packaging and bonding. 6. Acquaint the students with Basics of Nanotechnology and its approaches towards nano-device realization. Module:1 Mtroduction to Microsystems Or microelectronics and Microsystems technology, Microsystems and Miniaturization, The multi disciplinary nature of MEMS, Smart materials, Structures and Systems, RF MEMS, MOEMS, BioMEMS, Applications of MEMS in various industries. Module:2 Micro Sensors and Actuators 6 hours Working principle of Microsystems - micro actuation techniques - micro sensors - types - Micro actuators - types - micro actelerometers. Module:3 Module:3 Scaling Laws in Miniaturization 6 hours Introduction to scaling, Scaling in Mechanical Domain, Electrostatic Domain, Magnetic Domain and					r	
At the end of the course, the student should be able to 1. Understand the historical background of evolution of MEMS and Microsystems to the students. 2. Comprehend the various micro sensing and actuating units were provided to the students. 3. Discuss about scaling effects in different Physical domains on miniaturizing devices was done with the students. 4. Rudiments of silicon and various polymer materials for MEMS fabrication was discussed with students. 5. Explore latest micromachining techniques for complete device integration, packaging and bonding. 6. Acquaint the students with Basics of Nanotechnology and its approaches towards nano-device realization. Module:1 Introduction to Microsystems 7 hours Overview of microelectronics and Microsystems technology, Microsystems and Miniaturization, The multi disciplinary nature of MEMS, materials, Structures and Systems, RF MEMS, MOEMS, BioMEMS, Applications of MEMS in various industries. Module:2 Micro Sensors and Actuators 6 hours Working principle of Microsystems - micro actuation techniques - micro sensors - types - Micro actuators - types - micro actelerometers. Module:3 Module:3 Scaling Laws in Miniaturization 6 hours Introduction to scaling, Scaling in Mechanical Domain, Electrostatic Domain, Magnetic Domain and Thermal Domain Module:4 Module:4 Materials for Mems and Microsystems 6 hours Substr						
 1. Understand the historical background of evolution of MEMS and Microsystems to the students. 2. Comprehend the various micro sensing and actuating units were provided to the students. 3. Discuss about scaling effects in different Physical domains on miniaturizing devices was done with the students. 4. Rudiments of silicon and various polymer materials for MEMS fabrication was discussed with students. 5. Explore latest micromachining techniques for complete device integration, packaging and bonding. 6. Acquaint the students with Basics of Nanotechnology and its approaches towards nano-device realization. Module:1 Introduction to Microsystems (P nours) 7 hours Overview of microelectronics and Microsystems technology, Microsystems and Miniaturization, The multi disciplinary nature of MEMS, Smart materials, Structures and Systems, RF MEMS, MOEMS, BioMEMS, Applications of MEMS in various industries. Module:2 Micro Sensors and Actuators 6 hours Working principle of Microsystems - micro actuation techniques - micro sensors - types - Micro actuators - types - micro accelerometers. Module:3 Scaling Laws in Miniaturization 6 hours Introduction to scaling, Scaling in Mechanical Domain, Electrostatic Domain, Magnetic Domain and Thermal Domain Module:3 Fabrication Process 6 hours Photolithography - Ion implantation - Diffusion - Oxidation - Chemical Vapour Deposition (CVD) - Physical vapor deposition - Deposition epitaxy - etching process. Module:5 Micro System Manufacturing 6 hours Etching - isotropic and anisotrophic, Wet and Dry Etching of Silicon - Plasma Etching - Deep Reaction Ion Etching (DREF), Bulk Micro manufacturing - surface micro machining - LIGA - SLIGA - Micro system packaging materials - die level - device level - system level - packaging	-					
 2. Comprehend the various micro sensing and actuating units were provided to the students. 3. Discuss about scaling effects in different Physical domains on miniaturizing devices was done with the students. 4. Rudiments of silicon and various polymer materials for MEMS fabrication was discussed with students. 5. Explore latest micromachining techniques for complete device integration, packaging and bonding. 6. Acquaint the students with Basics of Nanotechnology and its approaches towards nano-device realization. Module:1 Introduction to Microsystems 7 hours Overview of microelectronics and Microsystems technology, Microsystems and Miniaturization, The multi disciplinary nature of MEMS, Smart materials, Structures and Systems, RF MEMS, MOEMS, BioMEMS, Applications of MEMS in various industries. Module:2 Micro Sensors and Actuators 6 hours Working principle of Microsystems - micro actuation techniques - micro sensors - types - Micro actuators - types - micro grippers - micro accelerometers. Module:3 Scaling Laws in Miniaturization 6 hours Introduction to scaling, Scaling in Mechanical Domain, Electrostatic Domain, Magnetic Domain and Thermal Domain Module:4 Materials for Mems and Microsystems 6 hours Substrates and wafers, Silicon and Silicon compounds, Gallium Arsenide, Piezoelectric materials, Polymers Module:5 Fabrication Process 6 hours Photolithography - Ion implantation - Diffusion - Oxidation - Chemical Vapour Deposition (CVD) - Physical vapor deposition - Deposition epitaxy - etching process. Module:6 Micro System Manufacturing 6 hours Etching - isotropic and anisotrophic, Wet and Dry Etching of Silicon - Plasma Etching - Deep Reaction Ion Etching (DREE), Bulk Micro manufacturing - surface micro machining - LIGA - SLIGA - Micro system packaging materials - die level - device level - syste			,	ns to the s	tude	nts.
 3. Discuss about scaling effects in different Physical domains on miniaturizing devices was done with the students. 4. Rudiments of silicon and various polymer materials for MEMS fabrication was discussed with students. 5. Explore latest micromachining techniques for complete device integration, packaging and bonding. 6. Acquaint the students with Basics of Nanotechnology and its approaches towards nano-device realization. Module:1 Introduction to Microsystems 7 hours 0 Overview of microelectronics and Microsystems technology, Microsystems and Miniaturization, The multi disciplinary nature of MEMS, smart materials, Structures and Systems, RF MEMS, MOEMS, BioMEMS, Applications of MEMS in various industries. Module:2 Micro Sensors and Actuators 6 hours 0 Working principle of Microsystems - micro actuation techniques - micro sensors - types - Micro actuators - types - micro accelerometers. Module:3 Scaling Laws in Miniaturization 6 hours 0 Introduction to scaling, Scaling in Mechanical Domain, Electrostatic Domain, Magnetic Domain and Thermal Domain 0 Module:4 Materials for Mems and Microsystems 6 hours 0 Substrates and wafers, Silicon and Silicon compounds, Gallium Arsenide, Piezoelectric materials, Polymers - Module:5 Fabrication Process 6 hours 0 Photolithography - Ion implantation - Diffusion - Oxidation - Chemical Vapour Deposition (CVD) - Physical vapor deposition - Deposition epitaxy - etching process. Module:6 Micro System Manufacturing 6 hours 0 Etching - isotropic and anisotrophic, Wet and Dry Etching of Silicon - Plasma Etching - Deep Reaction Ion Etching (DREE), Bulk Micro manufacturing - surface micro machining - LIGA - SLIGA - Micro System packaging materials - die level - device level - system level - packaging techniques - die preparation - surface bonding - wire bonding - surface micro machining - LIGA - SLIGA - Micro System packaging materials - die level			·			
 with the students. 4. Rudiments of silicon and various polymer materials for MEMS fabrication was discussed with students. 5. Explore latest micromachining techniques for complete device integration, packaging and bonding. 6. Acquaint the students with Basics of Nanotechnology and its approaches towards nano-device realization. Module:1 Introduction to Microsystems 7 hours 7 hours 0 Overview of microelectronics and Microsystems technology, Microsystems and Miniaturization, The multi disciplinary nature of MEMS, Smart materials, Structures and Systems, RF MEMS, MOEMS, BioMEMS, Applications of MEMS in various industries. Module:2 Micro Sensors and Actuators 6 hours 7 Working principle of Microsystems - micro actuation techniques - micro sensors - types - Micro actuators - types - micro accelerometers. Module:3 Scaling Laws in Miniaturization 6 hours 7 Module:4 Materials for Mems and Microsystems 6 hours 7 Module:5 Fabrication Process 6 hours 7 Module:5 Fabrication Process 6 hours 7 Photolithography - Ion implantation - Diffusion - Oxidation - Chemical Vapour Deposition (CVD) - Physical vapor deposition - Deposition epitaxy - etching process. Module:6 Micro System Manufacturing 6 hours 7 Etching - isotropic and anisotrophic, Wet and Dry Etching of Silicon - Plasma Etching - Deep Reaction Ion Etching (DRIE), Bulk Micro manufacturing - surface micro machining - LIGA - SLIGA - Micro system packaging materials - die level - device level - system level - packaging techniques - die preparation - surface bonding - wire bonding - seafing. 	-					ne
 4. Rudiments of silicon and various polymer materials for MEMS fabrication was discussed with students. 5. Explore latest micromachining techniques for complete device integration, packaging and bonding. 6. Acquaint the students with Basics of Nanotechnology and its approaches towards nano-device realization. Module:1 Introduction to Microsystems / 7 hours Overview of microelectronics and Microsystems technology, Microsystems and Miniaturization, The multi disciplinary nature of MEMS, Smart materials, Structures and Systems, RF MEMS, MOEMS, BioMEMS, Applications of MEMS in various industries. Module:2 Micro Sensors and Actuators / 6 hours Working principle of Microsystems - micro actuation techniques - micro sensors - types - Micro actuators - types - micro accelerometers. Module:3 Scaling Laws in Miniaturization / 6 hours Introduction to scaling, Scaling in Mechanical Domain, Electrostatic Domain, Magnetic Domain and Thermal Domain Module:4 Materials for Mems and Microsystems / 6 hours Substrates and wafers, Silicon and Silicon compounds, Gallium Arsenide, Piezoelectric materials, Polymers Photolithography - Ion implantation - Diffusion - Oxidation - Chemical Vapour Deposition (CVD) - Physical vapor deposition - Deposition epitaxy - etching process. Module:6 Micro System Manufacturing / 6 hours Etching - isotropic and anisotrophic, Wet and Dry Etching of Silicon - Plasma Etching - Deep Reaction Ion Etching (DRIE), Bulk Micro manufacturing - surface micro machining - LIGA - SLIGA - Micro system packaging materials - die level - device level - system level - packaging techniques - die preparation - surface bonding - wire bonding - sealing. 						
students. 5. Explore latest micromachining techniques for complete device integration, packaging and bonding. 6. Acquaint the students with Basics of Nanotechnology and its approaches towards nano-device realization. Module:1 Introduction to Microsystems 7 hours Overview of microelectronics and Microsystems technology, Microsystems and Miniaturization, The multi disciplinary nature of MEMS, Smart materials, Structures and Systems, RF MEMS, MOEMS, BioMEMS, Applications of MEMS in various industries. Module:2 Micro Sensors and Actuators 6 hours Working principle of Microsystems - micro actuation techniques - micro sensors - types - Micro actuators - types - microny - electrohydrodynamics- micromotors - micro - valves - micro actuators - types - micro accelerometers. Module:3 Scaling Laws in Miniaturization 6 hours Introduction to scaling, Scaling in Mechanical Domain, Electrostatic Domain, Magnetic Domain and Thermal Domain Module:4 Materials for Mems and Microsystems 6 hours Substrates and wafers, Silicon and Silicon compounds, Gallium Arsenide, Piezoelectric materials, Polymers Module:5 Fabrication Process 6 hours Module:6 Micro System Manufacturing 6 hours Etching - isotropic and anisotrophic, Wet and Dry Etching of Silicon - Plasma Etching - Deep Reaction Ion Etching (DRIE), Bulk Micro manufacturing - surface micro machining - LIGA - SLIGA - Micro system packaging materials - die level - device level - system level - packaging techniques - die preparation - surface bonding - wire bonding - sealing. Module:7 Nano Sensors 6 hours 6 hours			icon and various polymer materials for MEMS fabrication was	s discusse	ed w	ith
 5. Explore latest micromachining techniques for complete device integration, packaging and bonding. 6. Acquaint the students with Basics of Nanotechnology and its approaches towards nano-device realization. Module:1 Introduction to Microsystems 7 hours Overview of microelectronics and Microsystems technology, Microsystems and Miniaturization, The multi disciplinary nature of MEMS, Smart materials, Structures and Systems, RF MEMS, MOEMS, BioMEMS, Applications of MEMS in various industries. Module:2 Micro Sensors and Actuators 6 hours Working principle of Microsystems - micro actuation techniques - micro sensors - types - Micro actuators - types - micropump -Electrohydrodynamics- micromotors - micro - valves - micro grippers - micro accelerometers. Module:3 Scaling Laws in Miniaturization 6 hours Introduction to casling, Scaling in Mechanical Domain, Electrostatic Domain, Magnetic Domain and Thermal Domain Module:4 Materials for Mems and Microsystems 6 hours Substrates and wafers, Silicon and Silicon compounds, Gallium Arsenide, Piezoelectric materials, Polymers Module:5 Fabrication Process 6 hours Photolithography - Ion implantation - Diffusion - Oxidation - Chemical Vapour Deposition (CVD) - Physical vapor deposition - Deposition epitaxy - etching process. Module:6 Micro System Manufacturing 6 hours Etching - isotropic and anisotrophic, Wet and Dry Etching of Silicon - Plasma Etching - Deep Reaction Ion Etching (DRIE), Bulk Micro manufacturing - surface micro machining - LIGA - SLIGA - Micro system packaging materials - die level - device level - system level - packaging techniques - die preparation - surface bonding - wire bonding - sealing. 						
bonding. 6. Acquaint the students with Basics of Nanotechnology and its approaches towards nano-device realization. Module:1 Introduction to Microsystems 7 hours Overview of microelectronics and Microsystems technology, Microsystems and Miniaturization, The multi disciplinary nature of MEMS, Smart materials, Structures and Systems, RF MEMS, MOEMS, BioMEMS, Applications of MEMS in various industries. Module:2 Micro Sensors and Actuators 6 hours Working principle of Microsystems - micro actuation techniques - micro sensors - types - Micro actuators - types - micro accelerometers. Module:3 Module:3 Scaling Laws in Miniaturization 6 hours Introduction to scaling, Scaling in Mechanical Domain, Electrostatic Domain, Magnetic Domain and Thermal Domain 6 hours Module:4 Materials for Mems and Microsystems 6 hours Substrates and wafers, Silicon and Silicon compounds, Gallium Arsenide, Piezoelectric materials, Polymers Photolithography - Ion implantation - Diffusion - Oxidation - Chemical Vapour Deposition (CVD) - Physical vapor deposition - Deposition epitaxy - etching process. Module:6 Micro System Manufacturing 6 hours Etching - isotropic and anisotrophic, Wet and Dry Etching of Silicon - Plasma Etching - Deep Reaction Ion Etching (DRIE), Bulk Micro manufacturing - surface micro machining - LIGA - SLIGA - Micro system packaging materials - die level - device level - system level - packaging techniques - die preparation - surface bonding - sealing.<		test m	icromachining techniques for complete device integration, pac	kaging ar	nd	
6. Acquaint the students with Basics of Nanotechnology and its approaches towards nano-device realization. Module:1 Introduction to Microsystems 7 hours Overview of microelectronics and Microsystems technology, Microsystems and Miniaturization, The multi disciplinary nature of MEMS, Smart materials, Structures and Systems, RF MEMS, MOEMS, Bio/MEMS, Applications of MEMS in various industries. Module:2 Micro Sensors and Actuators 6 hours Module:3 Micro Sensors and Actuators 6 hours Module:3 Scaling Laws in Miniaturization 6 hours Module:3 Scaling Laws in Miniaturization 6 hours Introduction to scaling, Scaling in Mechanical Domain, Electrostatic Domain, Magnetic Domain and Thermal Domain 6 hours Module:4 Materials for Mems and Microsystems 6 hours Substrates and wafers, Silicon and Silicon compounds, Gallium Arsenide, Piezoelectric materials, Polymers Photolithography – Ion implantation – Diffusion – Oxidation – Chemical Vapour Deposition (CVD) - Physical vapor deposition - Deposition epitaxy - etching process. Module:6 Micro System Manufacturing 6 hours Etching – isotropic and anisotrophic, Wet and Dry Etching of Silicon – Plasma Etching – Deep Reaction Ion Etching (DRIE), Bulk Micro manufacturing - surface micro machining – LIGA – SLIGA - Micro system packaging materials - die level - device level - system level - packaging techniques – die preparation – surface bonding - wire	-		ieronnaetnining teerninques for comprete device integration, pue		14	
realization. Thours Module:1 Introduction to Microsystems 7 hours Overview of microelectronics and Microsystems technology, Microsystems and Miniaturization, The multi disciplinary nature of MEMS, Smart materials, Structures and Systems, RF MEMS, MOEMS, BioMEMS, Applications of MEMS in various industries. Module:2 Micro Sensors and Actuators 6 hours Working principle of Microsystems - micro actuation techniques - micro sensors - types - Micro actuators - types - micro accelerometers. 6 hours Module:3 Scaling Laws in Miniaturization 6 hours Introduction to scaling, Scaling in Mechanical Domain, Electrostatic Domain, Magnetic Domain and Thermal Domain 6 hours Module:4 Materials for Mems and Microsystems 6 hours Substrates and wafers, Silicon and Silicon compounds, Gallium Arsenide, Piezoelectric materials, Polymers Piezoelectric materials, Polymers Module:5 Fabrication Process 6 hours Photolithography – Ion implantation – Diffusion – Oxidation – Chemical Vapour Deposition (CVD) - Physical vapor deposition - Deposition epitaxy - etching process. Etching – isotropic and anisotrophic, Wet and Dry Etching of Silicon – Plasma Etching – Deep Reaction Ion Etching (DRE), Bulk Micro manufacturing - surface micro machining – LIGA – SLIGA - Micro system packaging materials - die level - device level - system level - packaging techniques – die preparation – surface bonding - wire bonding - sealing.	U	he stu	dents with Basics of Nanotechnology and its approaches towa	rds nano-	devi	ce
Module:1Introduction to Microsystems7 hoursOverview of microelectronics and Microsystems technology, Microsystems and Miniaturization, The multi disciplinary nature of MEMS, Smart materials, Structures and Systems, RF MEMS, MOEMS, BioMEMS, Applications of MEMS in various industries.Module:2Micro Sensors and Actuators6 hoursWorking principle of Microsystems - micro actuation techniques - micro sensors - types - Micro actuators - types - micropump -Electrohydrodynamics- micromotors - micro - valves - micro grippers - micro accelerometers.6 hoursModule:3Scaling Laws in Miniaturization6 hoursIntroduction to scaling, Scaling in Mechanical Domain, Electrostatic Domain, Magnetic Domain and Thermal Domain6 hoursModule:4Materials for Mems and Microsystems6 hoursSubstrates and wafers, Silicon and Silicon compounds, Gallium Arsenide, Piezoelectric materials, Polymers9 hoursModule:5Fabrication Process6 hoursPhotolithography - Ion implantation - Diffusion - Oxidation - Chemical Vapour Deposition (CVD) - Physical vapor deposition - Deposition epitaxy - etching process.9 hoursModule:6Micro System Manufacturing6 hoursEtching - isotropic and anisotrophic, Wet and Dry Etching of Silicon - Plasma Etching - Deep Reaction Ion Etching (DRIE), Bulk Micro manufacturing - surface micro machining - LIGA - SLIGA - Micro system packaging materials - die level - device level - system level - packaging techniques - die preparation - surface bonding - wire bonding - sealing.Module:7Nano Sensors6 hours	-	ne sta	dents with Dusles of Hunoteenhology and its upproaches towa	ius nuno	uevi	00
Overview of microelectronics and Microsystems technology, Microsystems and Miniaturization, The multi disciplinary nature of MEMS, Smart materials, Structures and Systems, RF MEMS, MOEMS, BioMEMS, Applications of MEMS in various industries. Module:2 Micro Sensors and Actuators 6 hours Working principle of Microsystems - micro actuation techniques - micro sensors - types - Micro actuators - types - micropump -Electrohydrodynamics- micromotors - micro - valves - micro grippers - micro accelerometers. 6 hours Module:3 Scaling Laws in Miniaturization 6 hours Introduction to scaling, Scaling in Mechanical Domain, Electrostatic Domain, Magnetic Domain and Thermal Domain 6 hours Module:4 Materials for Mems and Microsystems 6 hours Substrates and wafers, Silicon and Silicon compounds, Gallium Arsenide, Piezoelectric materials, Polymers Photolithography - Ion implantation - Diffusion - Oxidation - Chemical Vapour Deposition (CVD) - Physical vapor deposition - Deposition epitaxy - etching process. Module:6 Micro System Manufacturing 6 hours Etching - isotropic and anisotrophic, Wet and Dry Etching of Silicon - Plasma Etching - Deep Reaction Ion Etching (DRIE), Bulk Micro manufacturing - surface micro machining - LIGA - SLIGA - Micro system packaging materials - die level - device level - system level - packaging techniques - die preparation - surface bonding - wire bonding - sealing.		Introd	luction to Microsystems 7 hours			
The multi disciplinary nature of MEMS, Smart materials, Structures and Systems, RF MEMS, MOEMS, BioMEMS, Applications of MEMS in various industries. Module:2 Micro Sensors and Actuators 6 hours Working principle of Microsystems - micro actuation techniques - micro sensors - types - Micro actuators - types - micropump -Electrohydrodynamics- micromotors - micro - valves - micro grippers - micro accelerometers. 6 hours Module:3 Scaling Laws in Miniaturization 6 hours Introduction to scaling, Scaling in Mechanical Domain, Electrostatic Domain, Magnetic Domain and Thermal Domain 6 hours Module:4 Materials for Mems and Microsystems 6 hours Substrates and wafers, Silicon and Silicon compounds, Gallium Arsenide, Piezoelectric materials, Polymers Module:5 Fabrication Process 6 hours Photolithography – Ion implantation – Diffusion – Oxidation – Chemical Vapour Deposition (CVD) - Physical vapor deposition - Deposition epitaxy - etching process. Module:6 Micro System Manufacturing 6 hours Etching – isotropic and anisotrophic, Wet and Dry Etching of Silicon – Plasma Etching – Deep Reaction Ion Etching (DRIE), Bulk Micro manufacturing - surface micro machining – LIGA – SLIGA - Micro system packaging materials - die level - device level - system level - packaging techniques – die preparation – surface bonding - wire bonding - sealing.				nd Miniat	uriz	ation
MOEMS, Bio/MEMS, Applications of MEMS in various industries. Module:2 Micro Sensors and Actuators 6 hours Working principle of Microsystems - micro actuation techniques - micro sensors - types - Micro actuators - types - micropump -Electrohydrodynamics- micromotors - micro - valves - micro grippers - micro accelerometers. Module:3 Scaling Laws in Miniaturization 6 hours Module:3 Scaling Laws in Miniaturization 6 hours Introduction to scaling, Scaling in Mechanical Domain, Electrostatic Domain, Magnetic Domain and Thermal Domain Module:4 Materials for Mems and Microsystems 6 hours Substrates and wafers, Silicon and Silicon compounds, Gallium Arsenide, Piezoelectric materials, Polymers Module:5 Fabrication Process 6 hours Photolithography – Ion implantation – Diffusion – Oxidation – Chemical Vapour Deposition (CVD) - Physical vapor deposition - Deposition epitaxy - etching process. Module:6 Micro System Manufacturing 6 hours Etching – isotropic and anisotrophic, Wet and Dry Etching of Silicon – Plasma Etching – Deep Reaction Ion Etching (DRIE), Bulk Micro manufacturing - surface micro machining – LIGA – SLIGA - Micro system packaging materials - die level - device level - system level - packaging techniques – die preparation – surface bonding - wire bonding - sealing. Module:7 Nano Sensors 6 hours						
Module:2Micro Sensors and Actuators6 hoursWorking principle of Microsystems - micro actuation techniques - micro sensors - types - Micro actuators - types - micropump -Electrohydrodynamics- micromotors - micro - valves - micro grippers - micro accelerometers.Module:3Scaling Laws in Miniaturization6 hoursIntroduction to scaling, Scaling in Mechanical Domain, Electrostatic Domain, Magnetic Domain and Thermal Domain6 hoursModule:4Materials for Mems and Microsystems6 hoursSubstrates and wafers, Silicon and Silicon compounds, Gallium Arsenide, Piezoelectric materials, Polymers9 hoursModule:5Fabrication Process6 hoursPhotolithography - Ion implantation - Diffusion - Oxidation - Chemical Vapour Deposition (CVD) - Physical vapor deposition - Deposition epitaxy - etching process.6 hoursModule:6Micro System Manufacturing6 hoursEtching - isotropic and anisotrophic, Wet and Dry Etching of Silicon - Plasma Etching - Deep Reaction Ion Etching (DRIE), Bulk Micro manufacturing - surface micro machining - LIGA - SLIGA - Micro system packaging materials - die level - device level - system level - packaging techniques - die preparation - surface bonding - wire bonding - sealing.6 hours						<u> </u>
Working principle of Microsystems - micro actuation techniques - micro sensors - types - Micro actuators - types - micropump -Electrohydrodynamics- micromotors - micro - valves - micro grippers - micro accelerometers. Module:3 Scaling Laws in Miniaturization 6 hours Introduction to scaling, Scaling in Mechanical Domain, Electrostatic Domain, Magnetic Domain and Thermal Domain 6 hours 6 hours Module:4 Materials for Mems and Microsystems 6 hours 6 hours Substrates and wafers, Silicon and Silicon compounds, Gallium Arsenide, Piezoelectric materials, Polymers 6 hours 6 hours Module:5 Fabrication Process 6 hours 6 hours Photolithography – Ion implantation – Diffusion – Oxidation – Chemical Vapour Deposition (CVD) - Physical vapor deposition - Deposition epitaxy - etching process. 6 hours Etching – isotropic and anisotrophic, Wet and Dry Etching of Silicon – Plasma Etching – Deep Reaction Ion Etching (DRIE), Bulk Micro manufacturing - surface micro machining – LIGA – SLIGA - Micro system packaging materials - die level - device level - system level - packaging techniques – die preparation – surface bonding - wire bonding - sealing. Module:7 Nano Sensors 6 hours						
actuators – types – micropump –Electrohydrodynamics- micromotors – micro – valves – micro grippers – micro accelerometers. Module:3 Scaling Laws in Miniaturization 6 hours Introduction to scaling, Scaling in Mechanical Domain, Electrostatic Domain, Magnetic Domain and Thermal Domain 6 hours Module:4 Materials for Mems and Microsystems 6 hours Substrates and wafers, Silicon and Silicon compounds, Gallium Arsenide, Piezoelectric materials, Polymers 6 hours Module:5 Fabrication Process 6 hours Photolithography – Ion implantation – Diffusion – Oxidation – Chemical Vapour Deposition (CVD) - Physical vapor deposition - Deposition epitaxy - etching process. 9 Module:6 Micro System Manufacturing 6 hours Etching – isotropic and anisotrophic, Wet and Dry Etching of Silicon – Plasma Etching – Deep Reaction Ion Etching (DRIE), Bulk Micro manufacturing - surface micro machining – LIGA – SLIGA - Micro system packaging materials - die level - device level - system level - packaging techniques – die preparation – surface bonding - wire bonding - sealing. Module:7 Nano Sensors 6 hours				rs – type	s _ 1	Micro
grippers – micro accelerometers.Module:3Scaling Laws in Miniaturization6 hoursIntroduction to scaling, Scaling in Mechanical Domain, Electrostatic Domain, Magnetic Domainand Thermal DomainModule:4Materials for Mems and Microsystems6 hoursSubstrates and wafers, Silicon and Silicon compounds, Gallium Arsenide, Piezoelectric materials, PolymersModule:5Fabrication Process6 hoursModule:6Fabrication Process6 hoursPhotolithography – Ion implantation – Diffusion – Oxidation – Chemical Vapour Deposition (CVD) - Physical vapor deposition - Deposition epitaxy - etching process.Module:6Micro System Manufacturing6 hoursEtching – isotropic and anisotrophic, Wet and Dry Etching of Silicon – Plasma Etching – DeepReaction Ion Etching (DRIE), Bulk Micro manufacturing - surface micro machining – LIGA – SLIGA - Micro system packaging materials - die level - device level - system level - packaging techniques – die preparation – surface bonding - wire bonding - sealing.Module:7Nano Sensors6 hours						
Module:3Scaling Laws in Miniaturization6 hoursIntroduction to scaling, Scaling in Mechanical Domain, Electrostatic Domain, Magnetic Domain and Thermal DomainDomainModule:4Materials for Mems and Microsystems6 hoursSubstrates and wafers, Silicon and Silicon compounds, Gallium Arsenide, Piezoelectric materials, PolymersFabrication ProcessModule:5Fabrication Process6 hoursPhotolithography – Ion implantation – Diffusion – Oxidation – Chemical Vapour Deposition (CVD) - Physical vapor deposition - Deposition epitaxy - etching process.Vapour DepositionModule:6Micro System Manufacturing6 hoursEtching – isotropic and anisotrophic, Wet and Dry Etching of Silicon – Plasma Etching – Deep Reaction Ion Etching (DRIE), Bulk Micro manufacturing - surface micro machining – LIGA – SLIGA - Micro system packaging materials - die level - device level - system level - packaging techniques – die preparation – surface bonding - wire bonding - sealing.6 hoursModule:7Nano Sensors6 hours				vurve.		mero
Introduction to scaling, Scaling in Mechanical Domain, Electrostatic Domain, Magnetic Domain and Thermal Domain Module:4 Materials for Mems and Microsystems 6 hours Substrates and wafers, Silicon and Silicon compounds, Gallium Arsenide, Piezoelectric materials, Polymers Module:5 Fabrication Process Module:5 Fabrication Process 6 hours Photolithography – Ion implantation – Diffusion – Oxidation – Chemical Vapour Deposition (CVD) - Physical vapor deposition - Deposition epitaxy - etching process. Module:6 Micro System Manufacturing 6 hours Etching – isotropic and anisotrophic, Wet and Dry Etching of Silicon – Plasma Etching – Deep Reaction Ion Etching (DRIE), Bulk Micro manufacturing - surface micro machining – LIGA – SLIGA - Micro system packaging materials - die level - device level - system level - packaging techniques – die preparation – surface bonding - wire bonding - sealing. Module:7 Nano Sensors 6 hours						
and Thermal Domain Module:4 Materials for Mems and Microsystems 6 hours Substrates and wafers, Silicon and Silicon compounds, Gallium Arsenide, Piezoelectric materials, Polymers Substrates and wafers, Silicon and Silicon compounds, Gallium Arsenide, Piezoelectric materials, Polymers Module:5 Fabrication Process 6 hours Photolithography – Ion implantation – Diffusion – Oxidation – Chemical Vapour Deposition (CVD) - Physical vapor deposition - Deposition epitaxy - etching process. Module:6 Micro System Manufacturing 6 hours Etching – isotropic and anisotrophic, Wet and Dry Etching of Silicon – Plasma Etching – Deep Reaction Ion Etching (DRIE), Bulk Micro manufacturing - surface micro machining – LIGA – SLIGA - Micro system packaging materials - die level - device level - system level - packaging techniques – die preparation – surface bonding - wire bonding - sealing. Module:7 Nano Sensors 6 hours			P	Magnetic	· Do	main
Module:4Materials for Mems and Microsystems6 hoursSubstrates and wafers, Silicon and Silicon compounds, Gallium Arsenide, Piezoelectric materials, PolymersModule:5Fabrication Process6 hoursPhotolithography – Ion implantation – Diffusion – Oxidation – Chemical Vapour Deposition (CVD) - Physical vapor deposition - Deposition epitaxy - etching process.Vapour Deposition Process.Module:6Micro System Manufacturing6 hoursEtching – isotropic and anisotrophic, Wet and Dry Etching of Silicon – Plasma Etching – Deep Reaction Ion Etching (DRIE), Bulk Micro manufacturing - surface micro machining – LIGA – SLIGA - Micro system packaging materials - die level - device level - system level - packaging techniques – die preparation – surface bonding - wire bonding - sealing.6 hoursModule:7Nano Sensors6 hours				mugnetic		mam
Substrates and wafers, Silicon and Silicon compounds, Gallium Arsenide, Piezoelectric materials, Polymers Module:5 Fabrication Process Module:5 Fabrication Process Photolithography – Ion implantation – Diffusion – Oxidation – Chemical Vapour Deposition (CVD) - Physical vapor deposition - Deposition epitaxy - etching process. Module:6 Micro System Manufacturing Etching – isotropic and anisotrophic, Wet and Dry Etching of Silicon – Plasma Etching – Deep Reaction Ion Etching (DRIE), Bulk Micro manufacturing - surface micro machining – LIGA – SLIGA - Micro system packaging materials - die level - device level - system level - packaging techniques – die preparation – surface bonding - wire bonding - sealing. Module:7 Nano Sensors						
Polymers 6 hours Module:5 Fabrication Process 6 hours Photolithography – Ion implantation – Diffusion – Oxidation – Chemical Vapour Deposition (CVD) - Physical vapor deposition - Deposition epitaxy - etching process. Vapour Deposition Module:6 Micro System Manufacturing 6 hours Etching – isotropic and anisotrophic, Wet and Dry Etching of Silicon – Plasma Etching – Deep Place micro machining – LIGA – SLIGA - Micro system packaging materials - die level - device level - system level - packaging techniques – die preparation – surface bonding - wire bonding - sealing. Module:7 Nano Sensors 6 hours			-	oelectric	mate	rials
Module:5Fabrication Process6 hoursPhotolithography – Ion implantation – Diffusion – Oxidation – Chemical Vapour Deposition (CVD) - Physical vapor deposition - Deposition epitaxy - etching process.Vapour Deposition DepositionModule:6Micro System Manufacturing6 hoursEtching – isotropic and anisotrophic, Wet and Dry Etching of Silicon – Plasma Etching – Deep Reaction Ion Etching (DRIE), Bulk Micro manufacturing - surface micro machining – LIGA – SLIGA - Micro system packaging materials - die level - device level - system level - packaging techniques – die preparation – surface bonding - wire bonding - sealing.Module:7Nano Sensors6 hours		iu wai	ers, Smeon and Smeon compounds, Samun Arsende, 1 iez		mate	11 a 15,
Photolithography – Ion implantation – Diffusion – Oxidation – Chemical Vapour Deposition (CVD) - Physical vapor deposition - Deposition epitaxy - etching process. Module:6 Micro System Manufacturing 6 hours Etching – isotropic and anisotrophic, Wet and Dry Etching of Silicon – Plasma Etching – Deep Reaction Ion Etching (DRIE), Bulk Micro manufacturing - surface micro machining – LIGA – SLIGA - Micro system packaging materials - die level - device level - system level - packaging techniques – die preparation – surface bonding - wire bonding - sealing. Module:7 Nano Sensors 6 hours		Fahrid	cation Process 6 hours			
Module:6 Micro System Manufacturing 6 hours Etching – isotropic and anisotrophic, Wet and Dry Etching of Silicon – Plasma Etching – Deep Reaction Ion Etching (DRIE), Bulk Micro manufacturing - surface micro machining – LIGA – SLIGA - Micro system packaging materials - die level - device level - system level - packaging techniques – die preparation – surface bonding - wire bonding - sealing. Module:7 Nano Sensors 6 hours				Janour D	eno	sition
Module:6 Micro System Manufacturing 6 hours Etching – isotropic and anisotrophic, Wet and Dry Etching of Silicon – Plasma Etching – Deep Reaction Ion Etching (DRIE), Bulk Micro manufacturing - surface micro machining – LIGA – SLIGA - Micro system packaging materials - die level - device level - system level - packaging techniques – die preparation – surface bonding - wire bonding - sealing. Module:7 Nano Sensors	0		▲	apour D	cpo.	5111011
Etching – isotropic and anisotrophic, Wet and Dry Etching of Silicon – Plasma Etching – DeepReaction Ion Etching (DRIE), Bulk Micro manufacturing - surface micro machining – LIGA –SLIGA - Micro system packaging materials - die level - device level - system level - packagingtechniques – die preparation – surface bonding - wire bonding - sealing.Module:7Nano Sensors6 hours		ysicai	vapor deposition Deposition epitaxy eterning process.			
Etching – isotropic and anisotrophic, Wet and Dry Etching of Silicon – Plasma Etching – DeepReaction Ion Etching (DRIE), Bulk Micro manufacturing - surface micro machining – LIGA –SLIGA - Micro system packaging materials - die level - device level - system level - packagingtechniques – die preparation – surface bonding - wire bonding - sealing.Module:7Nano Sensors6 hours	Module 6	Micra	o System Manufacturing 6 hours			
Reaction Ion Etching (DRIE), Bulk Micro manufacturing - surface micro machining - LIGA - SLIGA - Micro system packaging materials - die level - device level - system level - packaging techniques - die preparation - surface bonding - wire bonding - sealing. Module:7 Nano Sensors 6 hours				Etching	_ ח	een
SLIGA - Micro system packaging materials - die level - device level - system level - packaging techniques - die preparation - surface bonding - wire bonding - sealing. Module:7 Nano Sensors 6 hours						
techniques – die preparation – surface bonding - wire bonding - sealing. Module:7 Nano Sensors 6 hours				-		
Module:7Nano Sensors6 hours		•		ievei - pa	илd	51118
				anotochn	مام	w in

sensing, CN	Γ based sensors, Nano el	ectronics and	nano photonio	cs.	
Module:8	Contemporary issues	5:		2 hours	
		Total Le	cture hours:	45 hours	
Text Book(s)				
1.Tai-Ran H	su,MEMS and Microsy	stems Desig	n and Manuf	facture, 2017	, 1 st edition, Tata
McGraw-Hil	l Publishing Company L	.td., India.			
Reference B					
1. Chang Liu	, Foundation of MEMS,	2011, 2 nd ed.	, Pearson Edu	cation India.	
2. Rai Choud	lhury, MEMS and MOE	MS Technolo	ogy and Appli	cations, 2013,	PHI Learning Private
Limited, Indi					
3. Zheng Cu	i, Nanofabrication, Prin	ciples, Capa	bilities and Li	imits,2016, 2 ¹	nd ed., Springer(India)
Pvt. Ltd., Ind	lia				
	aluation:Continuous As	sessment Tes	sts, Quiz, Dig	ital Assignme	ent, Final Assessment
Test					
	ed by Board of Studies :	1	26-02-2017		
Approved by	Academic Council :	44	Date :	1	6-03-2017

Course Code	Course Title		L	Τ	P	J	C
ECE3040	WIRELESS TECHNOLOGIES FO	R IoT	3	0	0	0	3
Pre-requisite	ECE3026 - IoT System Architecture			V	/ersi	on :	1.1
Course Objecti	ves:						
The course is air	ned at making the students to						
	e different types of fading and diversity, and si						
2. Understand th	e different wireless standards (WLAN, WPAN	and WMAN	N) and it	ts see	curity	У	
3. Understand th	e basics of 6LoWPAN and Bluetooth Low Ene	ergy (BLE) t	echnolo	gy			
Course Outcon	ne:						
	e course the student should be able to						
•	nt types of fading and diversity.						
	rent types of signal propagation mechanism and	l multiple ac	cess tec	hniq	ues.		
	racteristics of WLAN and their security issues.						
	racteristics of WPAN and their security issues.						
•	types of wireless MAN standards						
	the architecture and protocol stack of 6LoWPA						
	basics of Bluetooth Low Energy (BLE) technol						
	ading Channels and Diversity Technique	6 hours					
	ls –overview of fading channels – Diversity tec	hniques – N	Iultiple	ante	nnas	in	
wireless commu		~ -					
	adio Communication Basics	6 hours					
	Vireless Multiplexing and Multiple Access Tech	iniques-RF s	signal p	ropag	gatio	n an	d
1	Wideband Radio-MIMO.						
	/ireless LAN	7 hours					
	LAN standards- IEEE 802.11 MAC Layer –IEE	EE 802.11 P	HY Lay	er-IE	EEE	802.	11
	WLAN Security- Other WLAN Standards						
	Vireless PAN	6 hours					
	luetooth-Wireless USB-ZigBee-IrDA-Wireless		ity				
	/ireless MAN	6 hours	~			-	
	ireless MAN Standard-Metropolitan Area- Mes	h Network-S	Start-up	phas	se an	d	
operating phase		~ -					
	LoWPAN	6 hours					
	rchitecture – Protocol stack of 6LoWPAN Arch	itecture – N	eighbor	disc	over	у-	
Challenges in 6			1				
	luetooth SMART/Bluetooth Low	6 hours					
	nergy(BLE)	_			_		
	letwork topology – BLE frequency channels – I	Message exc	hange –	- BL	E pro	otoco)l
stack- Application			[
Module:8 C	ontemporary issues:	2 hours					
		Total L	Lecture	hou	rs: 4	5 ho	ur
Text Book(s)				0	1		
	ckley, Wireless Networking Technology - From		to succe	esstu	1		
-	ntation, 2007, First Edition, Elsevier, Science I		· () D				
	chiller, Mobile Communication, 2010, Second	Edition (Rej	print), P	ears	on		
Educatio							
Reference Book		d Dr. 4 - 1	2012 F	71			
	nt, The Internet of Things: Key Applications an	iu Protocols	,2013, F	irst			
Editon, V	•	odh I - T		a - 1	ar 1		
2. AKIba an	d Robert Davidson, Getting Started with Bluet	Join Low El	lergy-1	UOIS	and		

Techniques of Low power netw	vorking, 20	016, First Edition, O'Reill	y Media			
Mode of Evaluation: Continuous Asses	Mode of Evaluation: Continuous Assessment Test + Digital Assignment, Quiz, Final Assessment					
Test						
Recommended by Board of Studies :		26-02-2017				
Approved by Academic Council :	44 th	Date :	16-03-2017			

		L			J	C
ECE4002	Advanced Microcontrollers	-	-	v	4	4
Prerequisite:	ECE3003 – Microcontrollers and Applications	Syl	llab	us v	'ers	
						1.
Course Object						
	erstand advanced architectures.					
	elop Programs both in C and assembly for advanced architectures.					
	erstand the advanced features like memory management unit, exce	eptio	on h	and	ling	•
4. To buil	d real-time system using ARM/AVR controllers.					
Expected Cou	rse Outcomes:					
1. Compre	whend the architecture and instruction set of AVR controllers					
2. Develop	p efficient C codes for AVR architecture and program AVR perip	her	als l	like	tim	ers
interrup	ts and serial port.					
3. Design	AVR controller based system within realistic constraint like u	user	spe	ecifi	cati	or
availabi	lity of components					
4. Underst	and the design philosophy of ARM controllers.					
5. Compre	hend the instruction and assembly language program.					
	p efficient C codes for ARM architecture and its interfaces.					
7. Design	application for various social relevant and real time issues					
	VR architecture and Assembly language Programming:		5	hou	irs	
AVR Register	File, Special Addressing registers, Addressing modes, Stack	poi	inter	r. Pi	rogi	
Instructions, N	, Pipelines, Clock, Arithmetic and logical Instructions, Ju Iove, Load store Instructions, Load and store Program memory Instructions, I/O Port.		ar	nd	bra	nc
Instructions, M Instruction, Bit Module:2 A	Iove, Load store Instructions, Load and store Program memor Instructions, I/O Port. VR (C Programming):	ry,	ar Pus	nd h ai hou	bra nd	nc 20
Instructions, M Instruction, Bit Module:2 A Data types, '	Iove, Load store Instructions, Load and store Program memor Instructions, I/O Port.	ry,	ar Pus	nd h ai hou	bra nd	
Instructions, M Instruction, Bit Module:2 A Data types, ' Serialization, M	Iove, Load store Instructions, Load and store Program memor Instructions, I/O Port. VR (C Programming): Time delays, I/O Programming, Logic Operations, Data C	ry,	ar Pus 5 versi	nd h ai hou	bra nd	nc 20
Instructions, M Instruction, Bit Module:2 A Data types, Serialization, M Module:3 A	Iove, Load store Instructions, Load and store Program memor Instructions, I/O Port. VR (C Programming): Time delays, I/O Programming, Logic Operations, Data C Memory Allocation.	ry,	ar Pus 5 versi	nd h an hou ion,	bra nd	nc 20
Instructions, M Instruction, Bit Module:2 A Data types, Serialization, M Module:3 A Timers, Interru	Iove, Load store Instructions, Load and store Program memor Instructions, I/O Port. VR (C Programming): Time delays, I/O Programming, Logic Operations, Data C Memory Allocation. VR Peripherals (C programming): Tipts, Serial Port	ry,	ar Pus 5 versi 4	h an hou ion,	bra nd j irs D.	nc 20
Instructions, M Instruction, Bit Module:2 A Data types, Serialization, M Module:3 A Timers, Interru Module:4 C	Iove, Load store Instructions, Load and store Program memor Instructions, I/O Port. VR (C Programming): Time delays, I/O Programming, Logic Operations, Data C Memory Allocation. VR Peripherals (C programming): Typts, Serial Port Communication with real world (C programming):	ry,	ar Pus 5 versi 4	nd h an hou ion,	bra nd j irs D.	nc 20
Instructions, M Instruction, Bit Module:2 A Data types, Serialization, M Module:3 A Timers, Interru Module:4 C	Iove, Load store Instructions, Load and store Program memor Instructions, I/O Port. VR (C Programming): Time delays, I/O Programming, Logic Operations, Data C Memory Allocation. VR Peripherals (C programming): Tipts, Serial Port	ry,	ar Pus 5 versi 4	h an hou ion,	bra nd j irs D.	nc 20
Instructions, M Instruction, Bit Module:2 A Data types, ' Serialization, M Module:3 A Timers, Interru Module:4 C SPI, I2C, ADC	Iove, Load store Instructions, Load and store Program memor Instructions, I/O Port. VR (C Programming): Time delays, I/O Programming, Logic Operations, Data C Memory Allocation. VR Peripherals (C programming): Typts, Serial Port Ommunication with real world (C programming): C & DAC, PWM, Relay, stepper motor, LCD, keyboard	ry,	ar Pus 5 versi 4 8	nd h an hou ion, hou hou	bra nd j irs D: irs	nc 20
Instructions, M Instruction, Bit Module:2 A Data types, Serialization, M Module:3 A Timers, Interru Module:4 C SPI, I2C, ADC Module:5 A	Iove, Load store Instructions, Load and store Program memor Instructions, I/O Port. VR (C Programming): Time delays, I/O Programming, Logic Operations, Data C Memory Allocation. VR Peripherals (C programming): Typts, Serial Port Ommunication with real world (C programming): C & DAC, PWM, Relay, stepper motor, LCD, keyboard RM Architecture:	ry,	ar Pus 5 versi 4 8 5	nd h an hou ion, hou hou	irs irs irs	
Instructions, M Instruction, Bit Module:2 A Data types, ' Serialization, M Module:3 A Timers, Interru Module:4 C SPI, I2C, ADC Module:5 A ARM Design	Iove, Load store Instructions, Load and store Program memor Instructions, I/O Port. VR (C Programming): Time delays, I/O Programming, Logic Operations, Data C Memory Allocation. VR Peripherals (C programming): Typts, Serial Port Ommunication with real world (C programming): C & DAC, PWM, Relay, stepper motor, LCD, keyboard RM Architecture: Philosophy, Overview of ARM architecture States [ARM,	ry,	arr Pus 5 Versi 4 8 5 imb.	nd h an hou ion, hou hou , Ja	irs irs irs	
Instructions, M Instruction, Bit Module:2 A Data types, ' Serialization, M Module:3 A Timers, Interru Module:4 C SPI, I2C, ADC Module:5 A ARM Design	Iove, Load store Instructions, Load and store Program memor Instructions, I/O Port. VR (C Programming): Time delays, I/O Programming, Logic Operations, Data C Memory Allocation. VR Peripherals (C programming): Typts, Serial Port Ommunication with real world (C programming): C & DAC, PWM, Relay, stepper motor, LCD, keyboard RM Architecture:	ry,	arr Pus 5 Versi 4 8 5 imb.	nd h an hou ion, hou hou , Ja	irs irs irs	
Instructions, M Instruction, Bit Module:2 A Data types, ' Serialization, M Module:3 A Timers, Interru Module:4 C SPI, I2C, ADC Module:5 A ARM Design Registers, mod Module:6 A	Iove, Load store Instructions, Load and store Program memor Instructions, I/O Port. VR (C Programming): Time delays, I/O Programming, Logic Operations, Data C Memory Allocation. VR Peripherals (C programming): Typts, Serial Port Ommunication with real world (C programming): C & DAC, PWM, Relay, stepper motor, LCD, keyboard RM Architecture: Philosophy, Overview of ARM architecture States [ARM,	ry,	ar Pus 5 Versi 4 8 5 umb.	nd h an hou ion, hou hou , Ja	bra nd j nrs D. nrs nrs nrs nrs nrs	
Instructions, M Instruction, Bit Module:2 A Data types, Serialization, M Module:3 A Timers, Interru Module:4 C SPI, I2C, ADC Module:5 A ARM Design Registers, mod Module:6 A Pu	Iove, Load store Instructions, Load and store Program memor Instructions, I/O Port. VR (C Programming): Time delays, I/O Programming, Logic Operations, Data C Memory Allocation. VR Peripherals (C programming): Types, Serial Port Depts, Serial Port Communication with real world (C programming): C & DAC, PWM, Relay, stepper motor, LCD, keyboard RM Architecture: Philosophy, Overview of ARM architecture States [ARM, es, Conditional Execution, Pipelining, Vector Tables, Exception h RM & Thumb Instructions and Assembly language	ry, Conv	ar Pus 5 versi 4 8 5 umb Illing 8	nd h an hou ion, hou hou , Ja g. hou	bra nd j urs D: urs urs urs urs urs	e]
Instructions, M Instruction, Bit Module:2 A Data types, Serialization, M Module:3 A Timers, Interru Module:4 C SPI, I2C, ADC Module:5 A ARM Design Registers, mod Module:6 A Pn ARM Instructi	Iove, Load store Instructions, Load and store Program memor Instructions, I/O Port. VR (C Programming): Time delays, I/O Programming, Logic Operations, Data C Memory Allocation. VR Peripherals (C programming): Typts, Serial Port Ommunication with real world (C programming): C & DAC, PWM, Relay, stepper motor, LCD, keyboard RM Architecture: Philosophy, Overview of ARM architecture States [ARM, es, Conditional Execution, Pipelining, Vector Tables, Exception h RM & Thumb Instructions and Assembly language rogramming:	ry, Conv Conv Inst	ar Pus 5 versi 4 8 5 umb, 1lling 8 truc	h an hou ion, hou hou , Ja g. hou tion	bra nd j urs D urs urs urs urs urs s, S	
Instructions, M Instruction, Bit Module:2 A Data types, ' Serialization, M Module:3 A Timers, Interru Module:4 C SPI, I2C, ADC Module:5 A ARM Design Registers, mod Module:6 A Pn ARM Instructi instruction, La	Iove, Load store Instructions, Load and store Program memo Instructions, I/O Port. VR (C Programming): Time delays, I/O Programming, Logic Operations, Data C Memory Allocation. VR Peripherals (C programming): Typts, Serial Port Ommunication with real world (C programming): C & DAC, PWM, Relay, stepper motor, LCD, keyboard RM Architecture: Philosophy, Overview of ARM architecture States [ARM, es, Conditional Execution, Pipelining, Vector Tables, Exception h RM & Thumb Instructions and Assembly language rogramming: on- data processing instructions, branch instructions, load store	ry, Conv Conv Thu and inst ram	ar Pus 5 Versi 4 8 5 Imb Illing 8 trucc min	nd h an hou ion, hou hou , Ja g. tion g.	bra nd j urs D. urs urs urs s, S Thu	ncc 200
Instructions, M Instruction, Bit Module:2 A Data types, Serialization, M Module:3 A Timers, Interru Module:4 C SPI, I2C, ADC Module:5 A ARM Design Registers, mod Module:6 A ARM Instructi instruction, La Instruction, La	Iove, Load store Instructions, Load and store Program memo Instructions, I/O Port. VR (C Programming): Time delays, I/O Programming, Logic Operations, Data C Memory Allocation. VR Peripherals (C programming): Typts, Serial Port Ommunication with real world (C programming): & DAC, PWM, Relay, stepper motor, LCD, keyboard RM Architecture: Philosophy, Overview of ARM architecture States [ARM, es, Conditional Execution, Pipelining, Vector Tables, Exception h RM & Thumb Instructions and Assembly language rogramming: on- data processing instructions, branch instructions, load store bading instructions, conditional Execution, Assembly Programming Programming	ry, Conv Conv Thu nand inst ram	ar Pus 5 versi 4 8 5 umb lling 8 truc min ata	nd h an hou ion, hou hou , Ja g. tion g.	bra nd j urs D. urs urs urs s, S Thu	nccoc atta
Instructions, M Instruction, Bit Module:2 A Data types, Serialization, M Module:3 A Timers, Interru Module:4 C SPI, I2C, ADC Module:5 A ARM Design Registers, mod Module:6 A ARM Instructi instruction, La Instruction, La	Iove, Load store Instructions, Load and store Program memo Instructions, I/O Port. VR (C Programming): Time delays, I/O Programming, Logic Operations, Data Contended and Contended	ry, Conv Conv Thu nand inst ram	ar Pus 5 versi 4 8 5 umb lling 8 truc min ata	nd h an hou ion, hou hou , Ja g. tion g.	bra nd j urs D. urs urs urs s, S Thu	ncc 200

ARM Cortex M Microcontroller- Ports, Timer, UART, ADC, I2C.

Total Lecture:

Text Books:

- 1. Muhammad Ali Mazidi, Sarmad Naimi, Sepehr Naimi, "AVR Microcontroller and Embedded Systems Using Assembly and C", Pearson, 2013.
- 2. Andrew N Sloss, Dominic Symes, Chris Wright, "ARM System Developer's Guide" Morgan Kaufmann Publishers, 2010.

Reference Books:

1.	Joseph Liu, "The	Definitive	guide to	ARM Cortex	M0". Newnes	s. 2012.
	····r		0		-)	- ,

2. Simon Monk, "Programming Arduino Next Steps: Going further with sketches", McGraw Hill, 2014.

Typical Projects:

- 1. Home Automation
- 2. Smart precision irrigation system
- 3. Building Secure Home Automation
- 4. Green computing
- 5. Gesture controlled home automation for disabled
- 6. Patient monitoring system
- 7. Health monitoring system for old aged
- 8. Pollution monitoring and control system
- 9. Waste management
- 10. Smart Lighting
- 11. Forest Fire detection

Mode of Evaluation: CAT / Assignment / Quiz /	FAT / Project / S	Seminar	
Recommended by Board of Studies :	13.12.2015		
Approved by Academic Council	No: 40	Date	18-03-2016

45 hours

	Optical Communication and Networks		' P	J	С
ECE4005		2 0	2	4	4
Pre-requisite	ECE4001: Digital Communication Systems	Sylla	bus v	ersi	ion
^	· · · ·				1.0
Course Objectives	S:				
*	technology developments in Optical Communication system.				
	e an in-depth knowledge on various types of fibers and		ransı	niss	ion
characterist	tics, the construction, working principle and characteristic	cs of t	ransi	nitte	ers,
	nd various optical amplifiers used in long distance communic				
3. To describe	e the concepts of Wavelength Division Multiplexing techn	nique,	comp	one	nts
used and th	e estimation of rise-time and power budget for digital transm	ission s	yster	n.	
4. To introduc	ce SONET/SDH, OTN and PON Technologies.				
Expected Course					
1. Understand	the concept of optical communication.				
	r and optoelectronic components to design, analyze an optic				
	understand the basic concepts of optical transmitters, modula	ators ar	nd no	nlin	ear
effects.					
	the concepts of photodetectors and receivers and various opt		-		
	optical communication systems for multichannel systems	using n	nultij	olexi	ing
techniques.					
	the concepts of WDM system and their applications.	· .			
	and classify various types of optical Networks and their appl	lication	s.		
	alyze and evaluate optical communication systems.				
	Simulate Optical Communication systems and networks.	2	hou		
	view of optical fiber communication and Networks al bands-Key elements of optical fiber system-Modeling and s				
Module:2 Optica			hou		•
		4	' nou	15	
	MM SL MM (I), anagialty fibors (Compatrical Option D			Was	uo
	1 1 1	Descript	ion,		
Propagation, Chr	comatic Dispersion, Polarization Mode Dispersion, I	Descript Dispers	ion,		
Propagation, Chr Limitations, Fiber	omatic Dispersion, Polarization Mode Dispersion, I Losses, Nonlinear Optical Effects (SRS,SBS,SPM,CPM,FWI	Descript Dispers M)	ion, ion-I	nduc	
Propagation, Chr Limitations, Fiber Module:3 Optic	comatic Dispersion, Polarization Mode Dispersion, I Losses, Nonlinear Optical Effects (SRS,SBS,SPM,CPM,FWI cal Transmitters and Receivers	Descripti Dispers M) 6	ion, ion-I hou	nduc rs	ced
Propagation,ChrLimitations,FiberModule:3OpticSources:LED,LA	romatic Dispersion, Polarization Mode Dispersion, I Losses, Nonlinear Optical Effects (SRS,SBS,SPM,CPM,FW cal Transmitters and Receivers SER, Modulators, Transmitter Design, Mach-Zehnder and El	Descript Dispers M) 6 ectro-al	ion, ion-I hou bsorp	nduo rs otion	ced
Propagation, Chr Limitations, Fiber Module:3 Optic Sources: LED, LA Modulators. Photo	romatic Dispersion, Polarization Mode Dispersion, I Losses, Nonlinear Optical Effects (SRS,SBS,SPM,CPM,FWI eal Transmitters and Receivers SER, Modulators, Transmitter Design, Mach-Zehnder and El detector, Receiver Design, Receiver Noise, Bit Error rate, Rec	Descript Dispers M) 6 ectro-al	ion, ion-I hou bsorp	nduo rs otion	ced
Propagation,ChrLimitations,FiberModule:3OpticSources:LED,LAModulators.PhotoSensitivityDegrad	romatic Dispersion, Polarization Mode Dispersion, I Losses, Nonlinear Optical Effects (SRS,SBS,SPM,CPM,FW cal Transmitters and Receivers SER, Modulators, Transmitter Design, Mach-Zehnder and El detector, Receiver Design, Receiver Noise, Bit Error rate, Rec ation, Receiver Performance.	Descript Dispers M) 6 ectro-al ceiver S	ion, ion-I bon bsorp Sensi	nduc rs ption tivit	ced
Propagation,ChrLimitations,FiberModule:3OpticeSources:LED,LAModulators.Modulators.PhotoSensitivityDegrad.Module:4Optice	romatic Dispersion, Polarization Mode Dispersion, I Losses, Nonlinear Optical Effects (SRS,SBS,SPM,CPM,FWI cal Transmitters and Receivers SER, Modulators, Transmitter Design, Mach-Zehnder and El detector, Receiver Design, Receiver Noise, Bit Error rate, Rec ation, Receiver Performance.	Descripti Dispers M) ectro-al ceiver S	ion, ion-I bsorp Sensi	nduc rs ption tivit	y,
Propagation,ChrLimitations,FiberModule:3OpticeSources:LED,LAModulators.Modulators.PhotoSensitivityDegradaModule:4OpticeSemiconductorOptice	romatic Dispersion, Polarization Mode Dispersion, I Losses, Nonlinear Optical Effects (SRS,SBS,SPM,CPM,FW cal Transmitters and Receivers SER, Modulators, Transmitter Design, Mach-Zehnder and El detector, Receiver Design, Receiver Noise, Bit Error rate, Rec ation, Receiver Performance.	Descripti Dispers M) ectro-al ceiver S	ion, ion-I bsorp Sensi	nduc rs ption tivit	y,
Propagation,ChrLimitations,FiberModule:3OpticSources:LED,LAModulators.Modulators.PhotoSensitivityDegradaModule:4OpticaSemiconductorOpApplications	romatic Dispersion, Polarization Mode Dispersion, I Losses, Nonlinear Optical Effects (SRS,SBS,SPM,CPM,FWR eal Transmitters and Receivers SER, Modulators, Transmitter Design, Mach-Zehnder and El detector, Receiver Design, Receiver Noise, Bit Error rate, Rec ation, Receiver Performance. al Amplifiers otical Amplifiers, Raman Amplifiers, Erbium-Doped Fiber A	Descripti Dispers M) ectro-al ceiver S 3 Amplific	ion, ion-I bsorr Sensi hou ers , S	nduc rs otion tivity rs Syste	y,
Propagation,ChrLimitations,FiberModule:3OpticeSources:LED,LAModulators.Modulators.PhotoSensitivityDegradeModule:4OpticeSemiconductorOpApplications.Module:5Module:5Light-	romatic Dispersion, Polarization Mode Dispersion, I Losses, Nonlinear Optical Effects (SRS,SBS,SPM,CPM,FWI cal Transmitters and Receivers SER, Modulators, Transmitter Design, Mach-Zehnder and El detector, Receiver Design, Receiver Noise, Bit Error rate, Rec ation, Receiver Performance. Al Amplifiers otical Amplifiers, Raman Amplifiers, Erbium-Doped Fiber A wave Transmission Systems	Descripti Dispers M) ectro-al ceiver S 3 Amplifie	ion, ion-I bsorp Sensi hou ers , S	nduc rs ption tivit rs Syste rs	y, em
Propagation,ChrLimitations,FiberModule:3OpticaSources:LED,LAModulators.Modulators.PhotoSensitivityDegradaModule:4OpticaSemiconductorOpApplicationsModule:5Module:5Light-IntensityModulati	romatic Dispersion, Polarization Mode Dispersion, I Losses, Nonlinear Optical Effects (SRS,SBS,SPM,CPM,FWR eal Transmitters and Receivers SER, Modulators, Transmitter Design, Mach-Zehnder and El detector, Receiver Design, Receiver Noise, Bit Error rate, Rec ation, Receiver Performance. al Amplifiers otical Amplifiers, Raman Amplifiers, Erbium-Doped Fiber A	Descripti Dispers M) ectro-al ceiver S 3 Amplific detecti	ion, ion-I bsorp Sensi hou ers , S hou	nduc rs otion tivity rs Syste rs Opti	em
Propagation, Chr Limitations, Fiber Module:3 Optic Sources: LED, LA Modulators. Photo Sensitivity Degrad Module:4 Optica Semiconductor Op Applications Module:5 Light- Intensity Modulati time division mult	 romatic Dispersion, Polarization Mode Dispersion, I Losses, Nonlinear Optical Effects (SRS,SBS,SPM,CPM,FWI cal Transmitters and Receivers SER, Modulators, Transmitter Design, Mach-Zehnder and El detector, Receiver Design, Receiver Noise, Bit Error rate, Rec ation, Receiver Performance. Amplifiers Ditical Amplifiers , Raman Amplifiers , Erbium-Doped Fiber A wave Transmission Systems on - Direct Detection Systems, Homodyne and heterodyne 	Descripti Dispersi M) ectro-al ceiver S amplifie detecti rision m	ion, ion-I bsorp Sensi hou ers , S hou ion, f nultip	nduc rs tivit rs Syste rs Optia	em
Propagation,ChrLimitations,FiberModule:3OpticeSources:LED,LAModulators.Modulators.PhotoSensitivityDegradeModule:4OpticeSemiconductorOpApplicationsModule:5Module:5Light-IntensityModulatitimedivisionSubcarriermultiplicationmultiplication	romatic Dispersion, Polarization Mode Dispersion, I Losses, Nonlinear Optical Effects (SRS,SBS,SPM,CPM,FWI cal Transmitters and Receivers SER, Modulators, Transmitter Design, Mach-Zehnder and El detector, Receiver Design, Receiver Noise, Bit Error rate, Rec ation, Receiver Performance. Al Amplifiers otical Amplifiers , Raman Amplifiers , Erbium-Doped Fiber A wave Transmission Systems on - Direct Detection Systems, Homodyne and heterodyne iplexing (bit-interleaved, packet interleaved)Wavelength-div	Descripti Dispersi M) ectro-al ceiver S amplifie detecti rision m	ion, ion-I bsorp Sensi hou ers , S hou ion, f nultip	nduc rs tivit rs Syste rs Optia	em
Propagation,ChrLimitations,FiberModule:3OpticeSources:LED,LAModulators.Modulators.PhotoSensitivityDegradeModule:4OpticeSemiconductorOpApplicationsModule:5Module:5Light-IntensityModulatitimedivisionSubcarriermultiplicationmultiplication	 comatic Dispersion, Polarization Mode Dispersion, I Losses, Nonlinear Optical Effects (SRS,SBS,SPM,CPM,FWI cal Transmitters and Receivers SER, Modulators, Transmitter Design, Mach-Zehnder and El detector, Receiver Design, Receiver Noise, Bit Error rate, Recation, Receiver Performance. al Amplifiers bitcal Amplifiers , Raman Amplifiers , Erbium-Doped Fiber A wave Transmission Systems on - Direct Detection Systems, Homodyne and heterodyne iplexing (bit-interleaved, packet interleaved)Wavelength-divolexing, Polarization multiplexing. Digital links: Point-to-I power budget-Rise time budget, System performance 	Descripti Dispers M) ectro-al ceiver S amplific detecti vision m Point li	ion, ion-I bsorp Sensi hou ers , S hou ion, f nultip	nduc rs tion tivit rs Syste Dpti- lexi Syste	em
Propagation,ChrLimitations,FiberModule:3OpticeSources:LED,Modulators.PhotoSensitivityDegradModule:4OpticeSemiconductorOpApplicationsModule:5Module:5LightIntensityModulatisubcarriermultipconsideration-LinkModule:6Multice	 comatic Dispersion, Polarization Mode Dispersion, I Losses, Nonlinear Optical Effects (SRS,SBS,SPM,CPM,FWI cal Transmitters and Receivers SER, Modulators, Transmitter Design, Mach-Zehnder and El detector, Receiver Design, Receiver Noise, Bit Error rate, Recation, Receiver Performance. al Amplifiers bitcal Amplifiers , Raman Amplifiers , Erbium-Doped Fiber A wave Transmission Systems on - Direct Detection Systems, Homodyne and heterodyne iplexing (bit-interleaved, packet interleaved)Wavelength-divolexing, Polarization multiplexing. Digital links: Point-to-I power budget-Rise time budget, System performance 	Descripti Dispersi M) ectro-al ceiver S amplifie detecti rision m Point li	ion, ion-I bsorp Sensi hou ers , S hou ion, f nultip inks-	nduc rs tion tivit rs Dpti lexi Syst rs	em
Propagation,ChrLimitations,FiberModule:3OpticaSources:LED,LAModulators.Modulators.PhotoSensitivityDegradaModule:4OpticaSemiconductorOpticaSemiconductorOpticaModule:5Light-IntensityModulatitimedivisionSubcarriermultipconsideration-LinkModule:6MulticWDMLightwave	romatic Dispersion, Polarization Mode Dispersion, I Losses, Nonlinear Optical Effects (SRS,SBS,SPM,CPM,FWI cal Transmitters and Receivers SER, Modulators, Transmitter Design, Mach-Zehnder and El detector, Receiver Design, Receiver Noise, Bit Error rate, Rec ation, Receiver Performance. Il Amplifiers bitcal Amplifiers , Raman Amplifiers , Erbium-Doped Fiber A wave Transmission Systems on - Direct Detection Systems, Homodyne and heterodyne iplexing (bit-interleaved, packet interleaved)Wavelength-div oblexing, Polarization multiplexing. Digital links: Point-to-I power budget-Rise time budget, System performance	Descripti Dispers M) ectro-al ceiver S 3 Amplific detecti rision m Point li 4 M-Pass	ion, ion-I bsorp Sensi hou ers , S hou ion, O nultip inks- hou ive o	nduc rs tion tivit; rs Opti- lexi Syst rs pptic	em
Propagation, Chr Limitations, Fiber Module:3 Optice Sources: LED, LA Modulators. Photo Sensitivity Degrada Module:4 Optica Semiconductor Op Applications Module:5 Light- Intensity Modulati time division mult Sub carrier multip consideration-Link Module:6 Multice WDM Lightwave coupler:2x2 Fiber	romatic Dispersion, Polarization Mode Dispersion, I Losses, Nonlinear Optical Effects (SRS,SBS,SPM,CPM,FWI cal Transmitters and Receivers SER, Modulators, Transmitter Design, Mach-Zehnder and El detector, Receiver Design, Receiver Noise, Bit Error rate, Rec ation, Receiver Performance. al Amplifiers bitcal Amplifiers , Raman Amplifiers , Erbium-Doped Fiber A wave Transmission Systems on - Direct Detection Systems, Homodyne and heterodyne iplexing (bit-interleaved, packet interleaved)Wavelength-div olexing, Polarization multiplexing. Digital links: Point-to-l a power budget-Rise time budget, System performance Hannel Systems Systems and Components, Operational principles of WD	Descripti Dispers M) ectro-al ceiver S amplific detecti vision m Point li 4 M-Pass ers , Is	ion, ion-I bsorp Sensi hou ers , S hou ion, (nultip inks- ive (olato	nduc rs tion tivit; rs Opti- lexi Syst rs pptic	em cal ng, em

 Network concepts-Topologies SONET/SDH -The Optical Transport Network - Introduction

 OTN Network Layers - FEC in OTN - OTN Frame Structure - OPU-k - ODU-k - OTU-k-The

 Optical Channel - Optical Channel Carrier and Optical Channel Group - Optical Networks

 Access(existing PON Technologies; CWDM-PON, TDM-PON,Hybrid TDM-WDM –PON) and

 Metro Networks Long-Haul Networks

 2 hours

IVI0	baule:8	Contemporary Issues				2 nours
				Tot	al Lecture Hours:	45 hours
Te	xt Book(s)				
1.	Gerd K	eiser, "Optical Fiber Comm	nunication	s" McGrav	w Hill, 5th Edition, 2	2013.
2.	J. M. S	enior, "Optical Fiber Comm	nunication	s: Principl	es and Practice", Pea	arson 2011.
Ref	ference]	Books				
1.	Cvijeti	c, M., Djordjevic. I. B.: A	dvanced	Optical Co	ommunication Syste	ems and Networks,
	Artech	House 2012				
2.		naswami & K.N. Sivarajan,			"Optical Networks A	A practical
	perspec	ctive",2nd Edition, Pearson	Education	, 2010.		
3.	G.P Ag	grawal, Fiber Optic Commu	nication S	ystems, W	iley, 2nd Edition,20	11
4.	B.Muk	erjee, Optical WDM Netwo	orks (Optic	al Networ	ks), Springer edition	ı; 2006
5.	G. P. A	grawal, Nonlinear Fiber Op	otics, Acac	lemic Pres	s, 2nd Edition,2008	
Mo	de of Ev	aluation: CAT / Assignmen	t / Quiz / I	FAT / Proj	ect / Seminar	
Rec	Recommended by Board of Studies : 13.12.2015					
		-				
Ap	proved b	y Academic Council	No. 40		Date	18-03-2016

Course code	Course Title	LT	P	J	С
ECE4007	Information Theory and Coding	3 0	0	4	4
Pre-requisite	ECE4001 : Digital Communication Systems	Syllab	ous v	vers	ion
					1.0
Course Objective					
	uaint students with the basics of probability, information and it		erties	5	
	iliarize students with different channel models and their capacity	ity			
	h different types of source coding techniques				
4. To exp	lain various types of channel coding techniques				
Expected Course					
	nd and analyze the basics of probability, information and its pro-	opertie	S		
	ifferent types of channels and determine their capacity				
	the binary and non-binary source coding schemes				
	e dictionary-based coding schemes for image compression tech	nniques	5		
	the fundamentals of error control coding schemes				
	comprehend and analyze the advanced error control coding scl				
	e performance of source coding, channel coding techniques in	image	proc	cessi	ing
	ss applications				
Module: 1 Intr	oduction	4	l hou	ırs	
	lity Theory, Introduction to information theory				
Module:2 Entro			ó hou		
Uncertainty, self-i	nformation, average information, mutual information and t	heir p	rope	rties	- 3
1.	mation rate of Markov sources - Information measures of co	ontinuc	ous r	and	om
variables.					
Module:3 Char	nel Models and Capacity	-		irc	
Importance and t	ypes of various channel models - Channel capacity calcu	lation	-]	Bina	
Importance and t symmetric channe	ypes of various channel models - Channel capacity calcul, binary erasure channel - Shannon's channel capacity and	lation	-]	Bina	
Importance and t symmetric channe theorem - Shannon	ypes of various channel models - Channel capacity calculated, binary erasure channel - Shannon's channel capacity and a slimit.	ulation d chan	– 1 nel	Bina cod	
Importance and t symmetric channel theorem - Shannon Module:4 Sour	ypes of various channel models - Channel capacity calcul, binary erasure channel - Shannon's channel capacity and a s limit. ce Coding I	ilation d chan	–] nel	Bina cod irs	ing
Importance and tsymmetric channeltheorem - ShannonModule:4SourceSource coding the	ypes of various channel models - Channel capacity calculated, binary erasure channel - Shannon's channel capacity and a slimit. ce Coding I eorem - Huffman coding - Non binary Huffman codes - A	ilation d chan	–] nel	Bina cod irs	ing
Importance and tsymmetric channeltheorem - ShannonModule:4SourceSource coding the	ypes of various channel models - Channel capacity calcul, binary erasure channel - Shannon's channel capacity and a s limit. ce Coding I	ilation d chan	–] nel	Bina cod irs	ing
Importance and t symmetric channel theorem - ShannonModule:4Source coding - ShannonModule:5Source	ypes of various channel models - Channel capacity calculated, binary erasure channel - Shannon's channel capacity and an's limit. ce Coding I eorem - Huffman coding - Non binary Huffman codes - A Fano Elias coding - Non binary Shannon Fano codes ce Coding II	alation d chan d chan	–] nel i hou e Hu i hou	Bina cod urs uffm urs	ing
Importance and tsymmetric channeltheorem - ShannonModule:4SourceSource coding thecoding - ShannonModule:5SourceArithmetic coding	ypes of various channel models - Channel capacity calculated, binary erasure channel - Shannon's channel capacity and n's limit. ce Coding I eorem - Huffman coding - Non binary Huffman codes - A Fano Elias coding - Non binary Shannon Fano codes ce Coding II g - Lempel-Ziv coding - Run-length encoding and rate disc	alation d chan d chan	–] nel i hou e Hu i hou	Bina cod urs uffm urs	ing
Importance and t symmetric channel theorem - Shannon Module:4 Sour Source coding the coding - Shannon Module:5 Sour Arithmetic coding Overview of trans	ypes of various channel models - Channel capacity calculated, binary erasure channel - Shannon's channel capacity and a's limit. ce Coding I eorem - Huffman coding - Non binary Huffman codes - A Fano Elias coding - Non binary Shannon Fano codes ce Coding II g - Lempel-Ziv coding - Run-length encoding and rate dist form coding.	alation d chan daptiv daptiv tortion	– 1 nel 6 hou e Hu 6 hou fun	Bina cod irs uffm irs ctio	nan
Importance and t symmetric channel theorem - ShannonModule:4Source coding - ShannonModule:5Source coding coding - ShannonModule:5Source source Coding Overview of transModule:6Char	ypes of various channel models - Channel capacity calculated, binary erasure channel - Shannon's channel capacity and a slimit. ce Coding I eorem - Huffman coding - Non binary Huffman codes - A Fano Elias coding - Non binary Shannon Fano codes ce Coding II g - Lempel-Ziv coding - Run-length encoding and rate dist form coding. mel Coding I	alation d chan d chan daptiv daptiv tortion	– 1 nel 6 hou e Hu 6 hou fun 8 hou	Bina cod urs uffm urs ction	ing nan n -
Importance and t symmetric channel theorem - Shannon Module:4 Source Source coding the coding - Shannon Module:5 Source Arithmetic coding Overview of trans Module:6 Char Introduction to E	ypes of various channel models - Channel capacity calcu- el, binary erasure channel - Shannon's channel capacity and i's limit. ce Coding I eorem - Huffman coding - Non binary Huffman codes - A Fano Elias coding - Non binary Shannon Fano codes ce Coding II g - Lempel-Ziv coding - Run-length encoding and rate dis- form coding. mel Coding I rror control codes - Block codes, linear block codes, cyclic	alation d chan d chan daptiv daptiv tortion	– 1 nel 6 hou e Hu 6 hou fun 8 hou s an	Bina cod: urs uffm urs ction urs d th	nan n -
Importance and t symmetric channel theorem - ShannonModule:4Sour Source coding the coding - ShannonModule:5Sour Arithmetic coding Overview of transModule:6Char Char Introduction to E properties, Encode	ypes of various channel models - Channel capacity calculated, binary erasure channel - Shannon's channel capacity and an's limit. ce Coding I eorem - Huffman coding - Non binary Huffman codes - A Fano Elias coding - Non binary Shannon Fano codes ce Coding II g - Lempel-Ziv coding - Run-length encoding and rate dist form coding. mel Coding I rror control codes - Block codes, linear block codes, cyclic er and Decoder design- serial and parallel concatenated block of the series of the seri	alation d chan d chan daptiv daptiv tortion	– 1 nel 6 hou 6 hou 6 hou 6 hou 8 hou 8 nou 8 nou 8 nou 8 nou 8 nou	Bina cod urs uffn urs ction urs d th olut	nan n - neir ion
Importance and t symmetric channel theorem - ShannonModule:4Source coding - ShannonModule:5Source coding - ShannonModule:5Source coding Overview of transModule:6Char CharIntroduction to E properties, Encode Codes- Properties	ypes of various channel models - Channel capacity calculated, binary erasure channel - Shannon's channel capacity and a slimit. ce Coding I eorem - Huffman coding - Non binary Huffman codes - A Fano Elias coding - Non binary Shannon Fano codes ce Coding II g - Lempel-Ziv coding - Run-length encoding and rate dist form coding. mel Coding I rror control codes - Block codes, linear block codes, cyclic per and Decoder design- serial and parallel concatenated block of , Encoder-Tree diagram, Trellis diagram, state diagram, tra	alation d chan d chan daptiv daptiv tortion	– 1 nel 6 hou 6 hou 6 hou 6 hou 8 hou 8 nou 8 nou 8 nou 8 nou 8 nou	Bina cod urs uffn urs ction urs d th olut	nan n - neir ion
Importance and t symmetric channel theorem - Shannon Module:4 Source Source coding the coding - Shannon Module:5 Source Arithmetic coding Overview of trans Module:6 Char Introduction to E properties, Encode Codes- Properties convolutional code	ypes of various channel models - Channel capacity calcu- el, binary erasure channel - Shannon's channel capacity and i's limit. ce Coding I eorem - Huffman coding - Non binary Huffman codes - A Fano Elias coding - Non binary Shannon Fano codes ce Coding II g - Lempel-Ziv coding - Run-length encoding and rate dis- form coding. mel Coding I rror control codes - Block codes, linear block codes, cyclic er and Decoder design- serial and parallel concatenated block of , Encoder-Tree diagram, Trellis diagram, state diagram, tra- es, Viterbi Decoding, Trellis coding, Reed Solomon codes.	alation d chan d chan daptiv daptiv tortion code; C unsfer	–] nel <u>j hou</u> e Hu <u>j hou</u> fun <u>s an</u> Conv func	Bina cod uffn uffn urs ctio urs d th olut tion	nan n - neir ion
Importance and t symmetric channel theorem - ShannonModule:4Sour Source coding the coding - ShannonModule:5Sour Coding - ShannonModule:5Sour Sour Arithmetic coding Overview of transModule:6Char Introduction to E properties, Encode Codes- Properties convolutional codeModule:7Char	ypes of various channel models - Channel capacity calcu- el, binary erasure channel - Shannon's channel capacity and i's limit. ce Coding I eorem - Huffman coding - Non binary Huffman codes - A Fano Elias coding - Non binary Shannon Fano codes ce Coding II g - Lempel-Ziv coding - Run-length encoding and rate dis- form coding. mel Coding I rror control codes - Block codes, linear block codes, cyclic er and Decoder design- serial and parallel concatenated block of , Encoder-Tree diagram, Trellis diagram, state diagram, tra- es, Viterbi Decoding, Trellis coding, Reed Solomon codes. mel Coding II	alation d chan d chan daptiv daptiv tortion c code: code, C unsfer	-] nel b hou e Hu fun b hou fun Conv func	Bina cod uffn uffn urs ctio urs d th olut tion urs	ing nan n - neir of
Importance and t symmetric channel theorem - ShannonModule:4Source coding - ShannonModule:5Source coding - ShannonModule:5Source coding - ShannonModule:6CharOverview of transModule:6Overview of transCharIntroduction to E properties, Encode Codes- Properties convolutional codeModule:7Char	ypes of various channel models - Channel capacity calcu- el, binary erasure channel - Shannon's channel capacity and i's limit. ce Coding I eorem - Huffman coding - Non binary Huffman codes - A Fano Elias coding - Non binary Shannon Fano codes ce Coding II g - Lempel-Ziv coding - Run-length encoding and rate dis- form coding. mel Coding I rror control codes - Block codes, linear block codes, cyclider and Decoder design- serial and parallel concatenated block of , Encoder-Tree diagram, Trellis diagram, state diagram, tra- es, Viterbi Decoding, Trellis coding, Reed Solomon codes. mel Coding II concatenated convolutional codes, Block and convolutional	alation d chan d chan daptiv daptiv tortion c code code, C unsfer	–] nel j hou	Bina cod uffn uffn urs ctio urs d th olut tion urs	ing nan n - neir of
Importance and t symmetric channel symmetric channel Module:4 Source Source coding the coding - Shannon Module:5 Source Module:6 Coding Arithmetic coding Overview of trans Module:6 Chan Introduction to E properties, Encode Codes- Properties convolutional code Module:7 Chan Serial and parallel coder, Iterative Tu	ypes of various channel models - Channel capacity calcu- el, binary erasure channel - Shannon's channel capacity and i's limit. ce Coding I eorem - Huffman coding - Non binary Huffman codes - A Fano Elias coding - Non binary Shannon Fano codes ce Coding II g - Lempel-Ziv coding - Run-length encoding and rate dis- form coding. mel Coding I rror control codes - Block codes, linear block codes, cyclic er and Decoder design- serial and parallel concatenated block of , Encoder-Tree diagram, Trellis diagram, state diagram, tra- es, Viterbi Decoding, Trellis coding, Reed Solomon codes. mel Coding II	alation d chan d chan daptiv daptiv tortion c code code, C unsfer	–] nel j hou	Bina cod uffn uffn urs ctio urs d th olut tion urs	ing nan n - neir of
Importance and t symmetric channel symmetric channel Module:4 Source Source coding the coding - Shannon Module:5 Source Module:6 Char Introduction to E properties, Encode Codes- Properties convolutional code Module:7 Char Serial and parallel coder, Iterative Tu	ypes of various channel models - Channel capacity calcu- el, binary erasure channel - Shannon's channel capacity and i's limit. ce Coding I eorem - Huffman coding - Non binary Huffman codes - A Fano Elias coding - Non binary Shannon Fano codes ce Coding II g - Lempel-Ziv coding - Run-length encoding and rate dis- form coding. mel Coding I rror control codes - Block codes, linear block codes, cyclider and Decoder design- serial and parallel concatenated block of , Encoder-Tree diagram, Trellis diagram, state diagram, tra- es, Viterbi Decoding, Trellis coding, Reed Solomon codes. mel Coding II concatenated convolutional codes, Block and convolutional	alation d chan d chan daptiv daptiv tortion c code: code, C unsfer	–] nel j hou	Bina cod uffn uffn urs ctio urs d th olut tion urs Tu	ing nan n - neir of
Importance and t symmetric channel symmetric channel Module:4 Source Source coding the coding - Shannon Module:5 Source Module:6 Char Introduction to E properties, Encode Codes- Properties convolutional code Module:7 Char Serial and parallel coder, Iterative Tu	ypes of various channel models - Channel capacity calculated, binary erasure channel - Shannon's channel capacity and a's limit. ce Coding I eorem - Huffman coding - Non binary Huffman codes - A Fano Elias coding - Non binary Shannon Fano codes ce Coding II g - Lempel-Ziv coding - Run-length encoding and rate dist form coding. mel Coding I rror control codes - Block codes, linear block codes, cyclic er and Decoder design- serial and parallel concatenated block of , Encoder-Tree diagram, Trellis diagram, state diagram, tra- es, Viterbi Decoding, Trellis coding, Reed Solomon codes. mel Coding II concatenated convolutional codes, Block and convolutional in rbo decoder, Trellis coded modulation-set partitioning - LDPC emporary Issues	alation d chan d chan daptiv daptiv tortion c codes code, C ansfer interlea Codes	–] nel j hou e Hu fun fun s an Conv func S hou ver, 	Bina cod: uffn uffn urs ction urs d th olut tion urs Tur	ing nan n - neir ion of rbo
Importance and t symmetric channel symmetric channel Module:4 Source Source coding the coding - Shannon Module:5 Source Module:6 Char Introduction to E properties, Encode Codes- Properties convolutional code Module:7 Char Serial and parallel coder, Iterative Tu	ypes of various channel models - Channel capacity calcu- el, binary erasure channel - Shannon's channel capacity and n's limit. ce Coding I eorem - Huffman coding - Non binary Huffman codes - A Fano Elias coding - Non binary Shannon Fano codes ce Coding II g - Lempel-Ziv coding - Run-length encoding and rate dis form coding. mel Coding I rror control codes - Block codes, linear block codes, cyclic er and Decoder design- serial and parallel concatenated block of , Encoder-Tree diagram, Trellis diagram, state diagram, tra es, Viterbi Decoding, Trellis coding, Reed Solomon codes. mel Coding II concatenated convolutional codes, Block and convolutional rbo decoder, Trellis coded modulation-set partitioning - LDPC	alation d chan d chan daptiv daptiv tortion c codes code, C ansfer interlea Codes	–] nel 6 hou e Hu fun fun 3 hou func Conv func 3 hou func	Bina cod: uffn uffn urs ction urs d th olut tion urs Tur	ing nan n - neir ion of rbo
Importance and t symmetric channel symmetric channel theorem - Shannon Module:4 Sour Source coding the coding - Shannon Module:5 Sour Arithmetic coding Overview of trans Module:6 Char Introduction to E properties, Encode Codes- Properties convolutional code Module:7 Char Serial and parallel coder, Iterative Tu Module:8 Cont Text Book(s)	ypes of various channel models - Channel capacity calculated, binary erasure channel - Shannon's channel capacity and a's limit. ce Coding I eorem - Huffman coding - Non binary Huffman codes - A Fano Elias coding - Non binary Shannon Fano codes ce Coding II g - Lempel-Ziv coding - Run-length encoding and rate dist form coding. mel Coding I rror control codes - Block codes, linear block codes, cyclider and Decoder design- serial and parallel concatenated block of , Encoder-Tree diagram, Trellis diagram, state diagram, tra- es, Viterbi Decoding, Trellis coding, Reed Solomon codes. mel Coding II concatenated convolutional codes, Block and convolutional trades. mel Coding II concatenated convolutional codes, Block and convolutional trades. Total Lecture Hours:	alation d chan d chan daptiv daptiv tortion E codes code, C unsfer E codes code, C unsfer	- 1 nel 5 hou e Hu fun 6 hou fun conv func 3 hou wer, 2 hou 5 hou	Bina codi urs uffm urs ction urs d th olut tion urs urs	ing nan n - neir ion of rbo
Importance and t symmetric channel symmetric channel theorem - Shannon Module:4 Source Source coding the coding - Shannon Module:5 Source Module:6 Char Arithmetic coding Overview of trans Module:6 Char Introduction to E properties, Encode Codes- Properties coder, Iterative Tu Module:8 Cont Module:8 Cont Text Book(s) 1. Simon Haykin	ypes of various channel models - Channel capacity calculated, binary erasure channel - Shannon's channel capacity and a's limit. ce Coding I eorem - Huffman coding - Non binary Huffman codes - A Fano Elias coding - Non binary Shannon Fano codes ce Coding II g - Lempel-Ziv coding - Run-length encoding and rate dist form coding. mel Coding I rror control codes - Block codes, linear block codes, cyclic er and Decoder design- serial and parallel concatenated block of , Encoder-Tree diagram, Trellis diagram, state diagram, tra- es, Viterbi Decoding, Trellis coding, Reed Solomon codes. mel Coding II concatenated convolutional codes, Block and convolutional in rbo decoder, Trellis coded modulation-set partitioning - LDPC emporary Issues	alation d chan d chan daptiv daptiv tortion c codes code, C ansfer codes code, C ansfer codes codes code, C ansfer codes	–] nel j hou	Bina cod: uffn uffn urs ction urs d th olut tion urs urs a.	ing nan n - neir of rbo

Hill Education (India) Pvt. Ltd., India.

- Reference Books

 1.
 John G. Proakis, "Digital Communications", 2014, 5th Edition, McGraw-Hill, McGraw Hill Education (India) Pvt. Ltd., India.

 2.
 Bernard Sklar and Pabitra Kumar Ray "Digital Communications: Fundamentals and Applications", 2012, 1st Edition, Pearson Education, India.

 3
 Khalid Sayood, "Introduction to Data Compression", Reprint: 2015, 4th Edition, Elsevier,
- 3 Khalid Sayood, "Introduction to Data Compression", Reprint: 2015, 4th Edition, Elsevier, India.

Mode of Evaluation: CAT / Assignment / Quiz / FAT / Project / Seminar

Typical Projects

- 1. Efficient Image compression technique by using modified SPIHT algorithm
- 2. Develop the compression algorithms by using Discrete Wavelet Transform
- 3. Compress and decompress an Image using Modified Huffman coding
- 4. Apply Run length coding and Huffman encoding algorithm to compress an image.
- 5. Adaptive Huffman coding of 2D DCT coefficients for Image compression
- 6. Compress of an image by chaotic map and Arithmetic coding
- 7. Region of Interest based lossless medical image compression

8. Write a code to build the (3, 1, 3) repetition encoder. Map the encoder output to BPSK symbols. Transmit the symbols through AWGN channel. Investigate the error correction capability of the (3, 1, 3) repetition code by comparing its BER performance to that without using error correction code.

9. Write a code to compare the BER performance and error correction capability of (3, 1, 3) and (5, 1, 5) repetition codes. Assume BPSK modulation and AWGN channel. Also compare the simulated results with the theoretical results.

10. Write a code to compare the performance of hard decision and soft decision Viterbi decoding algorithms. Assume BPSK modulation and AWGN channel.

11. Write a code to build (8, 4, 3) block encoder and decoder. Compare the BER performance of (8, 4, 3) block coder with (3,1,3) repetition codes. Assume BPSK modulation and AWGN channel.

12. Consider the following Extended vehicular A channel power delay profile. Write a code to model the given profile. Also measure the channel capacity. Compare the obtained capacity to that without fading channel.

Delay (ns)	Power (dB)
30	-1.5
210	2.6
310	-3.6
710	-9.1
/10	-9.1
1730	-12
1150	12

13. Performance analysis of various channels (BSC, BEC, Noiseless, Lossless) under AWGN.

14. FPGA implementation of linear block coding and syndrome decoding.

- 15. Performance of linear block codes under single error and burst error.
- 16 .Performance of analysis of convolution codes under single error and burst error
- 17. Implementation of VITERBI decoding in FPGA.
- 18. Efficiency checking of different interleaver for turbo encoder.
- 19. Implementation of trellis code modulator in FPGA.

20. Developing the Compression algorithms for Wireless multimedia sensor networks.

Mode of evaluation: Review I, Review II and Review III

Recommended by Board of Studies :		13.12.20	15	
Approved by Academic Council	No. 40		Date	18-03-2016

Course Co	de				J	<u> </u>					
ECE4009		Wireless and Mobile Communications	3 (4	5					
Pre-requis	ite	ECE4001 : Digital Communication SystemsS	Syllabu	is ver							
						1.					
Course Ob	•										
		ize the concepts related to cellular communication and its cap	pacity.								
		students with different generations of mobile networks.									
		idents the fundamentals of multipath fading and propagation									
4. To (describe	the modulation and diversity schemes as applied in mobile c	commu	nicati	on.						
Expected (1. 1	• .1							
		and solve telecommunication design issues using cellular and		ing th	leor	y.					
		e functions of the building blocks of cellular network architec									
		ctical link budget analysis for next generation cellular netwo									
		e effect of multipath channels and suggest a suitable model for	or indo	or or							
		lications.	niacti -								
		e the implications of multipath parameters in mobile commune the digital modulation schemes evailable and scleet and			لم	1					
		e the digital modulation schemes available and select approximation	ropriat	e met	nod	ť					
1		performance of wireless communication.	ffaata								
		suitable diversity technique to combat the multipath fading effective and the suitable communication system by formulating the		hnian							
		e supporting software/ hardware components.	apt tec	nniqu	es a	8. Design a wireless mobile communication system by formulating the apt techniques and					
sele	сния на										
				(b							
Module:1 Cellular co Interference	Cellu ncept – e & syst	lar Concept Frequency reuse – Channel assignment strategies – Hat em capacity – Trunking & grade of service – Improving cov	ndoff		gies						
Module:1 Cellular co Interference in cellular s	Cellul ncept – e & syst system.	ar Concept Frequency reuse – Channel assignment strategies – Hat em capacity – Trunking & grade of service – Improving cov	ndoff verage	strate; and ca	gies apac						
Module:1 Cellular co Interference in cellular s Module:2	Cellul ncept – e & syst system.	lar Concept Frequency reuse – Channel assignment strategies – Hat em capacity – Trunking & grade of service – Improving cov	ndoff verage	strateg	gies apac						
Module:1 Cellular co Interference in cellular s Module:2	Cellul ncept – e & syst system.	ar Concept Frequency reuse – Channel assignment strategies – Hat em capacity – Trunking & grade of service – Improving cov	ndoff verage	strate; and ca	gies apac						
Module:1 Cellular co Interference in cellular s Module:2 GSM archit	Cellul ncept – e & syst system. Cellul recture –	lar Concept Frequency reuse – Channel assignment strategies – Hatem capacity – Trunking & grade of service – Improving cover and the service – Improving cover and the service and the service of service – Improving cover and the service of service – Improving cover and the service of service and the service of service of service of service and the service of serv	ndoff verage ture	strates and ca 5 hou	gies apac rs						
Module:1 Cellular co Interference in cellular s Module:2 GSM archit Module:3	Cellul ncept – e & syst system. Cellul recture –	lar Concept Frequency reuse – Channel assignment strategies – Hat em capacity – Trunking & grade of service – Improving cov lar Networks - CDMA architecture – GPRS architecture – UMTS architect duction to Mobile Radio Propagation	ndoff verage ture	strateg and ca 5 hou 5 hou	gies apac rs	it.					
Module:1 Cellular co Interference in cellular s Module:2 GSM archit Module:3 Free space	Cellul ncept – e & syst system. Cellul recture – Introo propaga	lar Concept Frequency reuse – Channel assignment strategies – Hatem capacity – Trunking & grade of service – Improving cover and the service – Improving cover and the service and the service of service – Improving cover and the service of service – Improving cover and the service of service and the service of service of service of service and the service of serv	ndoff verage ture	strateg and ca 5 hou 5 hou	gies apac rs	- it					
Module:1 Cellular co Interference in cellular s Module:2 GSM archit Module:3 Free space	Cellul ncept – e & syst system. Cellul ecture – Introo propaga Two ra	lar Concept Frequency reuse – Channel assignment strategies – Hatem capacity – Trunking & grade of service – Improving coverage lar Networks - CDMA architecture – GPRS architecture – UMTS architect duction to Mobile Radio Propagation tion model – Three basic propagation mechanism – Reflection	ndoff /erage ture	strateg and ca 5 hou 5 hou	gies apac rs rs on a	- it					
Module:1 Cellular co Interference in cellular s Module:2 GSM archit Module:3 Free space scattering – Module:4	Cellul ncept – e & syst system. Cellul recture – Introo propaga Two ra	lar Concept Frequency reuse – Channel assignment strategies – Hatem capacity – Trunking & grade of service – Improving coverage lar Networks - CDMA architecture – GPRS architecture – UMTS architectectectectectectectectectectectectect	ndoff /erage ture	strates and ca 5 hour 5 hour fracti	gies apac rs rs on a	- it					
Module:1 Cellular co Interference in cellular s Module:2 GSM archit Module:3 Free space scattering – Module:4	Cellul ncept – e & syst system. Cellul recture – Introo propaga Two ra	lar Concept Frequency reuse – Channel assignment strategies – Hatem capacity – Trunking & grade of service – Improving coverage of service – Improving covera	ndoff /erage ture	strates and ca 5 hour 5 hour fracti	gies apac rs rs on a	- it					
Module:1 Cellular co Interference in cellular s Module:2 GSM archit Module:3 Free space scattering – Module:4	Cellul ncept – e & syst system. Cellul recture – Introo propaga Two ra	lar Concept Frequency reuse – Channel assignment strategies – Hatem capacity – Trunking & grade of service – Improving coverage of service – Improving covera	ndoff /erage ture	strates and ca 5 hour 5 hour fracti	gies apac rs rs on a	- it					
Module:1 Cellular co Interference in cellular s Module:2 GSM archit Module:3 Free space scattering – Module:4	Cellul ncept – e & syst system. Cellul ecture – Introo propaga Two ra Mobil t design	lar Concept Frequency reuse – Channel assignment strategies – Hatem capacity – Trunking & grade of service – Improving covered and the service – Improving covered and the service – CDMA architecture – GPRS architecture – UMTS architected and the service of the service – UMTS architected and the service of	ndoff /erage ture	strates and ca 5 hour 5 hour fracti	gies apac rs rs on a rs	- it					
Module:1 Cellular co Interference in cellular s Module:2 GSM archite Module:3 Free space scattering – Module:4 Link budge Module:5 Small scale	Cellul ncept – e & syst system. Cellul ecture – Introo propaga Two ra Mobil t design Mobil Multi e multip	lar Concept Frequency reuse – Channel assignment strategies – Hatem capacity – Trunking & grade of service – Improving coverage of the Impr	ndoff verage	5 hou 5 hou 6 hou 6 hou 9 pes of	gies apac rs rs on a rs rs						
Module:1 Cellular co Interference in cellular s Module:2 GSM archite Module:3 Free space scattering – Module:4 Link budge Module:5 Small scale	Cellul ncept – e & syst system. Cellul ecture – Introo propaga Two ra Mobil t design Mobil Multi e multip	lar Concept Frequency reuse – Channel assignment strategies – Hatem capacity – Trunking & grade of service – Improving coverage of service – Improving covera	ndoff verage	5 hou 5 hou 6 hou 6 hou 9 pes of	gies apac rs rs on a rs rs						
Module:1 Cellular co Interference in cellular s Module:2 GSM archite Module:3 Free space scattering – Module:4 Link budge Module:5 Small scale	Cellul ncept – e & syst system. Cellul recture – Introo propaga Two ra Mobil t design Mobil Multi e multip g – Fad	lar Concept Frequency reuse – Channel assignment strategies – Hatem capacity – Trunking & grade of service – Improving coverage of the Impr	ndoff verage	5 hou 5 hou 6 hou 6 hou 9 pes of	gies apac rs rs on a rs rs						
Module:1 Cellular collination Interference in cellular s Module:2 GSM archite Module:3 Free space scattering – Module:4 Link budge Module:5 Small scale scale fading and Rician	Cellul ncept – e & syst system. Cellul ecture – Introo propaga Two ra Two ra Mobil t design Mobil t design Multi e multip g – Fad fading.	lar Concept Frequency reuse – Channel assignment strategies – Harem capacity – Trunking & grade of service – Improving coverse and the service – Improving coverse and the service – CDMA architecture – GPRS architecture – UMTS architected and the service – Three basic propagation mechanism – Reflecting ground reflection model Image: Here and the service of	ndoff verage	strateg and ca 5 hour 5 hour 6 hour 6 hour 9 pes of – Ra	gies apac rs rs on a rs f sn ayle						
Module:1 Cellular collular collular collular collular collular collular service and the service of the service	Cellul ncept – e & syst system. Cellul recture – Introo propaga Two ra Mobil dulti e multip g – Fad fading.	lar Concept Frequency reuse – Channel assignment strategies – Hatem capacity – Trunking & grade of service – Improving coverage of the Impr	ndoff verage ture ion, dif odels s – Ty spread	5 hou 5 hou 6 hou 6 hou 7 hou 9 hou	gies apac rs rs rs rs rs f sn ayle rs						

and its reduction techniques.

Module:7	Diversity Techniques	6 hours
	Types of diversity – Diversity combining techniques: Selection, Fe	edback, Maximal
Ratio Comb	bining and Equal Gain Combining – Rake receiver	
Module:8	Contemporary issues	2 hours
Wiouuic.o	Contemporary issues	2 11001 5
	Total Lecture hours:	45 hours
Text Book		
	port, T.S., "Wireless communications", 2012 (Reprint), 2 nd edition, P	earson Education
Noida,		
Reference		
	ngal, "Wireless Communications", 2014 (Reprint), Tata McGraw H	fill Education, 1 ^s
	, New Delhi, India. Q T Zhang, "Wireless Communications: Principles, Theory and Met	hadalagy" 2016
	ion, John Wiley & Sons, West Sussex, UK.	1100010gy , 2010,
	as.F. Molisch, "Wireless Communications", 2012, 2 nd edition, John	n Wiley & Sons
West S	ussex, UK.	
	u Sasibhushana Rao, "Mobile Cellular Communications", 2013, 1 ^s	^t edition, Pearsor
	ion, Noida, India.	
	Cho, J. Kim, W.Y. Yang, C. G. Kang, "MIMO-OFDM Wireless Com	munications with
	", 2014 (Reprint), 1 st edition, John Wiley & Sons, Singapore.	
	valuation: Continuous Assessment Test –I (CAT-I), Continuous Ass Digital Assignments/ Quiz / Completion of MOOC, Final Assessment	
	Illenging Experiments (Indicative)	Test (FAT).
	ly the effect of various fading channels such as Rayleigh, Ricean and	3 hours
	s noise channel such as AWGN and Laplacian noise	S nouis
	te to compute the pathloss of urban, suburban and rural environment	3 hours
	E/WiMAX/WLAN system using free space, Ericsson, COST 231,	
ECC, I	Hata and SUI model	
3. Evalua	te Signal to Interference Noise Ratio (SINR) distribution for the	6 hours
	ng scenarios	
	Effect of changing transmit power	
	Effect of common vertical tilt of antennas	
	Effect of changing percentage of users who are indoor and outdoor Different Terrains	
	te link level Bit Error Rate (BER) performance	6 hours
	Link level BER Performance without FEC	0 110015
	Link level BER Performance with various CQI indices	
с.	Link level BER Performance with various transmission mode	
5. Study of	of relative interference levels in homogeneous networks	3 hours
	te SINR distribution for heterogeneous scenarios with Picos	5 hours
	Effect of Pico locations and number of Picos	
	Effect of power levels of Picos	
	Effect of Pico bias	<i>1</i> 1 - - - - - -
•	of CQI variation CQI variations for different users	4 hours
	CQI variations in different sub bands	
υ.	Total Laboratory hour	s 30 hours

Mode of evaluation: Continuous Assessment of Challenging experiments / Final Assessment Test (FAT)

Typical Projects

- 1. Energy-and cost-efficient mobile communication using multi-cell MIMO and relaying techniques
- 2. Inter-cell interference mitigation for mobile communication system
- 3. Improving capacity / resource allocation for soft handoff performance in wireless mobile communication
- 4. Security in mobile communication
- 5. Call admission and control schemes for QoS in cellular networks
- 6. Analysis of different traffic models in mobile communication
- 7. Dynamic channel assignment in wireless mobile communication
- 8. Performance analysis of macrocell / microcell hierarchical cellular systems
- 9. Performance analysis of propagation models
- 10. Performance analysis of modulation schemes

Mode of evaluation: Review I, II and III.			
Recommended by Board of Studies :	13.12.2015		
Approved by Academic Council	No. 40	Date	18-03-2016

Course Code	Course Title		L T P J C			
ECE 4025	EMBEDDED PROGRAMMING		2 0 2 0 3			
Pre-requisite	ECE 3031 Microcontroller and Embedded System		Version:1			
Course Objecti	•					
The course is ai						
	Embedded C and Linux and the range of applications to v	which they	are suited.			
2. Developing skills in the Embedded C, SHELL programming and Linux						
	the students with data structures					
Expected Cour						
	e course, the student should be able to					
	d write simple Embedded pseudo codes.					
	he fundamentals of C					
-	he Data structures					
-	he basics of OS Concepts and Linux					
1	skill, knowledge and ability of SHELL programming.					
	orking knowledge of basic Embedded Linux					
	r experience in using state-of- art hardware and software t	ools				
		0015				
Module:1	Basics of Embedded Programming	3 hours				
	of C, Embedded C Vs. C, Embedded programming aspects					
	S Functions, Data Types, Data Type Conversions - Operat	lors - Cond	luonai			
	Controls- Input / Output Operations.	2 h anna				
	C Programming Concepts	3 hours				
	ys, pointers, structures and Inputs/Outputs	21	Γ			
	Data Structures	3 hours				
	gle linked list, Double linked list, Stack and Queues	21				
	OS Concepts	3 hours				
	m structures, Process Management, Process Synchronizat		cheduling			
	Basics of Linux	6 hours				
	pt, X windows basics, Navigating file system, finding file					
	t editing in Linux, Compression and archiving tools, Basic	c shell com	mands, File			
	O Handling, File Locking	·				
	Shell Programming	5 hours				
-	g more than one command at a time, prioritizing and killin	• •	-			
· I I	es and redirection, regular expression, pattern matching, S	cripting us	ing for while,			
if and other com						
	Linux Programming Concepts	5 hours				
	nt, I/O Handling, File Locking, Process Management, N	Iemory Ma	nagement,			
<u> </u>	s, Shared Memory, Semaphores					
Module:8	Contemporary issues:	2 hours				
	Total Lecture hours:	30 hours				
Text Book(s)						
	thew, Richard stones, Beginning Linux Programming, 201	2 reprint, V	Wrox –Wiley			
	Publishing, USA.					
2. Eric Foster Johnson, John C. Welch, Micah Anderson, Beginning shell scripting, 2012,						
<u> </u>	Wrox – Wiley Publishing, USA.					
Reference Bool	άδ					
	ove, Linux System Programming: Talking directly to the k	kernel and (C library: and			
C Librar	y, 2013, 2 nd Edition, O'Reilly Publication, USA.					

2. 3.	Paul J. Deitel, C How to Program, 201 William Stallings, Operating System,		
	of Evaluation: Continues Assessment T		
Test			
List o	f Challenging Experiments (Indicativ	e)	
1.	Task 1: C programming Create a child process by calling fork s	existem call and display the cu	5 hours
	process ID and parent process ID for th	ne following conditions.	ment
	(i) Process ID and parent process ID fe		
	(ii) Process ID and parent process ID f	or process and childprocess	while
	sleep in theparent.	for measure and shildnesses	while
	(iii) Process ID and parent process ID t sleep in achild.	for process and childprocess	white
2.	Task 2: C programming		5 hours
	Create a pipe system call to communic	ate between the parent proce	ss and
	child process.	1.00	
	Create a fifo system call and communi		
3.	Task 3: Implementation of data structu		6 hours
	Write a SortedMerge() function t		
	sorted in increasing order, and merges		
	is in increasing order. SortedMerge() s list should be made by splicing togethe		
4.	Task 4: Shell Programming	if the hodes of the first two h	6 hours
4.	Development of inventory manage	ment system using Shell scri	
	with the following features. User may		
	• User may add/update inventory		
	• Details include cost, quantity and		
	• Includes forms for inventory in	-	
	• User may create sub-inventorie		
	• An interactive user interface		
5.	Task 5: Inter Process Communication		6 hours
	Write an implementation of Message q	ueue, shared memory and	
	semaphore inter process communication		
		Total Laborato	ry Hours 30 hours
	of Evaluation: Challenging Experiment		
Recor	nmended by Board of Studies :	26-02-2017	
Appro	oved by Academic Council 44	Date :	16-03-2017

Course Code	Course Title			L T P J				
ECE4026	M2M COMMUNICATIONS		2	0	0	4	3	
Pre-requisite	ECE3030 - Principles of Computer Commu	nications	Version : 1.2					
Course objecti	ives (CoB):							
	The course is aimed at							
1. Introducing students with the basic concepts of M2M communication								
2. Acquainting	2. Acquainting with M2M architecture, protocols and its security							
3. Knowing the	3. Knowing the significance of M2M interfaces and services							
Course Outco	Course Outcomes (CO):							
At the end of th	ne course the student should be able to							
1. G et acquain	ted with the basics of M2M Communication							
2. Understand t	he operation of M2M protocols and architecture							
3. Possess an a	bility to optimize the M2M in public mobile netw	vorks						
4. Know about	IP in M2M							
5. distinguish b	etween different types of M2M security methods							
	the operation and, characteristics of M2M termine		aces					
7. Familiarise v	vith the basics of M2M services							
8. Analyse the	traffic models, routing protocols and different ser	vices using me	oderi	n eng	inee	ring		
tools.		-		-				
	I							
Module:1	Introduction M2M	4 hours						
What is M2M,	Business of M2M, Accelerating M2M maturity,	High level M2	M fr	amev	vork	,		
	Standards, M2M Value Chain, MVNO Led Mod							
Deployments.								
· ·	M2M Architecture and Protocols	4 hours						
Use-Case drive	n approach in M2M architecture, ETSI-M2M wo	ork on use case	s, Sr	nart l	Mete	ring		
	FSI M2M , Typical Smart Metering Deployment S							
market applicat								
	M2M Optimization in Public Mobile	5 hours						
	Networks							
M2M over a Te	elecommunications Network, M2M Communicat	ion Scenarios.	Data	a Cor	nnect	ions		
	ications, 3GPP Standardization of Network Impro							
11	ns, Numbering, Identifiers, and Addressing, Trigg				• •	bad a	nd	
Congestion Co				<i>,</i>				
	P in M2M	3 hours						
Neighbor Disco	overy Protocol, IPv6 for M2M, 6LoWPAN: Fram		r Co	mpre	ssio	۱.		
-	ol for Low-Power and Lossy Networks (RPL), R			-				
Architecture.	5	1 057		,				
	M2M Security	5 hours						
	cteristics of Cellular M2M, Security Requirement		vork	Prov	vider	M	2M	
	er perspectives, Approaches Against Hijacking, l							
		•						
based solutions, Methods Based on Pre-Provisioned Symmetric Keys, Bootstrapping and identity based encryption, Security for Groups of M2M Devices, ETSI M2M Security.								
Module:6M2M Terminals and Interfaces3hours								
	ogies, Physical form factors, Hardware interfaces		ersal	Integ	orate	d		
	nterface, GPIO (General-Purpose Input/Output Po						eral	
	face, Analog Audio Interfaces. Durability test.			50110		12110	41	
	M2M Services	4 hours						
	ecution Environment, Connectivity Services, Ma		ices	Soft	Ware			
					vv ai C	/		
services, AT C	services, AT Commands, SDK commands, Cellular identification, MNO Identification.							

Module:8	Contemporary issues:			2 hours			
				Total 1	Lecture hours:30 hours		
Text Book(s							
1. David	1. David Boswarthick, M2M Communications – A Systems Approach, 2012, Wiley, USA.						
Reference B	ooks						
	lav B. Misic, JelenaMisic,						
	nologies, Standards and Ap	-					
	s Anton-Haro, Mischa Doh						
	rmance and Applications, 2						
	luation: Continuous Assess	sment Test	s, Quiz, Digit	al Assignme	ent, Final Assessment		
Test							
Typical	.						
	n and implement a Teleme				munications.		
0	n and implement Telemetr	• • • •	0				
	n and implement a Buildin	0 0	0	2M			
	n and implement M2M Ap	1	U U				
	n and implement M2M Ap	1	0				
	n and implement Healthca		•				
0	n and implement Power se		•				
	8. Design and implement Transport and logistics using M2M						
-	Design and implement Smart metering applications						
	luation: Continuous Assess	sment Rev					
	ed by Board of Studies :		26-02-2017				
Approved by	Academic Council :	44	Date :		16-03-2017		

Course code	Course title		L T P J C		
ECE4027	EMBEDDED SENSING TECHNOLO	OGIES	2 0 0 4 3		
Pre-requisite	ECE3031 Microcontroller and Embedded Sy	stems	Version:1		
Course Objectives	s:				
The course is aime	d at				
1. Introducing fund	damentals of sensing and exploration of various se	ensors widel	ly used for real life		
application.					
2. Making a shift to	owards advanced microcontrollers for interfacing	sensors.			
Expected Course	Outcome:				
At the end of the course, the student should be able to					
1. Understand the v	vorking principle and behavior of sensors				
	e the importance automotive sensors and bio med				
3.Differentiate and	l associate the architecture, instruction set, inte	errupts of M	ISP430 and ARM		
Cortex M4.					
4. Know the ARM	A peripherals programming and interfacing	with adva	nced cortex MX		
microcontroller					
5. Design and inter	face sensors with embedded controllers				
	damentals of Sensors	5 hours			
	ng- capacitance- magnetic and electromagnetic in				
piezoelectric effect	t – heat transfer-light. Physical sensors, Optical D	etectors and	Sensors		
	omotive Sensors	4 hours			
Pressure, Engine te	emperature, Airflow, Combustion, Torque, Accele	erometers, G	as composition		
sensors – Liquid le	evel sensors				
	medical sensors	3 hours			
Electrical Potential	ls and Propagation of Nerve Signals, Electrodes, I	EMG, ECG,	EEG, Blood		
pressure.					
Module:4 Low	Power Microcontroller	4 hours			
	ture, Memory, Addressing modes, Instruction set,	Clock syste	em, Exceptions:		
<u> </u>	ts - Low power mode.				
	M Cortex MX Processor	4 hours			
ARM Cortex M4:	Assembly language basics, Thumb-2 Technology	, ARM Instr	uction set, Cortex		
M4 architecture, ad	dvantages, peripherals, instruction set, floating po	int operatior	ns.		
Module:6 ARM	M Peripherals Programming and Interfacing	4 hours			
1	equisition, ADC, DAC ,Sensor interface, single ch		Ũ		
	Displays, Watchdog timers, timers, SPI, I2C, UA	-	controller		
	anced Cortex MX Microcontroller	4 hours			
	, on chip wifi, configuring WLAN, on CHIP 6Lo		configuration.		
Module:8 Co	ntemporary issues:	2 hours			
	Total Lecture hours:	30 hours			
Text Book(s)					
1. Jacob Fraden, Handbook of Modern Sensors: Physics, Design and Applications, 2016, 5th					
Edition, Springer, USA					
2. John H. Davies, MSP430 Microcontroller Basics, Newones, 2011, second edition,					
Elsevier, USA.					
Reference Books					
	tomotive Sensors, 2012, Momentum Press, USA.				
	Medical Instrumentation; Application and Des	ign, 2010, 4	4th Edition, John		
Wiley, USA.					
3. John G Webster, Measurement, Instrumentation and sensors Handbook, 2014, CRC Press,					

USA.

4. Jonathan W Valvano, Embedded Systems: Introduction to ARM Cortex -M Microcontrollers, 2017, 5th edition, University of Texas, USA

Mode of Evaluation: Continuous Assessment Tests, Quiz, Digital Assignment, Final Assessment Test

Typical Projects

- 1. Remote monitoring of soil parameters deploy sensors in a land to measure the parameters like moisture, temperature, humidity etc.
- 2. Power optimization in home: Using human activity defectors appropriate appliances should be activated for a home application
- 3. Design and development of a prototype to demonstrate the structure health monitoring using strain gauge, accelerometer, ultra sonic sensor etc.
- 4. Design a gesture based controller to operate appropriate motors remotely.
- 5. Design an intelligent wearable device like watch, cap to sense the physical condition of human and to log the data for further analysis.
- 6. Design and develop an embedded bed monitoring system capable of sensing patient's temperature, pressure, pulse rate, ECG etc and decide necessary actuations

Mode of Evaluation:	Continuous	Assessment	Rev	views

Recommended by Board of Studies :		26-02-2017		
Approved by Academic Council :	44	Date :	16-03-2017	

Course Code	Course Title			Τ	P	J	С
ECE4030	Building Management Systems			0	0	0	1
Pre-requisite	NONE			Version : 1			
Course Object							
The Course is							
1. Acquainting	the student with the basic concepts of Building N	Management Sy	/sten	ns an	d co	mfoi	t
parameters.							
2. Describing	the students how HVAC, security Engineering, fin	re Engineering,	and	intru	ision		
systems works							
3. Making the	students to insight into Compressor performance.						
Course Outco							
	course, the student will be able to						
	e basic concepts of BMS						
	working of HVAC						
	various performance parameters of a compressor						
	relate various "concept parameters" in building r	nanagement sy	stem	S			
	the need and operation of security engineering						
	arious intrusion systems (FAT)						
7. Understand	the working of fire Engineering systems (FAT)						
Module:1	Introduction	2 hours					
	BMS and intelligent buildings, energy efficiency	, architecture of	f BM	IS, ir	trod	uctio	m
	protocols used in BMS.						
Module:2	Heating, Ventilation & Air-Conditioning	2 hours					
	(HVAC)						
	eating, ventilation & air-conditioning, concept of						
	vantages and disadvantages of AHU, different equ	uipment's in Al	HU,	diffe	rent	cont	rol
strategies							
Module:3	Compressor	1 Hour					
-	ompressor, heat recovery system, humidification,	de-humidificat	ion,	energ	gу		
conservation i							
Module:4	Comfort Parameters Measurement in	2 Hours					
	BMS System						
	emperature sensors, humidity and the Psychrome	tric chart moist	ure s	enso	rs, p	ressi	ıre
,	sensors and meters						
	Security Engineering	2 Hours					
	lifferent controllers used for the security, access c						
	Intrusion Systems	2 Hours					
Components of	f video surveillance system, CCTV & video surve	eillance system	s, co	mpo	nents	s of	
intrusion alarr							
Module:7	Fire Engineering	2 Hours					
Concept of fire, cold fire, concept of smoke, fire detection system, fundamental of fire alarm							
system, smoke detection system, fire alarm control panel, smoke detector, flame or fire detectors.							
Module:8Contemporary Issues2 Hours							
		Total Lect	ture	houi	s: 1	5 ho	urs
Text Book(s)							
	ng Management Systems-Course Material" by Jo	hnson controls	of Ir	idia			
	Reference Books						
	1. Building Energy Management Systems: An Application to Heating, Natural Ventilation,						
Lightin	Lighting and Occupant Satisfaction by Geoff Levermore, 2 nd Edition, Routledge, 2000						

 Automation Systems In Smart and Green Buildings by <u>V.K. Jain</u>, Khanna Publishers; First edition, 2009 					
Mode of Evaluation:					
Continuous Assessment Test + Digital Assignment +Quiz + Final Assessment Test					
Recommended by Board of Studies :		31-08-2018			
Approved by Academic Council :	53	Date :	13-12-2018		

Course Code	Course title	L T	PJC
ECE4031	Artificial Intelligence with python	3 0	2 0 4
Pre-requisite	NONE	Versi	on : 1
Course Objective	es:		
The course is aim			
	sure to the advancements in the Artificial Intelligence	e (AI) and facilitate	in depth
discussions on ch		• () •••••	m avpm
	mathematical and computational challenges of Clas	ssification. Regression	on using
0	ig and Predictive Analytics with Ensemble Learning		
	sure to various Artificial Intelligence techniques using		
Expected Course		ing i julion.	
	s course, the students will be able to		
	mary concepts of AI and Python.		
	e mathematical and computational models of Clas	sification Regression	on using
	ig and Predictive Analytics with Ensemble Learning		Jii using
	rn detection using Unsupervised Learning		
	ew of Building Recommender and Logic Programm	ing	
	e applications of AI, solution of which can be render	0	
	learnt artificial intelligence concepts in solving th		ms at a
basic level.	leant artificial intelligence concepts in solving in	e lear world proble	ins, at a
Module:1	Drimon Concenta	6 Hours	
	Primer Concepts		u alt a a
	al intelligence (AI) – Necessity of learning AI – App		
_	ce - Agent and Environment – python for AI – Featu	res of python – scrip	l Irom
the command line		7 11	
Module:2	Classification and Regression using	7 Hours	
	Supervised learning		_
	nsupervised learning – classification – preprocessing		
	n Classifier – Naïve Bayes Classifier – Confusion m		
	fying income data using Support Vector Machines –		
-	gressor - Building a multivariable regressor- Estimat	ing housing prices us	sing a
Support Vector R	0		
Module:3	Predictive Analytics with Ensemble Learning	6 Hours	1.
	ng - Decision Trees - Random Forests and Extremely		0
	nce-Finding optimal training parameters using grid		elative
	e - Predicting traffic using Extremely Random Fores		1
Module:4	Detecting Patterns with Unsupervised	6 Hours	
	Learning		
	rning - Clustering data with K-Means algorithm		
	n Shift algorithm - Estimating the quality of cluste	-	
	Models - Building a classifier based on Gaussian M		-
	k market using Affinity Propagation model- Segmen	ting the market base	d on
shopping patterns		1	
Module:5	Building Recommender	5 Hours	
	g pipeline - Extracting the nearest neighbors - Buildi		
_	ating similarity scores - Finding similar users using c	collaborative filtering	5 -
-	recommendation system		
Module:6	Logic Programming	5 Hours	

Basics of logic programming - Understanding the building blocks of logic programming - Solving problems using logic programming - Installing Python packages - Matching mathematical expressions

expression-Validat	ing primes - Parsing a family tree	- Analyzing geograp	hy - Building a puzzle solv	rer
Module			8 Hours	
Heuristic	Search Techniques - Genetic Al	1,	ames With Artificial Intell	igence ·
	A Speech Recognizer - Object D			U
Module			2 Hours	
Total Le	ecture hours:		45 Hours	
Text Boo	ok(s)			
1.	Artificial intelligence with p	ython, Prateek Jos	hi, Packt publishing	Ltd,
	UK, ISBN 978-1-78646-439-	2, 2017.		
2	Python code for Artificial	Intelligence: Four	dations of Computation	ona l
	Agents, David L. Poole and	Alan K. Mackwo	orth, Cambridge Uni	versity
	Press, 2017.			
	Artificial Intelligence: A M			ussell,
	Peter Norvig, Pearson Public			
	A First Course in Artificial	Intelligence, Dee	epak Khemani, McGrav	w Hill
	Education (India), 2013.			
	Introduction to Artificial In		C. Jackson, Second En	larged
	Edition, Dover Publications,			
	Evaluation: Continuous Assess	sment Test + Digital	Assignment +Quiz + Fina	al
	ent Test			
Lab Exe				
1.	Searching for Solutions: 7			
	branch and bound algorithm	n for identifying o	ccurrence of element of	r not
2	in the given graph.		1 1 1 ' .'	1
2.	Reasoning with Constrain			
	probabilistic mix of the var		•	
	and a random variable, to			. It
2	only maintains the data strue			dina
3.	Propositions and Inference consistency-based diagnosi		es foi assumable, meru	ung
1	Learning with Uncertain		tation of k means	and
4.	Expectation – maximization			
5.	Multiagent Systems: Impl	-	-	-
Э.	and mini- max with alpha-be		o prayer zero-sum g	annes
6.	Reinforcement Learning		del- based reinforce	ment
0.	learner, Feature- based rei	-		
	games	moreement rearner	and imprementing st	
Recomm	ended by Board of Studies :	31-08-2018		

Course Code	Course title		L T P J C
ECE4032	Neural Networks and Deep Learning		3 0 0 4 4
Pre-requisite	NONE	,	Version : 1
Course Objective	es:		
The course is aime	ed at making the students to		
	al networks advances and facilitate in depth discussion	ons on deep lea	rning
2. Understand abo	out the mathematical, statistical and computational of	challenges of b	uilding stable
representations for	r high-dimensional data, such as images, text and da	ta.	
3. Understand the	convolutional architectures, invariance learning, uns	supervised lear	ning and non-
convex optimizati	on.		
Expected Course	Outcome:		
The Students will	be able to		
1.Understand the	types of network architectures, learning processes	, and fundame	ntal issues &
challenges in deep	••••••		
0 1	e architectures of Deep feed forward Networks and C	Convolutional n	etworks.
	usage of Recurrent Neural Networks and Auto Enco		
	Generative Network - Boltzmann Machine for a pro		
-	al Intelligence based solutions		
-	of deep learning algorithms for the real world appli	cations.	
1			
Module 1 II	ntroduction to Neural Networks	3 Hours	
Definition - McCu	Illoch-Pitts's Neuron - Types of activation function -	Types of netw	ork
	urning processes - Advantages and disadvantages	51	
	Brief Introduction to Deep Learning	4 Hours	
	in Deep Learning; Applied Math and Machine Learr	ing Basics: Li	near Algebra:
	formation Theory; Numerical Computation; Machin		
	eep Feed forward Networks and Convolutional	10 Hours	
	etworks		
Example Learning	XOR; Hidden Units; Architecture Design; Backpro	pagation; Regu	larization for
	ptimization for Training Deep Models; The convolu-		
	of basic Convolution Function; Efficient Convolution	-	
Adversarial Netwo		C A	
Module:4 S	equence Models:	6 Hours	
	Networks; Bi directional RNNs; Deep Recurrent Networks; Bi directional RNNs; Deep Recurrent Networks; Deep Recurrent Netw	tworks; Leaky	units; Long
	bry and Other Gated RNNs		
Module:5 A	uto Encoders:	7 Hours	
Under-complete A	uto-encoders; Regularized Auto-encoders; Represer	ntational Power	. Layer Size
±	stic Encoders and Decoders; De-noising Auto-encoders		•
- ·	rs; Contractive Auto-encoders; Predictive Sparse De		
of Auto-encoders		1	
Module:6 D	eep Generative Models:	7 Hours	
	nes; Restricted Boltzmann Machines; Deep Belief N	etworks; Deep	Boltzmann
	ann Machines for Real-Valued Data; Convolutional	· .	
	nes for Structured or Sequential Outputs Other Boltz		
	ractical Applications and Road to Artificial	6 Hours	
	ntelligence:		
	Learning; Computer Vision; Speech Recognition; N	atural Languag	e Processing;
Other Application			
	contemporary Issues	2 Hours	
Total Lecture ho		45 Hours	

Text Book:

- 1) Deep Learning, Ian Goodfellow, Yoshua Bengio and Aaron Courville, MIT Press, ISBN: 9780262035613, 2016.
- 2) Neural Networks & Deep Learning, Pat Nakamoto, Kindle Edition, 2016.
- 3) Neural Network and Deep Learning, Michael Nielsen, Online Book, 2016

Mode of Evaluation: Continuous Assessment Test + Digital Assignment +Quiz + Final Assessment Test

List of Projects (J) (Indicative

- 1) Sleep Prediction Using Consumer Wearable Devices
- 2) Unsupervised Face Recognition in Television News Media
- 3) Finding Sarcasm in Reddit Postings: A Deep Learning Approach
- 4) Fake News Detection
- 5) Predicting Diabetes Re-admittance
- 6) Deep Imitation Learning for Playing Real Time Strategy Games
- 7) Time Series Sales Forecasting
- 8) A neural network approach for predicting urban building energy consumption
- 9) Weather-driven predictions of solar energy
- 10) Real-time Image Style Transfer
- 11) Deep Learning Approach to Accent Recognition
- 12) Voice Commands Recognition with Convolution Neural Network
- 13) Detecting Thoracic Diseases from Chest X-Ray Images
- 14) Supervised Learning for Autonomous Driving
- 15) Real-time Emotion Recognition From Facial Expressions

Recommended by Board of Studies:		31-08-2018	
Approved by Academic Council:	53	Date :	13-12-2018

Course code	Web Technologies	
ITE1002		
Pre-requisite	CSE1001	Syllabus versio
		1.1
Course Objective		
	the web architecture and web languages.	
1 0	web client and web server objects.	
5. To understand	web development environment and methodology	
Expected Course	Outcome:	
A	t interactive and responsive web pages using HTML and CSS	
	cript language to transfer data and add interactive component	
	sophisticated web application that appropriately employs the	
	ate a client server application using HTTP protocol and access	
	ent using AJAX.	
	e working of server-side scripts.	
	d the fundamental working of data using open source database	
	dvanced web frameworks by combining multiple web technol	logies
8. Implemen	t Client side and Server side programming.	
		4 hou
	Essentials – Web architecture – HTML –XHTML- CSS	4 hou
Evolution of Web	– Web architecture – HTML –XHTML- CSS	
Evolution of Web	- Web architecture – HTML –XHTML- CSS	5 hour
Evolution of Web Module:2 Clien Javascript Basics	 Web architecture – HTML –XHTML- CSS nt-Side Scripting –Arrays- Functions - Javascript objects – HTML DOM 	5 hou
Evolution of Web Module:2 Clien Javascript Basics	- Web architecture – HTML –XHTML- CSS	5 hou
Evolution of Web Module:2 Clien Javascript Basics Events- Regular E	- Web architecture – HTML –XHTML- CSS nt-Side Scripting –Arrays- Functions - Javascript objects – HTML DOM Expressions – Form Validation-JSON-Jquery	5 hou - DOM methods
Evolution of WebModule:2ClienJavascriptBasicsEvents-Regular EModule:3Web	 Web architecture – HTML –XHTML- CSS nt-Side Scripting –Arrays- Functions - Javascript objects – HTML DOM Expressions – Form Validation-JSON-Jquery Applications 	5 hou - DOM methods 5 hou
Evolution of Web Module:2 Clien Javascript Basics Events- Regular E Module:3 Web Web applications	Applications Application Frameworks-MVC framework-Angular	5 hour - DOM methods - 5 hour
Evolution of Web Module:2 Clien Javascript Basics Events- Regular E Module:3 Web Web applications	 Web architecture – HTML –XHTML- CSS nt-Side Scripting –Arrays- Functions - Javascript objects – HTML DOM Expressions – Form Validation-JSON-Jquery Applications 	5 hour - DOM methods - 5 hour
Evolution of Web Module:2 Clies Javascript Basics Events- Regular E Module:3 Web Web applications Applications-Res	Applications Application Frameworks-MVC framework-Angular	5 hour - DOM methods - 5 hour - JS – Single Pag
Evolution of WebModule:2ClienJavascriptBasicsEvents-Regular EModule:3WebWebapplicationsApplications-ResModule:4Clien	- Web architecture - HTML -XHTML- CSS -Arrays- Functions - Javascript objects - HTML DOM -Arrays- Form Validation-JSON-Jquery -Applications - Web Application Frameworks-MVC framework-Angular ponsive Web Design	5 hour - DOM methods - 5 hour - JS – Single Pag 4 hour
Evolution of WebModule:2ClierJavascriptBasicsEvents-Regular EModule:3WebWebapplicationsApplications-ResModule:4Clier		5 hour - DOM methods - 5 hour - JS – Single Pag 4 hour
Module:2ClientJavascriptBasicsJavascriptBasicsEvents-RegularModule:3WebWebapplicationsApplications-RespondentClientModule:4ClientHTTP-Request/RModule:5Web	Applications Web Application Frameworks-MVC framework-Angular Meb Design Model- HTTP Methods- RESTful APIs-AJAX-AJAX	5 hour - DOM methods - 5 hour - JS – Single Pag 4 hour X with JSON 5 hour
Evolution of Web Module:2 Clien Javascript Basics Events- Regular E Module:3 Web Web applications Applications-Resp Module:4 Clien HTTP- Request/R Module:5 Web		5 hour - DOM methods - 5 hour JS – Single Pag 4 hour X with JSON 5 hour
Evolution of Web Module:2 Clien Javascript Basics Events- Regular E Module:3 Web Web applications Applications-Resp Module:4 Clien HTTP- Request/R Module:5 Web	Applications Web Application Frameworks-MVC framework-Angular Meb Design Model- HTTP Methods- RESTful APIs-AJAX-AJAX	5 hour - DOM methods - 5 hour - JS – Single Pag 4 hour X with JSON 5 hour
Evolution of Web Module:2 Clien Javascript Basics Events- Regular Basics Module:3 Web Module:3 Web Module:3 Web Module:3 Web Module:4 Clien HTTP- Request/R Module:5 Web		5 hour - DOM methods - 5 hour - JS – Single Pag 4 hour X with JSON 5 hour ng
Evolution of WebModule:2ClienJavascriptBasicsEvents-Regular EModule:3WebWebapplicationsApplications-RespModule:4ClienHTTP-Request/RModule:5WebNode.js-NPM-CaModule:6Stor		5 hour - DOM methods - 5 hour - JS – Single Pag 4 hour X with JSON 5 hour ng
Evolution of WebModule:2ClienJavascriptBasicsEvents-Regular EModule:3WebWebapplicationsApplications-RespModule:4ClienHTTP-Request/RModule:5WebNode.js-NPM-CaModule:6Stor	 Web architecture – HTML –XHTML- CSS nt-Side Scripting Arrays- Functions - Javascript objects – HTML DOM Expressions – Form Validation-JSON-Jquery Applications Applications Web Application Frameworks-MVC framework-Angular ponsive Web Design nt/Server Communication Asymptote Model- HTTP Methods- RESTful APIs-AJAX-AJAX Servers Allbacks -Events- Express framework-Cookies-Sessions-Scalinage 	5 hour - DOM methods - 5 hour - JS – Single Pag 4 hour X with JSON 5 hour ng
Evolution of Web Module:2 Clier Javascript Basics Events- Regular E Module:3 Web Web applications Applications-Resp Module:4 Clier HTTP- Request/R Module:5 Web Node.js-NPM- Ca Module:6 Stor	 Web architecture – HTML –XHTML- CSS nt-Side Scripting Arrays- Functions - Javascript objects – HTML DOM Expressions – Form Validation-JSON-Jquery Applications Applications Web Application Frameworks-MVC framework-Angular ponsive Web Design nt/Server Communication Asymptote Model- HTTP Methods- RESTful APIs-AJAX-AJAX Servers Allbacks -Events- Express framework-Cookies-Sessions-Scalinage 	5 hour - DOM methods - 5 hour - JS – Single Page 4 hour X with JSON 5 hour ng 3 hour
Evolution of WebModule:2ClienJavascriptBasicsEvents-Regular EModule:3WebWebapplicationsApplications-RespModule:4ClienHTTP-Request/RModule:5WebNode.js-NPM-CaModule:6StorMongoDB-ManipModule:7Read	- Web architecture - HTML -XHTML- CSS -Arrays- Functions - Javascript objects - HTML DOM -Arrays- Functions - Javascript objects - HTML DOM -Arrays- Form Validation-JSON-Jquery -Applications - Web Application Frameworks-MVC framework-Angular ponsive Web Design -Arrays- Model- HTTP Methods- RESTful APIs-AJAX-AJAX Servers Illbacks -Events- Express framework-Cookies-Sessions-Scalin age ulating and Accessing MongoDB Documents from Node js	5 hour - DOM methods - 5 hour - JS – Single Page 4 hour X with JSON 5 hour ng 3 hour 2 hour
Evolution of Web Module:2 Cliet Javascript Basics Events- Regular E Module:3 Web Module:3 Web Module:3 Web Applications Applications Module:4 Cliet HTTP- Request/R Module:5 Module:5 Web Module:6 Stor MongoDB-Manip Module:7	- Web architecture – HTML –XHTML- CSS -Arrays- Functions - Javascript objects – HTML DOM -Arrays- Functions - Javascript objects – HTML DOM -Arrays- Form Validation-JSON-Jquery -Applications - Web Application Frameworks-MVC framework-Angular ponsive Web Design -Arrays- Communication -Arrays- RESTful APIs-AJAX-AJAX Servers Illbacks -Events- Express framework-Cookies-Sessions-Scalin age pulating and Accessing MongoDB Documents from Node js	5 hour JS – Single Pag 4 hour X with JSON 5 hour ng 3 hour 2 hour
Evolution of Web Module:2 Clientics Javascript Basics Events- Regular E Module:3 Web Web applications Applications-Respondent Module:4 Clientics Module:5 Web Module:6 Stor MongoDB-Manip Module:7 Module:7 Read Meteor JS framev Stor	- Web architecture – HTML –XHTML- CSS -Arrays- Functions - Javascript objects – HTML DOM -Arrays- Functions - Javascript objects – HTML DOM -Arrays- Form Validation-JSON-Jquery -Applications - Web Application Frameworks-MVC framework-Angular ponsive Web Design -Arrays- Communication -Arrays- RESTful APIs-AJAX-AJAX Servers Illbacks -Events- Express framework-Cookies-Sessions-Scalin age pulating and Accessing MongoDB Documents from Node js	5 hour - DOM methods - 5 hour - JS – Single Page 4 hour X with JSON 5 hour ng 3 hour 2 hour

		Total Lecture hours:	30 hours	
Tex	xt Book(5)		
1.		ayley, Node.js, MongoDB, and AngularJS Web De		
2.	Morris	Mano, Digital logic and Computer design, 4 th Edition	on, Pearson, 20	008.
Ref	ference I			
1.		ckett,HTML & CSSDesign and Build Websites,Wil		
2.		ckett, JavaScript and JQuery: Interactive Front-End	Web Developn	nent,Wiley,2014
3.		er, Ajax: The Definitive Guide,Oreilly,2010		
Lis		llenging Experiments (Indicative)		
1.		HTML to perform the following.		
	a)	Design the spotlight section of VIT home page. Us	se Box properti	ies of CSS.
	b)	To create a web page which includes a map and di	splay the relate	ed information when
		a hot spot is clicked in the map		
	c)	Create a web page which displays an image "gane"	sha.jpg" and th	e text "This is image
		of Lord Ganesh". Place three buttons in the web	page which pe	rforms the following
		on clicking them		
		• To right align the image.		
		• To change the height, width and border of the	ne image to 25	50, 350 and 3 pixels
		respectively	0	, I
		• To change the source and alternate text of the	image to "vin	avaga.jpg" and "The
		image cannot be loaded" respectively.	8	
		1. Design a web page with image gallery and	d sliding menu	for movie reviews
2.	Desig	the following using JavaScript and DOM	8	
2.	0	Given an array of words, write a javascript code	to count the m	umber of vowels and
	<i>a)</i>	number of consonants in each word. Use Regular l		
	b)	Include Image Slide Show Digital clock, Survey P	-	ur wehnage
		i) Dynamic.	on to make you	ur webpuze
	Devel	by a web application to implement online quiz sys	tem The annli	cation includes only
		side script	cm. me appli	cation includes only
3.		Ĩ	the contor of	organ on loading the
5.		a popup Login form using jQuery which appears at		
	page a	fter a specified time interval. Include Captcha text i	n me login pag	,e.

4.		Form given below using Jquery for the following
	conditions.	
	• All fields are mandat	•
	Zip code should be eEmail validation	xactry rive digits
	Email validation	
	Event Re	egistration Form
	First Name	
	Last Name	
	Mailing Address	
	City	
	State	
	Zip Code	
	Are you speaking at	□ No
	Conference Pass O 1-da O 2-da	
	○ 3-da ○ 4-da	y Pass
	Meal Preference	•
	Submit	
	b) Create a JSON file for a list of cit	ies. Provide autocomplete option for city field using the
	JSON file as source.	
5.	Using Angular JS, add names that ar	e entered in textbox to the list and clear the textbox once
	the name is added to list.	
	 Meenal 	• Meenal
	 Palak 	• Palak
	• Andrea	 Andrea Parul
		• Parul
	Parul add	add
L		

6.	the provisions	ing cart application using Angu- for selecting the list of items f king the submit button the items is given below.	rom differen	t catego	ry, Once tl	he items are
	Image	Product Description	Quantity	Price	Total	
	200	Box of 12 Rose Petal Blueberry Cupcakes Product Code: TLC12345	2 🗘	\$12.99	\$25.98	
	۲	Box of 6 Cookie Monster Raspberry Cupcakes Product Code: CHRIS99	1 🛊	\$12.99	\$12.99	
					tal \$38.97	
7.	Authors, Public	DDB collection of "books" with the cation ,Year of Publication and A			nue to Checkout Title, ISBN	(unique id),
		ommands for the following:				
		a new document with multiple a				
	· -	te a document with change in pri				
		ove documents with year of publi			90.	
8.	A MongoDB co	ollection of words has the docume	ent structure	as:		
		word: <word>,</word>				
	•	first: <first_letter>,</first_letter>				
		last: <last_letter>,</last_letter>				
		size: <character_count></character_count>				
	Perform t	he following operations on those	documente u	sing No.	leic	
		words which starts with letters 'a		Sing NO	uejs.	
		words which exactly has 12 lette	-			
		ber of words that starts and ends				
		en words that end with the letter '			acconding o	rder
9.						
7.	Initially the log	ine banking Web application ove in page should contain only user assword field should be displaye	id field. On e			-
	On successful l	ogin, display the account summar count no, Account type and Ava	ry with the fo	-	details retri	eved from
		top of the page display the Curre			ate and Use	erName and
	The session sho	ould expire on logout or if the page	e is idle for i	more tha	n 2 minutes	5.

10.	Create an application in node.js for employee management. The application should manage
	the following details of an employee: ID, name, surname, cadre and salary. Name and
	surname are strings, while ID, cadre and Salary are integers.
	The application should have the following functionalities:
	To search an employee using his/her ID If the employee exists, it will show his/her data in a
	form, otherwise an pop message should be displayed stating the employees does not exist.
	To delete an employee, by specifying his/her ID.
	To insert a new employee using a form. By default, the form is hidden, by pressing a button
	the form should appear. If the same button is clicked the form should disappear. Every time
	the form is shown, it should be empty. The form should allow to specify all data of an
	employee. If the ID field is left empty, the system will assign the next available ID. If the ID
	is already associated to an employee, the employee data are overwritten. If the ID is not
	associated to any employee, the employee is created. All the other fields cannot be empty.
11.	. Design an online book store using ExpressJS which has the following features (use the
	MongoDB database created in Question.No.9):
	a) Search option based on Title, Author or ISBN
	b) On retrieving the results, display the book details in table format with the Price field
	in sorted order using AngularJS
12.	Design a student registration form which takes student name, register number, DOB,
	program, email id, temporary address, permanent address, phone number. Validate the
	following using jquery: a. Mobile number should be exactly 10 digits b. Register number
	should have alphabets and numbers only c. Name should not exceed 30 characters and can
	be only alphabets. d. Email validation e. Provide a checkbox saying "Permanent address is
	same as temporary address". If checked, the value of permanent address should be added
	automatically from temp address. And should be in disabled mode.
	Total Laboratory Hours 30 hours
_	DescriptionDescriptionDescription12-08-2017
App	roved by Academic Council No. 47 Date 05-10-2017

	Course title		Т	Р	J	С
MAT3005	Applied Numerical Methods	3	2	0	0	4
Pre-requisite	MAT2002 – Applications of Differential and	Sylla	bus	Ve	rsio	n
	Difference Equations					
			1.	0		
	tives (CoB): 1,2,3,4					
The aim of this						
	certain basic, important computer oriented numerical	methods	for	ana	lyzi	ng
-	arise in engineering and physical sciences.		_			
	ATLAB as the primary computer language to obtain solution	tions to a	ı few	^v pro	ble	ms
	eir respective engineering courses.					
	skills to analyse problems connected with data analysis,					
4. is to solve of	ordinary and partial differential equations numerically					
Carrier Orates	(CO) + 12245					
	me (CO): 1,2,3,4,5 he course the student should be able to					
		tion				
	difference between exact solution and approximate solu- merical techniques (algorithms) to find the solution (a		nata)	.1.	ahr	
	system of equations.	approxim	iate)	aig	cor	aiC
	using interpolation technique and spline methods.					
	ution of ordinary differential equations, Heat and Wave	equation	num	neri/	-11e	,
	ulus of variation techniques to extremize the fund		and			
	eries solution to ordinary differential equations	Juonal	anu	aise) III	u
upproximate st	sites solution to ordinary unterential equations					
Module:1 A	lgebraic and Transcendental Equations 5 h	ours				
General iterati	ve method- rates of convergence- Secant method - Newt		phso	n m	etho	od
General iterati			phso	n m	etho	od
General iterati System of non	ve method- rates of convergence- Secant method - Newt -linear equations by Newton's method.	ton – Raj	phso	n m	etho	od∙
General iterati System of non Module:2 S	ve method- rates of convergence- Secant method - Newt -linear equations by Newton's method. ystem of Linear Equations and Eigen Value 6 he		phso	n m	etho	od.
General iterati System of non Module:2 S P	ve method- rates of convergence- Secant method - Newt -linear equations by Newton's method. ystem of Linear Equations and Eigen Value 6 he roblems	con – Raj ours				
General iterati System of non Module:2 S P Gauss –Seide	ve method- rates of convergence- Secant method - Newt -linear equations by Newton's method. ystem of Linear Equations and Eigen Value 6 he roblems el iteration method. Convergence analysis of	ton – Raj ours iterative	m	etho	ods-]	
General iterati System of non Module:2 S P Gauss –Seide Decomposition	ve method- rates of convergence- Secant method - Newt -linear equations by Newton's method. ystem of Linear Equations and Eigen Value 6 he roblems el iteration method. Convergence analysis of n -Tri diagonal system of equations-Thomas algorithm- 1	ton – Raj ours iterative	m	etho	ods-]	
General iterati System of non Module:2 S P Gauss –Seide Decomposition	ve method- rates of convergence- Secant method - Newt -linear equations by Newton's method. ystem of Linear Equations and Eigen Value 6 he roblems el iteration method. Convergence analysis of	ton – Raj ours iterative	m	etho	ods-]	
General iterati System of non Module:2 S P Gauss –Seide Decomposition matrix by Pow	ve method- rates of convergence- Secant method - Newt -linear equations by Newton's method. ystem of Linear Equations and Eigen Value 6 ho roblems el iteration method. Convergence analysis of n -Tri diagonal system of equations-Thomas algorithm- 1 er and Jacobi methods.	on – Ra ours iterative Eigen va	m	etho	ods-]	
General iterati System of non Module:2 S P Gauss –Seide Decomposition matrix by Pow Module:3 In	ve method- rates of convergence- Secant method - Newt -linear equations by Newton's method. ystem of Linear Equations and Eigen Value 6 he roblems el iteration method. Convergence analysis of n -Tri diagonal system of equations-Thomas algorithm- 1 er and Jacobi methods. hterpolation 6 he	on – Ra ours iterative Eigen va ours	ma	etho of a	ods-] ı	LU
General iterati System of non Module:2 S P Gauss –Seide Decomposition matrix by Pow Module:3 In Finite different	ve method- rates of convergence- Secant method - Newt -linear equations by Newton's method. ystem of Linear Equations and Eigen Value 6 he roblems el iteration method. Convergence analysis of n -Tri diagonal system of equations-Thomas algorithm- 1 er and Jacobi methods. hterpolation 6 he ce operators- Newton's forward-Newton's Backward-	on – Ra ours iterative Eigen va ours - Centra	mu lues	etho of a	ods-]	 LU :s-
General iterati System of non Module:2 S P Gauss –Seide Decomposition matrix by Pow Module:3 In Finite differen Stirling's inter	ve method- rates of convergence- Secant method - Newt -linear equations by Newton's method. ystem of Linear Equations and Eigen Value 6 he roblems el iteration method. Convergence analysis of n -Tri diagonal system of equations-Thomas algorithm- 1 er and Jacobi methods. hterpolation 6 he ce operators- Newton's forward-Newton's Backward- polation - Lagrange's interpolation - Inverse Interpola	on – Ra ours iterative Eigen va ours - Centra	mu lues	etho of a	ods-]	 LU :s-
General iterati System of non Module:2 S P Gauss –Seide Decomposition matrix by Pow Module:3 In Finite differen Stirling's inter	ve method- rates of convergence- Secant method - Newt -linear equations by Newton's method. ystem of Linear Equations and Eigen Value 6 he roblems el iteration method. Convergence analysis of n -Tri diagonal system of equations-Thomas algorithm- 1 er and Jacobi methods. hterpolation 6 he ce operators- Newton's forward-Newton's Backward-	on – Ra ours iterative Eigen va ours - Centra	mu lues	etho of a	ods-]	
General iterati System of non- Module:2 S P Gauss –Seide Decomposition matrix by Pow Module:3 In Finite differen Stirling's inter difference-Inte	ve method- rates of convergence- Secant method - Newt -linear equations by Newton's method. ystem of Linear Equations and Eigen Value 6 he roblems el iteration method. Convergence analysis of n -Tri diagonal system of equations-Thomas algorithm- 1 er and Jacobi methods. hterpolation 6 he ce operators- Newton's forward-Newton's Backward- polation - Lagrange's interpolation - Inverse Interpola problems.	on – Ra ours iterative Eigen va ours - Centra	mu lues	etho of a	ods-]	
General iterati System of non- Module:2 S P Gauss -Seide Decomposition matrix by Pow Module:3 In Finite difference Stirling's inter difference-Inter Module:4 N	ve method- rates of convergence- Secant method - Newt -linear equations by Newton's method. ystem of Linear Equations and Eigen Value roblems el iteration method. Convergence analysis of n -Tri diagonal system of equations-Thomas algorithm- I er and Jacobi methods. hterpolation ce operators- Newton's forward-Newton's Backward- polation - Lagrange's interpolation - Inverse Interpola problems fumerical Differentiation and Integration 6 ho	ours iterative Eigen va ours - Centra tion-New	lues lues	etho of a ffere	eds-]	
General iterati System of non- Module:2 S P Gauss -Seide Decomposition matrix by Pow Module:3 In Finite difference Stirling's inter difference-Inter Module:4 N	ve method- rates of convergence- Secant method - Newt -linear equations by Newton's method. ystem of Linear Equations and Eigen Value roblems el iteration method. Convergence analysis of n -Tri diagonal system of equations-Thomas algorithm- I er and Jacobi methods. hterpolation ce operators- Newton's forward-Newton's Backward- polation - Lagrange's interpolation - Inverse Interpola problems fumerical Differentiation and Integration 6 ho	ours iterative Eigen va ours - Centra tion-New	lues lues	etho of a ffere	eds-]	
General iterati System of non- Module:2 S P Gauss –Seide Decomposition matrix by Pow Module:3 In Finite differen Stirling's inter difference-Inter Module:4 N Numerical difference	ve method- rates of convergence- Secant method - Newt -linear equations by Newton's method. ystem of Linear Equations and Eigen Value 6 he roblems el iteration method. Convergence analysis of n -Tri diagonal system of equations-Thomas algorithm- 1 er and Jacobi methods. hterpolation 6 he ce operators- Newton's forward-Newton's Backward- polation - Lagrange's interpolation - Inverse Interpola problems.	ours iterative Eigen va ours - Centra tion-New	lues lues	etho of a ffere	eds-]	
General iterati System of non- Module:2 S P Gauss –Seide Decomposition matrix by Pow Module:3 In Finite differen Stirling's inter difference-Inte Module:4 N Numerical difference	ve method- rates of convergence- Secant method - Newt -linear equations by Newton's method. ystem of Linear Equations and Eigen Value roblems el iteration method. Convergence analysis of n -Tri diagonal system of equations-Thomas algorithm- I er and Jacobi methods. hterpolation ce operators- Newton's forward-Newton's Backward- roblation - Lagrange's interpolation - Inverse Interpola polation with cubic splines. (umerical Differentiation and Integration ferentiation with interpolation polynomials-maxima and polal rule, Simpsons 1/3 rd and 3/8 th rules. –Romberg's n	ours iterative Eigen va ours - Centra tion-New	lues lues	etho of a ffere	eds-]	
General iterati System of non Module:2 S P Gauss -Seide Decomposition matrix by Pow Module:3 In Finite difference Stirling's inter difference-Inte Module:4 N Numerical diffivalues-Trapezo point Gaussian	ve method- rates of convergence- Secant method - Newt -linear equations by Newton's method. ystem of Linear Equations and Eigen Value roblems el iteration method. Convergence analysis of n -Tri diagonal system of equations-Thomas algorithm- l er and Jacobi methods. futerpolation ce operators- Newton's forward-Newton's Backward- rpolation - Lagrange's interpolation - Inverse Interpola problems. fumerical Differentiation and Integration ferentiation with interpolation polynomials-maxima and poidal rule, Simpsons 1/3 rd and 3/8 th rules. –Romberg's n quadrature formula.	ours iterative Eigen va ours - Centra tion-New	lues lues	etho of a ffere	eds-]	
General iterati System of non- Module:2 S P Gauss -Seide Decomposition matrix by Pow Module:3 In Finite difference Stirling's inter difference-Inter Module:4 N Numerical difference point Gaussian Module:5 N	ve method- rates of convergence- Secant method - Newt -linear equations by Newton's method. ystem of Linear Equations and Eigen Value roblems el iteration method. Convergence analysis of n -Tri diagonal system of equations-Thomas algorithm- l er and Jacobi methods. futerpolation ce operators- Newton's forward-Newton's Backward- rpolation - Lagrange's interpolation - Inverse Interpola problems. fumerical Differentiation and Integration ferentiation with interpolation polynomials-maxima and poidal rule, Simpsons 1/3 rd and 3/8 th rules. –Romberg's n quadrature formula.	ours iterative Eigen va Ours Centra tion-New Ours I minima nethod. 7	lues lues	etho of a ffere	eds-]	LU es-
General iterati System of non- Module:2 S P Gauss -Seide Decomposition matrix by Pow Module:3 In Finite difference Stirling's inter difference-Inter Module:4 N Numerical difficult values-Trapezo point Gaussian Module:5 N E	ve method- rates of convergence- Secant method - Newt -linear equations by Newton's method. ystem of Linear Equations and Eigen Value 6 he roblems 6 he el iteration method. Convergence analysis of n -Tri diagonal system of equations-Thomas algorithm- 1 er and Jacobi methods. 6 he ce operators- Newton's forward-Newton's Backward- polation - Lagrange's interpolation - Inverse Interpola polation with cubic splines. fumerical Differentiation and Integration 6 he ferentiation with interpolation polynomials-maxima and poidal rule, Simpsons 1/3 rd and 3/8 th rules. –Romberg's n a quadrature formula. fumerical Solution of Ordinary Differential 8 he quations 8	ours iterative Eigen va Durs - Centra tion-New Durs 1 minima nethod. 7 Durs	lues lues lues	etho of a fferc 's d 	ence livic	
General iterati System of non- Module:2 S P Gauss -Seide Decomposition matrix by Pow Module:3 In Finite difference Stirling's inter difference-Inter Module:4 N Numerical diffivalues-Trapezo point Gaussian Module:5 N E First and second	ve method- rates of convergence- Secant method - Newt -linear equations by Newton's method. ystem of Linear Equations and Eigen Value 6 he roblems 6 he roblems 6 el iteration method. Convergence analysis of n -Tri diagonal system of equations-Thomas algorithm- 1 er and Jacobi methods. 6 he ce operators- Newton's forward-Newton's Backward- roblation - Lagrange's interpolation - Inverse Interpola erpolation with cubic splines. 6 he ferentiation with interpolation polynomials-maxima and bidal rule, Simpsons 1/3 rd and 3/8 th rules. –Romberg's n a quadrature formula. 8 he quations 1/3 rd and S-1000 polynomials-maxima and poidal rule, Simpsons 1/3 rd and 3/8 th rules. –Romberg's n a quadrature formula. 8 he quations 1/3 rd and S-1000 polynomials-maxima and poidal rule, Simpsons 1/3 rd and S-1000 polynomials-maxima and poidal rule, Simpsons 1/3 rd and S-1000 polynomials-maxima and poidal rule, Simpsons 1/3 rd and S-1000 polynomials-maxima and poidal rule formula.	on – Rap ours iterative Eigen va Durs Centra tion-New Durs I minima nethod. 7 Durs Kutta m	mulues lues lues l di: vvton	etho of a ffere 's d and d. A	ence ivic	
General iterati System of non- Module:2 S P Gauss –Seide Decomposition matrix by Pow Module:3 In Finite difference-Inter Stirling's inter difference-Inter Module:4 N Numerical difference-Inter Module:5 N First and secon Bashforth-Mot	ve method- rates of convergence- Secant method - Newt -linear equations by Newton's method. ystem of Linear Equations and Eigen Value 6 he roblems 6 he roblems 6 he el iteration method. Convergence analysis of n -Tri diagonal system of equations-Thomas algorithm- 1 er and Jacobi methods. hterpolation 6 he ce operators- Newton's forward-Newton's Backward- polation - Lagrange's interpolation - Inverse Interpola polation with cubic splines. fumerical Differentiation and Integration 6 he ferentiation with interpolation polynomials-maxima and poidal rule, Simpsons 1/3 rd and 3/8 th rules. –Romberg's n a quadrature formula. fumerical Solution of Ordinary Differential 8 he quations 8	on – Rap ours iterative Eigen va Durs Centra tion-New Durs I minima nethod. 7 Durs Kutta m	mulues lues lues l di: vvton	etho of a ffere 's d and d. A	ence ivic	LU es- led ree

Module:6	Numerical Solution of Partial Differential Equations	6 hours	
Classificatio	on of second order linear partial differential equation	s-Laplace eq	uation –Gauss-
	od-One dimensional heat equation- Schmidt explicit	1 1	
implicit met	hodOne dimensional wave equation-Explicit method	d.	
Module:7	Variational Methods	6 hours	
Introduction	- functional -variational problems- extremals of fund	ctional of a si	ngle dependent
variable and	its first derivative- functional involving higher orde	er derivatives	- Isoperimetric
problems- C	alerkins- Rayleigh Ritz methods.		
Module:8	Contemporary Issues	2 hours	
Industry Ex	pert Lecture	•	
	Total Lecture hours:	45 hours	
Tutorial	• A minimum of 10 problems to be worked	30 hours	
	out by students in every Tutorial Class.		
	• Another 5 problems per Tutorial Class to be		
	given for practise.		
Text Book(s)	•	
1. Nun	erical Methods for Scientific and Engineering, M. K	. Jain, S. R.	K. Iyengar and
	. Jain, New Age International Ltd., 6 th Edition, 2012.		
	lied Numerical Analysis, C. F. Gerald and P.V. Who	eatley, Additi	ion-Wesley, 7 th
	on, 2004.	-	
Reference 1	Books		
1. Intro	ductory Methods of Numerical Analysis, S.S. Sastry	, PHI Pvt. Lt	d., 5th Edition.
	Delhi, 2009.	,	, , , , , , , , , , , , , , , , , , , ,
2. App	lied Numerical Methods Using MATLAB, W.Y. Yar	ng, W. Cao, 7	F.S. Chung and
	orris, Wiley India Edn., 2007.		C
3. Nun	erical Methods for Engineers with Programming and	Software Ap	plications,
Stev	en C. Chapra and Ra P. Canale, 7 th Edition, Tata McG	raw Hill, 201	4.
4. Nun	erical Analysis, R.L. Burden and J. D. Faires, 4 th Edit	ion, Brooks (Cole, 2012.
5. Nun	erical Methods: Principles, Analysis and Algorithms,	Srimanta Pal	, Oxford
	versity Press India; 978-0195693751, 2009.		
Univ			
Univ Mode of Ev			
Mode of Ev Digital Ass	aluation ignments (Solutions by using soft skills), Continuo	us Assessme	nt Tests, Final
Mode of Ex Digital Ass Assessment	aluation ignments (Solutions by using soft skills), Continuo	us Assessme	nt Tests, Final

	Geographic information s	ystem	L T P J C
SWE4004			
Pre-requisite	SWE3002		Syllabus version
Course Objectiv			v. 1.
Course Objectiv		a and the arrival	fluencinc
	ate an understanding of guidelines, principle ic Information System.	s, and theories in	inuencing
01	about the GIS automation and decision making	ng using GIS	
	formation sources available, and be aware of		ies and technologies
	g the advances in GIS.		
	~		
Expected Cours	e Outcome:		
Upon Completion	n of the course, the students will be able to		
1. Have a c	lear understanding of the subject related cond	cepts and of conte	emporary issues
2. Gain kno	owledge in Map projections		
	and spatial data models		
	and the data input errors		
	sign thinking capability		
	and analytical modelling in GIS		
7. Use tech	niques, skills to develop new GIS application	1	
Module:1 Intr	oduction	3 hours	
	ographic Information Systems:- Definition of		and functions: why
	how GIS is applied; GIS as an Information S		
1			
Module:2 Maj	ps	7 hours	
Map Projections	and Coordinate Systems:-Characteristics of	Maps: Map Scal	
Map Projections Maps; Plane and	and Coordinate Systems:-Characteristics of Geographic Coordinates: Plane Rectangula	Maps: Map Scal ar Coordinate Sy	stem - Plane Pola
Map Projections Maps; Plane and Coordinate Syste	and Coordinate Systems:-Characteristics of Geographic Coordinates: Plane Rectangula em – Geographic Coordinate System of Ear	Maps: Map Scalar Coordinate Synth; Map Project	stem - Plane Pola ons: Types of Ma
Map Projections Maps; Plane and Coordinate Syste Projections – Co	and Coordinate Systems:-Characteristics of l Geographic Coordinates: Plane Rectangula em – Geographic Coordinate System of Ear mmon Map Projections -Properties - Major u	Maps: Map Scale ar Coordinate S th; Map Projecti ses; Map Project	vstem - Plane Pola ons: Types of Maj ions: Classification
Map Projections Maps; Plane and Coordinate Syste Projections – Cor -Aspects – View	and Coordinate Systems:-Characteristics of I Geographic Coordinates: Plane Rectangula em – Geographic Coordinate System of Ear mmon Map Projections -Properties - Major u points; Georeferencing framework – Geodeti	Maps: Map Scale ar Coordinate S th; Map Projecti ses; Map Project	vstem - Plane Pola ons: Types of Maj ions: Classification
Map Projections Maps; Plane and Coordinate Syste Projections – Cor -Aspects – View	and Coordinate Systems:-Characteristics of l Geographic Coordinates: Plane Rectangula em – Geographic Coordinate System of Ear mmon Map Projections -Properties - Major u	Maps: Map Scale ar Coordinate S th; Map Projecti ses; Map Project	vstem - Plane Pola ons: Types of Maj ions: Classification
Map Projections Maps; Plane and Coordinate Syste Projections – Cor -Aspects – View between coordina	and Coordinate Systems:-Characteristics of l Geographic Coordinates: Plane Rectangula em – Geographic Coordinate System of Ear mmon Map Projections -Properties - Major u points; Georeferencing framework – Geodeti ate system and Map Projections.	Maps: Map Scale ar Coordinate Sy th; Map Projecti ses; Map Project c and Vertical D	vstem - Plane Pola ons: Types of Magions: Classification
Map Projections Maps; Plane and Coordinate Syste Projections – Cor -Aspects – View between coordina Module:3 Car	and Coordinate Systems:-Characteristics of I Geographic Coordinates: Plane Rectangula em – Geographic Coordinate System of Ear mmon Map Projections -Properties - Major u points; Georeferencing framework – Geodeti ate system and Map Projections. tography and Spatial data modeling	Maps: Map Scale ar Coordinate Sy th; Map Projecti ses; Map Project c and Vertical D 7 hours	vstem - Plane Pola ons: Types of Maj ions: Classification atums; Relationshij
Map Projections Maps; Plane and Coordinate Syste Projections – Cor -Aspects – View between coordina Module:3 Car Cartography:- Gl	and Coordinate Systems:-Characteristics of l Geographic Coordinates: Plane Rectangula em – Geographic Coordinate System of Ear mmon Map Projections -Properties - Major u points; Georeferencing framework – Geodeti ate system and Map Projections.	Maps: Map Scale ar Coordinate Sy th; Map Projecti ses; Map Project c and Vertical D 7 hours D and GIS - Intr	vstem - Plane Pola ons: Types of Ma ions: Classification atums; Relationshi oduction to Remot
Map Projections Maps; Plane and Coordinate Syste Projections – Cor -Aspects – View between coordina Module:3 Car Cartography:- GI Sensing-Spatial I	and Coordinate Systems:-Characteristics of l Geographic Coordinates: Plane Rectangula em – Geographic Coordinate System of Ear mmon Map Projections -Properties - Major u points; Georeferencing framework – Geodeti ate system and Map Projections. tography and Spatial data modeling is and cartography - Difference between CA	Maps: Map Scale ar Coordinate Sy th; Map Projecti ses; Map Project c and Vertical D 7 hours D and GIS - Intr	vstem - Plane Pola ons: Types of Maj ions: Classification atums; Relationship oduction to Remote
Map Projections Maps; Plane and Coordinate Syste Projections – Cor -Aspects – View between coordina Module:3 Car Cartography:- Gl Sensing-Spatial I Data Structures: 1	and Coordinate Systems:-Characteristics of l Geographic Coordinates: Plane Rectangula em – Geographic Coordinate System of Ear mmon Map Projections -Properties - Major u points; Georeferencing framework – Geodeti ate system and Map Projections. tography and Spatial data modeling S and cartography - Difference between CA Data Modelling: Introduction – Entity Defini Raster data structures – vector data structure	Maps: Map Scale ar Coordinate Sy th; Map Projecti ses; Map Project c and Vertical D 7 hours D and GIS - Intr tion – Spatial Da	vstem - Plane Pola ons: Types of Ma ions: Classification atums; Relationshi oduction to Remot
Map ProjectionsMaps; Plane andCoordinate SysteProjections – Cor-Aspects – Viewbetween coordinateModule:3CarCartography:- GlSensing-Spatial IData Structures: IModule:4Data	and Coordinate Systems:-Characteristics of I Geographic Coordinates: Plane Rectangula em – Geographic Coordinate System of Ear mmon Map Projections -Properties - Major u points; Georeferencing framework – Geodeti ate system and Map Projections. tography and Spatial data modeling IS and cartography - Difference between CA Data Modelling: Introduction – Entity Defini Raster data structures – vector data structure a Input and Editing	Maps: Map Scale ar Coordinate Sy th; Map Project ses; Map Project c and Vertical D 7 hours D and GIS - Intr tion – Spatial Da	vstem - Plane Pola ons: Types of Ma ions: Classification atums; Relationshi oduction to Remot ta Models – Spatia
Map ProjectionsMaps; Plane andCoordinate SysteProjections – Cor-Aspects – Viewbetween coordinateModule:3CarCartography:- GlSensing-Spatial IData Structures: IModule:4DataMethods of data	and Coordinate Systems:-Characteristics of I Geographic Coordinates: Plane Rectangula em – Geographic Coordinate System of Ear mmon Map Projections -Properties - Major u points; Georeferencing framework – Geodeti ate system and Map Projections. tography and Spatial data modeling S and cartography - Difference between CA Data Modelling: Introduction – Entity Defini Raster data structures – vector data structure a Input and Editing input: keyboard entry-manual digitizing-au	Maps: Map Scale ar Coordinate Sy th; Map Projecti ses; Map Project c and Vertical D 7 hours D and GIS - Intr tion – Spatial Da 5 hours ttomatic digitizin	vstem - Plane Pola ons: Types of Ma ions: Classification atums; Relationshi oduction to Remot ta Models – Spatia
Map Projections Maps; Plane and Coordinate Syste Projections – Cor -Aspects – View between coordina Module:3 Car Cartography:- GI Sensing-Spatial I Data Structures: 1 Module:4 Data Methods of data transfer - Data e	and Coordinate Systems:-Characteristics of I Geographic Coordinates: Plane Rectangula em – Geographic Coordinate System of Ear mmon Map Projections -Properties - Major u points; Georeferencing framework – Geodeti ate system and Map Projections. tography and Spatial data modeling S and cartography - Difference between CA Data Modelling: Introduction – Entity Defini Raster data structures – vector data structure a Input and Editing input: keyboard entry-manual digitizing-au editing: Detecting and correcting errors – co	Maps: Map Scale ar Coordinate Synth; Map Projecti ses; Map Projecti c and Vertical D 7 hours D and GIS - Intr tion – Spatial Da 5 hours ntomatic digitizin ommon errors in	vstem - Plane Pola ons: Types of Maj ions: Classification atums; Relationship oduction to Remote ta Models – Spatia
Map Projections Maps; Plane and Coordinate Syste Projections – Cor -Aspects – View between coordina Module:3 Car Cartography:- Gl Sensing-Spatial I Data Structures: 1 Module:4 Dat Methods of data transfer - Data e projection, transf	and Coordinate Systems:-Characteristics of I Geographic Coordinates: Plane Rectangula em – Geographic Coordinate System of Ear mmon Map Projections -Properties - Major u points; Georeferencing framework – Geodeti ate system and Map Projections. tography and Spatial data modeling S and cartography - Difference between CA Data Modelling: Introduction – Entity Defini Raster data structures – vector data structure a Input and Editing input: keyboard entry-manual digitizing-au editing: Detecting and correcting errors – co formation and generalization – Geocoding	Maps: Map Scale ar Coordinate Synth; Map Project ses; Map Project c and Vertical D 7 hours D and GIS - Intr tion – Spatial Da 5 hours nomatic digitizin ommon errors in address data –	vstem - Plane Pola ons: Types of Ma ions: Classification atums; Relationshi oduction to Remot ta Models – Spatia
Map Projections Maps; Plane and Coordinate Syste Projections – Cor -Aspects – View between coordina Module:3 Car Cartography:- Gl Sensing-Spatial I Data Structures: 1 Module:4 Dat Methods of data transfer - Data e projection, transf maintaining spati	and Coordinate Systems:-Characteristics of I Geographic Coordinates: Plane Rectangula em – Geographic Coordinate System of Ear mmon Map Projections -Properties - Major u points; Georeferencing framework – Geodeti ate system and Map Projections. tography and Spatial data modeling S and cartography - Difference between CA Data Modelling: Introduction – Entity Defini Raster data structures – vector data structure a Input and Editing input: keyboard entry-manual digitizing-au editing: Detecting and correcting errors – co formation and generalization – Geocoding al database Case study: Ordnance Survey(OS	Maps: Map Scale ar Coordinate Synth; Map Project ses; Map Project c and Vertical D 7 hours D and GIS - Intr tion – Spatial Da 5 hours nomatic digitizin ommon errors in address data –	vstem - Plane Pola ons: Types of Maj ions: Classification atums; Relationship oduction to Remote ta Models – Spatia
Map Projections Maps; Plane and Coordinate Syste Projections – Cor -Aspects – View between coordina Module:3 Car Cartography:- Gl Sensing-Spatial I Data Structures: 1 Module:4 Dat Methods of data transfer - Data e projection, transf maintaining spati	and Coordinate Systems:-Characteristics of I Geographic Coordinates: Plane Rectangula em – Geographic Coordinate System of Ear mmon Map Projections -Properties - Major u points; Georeferencing framework – Geodeti ate system and Map Projections. tography and Spatial data modeling S and cartography - Difference between CA Data Modelling: Introduction – Entity Defini Raster data structures – vector data structure a Input and Editing input: keyboard entry-manual digitizing-au editing: Detecting and correcting errors – co formation and generalization – Geocoding	Maps: Map Scale ar Coordinate Synth; Map Project ses; Map Project c and Vertical D 7 hours D and GIS - Intr tion – Spatial Da 5 hours nomatic digitizin ommon errors in address data –	vstem - Plane Pola ons: Types of Maj ions: Classification atums; Relationship oduction to Remote ta Models – Spatia

Measurements in GIS – lengths, perimeters and areas – Queries – Reclassification - Buffering and
neighborhood functions- Integrating data – map overlay - Spatial interpolation- Analysis of
surfaces - Network analysis.

Module	e:6	Analytical modelling in GIS		7 hours		
	pro	n- Process models- Modelling physic cesses- Modelling the decision-makin cesses.				
Module	•7	Data Automation, Database and Da	ta Quality	7 hours		
		es: Internet resources for GIS - Data			l nation - locating and	
evaluati Databas	ng d es(E	ata - data formats – ArcGIS software; Ex. PostgreSQL); Data Quality Issues – rces of error in GIS – Finding and mod	Database- Po Introduction	ostGIS databasen, Describing d	e / ArcGIS supported ata quality and	
Module:8		Contemporary issues: Applications Geographic information systems in I Case Studies.		2 hours		
		Total Lec	ture hours:	45 hours		
Text Bo	ook(s)				
1.	Ian Heywood, Introduction to Geographical Information Systems, Pearson Education, fourth edition, 2012					
2.	C.P.LO, Albert K. W. Yeung, Concepts and Techniques of Geographic Information Systems, Publisher: PHI, 2 nd Edition, 2012.					
Referen						
1.	Jatin Pandey, <u>Darshana Pathak</u> , Geographic Information System, The Energy and Resources Institute, TERI, 2013 Kang-Tsung Chang, Introduction to Geographic Information Systems, McGraw-Hill					
2.	Higher Education, 6 edition, 2011 <u>Basudeb Bhatta</u> , Remote Sensing and GIS, Oxford; Second edition, 2011.					
-						
3.						
	nena	led by Board of Studies		05-03-2016		